

PIC16C6X

8-Bit CMOS Microcontrollers

Devices included in this data sheet:

PIC16C61

PIC16C64A

PIC16C62

PIC16CR64

PIC16C62A

PIC16C65

PIC16CR62

• PIC16C65A

PIC16C63

PIC16CR65

PIC16CR63

• PIC16C66

PIC16C64

PIC16C67

PIC16C6X Microcontroller Core Features:

- High performance RISC CPU
- · Only 35 single word instructions to learn
- All single cycle instructions except for program branches which are two-cycle
- Operating speed: DC 20 MHz clock input DC - 200 ns instruction cycle
- · Interrupt capability
- · Eight level deep hardware stack
- · Direct, indirect, and relative addressing modes
- · Power-on Reset (POR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Watchdog Timer (WDT) with its own on-chip RC oscillator for reliable operation
- · Programmable code-protection
- Power saving SLEEP mode
- · Selectable oscillator options

- Low-power, high-speed CMOS EPROM/ROM technology
- · Fully static design
- · Wide operating voltage range: 2.5V to 6.0V
- Commercial, Industrial, and Extended temperature ranges
- Low-power consumption:
 - < 2 mA @ 5V, 4 MHz
 - 15 μA typical @ 3V, 32 kHz
 - < 1 μA typical standby current

PIC16C6X Peripheral Features:

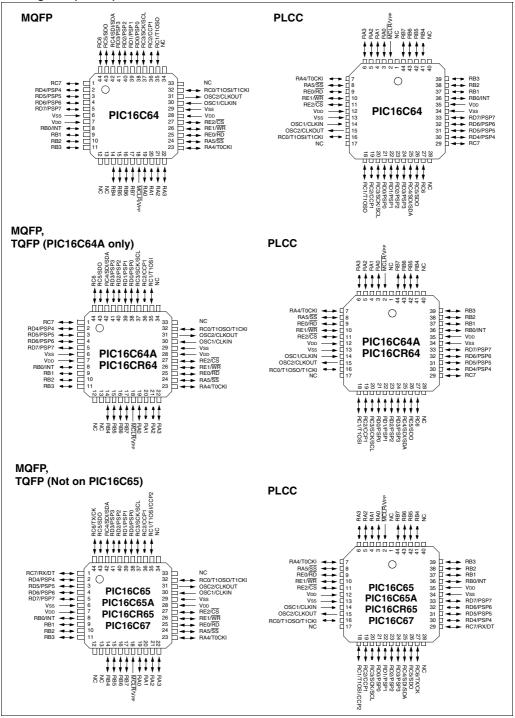
- Timer0: 8-bit timer/counter with 8-bit prescaler
- Timer1: 16-bit timer/counter with prescaler, can be incremented during sleep via external crystal/clock
- Timer2: 8-bit timer/counter with 8-bit period register, prescaler and postscaler
- Capture/Compare/PWM (CCP) module(s)
- Capture is 16-bit, max resolution is 12.5 ns, Compare is 16-bit, max resolution is 200 ns, PWM max resolution is 10-bit.
- Synchronous Serial Port (SSP) with SPI and I²C[™]
- Universal Synchronous Asynchronous Receiver Transmitter (USART/SCI)
- Parallel Slave Port (PSP) 8-bits wide, with external RD, WR and CS controls
- Brown-out detection circuitry for Brown-out Reset (BOR)

PIC16C6X Features	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67
Program Memory (EPROM) x 14	1K	2K	2K	_	4K	_	2K	2K		4K	4K	_	8K	8K
(ROM) x 14	_	_	_	2K	_	4K	_	_	2K	_	-	4K	-	_
Data Memory (Bytes) x 8	36	128	128	128	192	192	128	128	128	192	192	192	368	368
I/O Pins	13	22	22	22	22	22	33	33	33	33	33	33	22	33
Parallel Slave Port	_	_	_	_	_	_	Yes	Yes	Yes	Yes	Yes	Yes	-	Yes
Capture/Compare/PWM Module(s)	_	1	1	1	2	2	1	1	1	2	2	2	2	2
Timer Modules	1	3	3	3	3	3	3	3	3	3	3	3	3	3
Serial Communication	_	SPI/ I ² C	SPI/ I ² C	SPI/ I ² C	SPI/I ² C, USART	SPI/I ² C, USART	SPI/ I ² C	SPI/ I ² C	SPI/ I ² C	SPI/I ² C, USART				
In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Brown-out Reset	_	_	Yes	Yes	Yes	Yes	_	Yes	Yes	_	Yes	Yes	Yes	Yes
Interrupt Sources	3	7	7	7	10	10	8	8	8	11	11	11	10	11
Sink/Source Current (mA)	25/20	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25	25/25

Pin Diagrams PDIP, SOIC, Windowed CERDIP SDIP, SOIC, SSOP, Windowed CERDIP (300 mil) 18 → RA1 MCI R/Vpp RA3 ← 2 RA4/T0CKI ← 3 RA0 ← □ 2 27 ☐ → RB6 26 ☐ → RB5 17 → RA0 RA1 **←** ► □ 3 16 → OSC1/CLKIN 25 □ → RB4 MCLR/VPP → 4 15 → OSC2/CLKOUT RA3 **→** □ 5 24 ☐ → RB3 Vss --- □ 5 RA4/T0CKI ← □ 6 23 ☐ → RB2 RA5/SS → □ 7 Vss → □ 8 22 ☐ → RB1 21 ☐ → RB0/INT 13 ←→ RB7 RB0/INT ← 6 RB1 **→** 7 12 ←→ RB6 20 - VDD 19 - VSS RB2 → □ 8 11 → RB5 RC0/T1OSI/T1CKI ← ☐ 11 RC1/T1OSO ← ☐ 12 RC2/CCP1 ← ☐ 13 RB3 **→** 9 RB4 16 ☐ ←→ RC5/SDO PIC16C61 RC3/SCK/SCL ← ► □ 14 15 ☐ ←→ RC4/SDI/SDA **PIC16C62** SDIP, SOIC, SSOP, Windowed CERDIP (300 mil) SDIP, SOIC, Windowed CERDIP (300 mil) R/VPP - C RA0 - C RA1 - C RA2 - C MCI B/Vpp -28 ☐ ←→ RB7 MCI B/Vpp -□ ←→ RB6 □ - RB6 RA1 → □ 3 26 ☐ ←→ RB5 26 ☐ ←→ RB5 RA2 ▼ ► □ 4 25 ☐ ←→ RB4 4 25 ☐ ←→ RB4 RA3 **→** 5 RA4/T0CKI **→** 6 24 ☐ → RB3 23 ☐ → RB2 24 ☐ → RB3 23 ☐ → RB2 RA5/SS → □ 7 22 ☐ **← ►** RB1 Vss — **-** □ 8 21 □ - RB0/INT OSC1/CLKIN → 9 OSC2/CLKOUT ← 10 10 10 19 ☐ **→** Vss RC0/T1OSO/T1CKI - 11 RC1/T1OSI - 12 RC2/CCP1 - 13 RC0/T1OSO/T1CKI ---18 ☐ ← ► RC7/RX/DT 17 ☐ → RC6 12 17 ☐ → RC6/TX/CK RC2/CCP1 → ► 16 ☐ → BC5/SDO 13 16 - RC5/SDO RC3/SCK/SCL ← ► RC3/SCK/SCL → □ 14 15 T → RC4/SDI/SDA 15 RC4/SDI/SDA PIC16C62A PIC16C63 PIC16CR62 PIC16CR63 **PIC16C66** PDIP, Windowed CERDIP MCLR/Vpp → □ 1 40 1 → BR7 MCLB/Vpp → 1 40 1 → BB7 40 → RB7 39 → RB6 38 → RB5 37 → RB4 39 ☐ < ► RB6 38 ☐ < ► RB5 RA0 ▼ ► □ 2 RA1 → □ 3 37 RB4 36 RB3 35 RB2 34 RB1 RA2 ▼ ► □ 4 36 ☐ < ► RB3 35 ☐ < ► RB2 BA3 ▼ ► □ 5 RA4/T0CKI → □ 6 RA5/SS → □ 7 33 ☐ → ► RB0/INT RE0/RD → □ 8 RE1/WR → □ 9 RE2/CS → □ 10 26 → RC7/RX/DT PIC16C64A PIC16C64 **PIC16C65** PIC16CR64 PIC16C65A

PIC16CR65 PIC16C67

Pin Diagrams (Cont.'d)



PIC16C6X

Table Of Contents

1.0 General Description	5
2.0 PIC16C6X Device Varieties	7
3.0 Architectural Overview	c
4.0 Memory Organization	
5.0 I/O Ports	51
6.0 Overview of Timer Modules	63
7.0 Timer0 Module	65
8.0 Timer1 Module	71
9.0 Timer2 Module	75
10.0 Capture/Compare/PWM (CCP) Module(s)	77
11.0 Synchronous Serial Port (SSP) Module	83
12.0 Universal Synchronous Asynchronous Receiver Transmitter (USART) Module	105
13.0 Special Features of the CPU	123
14.0 Instruction Set Summary	143
15.0 Development Support	159
16.0 Electrical Characteristics for PIC16C61	163
17.0 DC and AC Characteristics Graphs and Tables for PIC16C61	173
18.0 Electrical Characteristics for PIC16C62/64	183
19.0 Electrical Characteristics for PIC16C62A/R62/64A/R64	199
20.0 Electrical Characteristics for PIC16C65	215
21.0 Electrical Characteristics for PIC16C63/65A	231
22.0 Electrical Characteristics for PIC16CR63/R65	247
23.0 Electrical Characteristics for PIC16C66/67	263
24.0 DC and AC Characteristics Graphs and Tables for:	
PIC16C62, PIC16C62A, PIC16CR62, PIC16C63, PIC16C64, PIC16C64A, PIC16CR64,	
PIC16C65A, PIC16C66, PIC16C67	281
25.0 Packaging Information	291
Appendix A: Modifications	307
Appendix B: Compatibility	
Appendix C: What's New	
Appendix D: What's Changed	308
Appendix E: PIC16/17 Microcontrollers	
Pin Compatibility	
Index	
List of Equation and Examples	
List of Figures	
List of Tables	
Reader Response	
PIC16C6X Product Identification System	335

For register and module descriptions in this data sheet, device legends show which devices apply to those sections. For example, the legend below shows that some features of only the PIC16C62A, PIC16CR62, PIC16C63, PIC16C64A, PIC16CR64, and PIC16C65A are described in this section.

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

To Our Valued Customers

We constantly strive to improve the quality of all our products and documentation. We have spent an exceptional amount of time to ensure that these documents are correct. However, we realize that we may have missed a few things. If you find any information that is missing or appears in error, please use the reader response form in the back of this data sheet to inform us. We appreciate your assistance in making this a better document.

1.0 GENERAL DESCRIPTION

The PIC16CXX is a family of low-cost, high-performance, CMOS, fully-static, 8-bit microcontrollers.

All PIC16/17 microcontrollers employ an advanced RISC architecture. The PIC16CXX microcontroller family has enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with separate 8-bit wide data. The two stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16CXX microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

The **PIC16C61** device has 36 bytes of RAM and 13 I/O pins. In addition a timer/counter is available.

The PIC16C62/62A/R62 devices have 128 bytes of RAM and 22 I/O pins. In addition, several peripheral features are available, including: three timer/counters, one Capture/Compare/PWM module and one serial port. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI™) or the two-wire Inter-Integrated Circuit (I²C) bus.

The PIC16C63/R63 devices have 192 bytes of RAM, while the PIC16C66 has 368 bytes. All three devices have 22 I/O pins. In addition, several peripheral features are available, including: three timer/counters, two Capture/Compare/PWM modules and two serial ports. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI) or the two-wire Inter-Integrated Circuit (I²C) bus. The Universal Synchronous Asynchronous Receiver Transmitter (USART) is also know as a Serial Communications Interface or SCI.

The PIC16C64/64A/R64 devices have 128 bytes of RAM and 33 I/O pins. In addition, several peripheral features are available, including: three timer/counters, one Capture/Compare/PWM module and one serial port. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI) or the two-wire Inter-Integrated Circuit (I²C) bus. An 8-bit Parallel Slave Port is also provided.

The PIC16C65/65A/R65 devices have 192 bytes of RAM, while the PIC16C67 has 368 bytes. All four devices have 33 I/O pins. In addition, several peripheral features are available, including: three timer/counters, two Capture/Compare/PWM modules and two serial ports. The Synchronous Serial Port can be configured as either a 3-wire Serial Peripheral Interface (SPI) or the two-wire Inter-Integrated Circuit (I²C) bus. The Universal Synchronous Asynchronous Receiver Transmit-

ter (USART) is also known as a Serial Communications Interface or SCI. An 8-bit Parallel Slave Port is also provided.

The PIC16C6X device family has special features to reduce external components, thus reducing cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low-cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for High Speed crystals. The SLEEP (power-down) mode offers a power saving mode. The user can wake the chip from SLEEP through several external and internal interrupts, and resets

A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software lock-up.

A UV erasable CERDIP packaged version is ideal for code development, while the cost-effective One-Time-Programmable (OTP) version is suitable for production in any volume.

The PIC16C6X family fits perfectly in applications ranging from high-speed automotive and appliance control to low-power remote sensors, keyboards and telecom processors. The EPROM technology makes customization of application programs (transmitter codes, motor speeds, receiver frequencies, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series perfect for all applications with space limitations. Low-cost, low-power, high performance, ease-of-use, and I/O flexibility make the PIC16C6X very versatile even in areas where no microcontroller use has been considered before (e.g. timer functions, serial communication, capture and compare, PWM functions, and co-processor applications).

1.1 Family and Upward Compatibility

Those users familiar with the PIC16C5X family of microcontrollers will realize that this is an enhanced version of the PIC16C5X architecture. Please refer to Appendix A for a detailed list of enhancements. Code written for PIC16C5X can be easily ported to PIC16CXX family of devices (Appendix B).

1.2 <u>Development Support</u>

PIC16C6X devices are supported by the complete line of Microchip Development tools.

Please refer to Section 15.0 for more details about Microchip's development tools.

TABLE 1-1: PIC16C6X FAMILY OF DEVICES

		PIC16C61	PIC16C62A	PIC16CR62	PIC16C63	PIC16CR63
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20
	EPROM Program Memory (x14 words)	1K	2K	_	4K	_
Memory	ROM Program Memory (x14 words)	_	_	2K		4K
	Data Memory (bytes)	36	128	128	192	192
	Timer Module(s)	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/ PWM Module(s)	_	1	1	2	2
	Serial Port(s) (SPI/I ² C, USART)	_	SPI/I ² C	SPI/I ² C	SPI/I ² C, USART	SPI/I ² C USART
	Parallel Slave Port	_	_	_	_	_
	Interrupt Sources	3	7	7	10	10
	I/O Pins	13	22	22	22	22
	Voltage Range (Volts)	3.0-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	_	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SO	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC	28-pin SDIP, SOIC

		PIC16C64A	PIC16CR64	PIC16C65A	PIC16CR65	PIC16C66	PIC16C67
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x14 words)	2K	_	4K	_	8K	8K
Memory	ROM Program Memory (x14 words)	_	2K	_	4K	_	_
	Data Memory (bytes)	128	128	192	192	368	368
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Mod- ule(s)	1	1	2	2	2	2
	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C	SPI/I ² C	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	Yes	Yes	Yes	Yes	_	Yes
	Interrupt Sources	8	8	11	11	10	11
	I/O Pins	33	33	33	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
Features	Brown-out Reset	Yes	Yes	Yes	Yes	Yes	Yes
	Packages	44-pin PLCC,		40-pin DIP; 44-pin PLCC, MQFP, TQFP	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C6X Family devices use serial programming with clock pin RB6 and data pin RB7.

2.0 PIC16C6X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC16C6X Product Identification System section at the end of this data sheet. When placing orders, please use that page of the data sheet to specify the correct part number.

For the PIC16C6X family of devices, there are four device "types" as indicated in the device number:

- C, as in PIC16C64. These devices have EPROM type memory and operate over the standard voltage range.
- LC, as in PIC16LC64. These devices have EPROM type memory and operate over an extended voltage range.
- CR, as in PIC16CR64. These devices have ROM program memory and operate over the standard voltage range.
- LCR, as in PIC16LCR64. These devices have ROM program memory and operate over an extended voltage range.

2.1 UV Erasable Devices

The UV erasable version, offered in CERDIP package is optimal for prototype development and pilot programs. This version can be erased and reprogrammed to any of the oscillator modes.

Microchip's PICSTART® Plus and PRO MATE® II programmers both support programming of the PIC16C6X.

2.2 <u>One-Time-Programmable (OTP)</u> Devices

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must also be programmed.

2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

2.4 <u>Serialized Quick-Turnaround</u> Production (SQTPSM) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random, or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password, or ID number.

ROM devices do not allow serialization information in the program memory space. The user may have this information programmed in the data memory space.

For information on submitting ROM code, please contact your regional sales office.

2.5 Read Only Memory (ROM) Devices

Microchip offers masked ROM versions of several of the highest volume parts, thus giving customers a low cost option for high volume, mature products.

For information on submitting ROM code, please contact your regional sales office.

PIC16C6X

NOTES:

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXX uses a Harvard architecture, in which, program and data are accessed from separate memories using separate buses. This improves bandwidth over traditional von Neumann architecture where program and data may be fetched from the same memory using the same bus. Separating program and data busses further allows instructions to be sized differently than 8-bit wide data words. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A twostage pipeline overlaps fetch and execution of instructions (Example 3-1). Consequently, all instructions execute in a single cycle (200 ns @ 20 MHz) except for program branches.

The PIC16C61 addresses 1K x 14 of program memory. The PIC16C62/62A/R62/64/64A/R64 address 2K x 14 of program memory, and the PIC16C63/R63/65/65A/R65 devices address 4K x 14 of program memory. The PIC16C66/67 address 8K x 14 program memory. All program memory is internal.

The PIC16CXX can directly or indirectly address its register files or data memory. All special function registers including the program counter are mapped in the data memory. The PIC16CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of "special optimal situations" makes programming with the PIC16CXX simple yet efficient, thus significantly reducing the learning curve.

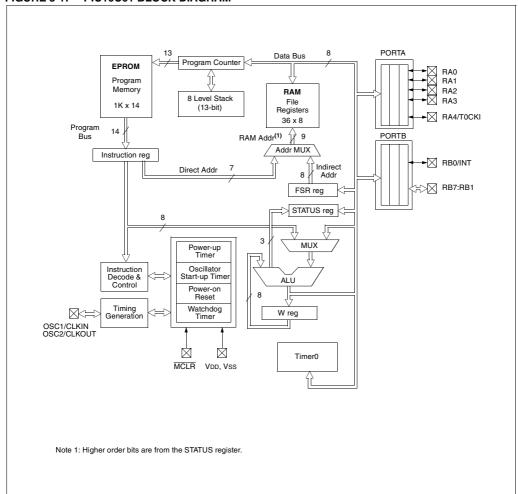
The PIC16CXX device contains an 8-bit ALU and working register (W). The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file

The ALU is 8-bits wide and capable of addition, subtraction, shift, and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register), the other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending upon the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. Bits C and DC operate as a borrow and digit borrow out bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

FIGURE 3-1: PIC16C61 BLOCK DIAGRAM



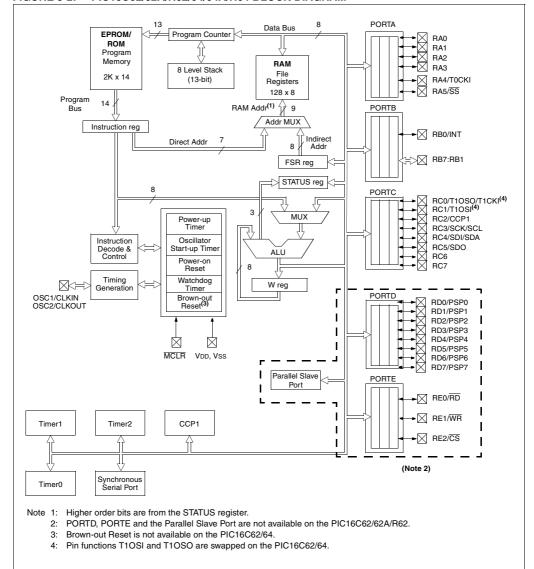


FIGURE 3-2: PIC16C62/62A/R62/64/64A/R64 BLOCK DIAGRAM

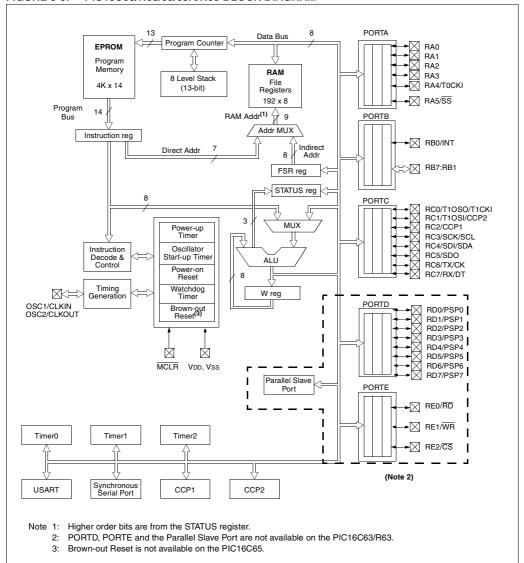
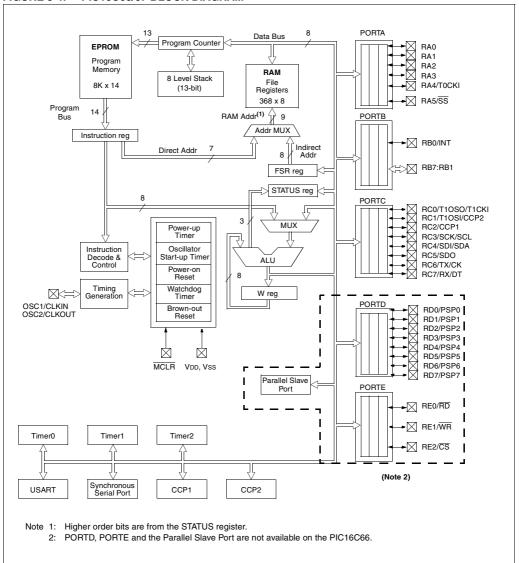


FIGURE 3-3: PIC16C63/R63/65/65A/R65 BLOCK DIAGRAM

FIGURE 3-4: PIC16C66/67 BLOCK DIAGRAM



PIC16C61 PINOUT DESCRIPTION TABLE 3-1:

Pin Name	DIP Pin#	SOIC Pin#	Pin Type	Buffer Type	Description
OSC1/CLKIN	16	16	I	ST/CMOS ⁽¹⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	15	15	0	_	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/VPP	4	4	I/P	ST	Master clear reset input or programming voltage input. This pin is an active low reset to the device.
					PORTA is a bi-directional I/O port.
RA0	17	17	I/O	TTL	
RA1	18	18	I/O	TTL	
RA2	1	1	I/O	TTL	
RA3	2	2	I/O	TTL	
RA4/T0CKI	3	3	I/O	ST	RA4 can also be the clock input to the Timer0 timer/counter. Output is open drain type.
					PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT	6	6	I/O	TTL/ST ⁽²⁾	RB0 can also be the external interrupt pin.
RB1	7	7	I/O	TTL	
RB2	8	8	I/O	TTL	
RB3	9	9	I/O	TTL	
RB4	10	10	I/O	TTL	Interrupt on change pin.
RB5	11	11	I/O	TTL	Interrupt on change pin.
RB6	12	12	I/O	TTL/ST(3)	Interrupt on change pin. Serial programming clock.
RB7	13	13	I/O	TTL/ST(3)	Interrupt on change pin. Serial programming data.
Vss	5	5	Р	_	Ground reference for logic and I/O pins.
VDD	14	14	Р	_	Positive supply for logic and I/O pins.

Legend: I = input O = output

Note 1: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.
2: This buffer is a Schmitt Trigger input when configured as the external interrupt.

^{- =} Not used

I/O = input/output TTL = TTL input

P = power ST = Schmitt Trigger input

^{3:} This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 3-2: PIC16C62/62A/R62/63/R63/66 PINOUT DESCRIPTION

Pin Name	Pin#	Pin Type	Buffer Type	Description
OSC1/CLKIN	9	I	ST/CMOS ⁽³⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	10	0	ı	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the pin outputs CLKOUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/VPP	1	I/P	ST	Master clear reset input or programming voltage input. This pin is an active low reset to the device.
				PORTA is a bi-directional I/O port.
RA0	2	I/O	TTL	
RA1	3	I/O	TTL	
RA2	4	I/O	TTL	
RA3	5	I/O	TTL	
RA4/T0CKI	6	I/O	ST	RA4 can also be the clock input to the Timer0 timer/counter. Output is open drain type.
RA5/SS	7	I/O	TTL	RA5 can also be the slave select for the synchronous serial port.
				PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT	21	I/O	TTL/ST(4)	RB0 can also be the external interrupt pin.
RB1	22	I/O	TTL	
RB2	23	I/O	TTL	
RB3	24	I/O	TTL	
RB4	25	I/O	TTL	Interrupt on change pin.
RB5	26	I/O	TTL	Interrupt on change pin.
RB6	27	I/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming clock.
RB7	28	I/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming data.
				PORTC is a bi-directional I/O port.
RC0/T1OSO ⁽¹⁾ /T1CKI	11	I/O	ST	RC0 can also be the Timer1 oscillator output ⁽¹⁾ or Timer1 clock input.
RC1/T1OSI ⁽¹⁾ /CCP2 ⁽²⁾	12	I/O	ST	RC1 can also be the Timer1 oscillator input ⁽¹⁾ or Capture2 input/Compare2 output/PWM2 output ⁽²⁾ .
RC2/CCP1	13	I/O	ST	RC2 can also be the Capture1 input/Compare1 out- put/PWM1 output.
RC3/SCK/SCL	14	I/O	ST	RC3 can also be the synchronous serial clock input/output for both SPI and I ² C modes.
RC4/SDI/SDA	15	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	16	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK ⁽²⁾	17	I/O	ST	RC6 can also be the USART Asynchronous Transmit ⁽²⁾ or Synchronous Clock ⁽²⁾ .
RC7/RX/DT ⁽²⁾	18	I/O	ST	RC7 can also be the USART Asynchronous Receive ⁽²⁾ or Synchronous Data ⁽²⁾ .
Vss	8,19	Р	_	Ground reference for logic and I/O pins.
VDD	20	Р	_	Positive supply for logic and I/O pins.
Legend: I = input O =	output	l/	O = input/outpu	

— = Not used

I/O = input/output TTL = TTL input

P = power ST = Schmitt Trigger input

Note 1: Pin functions T10SO and T10SI are reversed on the PIC16C62.

- 2: The USART and CCP2 are not available on the PIC16C62/62A/R62.
- 3: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.
- 4: This buffer is a Schmitt Trigger input when configured as the external interrupt.
- 5: This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 3-3: PIC16C64/64A/R64/65/65A/R65/67 PINOUT DESCRIPTION

Pin Name	DIP Pin#	PLCC Pin#	TQFP MQFP Pin#	Pin Type	Buffer Type	Description
OSC1/CLKIN	13	14	30	ı	ST/CMOS ⁽³⁾	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	14	15	31	0	_	Oscillator crystal output. Connects to crystal or resonator in crystal oscillator mode. In RC mode, the pin outputs CLK-OUT which has 1/4 the frequency of OSC1, and denotes the instruction cycle rate.
MCLR/VPP	1	2	18	I/P	ST	Master clear reset input or programming voltage input. This pin is an active low reset to the device.
						PORTA is a bi-directional I/O port.
RA0	2	3	19	I/O	TTL	
RA1	3	4	20	I/O	TTL	
RA2	4	5	21	I/O	TTL	
RA3	5	6	22	I/O	TTL	
RA4/T0CKI	6	7	23	I/O	ST	RA4 can also be the clock input to the Timer0 timer/counter. Output is open drain type.
RA5/SS	7	8	24	I/O	TTL	RA5 can also be the slave select for the synchronous serial port.
						PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.
RB0/INT	33	36	8	I/O	TTL/ST ⁽⁴⁾	RB0 can also be the external interrupt pin.
RB1	34	37	9	I/O	TTL	
RB2	35	38	10	I/O	TTL	
RB3	36	39	11	I/O	TTL	
RB4	37	41	14	I/O	TTL	Interrupt on change pin.
RB5	38	42	15	I/O	TTL	Interrupt on change pin.
RB6	39	43	16	I/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming clock.
RB7	40	44	17	I/O	TTL/ST ⁽⁵⁾	Interrupt on change pin. Serial programming data.
						PORTC is a bi-directional I/O port.
RC0/T10SO ⁽¹⁾ /T1CKI	15	16	32	I/O	ST	RC0 can also be the Timer1 oscillator output ⁽¹⁾ or Timer1 clock input.
RC1/T1OSI ⁽¹⁾ /CCP2 ⁽²⁾	16	18	35	I/O	ST	RC1 can also be the Timer1 oscillator input ⁽¹⁾ or Capture2 input/Compare2 output/PWM2 output ⁽²⁾ .
RC2/CCP1	17	19	36	I/O	ST	RC2 can also be the Capture1 input/Compare1 out- put/PWM1 output.
RC3/SCK/SCL	18	20	37	I/O	ST	RC3 can also be the synchronous serial clock input/out- put for both SPI and I ² C modes.
RC4/SDI/SDA	23	25	42	I/O	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	24	26	43	I/O	ST	RC5 can also be the SPI Data Out (SPI mode).
RC6/TX/CK ⁽²⁾	25	27	44	I/O	ST	RC6 can also be the USART Asynchronous Transmit ⁽²⁾ or Synchronous Clock ⁽²⁾ .
RC7/RX/DT ⁽²⁾	26	29	1	I/O	ST	RC7 can also be the USART Asynchronous Receive ⁽²⁾ or Synchronous Data ⁽²⁾ .

Legend: I = input O = output - = Not used

TTL = TTL input

ST = Schmitt Trigger input

Note 1: Pin functions T1OSO and T1OSI are reversed on the PIC16C64.

- 2: CCP2 and the USART are not available on the PIC16C64/64A/R64.
- 3: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.
- 4: This buffer is a Schmitt Trigger input when configured as the external interrupt.
- 5: This buffer is a Schmitt Trigger input when used in serial programming mode.
- 6: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

TABLE 3-3: PIC16C64/64A/R64/65/65A/R65/67 PINOUT DESCRIPTION (Cont.'d)

Pin Name	DIP Pin#	PLCC Pin#	TQFP MQFP Pin#	Pin Type	Buffer Type	Description
						PORTD can be a bi-directional I/O port or parallel slave port for interfacing to a microprocessor bus.
RD0/PSP0	19	21	38	I/O	ST/TTL ⁽⁶⁾	
RD1/PSP1	20	22	39	I/O	ST/TTL ⁽⁶⁾	
RD2/PSP2	21	23	40	I/O	ST/TTL ⁽⁶⁾	
RD3/PSP3	22	24	41	I/O	ST/TTL(6)	
RD4/PSP4	27	30	2	I/O	ST/TTL ⁽⁶⁾	
RD5/PSP5	28	31	3	I/O	ST/TTL ⁽⁶⁾	
RD6/PSP6	29	32	4	I/O	ST/TTL ⁽⁶⁾	
RD7/PSP7	30	33	5	I/O	ST/TTL(6)	
						PORTE is a bi-directional I/O port.
RE0/RD	8	9	25	I/O	ST/TTL ⁽⁶⁾	RE0 can also be read control for the parallel slave port.
RE1/WR	9	10	26	I/O	ST/TTL ⁽⁶⁾	RE1 can also be write control for the parallel slave port.
RE2/CS	10	11	27	I/O	ST/TTL(6)	RE2 can also be select control for the parallel slave port.
Vss	12,31	13,34	6,29	Р	_	Ground reference for logic and I/O pins.
VDD	11,32	12,35	7,28	Р	_	Positive supply for logic and I/O pins.
NC	_	1,17,	12,13,	_	_	These pins are not internally connected. These pins should
		28,40	33,34			be left unconnected.
Legend: I = input O = output			1/0	0 = input/	output	P = power

- = Not used

I/O = input/output TTL = TTL input

ST = Schmitt Trigger input

Note 1: Pin functions T1OSO and T1OSI are reversed on the PIC16C64.

- 2: CCP2 and the USART are not available on the PIC16C64/64A/R64.
- 3: This buffer is a Schmitt Trigger input when configured in RC oscillator mode and a CMOS input otherwise.
- 4: This buffer is a Schmitt Trigger input when configured as the external interrupt.
- 5: This buffer is a Schmitt Trigger input when used in serial programming mode.
- 6: This buffer is a Schmitt Trigger input when configured as general purpose I/O and a TTL input when used in the Parallel Slave Port mode (for interfacing to a microprocessor bus).

3.1 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3, and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clock and instruction execution flow is shown in Figure 3-5.

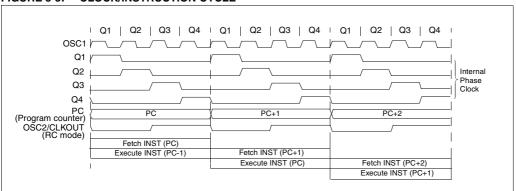
3.2 <u>Instruction Flow/Pipelining</u>

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3, and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g. GOTO) then two cycles are required to complete the instruction (Example 3-1).

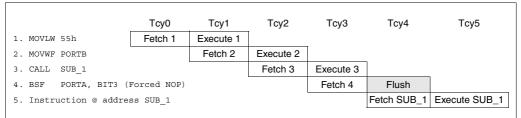
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register (IR)" in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-5: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



All instructions are single cycle, except for any program branches. These take two cycles since the fetch instruction is "flushed" from the pipeline while the new instruction is being fetched and then executed.

4.0 MEMORY ORGANIZATION

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

4.1 Program Memory Organization

The PIC16C6X family has a 13-bit program counter capable of addressing an 8K x 14 program memory space. The amount of program memory available to each device is listed below:

Device	Program Memory	Address Range
PIC16C61	1K x 14	0000h-03FFh
PIC16C62	2K x 14	0000h-07FFh
PIC16C62A	2K x 14	0000h-07FFh
PIC16CR62	2K x 14	0000h-07FFh
PIC16C63	4K x 14	0000h-0FFFh
PIC16CR63	4K x 14	0000h-0FFFh
PIC16C64	2K x 14	0000h-07FFh
PIC16C64A	2K x 14	0000h-07FFh
PIC16CR64	2K x 14	0000h-07FFh
PIC16C65	4K x 14	0000h-0FFFh
PIC16C65A	4K x 14	0000h-0FFFh
PIC16CR65	4K x 14	0000h-0FFFh
PIC16C66	8K x 14	0000h-1FFFh
PIC16C67	8K x 14	0000h-1FFFh

For those devices with less than 8K program memory, accessing a location above the physically implemented address will cause a wraparound.

The reset vector is at 0000h and the interrupt vector is at 0004h.

FIGURE 4-1: PIC16C61 PROGRAM MEMORY MAP AND STACK

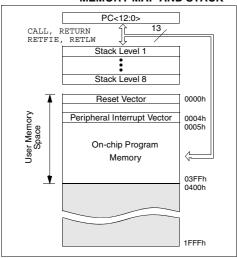


FIGURE 4-2: PIC16C62/62A/R62/64A/64A/ R64 PROGRAM MEMORY MAP AND STACK

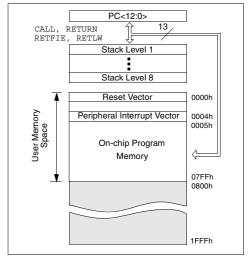


FIGURE 4-3: PIC16C63/R63/65/65A/R65 PROGRAM MEMORY MAP AND STACK

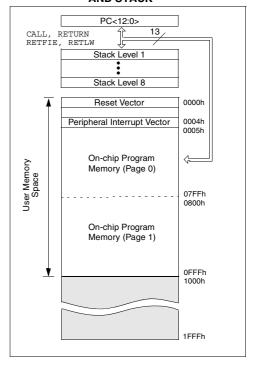
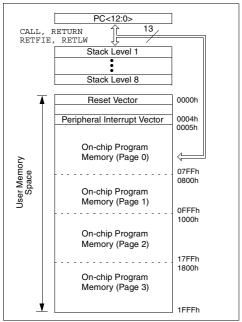


FIGURE 4-4: PIC16C66/67 PROGRAM MEMORY MAP AND STACK



4.2 Data Memory Organization

Αį	pli	cable	e Dev	/ice	es								
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

The data memory is partitioned into multiple banks which contain the General Purpose Registers and the Special Function Registers. Bits RP1 and RP0 are the bank select bits.

RP1:RP0 (STATUS<6:5>)

 $= 00 \rightarrow Bank0$

 $= 01 \rightarrow Bank1$

= $10 \rightarrow Bank2$

= 11 → Bank3

Each bank extends up to 7Fh (128 bytes). The lower locations of each bank are reserved for the Special Function Registers. Above the Special Function Registers are General Purpose Registers, implemented as static RAM. All implemented banks contain special function registers. Some "high use" special function registers from one bank may be mirrored in another bank for code reduction and quicker access.

4.2.1 GENERAL PURPOSE REGISTERS

These registers are accessed either directly or indirectly through the File Select Register (FSR) (Section 4.5).

For the PIC16C61, general purpose register locations 8Ch-AFh of Bank 1 are not physically implemented. These locations are mapped into 0Ch-2Fh of Bank 0.

FIGURE 4-5: PIC16C61 REGISTER FILE MAP

File Address	S	File	e Address				
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h				
01h	TMR0	OPTION	81h				
02h	PCL	PCL	82h				
03h	STATUS	STATUS	83h				
04h	FSR	FSR	84h				
05h	PORTA	TRISA	85h				
06h	PORTB	TRISB	86h				
07h			87h				
08h			88h				
09h			89h				
0Ah	PCLATH	PCLATH	8Ah				
0Bh	INTCON	INTCON	8Bh				
0Ch			8Ch				
	General Purpose Register	Mapped in Bank 0 ⁽²⁾					
2Fh			AFh				
30h			B0h				
	(
7Fh			FFh				
	Bank 0	Bank 1	_				
Unimplemented data memory location; read as '0'. Note 1: Not a physical register.							

 These locations are unimplemented in Bank 1. Any access to these locations will access the corresponding Bank 0 register.

FIGURE 4-6: PIC16C62/62A/R62/64/64A/ **R64 REGISTER FILE MAP**

	N04 NE	GISTER FILE	IWAP				
File Addre	ess		File Address				
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h				
01h	TMR0	OPTION	81h				
02h	PCL	PCL	82h				
03h	STATUS	STATUS	83h				
04h	FSR	FSR	84h				
05h	PORTA	TRISA	85h				
06h	PORTB	TRISB	86h				
07h	PORTC	TRISC	87h				
08h	PORTD ⁽²⁾	TRISD ⁽²⁾	88h				
09h	PORTE ⁽²⁾	TRISE ⁽²⁾	89h				
0Ah	PCLATH	PCLATH	8Ah				
0Bh	INTCON	INTCON	8Bh				
0Ch	PIR1	PIE1	8Ch				
0Dh			8Dh				
0Eh	TMR1L	PCON	8Eh				
0Fh	TMR1H		8Fh				
10h	T1CON		90h				
11h	TMR2		91h				
12h	T2CON	PR2	92h				
13h	SSPBUF	SSPADD	93h				
14h	SSPCON	SSPSTAT	94h				
15h	CCPR1L		95h				
16h	CCPR1H		96h				
17h	CCP1CON		97h				
18h			98h				
1Fh			9Fh				
20h			A0h				
2011	General	General Purpose Register	BFh				
	Purpose Register		C0h				
7Fh	D 10	D. d.	FFh				
Bank 0 Bank 1 Unimplemented data memory location; read as '0'. Note 1: Not a physical register. 2: PORTD and PORTE are not available on							

the PIC16C62/62A/R62.

FIGURE 4-7: PIC16C63/R63/65/65A/R65 **REGISTER FILE MAP**

	REGIS	IER FILE MA	Р
File Addre	ess		File Address
00h	INDF ⁽¹⁾	INDF ⁽¹⁾	80h
01h	TMR0	OPTION	81h
02h	PCL	PCL	82h
03h	STATUS	STATUS	83h
04h	FSR	FSR	84h
05h	PORTA	TRISA	85h
06h	PORTB	TRISB	86h
07h	PORTC	TRISC	87h
08h	PORTD ⁽²⁾	TRISD ⁽²⁾	88h
09h	PORTE ⁽²⁾	TRISE ⁽²⁾	89h
0Ah	PCLATH	PCLATH	8Ah
0Bh	INTCON	INTCON	8Bh
0Ch	PIR1	PIE1	8Ch
0Dh	PIR2	PIE2	8Dh
0Eh	TMR1L	PCON	8Eh
0Fh	TMR1H		8Fh
10h	T1CON		90h
11h	TMR2		91h
12h	T2CON	PR2	92h
13h	SSPBUF	SSPADD	93h
14h	SSPCON	SSPSTAT	94h
15h	CCPR1L		95h
16h	CCPR1H		96h
17h	CCP1CON		97h
18h	RCSTA	TXSTA	98h
19h	TXREG	SPBRG	99h
1Ah	RCREG		9Ah
1Bh	CCPR2L		9Bh
1Ch	CCPR2H		9Ch
1Dh	CCP2CON		9Dh
1Eh			9Eh
1Fh			9Fh
20h	General	General	A0h
75.	Purpose Register	Purpose Register	
7Fh	Bank 0	Bank 1	FFh
Unin	nplemented data m		ead as '0'.
NI-4-	. 4. Nata alamata	al register	

Note 1: Not a physical register

^{2:} PORTD and PORTE are not available on the PIC16C63/R63.

FIGURE 4-8: PIC16C66/67 DATA MEMORY MAP

							File Address
Indirect addr.(*)	00h	Indirect addr.(*)	80h	Indirect addr.(*)	100h	Indirect addr.(*)	180h
TMR0	01h	OPTION	81h	TMR0	101h	OPTION	181h
PCL	02h	PCL	82h	PCL	102h	PCL	182h
STATUS	03h	STATUS	83h	STATUS	103h	STATUS	183h
FSR	04h	FSR	84h	FSR	104h	FSR	184h
PORTA	05h	TRISA	85h		105h		185h
PORTB	06h	TRISB	86h	PORTB	106h	TRISB	186h
PORTC	07h	TRISC	87h		107h		187h
PORTD (1)	08h	TRISD (1)	88h		108h		188h
PORTE (1)	09h	TRISE (1)	89h		109h		189h
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH	18Ah
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON	18Bh
PIR1	0Ch	PIE1	8Ch		10Ch		18Ch
PIR2	0Dh	PIE2	8Dh		10Dh		18Dh
TMR1L	0Eh	PCON	8Eh		10Eh		18Eh
TMR1H	0Fh		8Fh		10Fh		18Fh
T1CON	10h		90h		110h		190h
TMR2	11h		91h		111h		191h
T2CON	12h	PR2	92h		112h		192h
SSPBUF	13h	SSPADD	93h		113h		193h
SSPCON	14h	SSPSTAT	94h		114h		194h
CCPR1L	15h		95h		115h		195h
CCPR1H	16h		96h		116h		196h
CCP1CON	17h		97h	General Purpose	117h	General Purpose	197h
RCSTA	18h	TXSTA	98h	Register	118h	Register	198h
TXREG	19h	SPBRG	99h	16 Bytes	119h	16 Bytes	199h
RCREG	1Ah		9Ah		11Ah		19Ah
CCPR2L	1Bh		9Bh		11Bh		19Bh
CCPR2H	1Ch		9Ch		11Ch		19Ch
CCP2CON	1Dh		9Dh		11Dh		19Dh
	1Eh		9Eh		11Eh		19Eh
	1Fh		9Fh		11Fh		19Fh
	20h		A0h		120h		1A0h
General Purpose Register 96 Bytes		General Purpose Register 80 Bytes	EFh	General Purpose Register 80 Bytes	16Fh	General Purpose Register 80 Bytes	_ 1EFh
	7Fh	accesses 70h-7Fh in Bank 0	F0h	accesses 70h-7Fh in Bank 0	170h	accesses 70h-7Fh in Bank 0	1F0h
Bank 0	71.11	Bank 1	1 1 11	Bank 2		Bank 3	

Unimplemented data memory locations, read as '0'.

These registers are not implemented on the PIC16C66.

Note: The upper 16 bytes of data memory in banks 1, 2, and 3 are mapped in Bank 0. This may require relocation of data memory usage in the user application code if upgrading to the PIC16C66/67.

^{*} Not a physical register.

4.2.2 SPECIAL FUNCTION REGISTERS:

The Special Function Registers are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. The special function registers can be classified into two sets (core and peripheral). The registers associated with the "core" functions are described in this section and those related to the operation of the peripheral features are described in the section of that peripheral feature.

TABLE 4-1: SPECIAL FUNCTION REGISTERS FOR THE PIC16C61

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conten	ts of FSR to	address data	memory (no	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	lule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signif	icant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect data	a memory ad	dress pointe	er					xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	en read	x xxxx	u uuuu					
06h	PORTB	PORTB Dat	a Latch whe		xxxx xxxx	uuuu uuuu					
07h	_	Unimpleme	nted		_	_					
08h	_	Unimpleme	nted		_						
09h	_	Unimpleme	nted		_	-					
0Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	_	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0-00 000x	0-00 000u
Bank 1											
80h ⁽¹⁾	INDF	Addressing	this location	uses conten	ts of FSR to	address data	memory (no	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signif	icant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	a memory ad	dress pointe	er					xxxx xxxx	uuuu uuuu
85h	TRISA	_	_	_	PORTA Dat	a Direction F	legister			1 1111	1 1111
86h	TRISB	PORTB Dat	a Direction C	Control Regis	ster					1111 1111	1111 1111
87h	-	Unimpleme	nimplemented								_
88h	-	Unimpleme	Inimplemented							_	
89h	-	Unimpleme	nted							_	_
8Ah ^(1,2)	PCLATH	_	Write Buffer for the upper 5 bits of the Program Counter								0 0000
8Bh ⁽¹⁾	INTCON	GIE	_	TOIE	RBIF	0-00 000x	0-00 000u				

 $\label{eq:localization} \textbf{Legend:} \quad \textbf{x} = \textbf{unknown}, \textbf{u} = \textbf{unchanged}, \textbf{q} = \textbf{value} \ \textbf{depends} \ \textbf{on condition}, \ \textbf{-} = \textbf{unimplemented locations read as '0'}.$

Shaded locations are unimplemented and read as '0'

Note 1: These registers can be addressed from either bank.

^{2:} The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

^{3:} Other (non power-up) resets include external reset through MCLR and the Watchdog Timer Reset.

^{4:} The IRP and RP1 bits are reserved on the PIC16C61, always maintain these bits clear.

TABLE 4-2: SPECIAL FUNCTION REGISTERS FOR THE PIC16C62/62A/R62

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	lule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect dat	a memory ac		xxxx xxxx	uuuu uuuu					
05h	PORTA	_	_	PORTA Dat	a Latch wher	written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Da	ta Latch whe	n written: PC	ORTB pins wh	nen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Da	ta Latch whe		xxxx xxxx	uuuu uuuu					
08h	_	Unimpleme	nted		_	_					
09h	_	Unimpleme	nted							_	_
0Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	(6)	(6)	-	_	SSPIF	CCP1IF	TMR2IF	TMR1IF	00 0000	00 0000
0Dh	_	Unimpleme	nted							_	_
0Eh	TMR1L	Holding reg	ister for the I	_east Signific	cant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	ne 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	lule's registe	r						0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	ıs Serial Por	t Receive Bu	ıffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	Capture/Compare/PWM1 (LSB)							xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	apture/Compare/PWM1 (MSB)							xxxx xxxx	uuuu uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h-1Fh	_	Unimpleme	plemented								_

 $\begin{tabular}{ll} Legend: & $x=$ unknown, $u=$ unchanged, $q=$ value depends on condition, $-=$ unimplemented location read as '0'. \end{tabular}$

Shaded locations are unimplemented, read as '0'.

- Note 1: These registers can be addressed from either bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
 - 4: The BOR bit is reserved on the PIC16C62, always maintain this bit set.
 - 5: The IRP and RP1 bits are reserved on the PIC16C62/62A/R62, always maintain these bits clear.
 - 6: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C62/62A/R62, always maintain these bits clear.

TABLE 4-2: SPECIAL FUNCTION REGISTERS FOR THE PIC16C62/62A/R62 (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1											
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	С	0001 1xxx	000q quuu					
84h ⁽¹⁾	FSR	Indirect data	a memory ac	Idress pointe		xxxx xxxx	uuuu uuuu				
85h	TRISA	_	_	PORTA Dat		11 1111	11 1111				
86h	TRISB	PORTB Date	ta Direction F	Register		1111 1111	1111 1111				
87h	TRISC	PORTC Da	ta Direction F	Register		1111 1111	1111 1111				
88h	-	Unimpleme	nted							_	-
89h	1	Unimpleme	nted							_	I
8Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	r 5 bits of the	Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	(6)	(6)	_	_	SSPIE	CCP1IE	TMR2IE	TMR1IE	00 0000	00 0000
8Dh	_	Unimpleme	nted							_	-
8Eh	PCON	_	_	-	_	_	_	POR	BOR ⁽⁴⁾	qq	uu
8Fh	-	Unimpleme	nted							_	-
90h	-	Unimpleme	nted							_	-
91h	_	Unimpleme	nted			_	_				
92h	PR2	Timer2 Peri	iod Register			1111 1111	1111 1111				
93h	SSPADD	Synchronou	us Serial Port	t (I ² C mode)		0000 0000	0000 0000				
94h	SSPSTAT	_	_	D/Ā	BF	00 0000	00 0000				
95h-9Fh	1	Unimpleme	nted							_	1

 $\begin{tabular}{ll} Legend: & $x=$ unknown, $u=$ unchanged, $q=$ value depends on condition, $-=$ unimplemented location read as '0'. \\ & Shaded locations are unimplemented, read as '0'. \\ \end{tabular}$

- Note 1: These registers can be addressed from either bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
 - 4: The BOR bit is reserved on the PIC16C62, always maintain this bit set.
 - 5: The IRP and RP1 bits are reserved on the PIC16C62/62A/R62, always maintain these bits clear.
 - 6: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C62/62A/R62, always maintain these bits clear.

TABLE 4-3: SPECIAL FUNCTION REGISTERS FOR THE PIC16C63/R63

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	lule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	ficant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect data	a memory ad	dress pointe	er					xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	PORTA Dat	a Latch wher	written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Dat	a Latch whe	n written: P0	ORTB pins wi	nen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Dat	ta Latch whe	n written: Po	ORTC pins w	hen read				xxxx xxxx	uuuu uuuu
08h	-	Unimpleme	nimplemented							_	_
09h	_	Unimpleme	nimplemented							_	_
0Ah ^(1,2)	PCLATH	_	— — Write Buffer for the upper 5 bits of the Program Counter						ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	GIE PEIE TOIE INTE RBIE TOIF INTE RBIE							0000 000x	0000 000u
0Ch	PIR1	(5)	(5)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	_	_	_		_	_	_	CCP2IF	0	0
0Eh	TMR1L	Holding reg	ister for the L	east Signific	cant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the N	Nost Signific	ant Byte of th	ne 16-bit TMI	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	lule's registe	r						0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	ıs Serial Port	Receive Bu	ıffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						xxxx xxxx	uuuu uuuu
17h	CCP1CON	_	-	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Trai	nsmit Data R	egister						0000 0000	0000 0000
1Ah	RCREG	USART Red	ceive Data R	egister						0000 0000	0000 0000
1Bh	CCPR2L	Capture/Co	mpare/PWM	2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Co	mpare/PWM	2 (MSB)						xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	-	_	CCP2X	CCP2Y	ССР2М3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
1Eh-1Fh	_	Unimpleme	nted							_	_

 $\label{eq:location} \textbf{Legend:} \quad \textbf{x} = \textbf{unknown}, \ \textbf{u} = \textbf{unchanged}, \ \textbf{q} = \textbf{value} \ \textbf{depends} \ \textbf{on condition}, \ \textbf{-} = \textbf{unimplemented} \ \textbf{location} \ \textbf{read} \ \textbf{as} \ \textbf{'0'}.$

Shaded locations are unimplemented, read as '0'.

- Note 1: These registers can be addressed from either bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
 - 4: The IRP and RP1 bits are reserved on the PIC16C63/R63, always maintain these bits clear.
 - $5: \quad \text{PIE1} < 7:6 \text{> and PIR1} < 7:6 \text{> are reserved on the PIC16C63/R63, always maintain these bits clear.} \\$

TABLE 4-3: SPECIAL FUNCTION REGISTERS FOR THE PIC16C63/R63 (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1											
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁴⁾	RP1 ⁽⁴⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	a memory ac	dress pointe	er					xxxx xxxx	uuuu uuuu
85h	TRISA	_	_	PORTA Dat	a Direction R	egister				11 1111	11 1111
86h	TRISB	PORTB Dat	ta Direction F	Register						1111 1111	1111 1111
87h	TRISC	PORTC Da	ta Direction F	Register						1111 1111	1111 1111
88h	_	Unimpleme	nted			_	_				
89h	_	Unimpleme	nted			_	_				
8Ah ^(1,2)	PCLATH	_	_	_	ounter	0 0000	0 0000				
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	RBIF	0000 000x	0000 000u				
8Ch	PIE1	(5)	(5)	RCIE	TMR1IE	0000 0000	0000 0000				
8Dh	PIE2	_	_	_	_	_	_	_	CCP2IE	0	0
8Eh	PCON	_	_	_	_	_	_	POR	BOR	qq	uu
8Fh	_	Unimpleme	nted							_	_
90h	_	Unimpleme	nted							_	_
91h	_	Unimpleme	nted							_	_
92h	PR2	Timer2 Peri	iod Register							1111 1111	1111 1111
93h	SSPADD	Synchronou	us Serial Port	t (I ² C mode)	Address Reg	gister				0000 0000	0000 0000
94h	SSPSTAT	_	_	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
95h	_	Unimpleme	nted							_	_
96h	_	Unimpleme	nted							_	_
97h	_	Unimpleme	nted							_	_
98h ⁽²⁾	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h ⁽²⁾	SPBRG	Baud Rate	ud Rate Generator Register								0000 0000
9Ah	_	Unimpleme	mplemented								_
9Bh	_	Unimpleme	nted		_	_					
9Ch	_	Unimpleme	plemented								_
9Dh	_	Unimpleme	nted	_	_						
9Eh	_	Unimpleme	nted							_	_
9Fh	_	Unimpleme	nted							-	_

 $\label{eq:local_equation} \textbf{Legend:} \quad \textbf{x} = \textbf{unknown}, \ \textbf{u} = \textbf{unchanged}, \ \textbf{q} = \textbf{value depends on condition}, \ \textbf{-} = \textbf{unimplemented location read as '0'}.$

Shaded locations are unimplemented, read as '0'.

- Note 1: These registers can be addressed from either bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
 - 4: The IRP and RP1 bits are reserved on the PIC16C63/R63, always maintain these bits clear.
 - 5: PIE1<7:6> and PIR1<7:6> are reserved on the PIC16C63/R63, always maintain these bits clear.

TABLE 4-4: SPECIAL FUNCTION REGISTERS FOR THE PIC16C64/64A/R64

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conten	ts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	lule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signif	icant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect data	a memory ac	ldress pointe	r	I	I	I	I	xxxx xxxx	uuuu uuuu
05h	PORTA	-	_		xx xxxx	uu uuuu					
06h	PORTB	PORTB Dat	a Latch whe		xxxx xxxx	uuuu uuuu					
07h	PORTC	PORTC Da	RTC Data Latch when written: PORTC pins when read								uuuu uuuu
08h	PORTD	PORTD Da	a Latch whe	n written: PC		xxxx xxxx	uuuu uuuu				
09h	PORTE	-	_	_	_	_	RE2	RE1	RE0	xxx	uuu
0Ah ^(1,2)	PCLATH	-	-	_	Write Buffer	for the uppe	r 5 bits of the	Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF	(6)	_	-	SSPIF	CCP1IF	TMR2IF	TMR1IF	00 0000	00 0000
0Dh	_	Unimpleme	nted							_	_
0Eh	TMR1L	Holding reg	ister for the L	east Signific	ant Byte of the	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	e 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	lule's registe	r		•				0000 0000	0000 0000
12h	T2CON	-	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	s Serial Por	Receive Bu	ffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	apture/Compare/PWM1 (LSB)							xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	apture/Compare/PWM1 (MSB)							xxxx xxxx	uuuu uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h-1Fh	_	Unimpleme	nted			_	_				
		•		r – value de							

 $\begin{tabular}{ll} Legend: & $x=$ unknown, $u=$ unchanged, $q=$ value depends on condition, $-=$ unimplemented location read as '0'. \end{tabular}$

- Note 1: These registers can be addressed from either bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
 - 4: The BOR bit is reserved on the PIC16C64, always maintain this bit set.
 - 5: The IRP and RP1 bits are reserved on the PIC16C64/64A/R64, always maintain these bits clear.
 - $\hbox{6:} \quad \hbox{PIE1<6> and PIR1<6> are reserved on the PIC16C64/64A/R64, always maintain these bits clear. } \\$

Shaded locations are unimplemented, read as '0'.

TABLE 4-4: SPECIAL FUNCTION REGISTERS FOR THE PIC16C64/64A/R64 (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1		•				•		•			
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	rect data memory address pointer								uuuu uuuu
85h	TRISA	_	PORTA Data Direction Register								11 1111
86h	TRISB	PORTB Dat	RTB Data Direction Register								1111 1111
87h	TRISC	PORTC Da	RTC Data Direction Register								1111 1111
88h	TRISD	PORTD Da	ta Direction F	Register						1111 1111	1111 1111
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Da	ta Direction I	Bits	0000 -111	0000 -111
8Ah ^(1,2)	PCLATH	_	1	-	Write Buffer	for the uppe	r 5 bits of the	Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
8Ch	PIE1	PSPIE	(6)	_	_	SSPIE	CCP1IE	TMR2IE	TMR1IE	00 0000	00 0000
8Dh	_	Unimpleme	nted							-	_
8Eh	PCON	_	_	_	_	_	_	POR	BOR ⁽⁴⁾	qq	uu
8Fh	_	Unimpleme	nted							_	_
90h	_	Unimpleme	nted							_	_
91h	_	Unimpleme	Inimplemented							_	_
92h	PR2	Timer2 Peri	imer2 Period Register							1111 1111	1111 1111
93h	SSPADD	Synchronou	Synchronous Serial Port (I ² C mode) Address Register							0000 0000	0000 0000
94h	SSPSTAT	_	D/Ā P S R/₩ UA BF						BF	00 0000	00 0000
95h-9Fh	_	Unimpleme	nted			_	_				

 $\label{eq:location} \textbf{Legend:} \quad \textbf{x} = \textbf{unknown}, \ \textbf{u} = \textbf{unchanged}, \ \textbf{q} = \textbf{value} \ \textbf{depends} \ \textbf{on condition}, \ \textbf{-} = \textbf{unimplemented} \ \textbf{location} \ \textbf{read} \ \textbf{as} \ \textbf{'0'}.$

Shaded locations are unimplemented, read as '0'.

- Note 1: These registers can be addressed from either bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
 - 4: The BOR bit is reserved on the PIC16C64, always maintain this bit set.
 - 5: The IRP and RP1 bits are reserved on the PIC16C64/64A/R64, always maintain these bits clear.
 - 6: PIE1<6> and PIR1<6> are reserved on the PIC16C64/64A/R64, always maintain these bits clear.

TABLE 4-5: SPECIAL FUNCTION REGISTERS FOR THE PIC16C65/65A/R65

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	ts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	dule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	icant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect data	a memory ac	Idress pointe	r					xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	PORTA Dat	a Latch wher	written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Da	ta Latch whe	n written: PC	ORTB pins wh	nen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Da	ta Latch whe	n written: PO	ORTC pins w	hen read				xxxx xxxx	uuuu uuuu
08h	PORTD	PORTD Da	ta Latch whe	n written: PO	ORTD pins w	hen read				xxxx xxxx	uuuu uuuu
09h	PORTE	-	_	_	_	_	RE2	RE1	RE0	xxx	uuu
0Ah ^(1,2)	PCLATH	-	_	-	Write Buffer	for the uppe	r 5 bits of the	Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF	(6)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	_	_	_	_	_	_	_	CCP2IF	0	0
0Eh	TMR1L	Holding reg	ister for the I	_east Signific	ant Byte of t	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	ne 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	-	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	dule's registe	r						0000 0000	0000 0000
12h	T2CON	-	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	us Serial Por	t Receive Bu	ffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						xxxx xxxx	uuuu uuuu
17h	CCP1CON	1	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	nsmit Data F	legister						0000 0000	0000 0000
1Ah	RCREG	USART Red	ceive Data R	egister						0000 0000	0000 0000
1Bh	CCPR2L	Capture/Co	mpare/PWM	2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Co	mpare/PWM	2 (MSB)						xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	_	_	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
1Eh-1Fh	_	Unimpleme	nted							_	_

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'.

Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

^{2:} The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

^{3:} Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.

^{4:} The BOR bit is reserved on the PIC16C65, always maintain this bit set.

^{5:} The IRP and RP1 bits are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

^{6:} PIE1<6> and PIR1<6> are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

TABLE 4-5: SPECIAL FUNCTION REGISTERS FOR THE PIC16C65/65A/R65 (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1											
80h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
81h	OPTION	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
82h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
83h ⁽¹⁾	STATUS	IRP ⁽⁵⁾	RP1 ⁽⁵⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	a memory ac	Idress pointe	er					xxxx xxxx	uuuu uuuu
85h	TRISA	_	_	PORTA Da	ta Direction R	egister				11 1111	11 1111
86h	TRISB	PORTB Dat	ta Direction F	Register						1111 1111	1111 1111
87h	TRISC	PORTC Dat	RTC Data Direction Register								1111 1111
88h	TRISD	PORTD Dat	RTD Data Direction Register								1111 1111
89h	TRISE	IBF									0000 -111
8Ah ^(1,2)	PCLATH	_	_	_	ounter	0 0000	0 0000				
8Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	RBIF	0000 000x	0000 000u				
8Ch	PIE1	PSPIE	(6)	RCIE	TMR1IE	0000 0000	0000 0000				
8Dh	PIE2	_	_	_	_	_	_	_	CCP2IE	0	0
8Eh	PCON	_	_	-	_	_	_	POR	BOR ⁽⁴⁾	qq	uu
8Fh	_	Unimpleme	nted							_	_
90h	_	Unimpleme	nted							_	_
91h	_	Unimpleme	nted							_	_
92h	PR2	Timer2 Peri	iod Register							1111 1111	1111 1111
93h	SSPADD	Synchronou	us Serial Port	t (I ² C mode)	Address Reg	jister				0000 0000	0000 0000
94h	SSPSTAT	_	_	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000
95h	_	Unimpleme	nted							_	_
96h	_	Unimpleme	nted							_	_
97h	_	Unimpleme	nted							_	_
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	ud Rate Generator Register								0000 0000
9Ah	_	Unimpleme	nted			_	_				
9Bh	_	Unimpleme	nted			_	_				
9Ch	_	Unimpleme	nplemented							_	_
9Dh	_	Unimpleme	nted			_	_				
9Eh	_	Unimpleme	nted							_	_
9Fh	_	Unimpleme	nted							_	_

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'.

Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from either bank.

- 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
- 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
- 4: The $\overline{\text{BOR}}\,$ bit is reserved on the PIC16C65, always maintain this bit set.
- 5: The IRP and RP1 bits are reserved on the PIC16C65/65A/R65, always maintain these bits clear.
- 6: PIE1<6> and PIR1<6> are reserved on the PIC16C65/65A/R65, always maintain these bits clear.

TABLE 4-6: SPECIAL FUNCTION REGISTERS FOR THE PIC16C66/67

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 0											
00h ⁽¹⁾	INDF	Addressing	this location	uses conter	ts of FSR to	address data	memory (n	ot a physical	register)	0000 0000	0000 0000
01h	TMR0	Timer0 mod	lule's registe	r						xxxx xxxx	uuuu uuuu
02h ⁽¹⁾	PCL	Program Co	ounter's (PC)	Least Signi	icant Byte					0000 0000	0000 0000
03h ⁽¹⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
04h ⁽¹⁾	FSR	Indirect data	a memory ac	Idress pointe	er					xxxx xxxx	uuuu uuuu
05h	PORTA	_	_	PORTA Dat	a Latch wher	written: PO	RTA pins wh	en read		xx xxxx	uu uuuu
06h	PORTB	PORTB Dat	a Latch whe	n written: PC	ORTB pins wh	nen read				xxxx xxxx	uuuu uuuu
07h	PORTC	PORTC Dat	a Latch whe	n written: PO	ORTC pins wi	nen read				xxxx xxxx	uuuu uuuu
08h ⁽⁵⁾	PORTD	PORTD Dat	a Latch whe	n written: PO	ORTD pins wh	nen read				xxxx xxxx	uuuu uuuu
09h ⁽⁵⁾	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	uuu
0Ah ^(1,2)	PCLATH	_	-	-	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
0Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽⁶⁾	(4)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
0Dh	PIR2	_	-	_	_	_	-	_	CCP2IF	0	0
0Eh	TMR1L	Holding reg	ister for the I	_east Signific	ant Byte of the	he 16-bit TM	R1 register			xxxx xxxx	uuuu uuuu
0Fh	TMR1H	Holding reg	ister for the I	Most Signific	ant Byte of th	e 16-bit TMF	R1 register			xxxx xxxx	uuuu uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	00 0000	uu uuuu
11h	TMR2	Timer2 mod	lule's registe	r						0000 0000	0000 0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
13h	SSPBUF	Synchronou	ıs Serial Por	t Receive Bu	ffer/Transmit	Register				xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
15h	CCPR1L	Capture/Co	mpare/PWM	1 (LSB)						xxxx xxxx	uuuu uuuu
16h	CCPR1H	Capture/Co	mpare/PWM	1 (MSB)						xxxx xxxx	uuuu uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Trai	nsmit Data F	legister						0000 0000	0000 0000
1Ah	RCREG	USART Red	ceive Data R	egister						0000 0000	0000 0000
1Bh	CCPR2L	Capture/Co	mpare/PWM	2 (LSB)						xxxx xxxx	uuuu uuuu
1Ch	CCPR2H	Capture/Co	mpare/PWM	2 (MSB)						xxxx xxxx	uuuu uuuu
1Dh	CCP2CON	_	_	CCP2X	CCP2Y	ССР2М3	CCP2M2	CCP2M1	CCP2M0	00 0000	00 0000
1Eh-1Fh	_	Unimpleme	nted							_	_

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'. Shaded locations are unimplemented, read as '0'.

Note 1: These registers can be addressed from any bank.

- 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
- 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
- 4: PIE1<6> and PIR1<6> are reserved on the PIC16C66/67, always maintain these bits clear.
- 5: PORTD, PORTE, TRISD, and TRISE are not implemented on the PIC16C66, read as '0'.
- 6: PSPIF (PIR1<7>) and PSPIE (PIE1<7>) are reserved on the PIC16C66, maintain these bits clear.

TABLE 4-6: SPECIAL FUNCTION REGISTERS FOR THE PIC16C66/67 (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 1											
80h ⁽¹⁾	INDF	Addressing	0000 0000	0000 0000							
81h	OPTION	RBPU INTEDG TOCS TOSE PSA PS2 PS1 PS0 1									1111 1111
82h ⁽¹⁾	PCL	Program Co	0000 0000	0000 0000							
83h ⁽¹⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
84h ⁽¹⁾	FSR	Indirect data	xxxx xxxx	uuuu uuuu							
85h	TRISA	_	_	PORTA Da	ta Direction R	egister				11 1111	11 1111
86h	TRISB	PORTB Dat	a Direction F	Register						1111 1111	1111 1111
87h	TRISC	PORTC Dat	ta Direction F	Register						1111 1111	1111 1111
88h ⁽⁵⁾	TRISD	PORTD Date	ta Direction F	Register						1111 1111	1111 1111
89h ⁽⁵⁾	TRISE	PORTA Data Direction Register									0000 -111
8Ah ^(1,2)	PCLATH	_	_	_	Write Buffer	for the uppe	r 5 bits of the	Program C	ounter	0 0000	0 0000
8Bh ⁽¹⁾	INTCON									0000 000u	
8Ch	PIE1	PSPIE ⁽⁶⁾	(4)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
8Dh	PIE2	_	_	_	_	_	_	_	CCP2IE	0	0
8Eh	PCON	_	_	_	_	_	_	POR	BOR	qq	uu
8Fh	_	Unimpleme	nted		•		-			_	_
90h	_	Unimpleme	nted							_	_
91h	_	Unimpleme	nted							_	_
92h	PR2	Timer2 Period Register								1111 1111	1111 1111
93h	SSPADD	Synchronous Serial Port (I ² C mode) Address Register								0000 0000	0000 0000
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	0000 0000
95h	_	Unimpleme	nted							_	_
96h	_	Unimpleme	nted							_	_
97h	_	Unimpleme	nted							_	_
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generator Re	egister	•			•		0000 0000	0000 0000
9Ah	_	Unimpleme	nted							_	_
9Bh	_	Unimpleme	nted							_	_
9Ch	_	Unimpleme	nted							_	_
9Dh	_	Unimpleme	nted							_	_
9Eh	_	Unimpleme	nted							_	_
9Fh	_	Unimpleme	nted							_	_

 $\label{eq:location} \textbf{Legend:} \quad \textbf{x} = \textbf{unknown}, \ \textbf{u} = \textbf{unchanged}, \ \textbf{q} = \textbf{value depends on condition}, \ \textbf{-} = \textbf{unimplemented location read as '0'}.$

Shaded locations are unimplemented, read as '0'.

- Note 1: These registers can be addressed from any bank.
 - 2: The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)
 - 3: Other (non power-up) resets include external reset through $\overline{\text{MCLR}}$ and the Watchdog Timer reset.
 - 4: PIE1<6> and PIR1<6> are reserved on the PIC16C66/67, always maintain these bits clear.
 - 5: PORTD, PORTE, TRISD, and TRISE are not implemented on the PIC16C66, read as '0'.
 - 6: PSPIF (PIR1<7>) and PSPIE (PIE1<7>) are reserved on the PIC16C66, maintain these bits clear.

TABLE 4-6: SPECIAL FUNCTION REGISTERS FOR THE PIC16C66/67 (Cont.'d)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets ⁽³⁾
Bank 2	•					•				-	
100h ⁽¹⁾	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								0000 0000	0000 0000
101h	TMR0	Timer0 module's register									uuuu uuuu
102h ⁽¹⁾	PCL	Program Counter's (PC) Least Significant Byte							0000 0000	0000 0000	
103h ⁽¹⁾	STATUS	IRP RP1 RP0 TO PD Z DC C 0							0001 1xxx	000q quuu	
104h ⁽¹⁾	FSR	Indirect dat	a memory ac	Idress pointe	er					xxxx xxxx	uuuu uuuu
105h	_	Unimpleme	ented							_	_
106h	PORTB	PORTB Da	ta Latch whe	n written: PO	ORTB pins wh	nen read				xxxx xxxx	uuuu uuuu
107h	_	Unimpleme	ented							_	_
108h	_	Unimpleme	nted							_	_
109h	_	Unimpleme	nted							_	_
10Ah ^(1,2)	PCLATH	_	_	1	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
10Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
10Ch- 10Fh	_	Unimplemented								_	_
Bank 3											
180h ⁽¹⁾	INDF	Addressing	this location	uses conter	nts of FSR to	address data	a memory (n	ot a physical	register)	0000 0000	0000 0000
181h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
182h ⁽¹⁾	PCL	Program C	ounter's (PC)	Least Sigr	nificant Byte					0000 0000	0000 0000
183h ⁽¹⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	000q quuu
184h ⁽¹⁾	FSR	Indirect dat	a memory ac	Idress pointe	er					xxxx xxxx	uuuu uuuu
185h	_	Unimpleme	ented							_	_
186h	TRISB	PORTB Da	ta Direction F	Register						1111 1111	1111 1111
187h	_	Unimpleme	nted							_	_
188h	_	Unimplemented — — —						_			
189h	_	Unimpleme	nted							_	_
18Ah ^(1,2)	PCLATH	_	_	-	Write Buffer	for the uppe	r 5 bits of the	e Program C	ounter	0 0000	0 0000
18Bh ⁽¹⁾	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
18Ch- 19Fh	_	Unimpleme			anands on					_	_

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented location read as '0'.

Shaded locations are unimplemented, read as '0'.

- 3: Other (non power-up) resets include external reset through MCLR and the Watchdog Timer reset.
- 4: PIE1<6> and PIR1<6> are reserved on the PIC16C66/67, always maintain these bits clear.
- 5: PORTD, PORTE, TRISD, and TRISE are not implemented on the PIC16C66, read as '0'.
- 6: PSPIF (PIR1<7>) and PSPIE (PIE1<7>) are reserved on the PIC16C66, maintain these bits clear.

Note 1: These registers can be addressed from any bank.

^{2:} The upper byte of the Program Counter (PC) is not directly accessible. PCLATH is a holding register for the PC whose contents are transferred to the upper byte of the program counter. (PC<12:8>)

4.2.2.1 STATUS REGISTER

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The STATUS register, shown in Figure 4-9, contains the arithmetic status of the ALU, the RESET status and the bank select bits for data memory.

The STATUS register can be the destination for any instruction, as with any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

For example, CLRF STATUS will clear the upper-three bits and set the Z bit. This leaves the STATUS register as 000u uluu (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register because these instructions do not affect the Z, C or DC bits from the STATUS register. For other instructions, not affecting any status bits, see the "Instruction Set Summary."

Note 1: For those devices that do not use bits IRP and RP1 (STATUS<7:6>), maintain these bits clear to ensure upward compatibility with future products.

Note 2: The C and DC bits operate as a borrow and digit borrow bit, respectively, in subtraction. See the SUBLW and SUBWF instructions for examples.

FIGURE 4-9: STATUS REGISTER (ADDRESS 03h, 83h, 103h, 183h)

R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x	
IRP	RP1	RP0	TO	PD	Z	DC	С	R = Readable bit
bit7							bit0	W = Writable bit - n = Value at POR reset x = unknown
bit 7:	1 = Bank 2	ster Bank So 2, 3 (100h - 9, 1 (00h - F	1FFh)	sed for indir	ect addressir	ng)		
bit 6-5:	11 = Bank 10 = Bank 01 = Bank 00 = Bank	Register Ba 3 (180h - 1 2 (100h - 1 1 (80h - FF 0 (00h - 7F is 128 byte	FFh) 7Fh) h) h)	bits (used f	or direct addı	ressing)		
bit 4:				uction, or s	LEEP instruc	tion		
bit 3:		-down bit ower-up or cution of th			tion			
bit 2:		sult of an a			ution is zero	ero		
bit 1:	1 = A carry		ne 4th low	order bit of	the result occ		nstructions)	(For borrow the polarity is reverse
bit 0:	1 = A carry 0 = No carry Note: a sub	/-out from the ry-out from otraction is	ne most sig the most s executed b	nificant bit ignificant bi y adding th	of the result of t of the result e two's comp	occurred t lement of th	ne second op	orrow the polarity is reversed). Derand. Dow order bit of the source register

4.2.2.2 **OPTION REGISTER**

Applicable Devices 61 | 62 | 62A | R62 | 63 | R63 | 64 | 64A | R64 | 65 | 65A | R65 | 66 | 67

The OPTION register is a readable and writable register which contains various control bits to configure the TMR0/WDT prescaler, the external INT interrupt, TMR0, and the weak pull-ups on PORTB.

Note: To achieve a 1:1 prescaler assignment for TMR0 register, assign the prescaler to the Watchdog Timer.

FIGURE 4-10: OPTION REGISTER (ADDRESS 81h, 181h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	R = Readable bit
bit7							bit0	W = Writable bit
								U = Unimplemented bit, read as '0'
								- n = Value at POR reset
bit 7:	RBPU: POF	RTB Pull-up						
	1 = PORTB	pull-ups a	re disabled					
	0 = PORTB	pull-ups a	re enabled	by individu	al port latch	values		
bit 6:	INTEDG: Int	terrupt Edg	ge Select b	it				
	1 = Interrupt							
	0 = Interrupt	t on falling	edge of RI	30/INT pin				
bit 5:	TOCS: TMR							
	1 = Transitio			. /0/0	-\			
	0 = Internal		•	,)			
bit 4:	TOSE: TMR							
	1 = Increme 0 = Increme							
bit 3:	PSA: Presci		•		71.17 TOOTH PII			
DIL 3.	1 = Prescale			WDT				
	0 = Prescale				lule			
bit 2-0:	PS2:PS0 : P	rescaler R	ate Select	bits				
	Bit Value	TMR0 R	ate WD	ΓRate				
	000	1:2	1:	1				
	001	1:4		2				
	010	1:8	1:					
	011	1:16		∶8 ∶16				
	100 101	1:32 1:64	•	32				
	110							
	111	1 : 12 1 : 25		64 128				

4.2.2.3 INTCON REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The INTCON Register is a readable and writable register which contains the various enable and flag bits for the TMR0 register overflow, RB port change and external RB0/INT pin interrupts.

Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

FIGURE 4-11: INTCON REGISTER (ADDRESS 0Bh, 8Bh, 10Bh 18Bh)

	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x	
GIE oit7	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF bit0	R = Readable bit W = Writable bit
117							bito	U = Unimplemented bit, read as '0' - n = Value at POR reset
		s all un-ma	sked interr					x = unknown
bit 6:	0 = Disable PEIE:(2) Pe 1 = Enable 0 = Disable	eripheral In	terrupt Ena sked peripl	neral interru	ipts			
	T0IE: TMR 1 = Enable 0 = Disable	s the TMR	overflow i	nterrupt				
		s the RB0/	NT externa					
	RBIE: RB 1 = Enable 0 = Disable	s the RB p	ort change	interrupt				
	T0IF: TMR 1 = TMR0 0 = TMR0	register ove	erflowed (m	ust be clea	red in softwa	re)		
		30/INT exte	rnal interru		(must be cle	eared in soft	ware)	
bit 0:	1 = At leas		RB7:RB4		ed state (see d state	Section 5.2	2 to clear the	interrupt)
		led by the 1						ed, the GIE bit may unintentionally Refer to Section 13.5 for a detailed
			unimpleme	nted on the	PIC16C61, I	ead as '0'.		

PIC16C6X

4.2.2.4 PIE1 REGISTER

Applicable Devices 61 | 62 | 62A | R62 | 63 | R63 | 64 | 64A | R64 | 65 | 65A | R65 | 66 | 67

This register contains the individual enable bits for the peripheral interrupts.

Note: Bit PEIE (INTCON<6>) must be set to enable any peripheral interrupt.

FIGURE 4-12: PIE1 REGISTER FOR PIC16C62/62A/R62 (ADDRESS 8Ch)

RW-0	R/W-0	U-0	U-0	R/W-0 SSPIE	R/W-0 CCP1IE	R/W-0 TMR2IE	R/W-0 TMR1IE	R = Readable bit		
bit7				SSFIE	COFFIE	TIWINZIE	bit0	W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset		
bit 7-6:	Reserved:	Always ma	intain thes	e bits clear.						
bit 5-4:	Unimpleme	ented: Rea	nd as '0'							
bit 3:	1 = Enables	SSPIE: Synchronous Serial Port Interrupt Enable bit 1 = Enables the SSP interrupt 0 = Disables the SSP interrupt								
bit 2:	1 = Enables	CCP1IE: CCP1 Interrupt Enable bit 1 = Enables the CCP1 interrupt 0 = Disables the CCP1 interrupt								
bit 1:	1 = Enables	MR2IE: TMR2 to PR2 Match Interrupt Enable bit = Enables the TMR2 to PR2 match interrupt = Disables the TMR2 to PR2 match interrupt								
bit 0:	TMR1IE: TM 1 = Enables 0 = Disables	the TMR	l overflow i	nterrupt	t					

FIGURE 4-13: PIE1 REGISTER FOR PIC16C63/R63/66 (ADDRESS 8Ch)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
_	_	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit			
oit7							bit0	W = Writable bitU = Unimplemented bit, read as '0'n = Value at POR reset			
bit 7-6:	Reserved:	Always ma	intain these	e bits clear.							
bit 5:	1 = Enable	RCIE: USART Receive Interrupt Enable bit 1 = Enables the USART receive interrupt 0 = Disables the USART receive interrupt									
bit 4:	1 = Enable	TXIE: USART Transmit Interrupt Enable bit 1 = Enables the USART transmit interrupt 0 = Disables the USART transmit interrupt									
bit 3:	SSPIE: Syr 1 = Enable 0 = Disable	s the SSP i	nterrupt	Interrupt Er	nable bit						
bit 2:	CCP1IE: CCP1 Interrupt Enable bit 1 = Enables the CCP1 interrupt 0 = Disables the CCP1 interrupt										
bit 1:	TMR2IE: T 1 = Enable 0 = Disable	s the TMR2	to PR2 ma	tch interru							
bit 0:	TMR1IE: T 1 = Enable 0 = Disable	s the TMR1	overflow in	nterrupt	t						

FIGURE 4-14: PIE1 REGISTER FOR PIC16C64/64A/R64 (ADDRESS 8Ch)

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
PSPIE bit7	_	SSPIE CCP1IE TMR2IE TMR1IE R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset								
bit 7:	1 = Enables	SPIE: Parallel Slave Port Read/Write Interrupt Enable bit = Enables the PSP read/write interrupt = Disables the PSP read/write interrupt								
bit 6:	Reserved:	eserved: Always maintain this bit clear.								
bit 5-4:	Unimplem	Jnimplemented: Read as '0'								
bit 3:	1 = Enable	SSPIE: Synchronous Serial Port Interrupt Enable bit 1 = Enables the SSP interrupt 0 = Disables the SSP interrupt								
bit 2:	CCP1IE: C 1 = Enables 0 = Disable	s the CCP1	interrupt	bit						
bit 1:	1 = Enables	TMR2IE: TMR2 to PR2 Match Interrupt Enable bit 1 = Enables the TMR2 to PR2 match interrupt 0 = Disables the TMR2 to PR2 match interrupt								
bit 0:	TMR1IE: T 1 = Enable: 0 = Disable	s the TMR1	overflow in	nterrupt	t					

FIGURE 4-15: PIE1 REGISTER FOR PIC16C65/65A/R65/67 (ADDRESS 8Ch)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
PSPIE	_	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	R = Readable bit			
oit7							bit0	W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset			
oit 7:	1 = Enable	PSPIE: Parallel Slave Port Read/Write Interrupt Enable bit = Enables the PSP read/write interrupt = Disables the PSP read/write interrupt									
bit 6:	Reserved:	Always ma	aintain this	oit clear.							
bit 5:	RCIE: USA 1 = Enable 0 = Disable	s the USAF	RT receive i	nterrupt							
bit 4:	1 = Enable	TXIE: USART Transmit Interrupt Enable bit 1 = Enables the USART transmit interrupt 0 = Disables the USART transmit interrupt									
bit 3:	SSPIE: Syr 1 = Enable: 0 = Disable	s the SSP i	nterrupt	Interrupt Er	nable bit						
bit 2:	CCP1IE: C 1 = Enable: 0 = Disable	s the CCP1	interrupt	bit							
bit 1:	TMR2IE: T 1 = Enable: 0 = Disable	s the TMR2	2 to PR2 m	atch interru	ot						
bit 0:	TMR1IE: T 1 = Enable: 0 = Disable	s the TMR1	l overflow i	nterrupt	t						

4.2.2.5 PIR1 REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the individual flag bits for the peripheral interrupts.

Note: Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an

interrupt.

FIGURE 4-16: PIR1 REGISTER FOR PIC16C62/62A/R62 (ADDRESS 0Ch)

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	
_		_	_	SSPIF	CCP1IF	TMR2IF	TMR1IF	R = Readable bit
bit7							bit0	W = Writable bit
								U = Unimplemented bit,
								read as '0'
								- n = Value at POR reset

- bit 7-6: Reserved: Always maintain these bits clear.
- bit 5-4: Unimplemented: Read as '0'
- bit 3: SSPIF: Synchronous Serial Port Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 2: CCP1IF: CCP1 Interrupt Flag bit

Capture Mode

- 1 = A TMR1 register capture occurred (must be cleared in software)
- 0 = No TMR1 register capture occurred

Compare Mode

- 1 = A TMR1 register compare match occurred (must be cleared in software)
- 0 = No TMR1 register compare match occurred

PWM Mode

Unused in this mode

- bit 1: TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
 - 1 = TMR2 to PR2 match occurred (must be cleared in software)
 - 0 = No TMR2 to PR2 match occurred
- bit 0: TMR1IF: TMR1 Overflow Interrupt Flag bit
 - 1 = TMR1 register overflow occurred (must be cleared in software)
 - 0 = No TMR1 register overflow occurred

Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-17: PIR1 REGISTER FOR PIC16C63/R63/66 (ADDRESS 0Ch)

U = Unimplemented bit, read as '0' - n = Value at POR reset 1.7-6: Reserved: Always maintain these bits clear. RCIF: USART Receive Interrupt Flag bit 1 = The USART receive buffer is full (cleared by reading RCREG) 0 = The USART receive buffer is empty 1.4: TXIF: USART Transmit Interrupt Flag bit 1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full 1.3: SSPIF: Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive 1.2: CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 1. TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred	R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0				
U = Unimplemented bit, read as '0' - n = Value at POR reset RCIF: USART Receive Interrupt Flag bit 1 = The USART receive buffer is full (cleared by reading RCREG) 0 = The USART receive buffer is empty TXIF: USART transmit Interrupt Flag bit 1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full SSPIF: Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 1 : TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR1 to PR2 match occurred (must be cleared in software) 1 : TMR1F: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software)	_	_	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF				
t 5: RCIF: USART Receive Interrupt Flag bit 1 = The USART receive buffer is full (cleared by reading RCREG) 0 = The USART receive buffer is empty 44: TXIF: USART Transmit Interrupt Flag bit 1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive 1 = CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 1 = TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2IF: TMR2 to PR2 match occurred 0 = No TMR1 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred 1 O: TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software)	oit7							bit0	U = Unimplemented bit, read as '0'			
1 = The USART receive buffer is full (cleared by reading RCREG) 0 = The USART receive buffer is empty 14: TXIF: USART Transmit Interrupt Flag bit 1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full SSPIF: Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive 2: CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 1: TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR1 to PR2 match occurred 1: 1: TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow loccurred (must be cleared in software)	bit 7-6:	Reserved:	Always ma	intain thes	e bits clear.							
1 = The USART transmit buffer is empty (cleared by writing to TXREG) 0 = The USART transmit buffer is full 3: SSPIF: Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive 4: 2: CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 4: 1: TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR1 to PR2 match occurred 1: TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software)	bit 5:	1 = The US	ART receiv	e buffer is	full (cleared	d by reading	RCREG)					
1 = The transmission/reception is complete (must be cleared in software) 0 = Waiting to transmit/receive 2 : CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 1 = TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR1 to PR2 match occurred 1 to: TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software)	bit 4:	1 = The US	ART transi	nit buffer is	empty (cle	ared by writi	ng to TXRE	G)				
Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode Unused in this mode 1 : TMR2IF: TMR2 to PR2 Match Interrupt Flag bit 1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred 1 : TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software)	bit 3:	1 = The tra	nsmission/i	reception is			ared in softv	vare)				
1 = TMR2 to PR2 match occurred (must be cleared in software) 0 = No TMR2 to PR2 match occurred t 0: TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software)	bit 2:	Capture Mo 1 = A TMR 0 = No TMI Compare M 1 = A TMR 0 = No TMI PWM Mode	CCP1IF: CCP1 Interrupt Flag bit Capture Mode 1 = A TMR1 register capture occurred (must be cleared in software) 0 = No TMR1 register capture occurred Compare Mode 1 = A TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred (must be cleared in software) 0 = No TMR1 register compare match occurred PWM Mode									
1 = TMR1 register overflow occurred (must be cleared in software)	bit 1:	1 = TMR2 t	o PR2 mat	ch occurre	d (must be		oftware)					
	bit 0:	1 = TMR1 ı	egister ove	rflow occu	rred (must l	oe cleared in	software)					

Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-18: PIR1 REGISTER FOR PIC16C64/64A/R64 (ADDRESS 0Ch)

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0			
PSPIF	_	_	_	SSPIF	CCP1IF	TMR2IF	TMR1IF	R = Readable bit		
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset									
bit 7:	1 = A read	PSPIF: Parallel Slave Port Interrupt Flag bit 1 = A read or a write operation has taken place (must be cleared in software) 0 = No read or write operation has taken place								
bit 6:	Reserved: Always maintain this bit clear.									
bit 5-4:	Unimplemented: Read as '0'									

- bit 3: SSPIF: Synchronous Serial Port Interrupt Flag bit
 - 1 = The transmission/reception is complete (must be cleared in software)
 - 0 = Waiting to transmit/receive
- bit 2: CCP1IF: CCP1 Interrupt Flag bit

Capture Mode

- 1 = A TMR1 register capture occurred (must be cleared in software)
- 0 = No TMR1 register capture occurred

Compare Mode

- 1 = A TMR1 register compare match occurred (must be cleared in software)
- 0 = No TMR1 register compare match occurred

PWM Mode

Unused in this mode

- bit 1: TMR2IF: TMR2 to PR2 Match Interrupt Flag bit
 - 1 = TMR2 to PR2 match occurred (must be cleared in software)
 - 0 = No TMR2 to PR2 match occurred
- TMR1IF: TMR1 Overflow Interrupt Flag bit bit 0:
 - 1 = TMR1 register overflow occurred (must be cleared in software)
 - 0 = No TMR1 register occurred

Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-19: PIR1 REGISTER FOR PIC16C65/65A/R65/67 (ADDRESS 0Ch)

R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0				
PSPIF	_	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	R = Readable bit			
bit7		1.0	17	<u> </u>			bit0	W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset			
bit 7:	1 = A read	SPIF: Parallel Slave Port Interrupt Flag bit = A read or a write operation has taken place (must be cleared in software) = No read or write operation has taken place									
bit 6:	Reserved:	Always ma	aintain this	bit clear.							
bit 5:	1 = The US	CIF: USART Receive Interrupt Flag bit = The USART receive buffer is full (cleared by reading RCREG) = The USART receive buffer is empty									
bit 4:	1 = The US	XIF: USART Transmit Interrupt Flag bit = The USART transmit buffer is empty (cleared by writing to TXREG) = The USART transmit buffer is full									
bit 3:	1 = The tra	SSPIF: Synchronous Serial Port Interrupt Flag bit 1 = The transmission/reception is complete (must be cleared in software) 0 = Walting to transmit/receive									
bit 2:	Capture Model 1 = A TMR 0 = No TM Compare Model 1 = A TMR 0 = No TM PWM Model	CCP1IF: CCP1 Interrupt Flag bit Capture Mode I = A TMR1 register capture occurred (must be cleared in software) D = No TMR1 register capture occurred Compare Mode I = A TMR1 register compare match occurred (must be cleared in software) D = No TMR1 register compare match occurred O = No TMR1 register compare match occurred PWM Mode Unused in this mode									
bit 1:		to PR2 mat	ch occurre		bit cleared in so	ftware)					
bit 0:	TMR1IF: TMR1 Overflow Interrupt Flag bit 1 = TMR1 register overflow occurred (must be cleared in software) 0 = No TMR1 register overflow occurred										

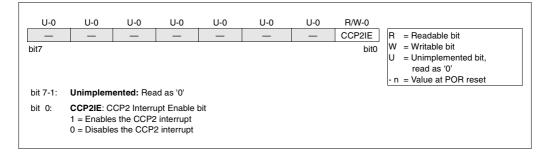
Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

4.2.2.6 PIE2 REGISTER

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the CCP2 interrupt enable bit.

FIGURE 4-20: PIE2 REGISTER (ADDRESS 8Dh)



4.2.2.7 PIR2 REGISTER

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

This register contains the CCP2 interrupt flag bit.

Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

FIGURE 4-21: PIR2 REGISTER (ADDRESS 0Dh)

U-0 U-0 U-0 U-0 U-0 U-0 U-0 R/W-0 CCP2IF bit7

R = Readable bit W = Writable bit

bit 7-1: Unimplemented: Read as '0'

U = Unimplemented bit, read as '0' n = Value at POR reset

bit 0: CCP2IF: CCP2 Interrupt Flag bit

Capture Mode

1 = A TMR1 register capture occurred (must be cleared in software)

0 = No TMR1 register capture occurred

Compare Mode

1 = A TMR1 register compare match occurred (must be cleared in software)

0 = No TMR1 register compare match occurred

PWM Mode

Unused in this mode

Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

Note:

4.2.2.8 PCON REGISTER

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Power Control register (PCON) contains a flag bit to allow differentiation between a Power-on Reset to an external MCLR reset or WDT reset. Those devices with brown-out detection circuitry contain an additional bit to differentiate a Brown-out Reset condition from a Power-on Reset condition.

Note: BOR is unknown on Power-on Reset. It must then be set by the user and checked on subsequent resets to see if BOR is clear, indicating a brown-out has occurred. The BOR status bit is a "don't care" and is not necessarily predictable if the brown-out circuit is disabled (by clearing the BODEN

bit in the Configuration word).

FIGURE 4-22: PCON REGISTER FOR PIC16C62/64/65 (ADDRESS 8Eh)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-q				
_	_	_	_	_	_	POR	_	R = Readable bit			
bit7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset q = value depends on conditions										
bit 7-2:	Unimplem	Unimplemented: Read as '0'									
bit 1:	1 = No Pov	POR: Power-on Reset Status bit 1 = No Power-on Reset occurred 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)									
bit 0:	Reserved This bit should be set upon a Power-on Reset by user software and maintained as set. Use of this bit as a general purpose read/write bit is not recommended, since this may affect upward compatibility with future products.										

FIGURE 4-23: PCON REGISTER FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67 (ADDRESS 8Eh)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-q				
_	_	_	_	-	_	POR	BOR	R = Readable bit			
bit7		bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset q = value depends on conditions									
bit 7-2:	Unimplem	Inimplemented: Read as '0'									
bit 1:	1 = No Pov	POR: Power-on Reset Status bit 1 = No Power-on Reset occurred 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)									
bit 0:	BOR: Brown-out Reset Status bit 1 = No Brown-out Reset occurred 0 = A Brown-out Reset occurred (must be set in software after a Brown-out Reset occurs)										

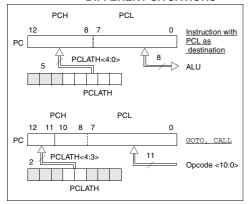
4.3 PCL and PCLATH

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The program counter (PC) is 13-bits wide. The low byte comes from the PCL register, which is a readable and writable register. The upper bits (PC<12:8>) are not readable, but are indirectly writable through the PCLATH register. On any reset, the upper bits of the PC will be cleared. Figure 4-24 shows the two situations for the loading of the PC. The upper example in the figure shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in the figure shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 4-24: LOADING OF PC IN DIFFERENT SITUATIONS



4.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When doing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256 word block). Refer to the application note "Implementing a Table Read" (AN556).

4.3.2 STACK

The PIC16CXX family has an 8 deep x 13-bit wide hardware stack. The stack space is not part of either program or data space and the stack pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or a POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth push overwrites the value that was stored from the first push. The tenth push overwrites the second push (and so on).

Note 1: There are no status bits to indicate stack overflows or stack underflow conditions

Note 2: There are no instructions mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW, and RETFIE instructions, or the vectoring to an interrupt address

4.4 Program Memory Paging

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PIC16C6X devices are capable of addressing a continuous 8K word block of program memory. The CALL and GOTO instructions provide only 11 bits of address to allow branching within any 2K program memory page. When doing a CALL or GOTO instruction the upper two bits of the address are provided by PCLATH<4:3>. When doing a CALL or GOTO instruction, the user must ensure that the page select bits are programmed so that the desired program memory page is addressed. If a return from a CALL instruction (or interrupt) is executed, the entire 13-bit PC is pushed onto the stack. Therefore, manipulation of the PCLATH<4:3> bits are not required for the return instructions (which POPs the address from the stack).

Note: PIC16C6X devices with 4K or less of program memory ignore paging bit PCLATH<4>. The use of PCLATH<4> as a general purpose read/write bit is not recommended since this may affect upward compatibility with future products.

Example 4-1 shows the calling of a subroutine in page 1 of the program memory. This example assumes that the PCLATH is saved and restored by the interrupt service routine (if interrupts are used).

EXAMPLE 4-1: CALL OF A SUBROUTINE IN PAGE 1 FROM PAGE 0

```
ORG 0x500
BSF PCLATH,3 ;Select page 1 (800h-FFFh)
BCF PCLATH,4 ;Only on >4K devices

CALL SUB1_P1 ;Call subroutine in
;;page 1 (800h-FFFh)
;
ORG 0x900
SUB1_P1: ;called subroutine
;;page 1 (800h-FFFh)
;
RETURN ;return to Call subroutine
;in page 0 (000h-7FFh)
```

4.5 Indirect Addressing, INDF and FSR Registers

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

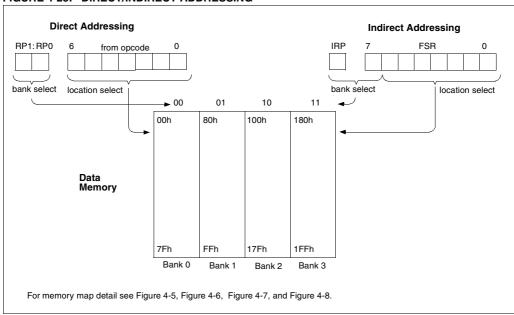
Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses the register pointed to by the File Select Register, FSR. Reading the INDF register itself indirectly (FSR = '0') will produce 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-25.

A simple program to clear RAM location 20h-2Fh using indirect addressing is shown in Example 4-2.

EXAMPLE 4-2: INDIRECT ADDRESSING

```
movlw 0x20
                        ;initialize pointer
         movwf FSR
                        ; to RAM
NEXT
         clrf
                INDF
                        ;clear INDF register
                FSR,F
          incf
                        ;inc pointer
         btfss FSR,4
                        ;all done?
                        ;NO, clear next
         goto NEXT
CONTINUE
                        ;YES, continue
```

FIGURE 4-25: DIRECT/INDIRECT ADDRESSING



PIC16C6X

NOTES:

5.0 I/O PORTS

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Some pins for these I/O ports are multiplexed with an alternate function(s) for the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

5.1 PORTA and TRISA Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

All devices have a 6-bit wide PORTA, except for the PIC16C61 which has a 5-bit wide PORTA.

Pin RA4/T0CKI is a Schmitt Trigger input and an open drain output. All other RA port pins have TTL input levels and full CMOS output drivers. All pins have data direction bits (TRIS registers) which can configure these pins as output or input.

Setting a bit in the TRISA register puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISA register puts the contents of the output latch on the selected pin.

Reading PORTA register reads the status of the pins whereas writing to it will write to the port latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified, and then written to the port data latch.

Pin RA4 is multiplexed with Timer0 module clock input to become the RA4/T0CKI pin.

EXAMPLE 5-1: INITIALIZING PORTA

```
BCF
       STATUS, RP0
BCF
       STATUS, RP1 ; PIC16C66/67 only
                    ; Initialize PORTA by
CLRE
       PORTA
                    : clearing output
                    ; data latches
BSF
       STATUS, RPO ; Select Bank 1
                    ; Value used to
MOVLW
       0xCF
                    : initialize data
                    : direction
MOVWF TRISA
                    ; Set RA<3:0> as inputs
                    ; RA<5:4> as outputs
                    ; TRISA<7:6> are always
                    ; read as '0'.
```

FIGURE 5-1: BLOCK DIAGRAM OF THE RA3:RA0 PINS AND THE RA5 PIN

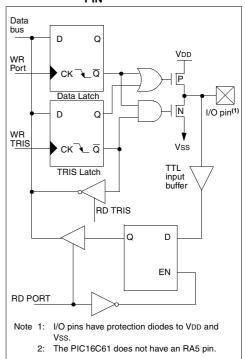
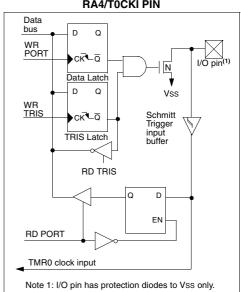


FIGURE 5-2: BLOCK DIAGRAM OF THE RA4/T0CKI PIN



PIC16C6X

TABLE 5-1: PORTA FUNCTIONS

Name	Bit#	Buffer Type	Function
RA0	bit0	TTL	Input/output
RA1	bit1	TTL	Input/output
RA2	bit2	TTL	Input/output
RA3	bit3	TTL	Input/output
RA4/T0CKI	bit4	ST	Input/output or external clock input for Timer0. Output is open drain type.
RA5/SS (1)	bit5	TTL	Input/output or slave select input for synchronous serial port.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: The PIC16C61 does not have PORTA<5> or TRISA<5>, read as '0'.

TABLE 5-2: REGISTERS/BITS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
05h	PORTA	_	_	RA5 ⁽¹⁾	RA4	RA3	RA2	RA1	RA0	xx xxxx	uu uuuu
85h	TRISA	_	_	PORTA Data	Direction Re	11 1111	11 1111				

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

Note 1: PORTA<5> and TRISA<5> are not implemented on the PIC16C61, read as '0'.

5.2 PORTB and TRISB Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTB is an 8-bit wide bi-directional port. The corresponding data direction register is TRISB. Setting a bit in the TRISB register puts the corresponding output driver in a hi-impedance mode. Clearing a bit in the TRISB register puts the contents of the output latch on the selected pin(s).

EXAMPLE 5-2: INITIALIZING PORTB

```
STATUS, RPO
CLRF
       PORTB
                     ; Initialize PORTB by
                     ; clearing output
                     ; data latches
BSF
       STATUS, RPO
                    ; Select Bank 1
MOVLW
                     ; Value used to
                     ; initialize data
                     ; direction
MOVWE TRISE
                    ; Set RB<3:0> as inputs
                    ; RB<5:4> as outputs
                     ; RB<7:6> as inputs
```

Each of the PORTB pins has a weak internal pull-up. A single control bit can turn on all the pull-ups. This is performed by clearing bit RBPU (OPTION<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are also disabled on a Power-on Reset.

Four of PORTB's pins, RB7:RB4, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB7:RB4 pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB7:RB4) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB7:RB4 are OR'ed together to generate the RB port change interrupt with flag bit RBIF (INTCON<0>).

This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB. This will end the mismatch condition.
- b) Clear flag bit RBIF.

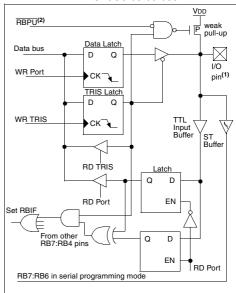
A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition, and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a keypad and make it possible for wake-up on key-depression. Refer to the Embedded Control Handbook, Application Note, "Implementing Wake-up on Key Stroke" (AN552).

Note: For PIC16C61/62/64/65, if a change on the I/O pin should occur when a read operation is being executed (start of the Q2 cycle), then interrupt flag bit RBIF may not get set.

The interrupt on change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt on change feature.

FIGURE 5-3: BLOCK DIAGRAM OF THE RB7:RB4 PINS FOR PIC16C61/62/64/65



Note 1: I/O pins have diode protection to VDD and VSS.

2: To enable weak pull-ups, set the appropriate TRIS bit(s) and clear the RPBU bit (OPTION<7>).

FIGURE 5-4: BLOCK DIAGRAM OF THE RB7:RB4 PINS FOR PIC16C62A/63/R63/64A/65A/

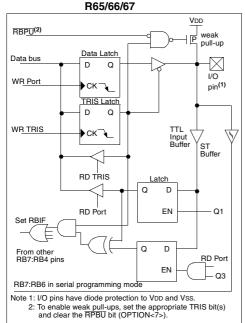


FIGURE 5-5: BLOCK DIAGRAM OF THE RB3:RB0 PINS

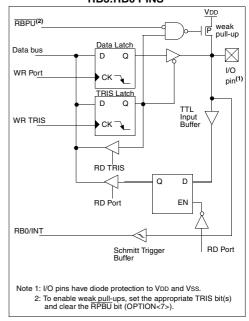


TABLE 5-3: PORTB FUNCTIONS

IADLE 3-3.	FUN	I B FUNCTION	5
Name	Bit#	Buffer Type	Function
RB0/INT	bit0	TTL/ST ⁽¹⁾	Input/output pin or external interrupt input. Internal software programmable weak pull-up.
RB1	bit1	TTL	Input/output pin. Internal software programmable weak pull-up.
RB2	bit2	TTL	Input/output pin. Internal software programmable weak pull-up.
RB3	bit3	TTL	Input/output pin. Internal software programmable weak pull-up.
RB4	bit4	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB5	bit5	TTL	Input/output pin (with interrupt on change). Internal software programmable weak pull-up.
RB6	bit6	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming clock.
RB7	bit7	TTL/ST ⁽²⁾	Input/output pin (with interrupt on change). Internal software programmable weak pull-up. Serial programming data.

Legend: TTL = TTL input, ST = Schmitt Trigger input

Note 1: This buffer is a Schmitt Trigger input when configured as the external interrupt.

2: This buffer is a Schmitt Trigger input when used in serial programming mode.

TABLE 5-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTB

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
06h, 106h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	uuuu uuuuu
86h, 186h	TRISB	PORTB D	ata Direction	1111 1111	1111 1111						
81h, 181h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged. Shaded cells are not used by PORTB.

5.3 PORTC and TRISC Register

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

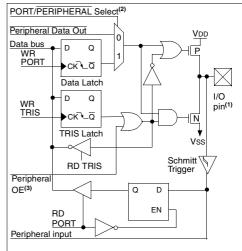
PORTC is an 8-bit wide bi-directional port. Each pin is individually configurable as an input or output through the TRISC register. PORTC is multiplexed with several peripheral functions (Table 5-5). PORTC pins have Schmitt Trigger input buffers.

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. Since the TRIS bit override is in effect while the peripheral is enabled, read-modifywrite instructions (BSF, BCF, XORWF) with TRISC as destination should be avoided. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

EXAMPLE 5-3: INITIALIZING PORTC

```
BCF
       STATUS, RPO ;
BCF
       STATUS, RP1 ; PIC16C66/67 only
                    ; Initialize PORTC by
CLRE
       PORTC
                    ; clearing output
                    ; data latches
BSF
       STATUS, RPO ; Select Bank 1
                    ; Value used to
MOVILW
      0xCF
                    ; initialize data
                    : direction
MOVWF TRISC
                    ; Set RC<3:0> as inputs
                    ; RC<5:4> as outputs
                    ; RC<7:6> as inputs
```

FIGURE 5-6: PORTC BLOCK DIAGRAM



- Note 1: I/O pins have diode protection to VDD and Vss.
 - Port/Peripheral select signal selects between port data and peripheral output.
 - Peripheral OE (output enable) is only activated if peripheral select is active.

TABLE 5-5: PORTC FUNCTIONS FOR PIC16C62/64

Name	Bit#	Buffer Type	Function
RC0/T1OSI/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator input or Timer1 clock input
RC1/T1OSO	bit1	ST	Input/output port pin or Timer1 oscillator output
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I ² C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or synchronous serial port data output
RC6	bit6	ST	Input/output port pin
RC7	bit7	ST	Input/output port pin

Legend: ST = Schmitt Trigger input

TABLE 5-6: PORTC FUNCTIONS FOR PIC16C62A/R62/64A/R64

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output or Timer1 clock input
RC1/T1OSI	bit1	ST	Input/output port pin or Timer1 oscillator input
RC2/CCP1	bit2	ST	Input/output port pin or Capture input/Compare output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I ² C modes.
RC4/SDI/SDA	bit4		RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or synchronous serial port data output
RC6	bit6	ST	Input/output port pin
RC7	bit7	ST	Input/output port pin

Legend: ST = Schmitt Trigger input

TABLE 5-7: PORTC FUNCTIONS FOR PIC16C63/R63/65/65A/R65/66/67

Name	Bit#	Buffer Type	Function
RC0/T1OSO/T1CKI	bit0	ST	Input/output port pin or Timer1 oscillator output or Timer1 clock input
RC1/T1OSI/CCP2	bit1		Input/output port pin or Timer1 oscillator input or Capture2 input/Compare2 output/PWM2 output
RC2/CCP1	bit2	ST	Input/output port pin or Capture1 input/Compare1 output/PWM1 output
RC3/SCK/SCL	bit3	ST	RC3 can also be the synchronous serial clock for both SPI and I ² C modes.
RC4/SDI/SDA	bit4	ST	RC4 can also be the SPI Data In (SPI mode) or data I/O (I ² C mode).
RC5/SDO	bit5	ST	Input/output port pin or synchronous serial port data output
RC6/TX/CK	bit6		Input/output port pin or USART Asynchronous Transmit, or USART Synchronous Clock
RC7/RX/DT	bit7	ST	Input/output port pin or USART Asynchronous Receive, or USART Synchronous Data

Legend: ST = Schmitt Trigger input

TABLE 5-8: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
07h	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	uuuu uuuu
87h	TRISC	PORTC D	Data Direct	1111 1111	1111 1111						

Legend: x = unknown, u = unchanged.

5.4 PORTD and TRISD Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTD is an 8-bit port with Schmitt Trigger input buffers. Each pin is individually configurable as input or output.

PORTD can be configured as an 8-bit wide microprocessor port (parallel slave port) by setting control bit PSPMODE (TRISE<4>). In this mode, the input buffers are TTL.

FIGURE 5-7: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)

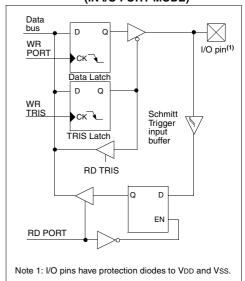


TABLE 5-9: PORTD FUNCTIONS

Name	Bit#	Buffer Type	Function
RD0/PSP0	bit0	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit0
RD1/PSP1	bit1	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit1
RD2/PSP2	bit2	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit2
RD3/PSP3	bit3	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit3
RD4/PSP4	bit4	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit4
RD5/PSP5	bit5	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit5
RD6/PSP6	bit6	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit6
RD7/PSP7	bit7	ST/TTL ⁽¹⁾	Input/output port pin or parallel slave port bit7

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Buffer is a Schmitt Trigger when in I/O mode, and a TTL buffer when in Parallel Slave Port mode.

TABLE 5-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTD

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	uuuu uuuu
88h	TRISD	PORTD I	Data Direc	1111 1111	1111 1111						
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE Da	ata Directio	0000 -111	0000 -111	

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTD.

5.5 PORTE and TRISE Register

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTE has three pins, RE2/\overline{\sigma}S, RE1/\overline{\text{WR}}, and RE0/\overline{\text{RD}} which are individually configurable as inputs or outputs. These pins have Schmitt Trigger input buffers.

I/O PORTE becomes control inputs for the microprocessor port when bit PSPMODE (TRISE<4>) is set. In this mode, the user must make sure that the TRISE<2:0> bits are set (pins are configured as digital inputs). In this mode the input buffers are TTL.

Figure 5-9 shows the TRISE register, which controls the parallel slave port operation and also controls the direction of the PORTE pins.

FIGURE 5-8: PORTE BLOCK DIAGRAM (IN I/O PORT MODE)

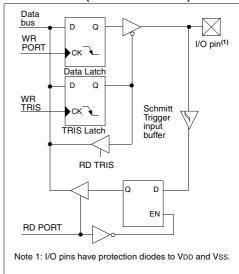


FIGURE 5-9: TRISE REGISTER (ADDRESS 89h)

R-0	R-0	R/W-0	R/W-0	U-0	R/W-1	R/W-1	R/W-1	
IBF	OBF	IBOV	PSPMODE	_	bit2	bit1	bit0	R = Readable bit
bit7							bit0	W = Writable bit U = Unimplemented bit, read as '0'
			0					- n = Value at POR reset
bit 7:	IBF: Input 1 = A word 0 = No wor	has been	received and	is waiting t	to be read by	the CPU		
bit 6:	1 = The ou	tput buffer	full Status bit still holds a p has been rea		vritten word			
bit 5:		occurred					(must be cle	ared in software)
bit 4:	PSPMODE 1 = Paralle 0 = Genera	l slave por		de Select t	oit			
bit 3:	Unimplem	ented: Re	ad as '0'					
	PORTE D	ata Dire	ction Bits					
bit 2:	Bit2: Direct 1 = Input 0 = Output		ol bit for pin R	E2/CS				
bit 1:	Bit1: Direct 1 = Input 0 = Output		ol bit for pin R	E1/WR				
bit 0:	Bit0: Direct 1 = Input 0 = Output		ol bit for pin R	E0/RD				

TABLE 5-11: PORTE FUNCTIONS

Name	Bit#	Buffer Type	Function
RE0/RD	bit0	ST/TTL ⁽¹⁾	Input/output port pin or Read control input in parallel slave port mode. RD 1 = Not a read operation 0 = Read operation. The system reads the PORTD register (if chip selected)
RE1/WR	bit1	ST/TTL ⁽¹⁾	Input/output port pin or Write control input in parallel slave port mode. WR 1 = Not a write operation 0 = Write operation. The system writes to the PORTD register (if chip selected)
RE2/CS	bit2	ST/TTL ⁽¹⁾	Input/output port pin or Chip select control input in parallel slave port mode. CS 1 = Device is not selected 0 = Device is selected

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Buffer is a Schmitt Trigger when in I/O mode, and a TTL buffer when in Parallel Slave Port (PSP) mode.

TABLE 5-12: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
09h	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	-	PORTE Data Direction Bits		0000 -111	0000 -111	

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells not used by PORTE.

5.6 <u>I/O Programming Considerations</u>

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

5.6.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (e.g., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stavs in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read-modify-write instructions (ex. BCF, BSF, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-4 shows the effect of two sequential read-modify-write instructions on an I/O port.

EXAMPLE 5-4: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

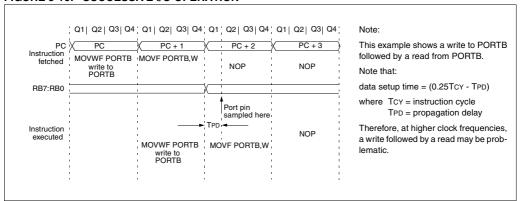
```
;Initial PORT settings: PORTB<7:4> Inputs
                        PORTB<3:0> Outputs
;PORTB<7:6> have external pull-ups and are
;not connected to other circuitry
                     PORT latch PORT pins
 BCF PORTB, 7
                   ; 01pp pppp
                                 11pp pppp
 BCF PORTB, 6
                   ; 10pp pppp
                                 11pp pppp
 BSF STATUS, RPO
 BCF TRISB, 7
                   ; 10pp pppp
                                 11pp pppp
 BCF TRISB, 6
                   ; 10pp pppp
                                 10pp pppp
; Note that the user may have expected the
;pin values to be 00pp pppp. The 2nd BCF
; caused RB7 to be latched as the pin value
: (high).
```

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

5.6.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-10). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should be such to allow the pin voltage to stabilize (load dependent) before the next instruction which causes that file to be read into the CPU is executed. Otherwise, the previous state of that pin may be read into the CPU separate than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

FIGURE 5-10: SUCCESSIVE I/O OPERATION



5.7 Parallel Slave Port

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

PORTD operates as an 8-bit wide parallel slave port (microprocessor port) when control bit PSPMODE (TRISE<4>) is set. In slave mode it is asynchronously readable and writable by the external world through $\overline{\text{RD}}$ control input (RE0/ $\overline{\text{RD}}$) and $\overline{\text{WR}}$ control input pin (RE1/ $\overline{\text{WR}}$).

It can directly interface to an 8-bit microprocessor data bus. The external microprocessor can read or write the PORTD latch as an 8-bit latch. Setting PSPMODE enables port pin RE0/ \overline{RD} to be the \overline{RD} input, RE1/ \overline{WR} to be the \overline{WR} input and RE2/ \overline{CS} to be the \overline{CS} (chip select) input. For this functionality, the corresponding data direction bits of the TRISE register (TRISE<2:0>) must be configured as inputs (set).

There are actually two 8-bit latches, one for data-out (from the PIC16/17) and one for data input. The user writes 8-bit data to PORTD data latch and reads data from the port pin latch (note that they have the same address). In this mode, the TRISD register is ignored since the microprocessor is controlling the direction of data flow.

A write to the PSP occurs when both the $\overline{\text{CS}}$ and $\overline{\text{WR}}$ lines are first detected low. When either the $\overline{\text{CS}}$ or $\overline{\text{WR}}$ lines become high (level triggered), then the Input Buffer Full status flag bit IBF (TRISE<7>) is set on the Q4 clock cycle, following the next Q2 cycle, to signal the write is complete (Figure 5-12). The interrupt flag bit PSPIF (PIR1<7>) is also set on the same Q4 clock cycle. IBF can only be cleared by reading the PORTD input latch. The input Buffer Overflow status flag bit IBOV (TRISE<5>) is set if a second write to the Parallel Slave Port is attempted when the previous byte has not been read out of the buffer.

A read from the PSP occurs when both the $\overline{\text{CS}}$ and $\overline{\text{RD}}$ lines are first detected low. The Output Buffer Full status flag bit OBF (TRISE<6>) is cleared immediately (Figure 5-13) indicating that the PORTD latch is waiting to be read by the external bus. When either the $\overline{\text{CS}}$ or $\overline{\text{RD}}$ pin becomes high (level triggered), the interrupt flag bit PSPIF is set on the Q4 clock cycle, following the next Q2 cycle, indicating that the read is complete. OBF remains low until data is written to PORTD by the user firmware.

When not in Parallel Slave Port mode, the IBF and OBF bits are held clear. However, if flag bit IBOV was previously set, it must be cleared in firmware.

An interrupt is generated and latched into flag bit PSPIF when a read or write operation is completed. PSPIF must be cleared by the user in firmware and the interrupt can be disabled by clearing the interrupt enable bit PSPIE (PIE1<7>).

FIGURE 5-11: PORTD AND PORTE AS A PARALLEL SLAVE PORT

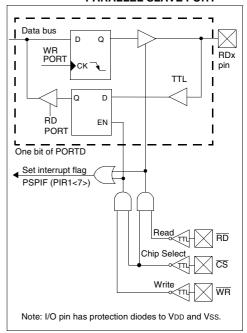


FIGURE 5-12: PARALLEL SLAVE PORT WRITE WAVEFORMS

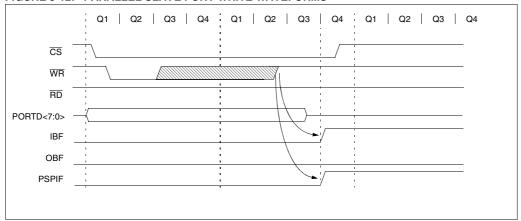


FIGURE 5-13: PARALLEL SLAVE PORT READ WAVEFORMS

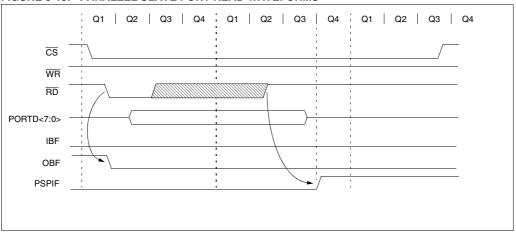


TABLE 5-13: REGISTERS ASSOCIATED WITH PARALLEL SLAVE PORT

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
08h	PORTD	PSP7	PSP6	PSP5	PSP4	PSP3	PSP2	PSP1	PSP0	xxxx xxxx	uuuu uuuu
09h	PORTE	_	_	-	_	_	RE2	RE1	RE0	xxx	uuu
89h	TRISE	IBF	OBF	IBOV	PSPMODE	_	PORTE D	ata Direction	Bits	0000 -111	0000 -111
0Ch	PIR1	PSPIF	(1)	RCIF ⁽²⁾	TXIF ⁽²⁾	SSPIF	CCP1IF	TMR2IF	TRM1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE	(1)	RCIE ⁽²⁾	TXIE ⁽²⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by the PSP.

Note 1: These bits are reserved, always maintain these bits clear.

^{2:} These bits are implemented on the PIC16C65/65A/R65/67 only.

6.0 OVERVIEW OF TIMER MODULES

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

All PIC16C6X devices have three timer modules except for the PIC16C61, which has one timer module. Each module can generate an interrupt to indicate that an event has occurred (i.e., timer overflow). Each of these modules are detailed in the following sections. The timer modules are:

- Timer0 module (Section 7.0)
- Timer1 module (Section 8.0)
- Timer2 module (Section 9.0)

6.1 <u>Timer0 Overview</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Timer0 module is a simple 8-bit overflow counter. The clock source can be either the internal system clock (Fosc/4) or an external clock. When the clock source is an external clock, the Timer0 module can be selected to increment on either the rising or falling edge.

The Timer0 module also has a programmable prescaler option. This prescaler can be assigned to either the Timer0 module or the Watchdog Timer. Bit PSA (OPTION<3>) assigns the prescaler, and bits PS2:PS0 (OPTION<2:0>) determine the prescaler value. TMR0 can increment at the following rates: 1:1 when the prescaler is assigned to Watchdog Timer, 1:2, 1:4, 1:8, 1:16, 1:32, 1:64, 1:128, and 1:256.

Synchronization of the external clock occurs after the prescaler. When the prescaler is used, the external clock frequency may be higher then the device's frequency. The maximum frequency is 50 MHz, given the high and low time requirements of the clock.

6.2 Timer1 Overview

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer1 is a 16-bit timer/counter. The clock source can be either the internal system clock (Fosc/4), an external clock, or an external crystal. Timer1 can operate as either a timer or a counter. When operating as a counter (external clock source), the counter can either operate synchronized to the device or asynchronously to the device. Asynchronous operation allows Timer1 to operate during sleep, which is useful for applications that require a real-time clock as well as the power savings of SLEEP mode.

Timer1 also has a prescaler option which allows TMR1 to increment at the following rates: 1:1, 1:2, 1:4, and 1:8. TMR1 can be used in conjunction with the Capture/Compare/PWM module. When used with a CCP module, Timer1 is the time-base for 16-bit capture or 16-bit compare and must be synchronized to the device.

6.3 Timer2 Overview

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer2 is an 8-bit timer with a programmable prescaler and a programmable postscaler, as well as an 8-bit Period Register (PR2). Timer2 can be used with the CCP module (in PWM mode) as well as the Baud Rate Generator for the Synchronous Serial Port (SSP). The prescaler option allows Timer2 to increment at the following rates: 1:1, 1:4, and 1:16.

The postscaler allows TMR2 register to match the period register (PR2) a programmable number of times before generating an interrupt. The postscaler can be programmed from 1:1 to 1:16 (inclusive).

6.4 CCP Overview

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The CCP module(s) can operate in one of three modes: 16-bit capture, 16-bit compare, or up to 10-bit Pulse Width Modulation (PWM).

Capture mode captures the 16-bit value of TMR1 into the CCPRxH:CCPRxL register pair. The capture event can be programmed for either the falling edge, rising edge, fourth rising edge, or sixteenth rising edge of the CCPx pin.

Compare mode compares the TMR1H:TMR1L register pair to the CCPRxH:CCPRxL register pair. When a match occurs, an interrupt can be generated and the output pin CCPx can be forced to a given state (High or Low) and Timer1 can be reset. This depends on control bits CCPxM3:CCPxM0.

PWM mode compares the TMR2 register to a 10-bit duty cycle register (CCPRxH:CCPRxL<5:4>) as well as to an 8-bit period register (PR2). When the TMR2 register = Duty Cycle register, the CCPx pin will be forced low. When TMR2 = PR2, TMR2 is cleared to 00h, an interrupt can be generated, and the CCPx pin (if an output) will be forced high.

PIC16C6X

NOTES:

7.0 TIMERO MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Timer0 module has the following features:

- 8-bit timer/counter register, TMR0
 - Read and write capability
 - Interrupt on overflow from FFh to 00h
- · 8-bit software programmable prescaler
- · Internal or external clock select
 - Edge select for external clock

Figure 7-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing bit TOCS (OPTION<5>). In timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two instruction cycles (Figure 7-2 and Figure 7-3). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting bit T0CS. In this mode, Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the source edge select bit T0SE

(OPTION<4>). Clearing bit T0SE selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 7.2.

The prescaler is mutually exclusively shared between the Timer0 module and the Watchdog Timer. The prescaler assignment is controlled in software by control bit PSA (OPTION<3>). Clearing bit PSA will assign the prescaler to the Timer0 module. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4, ..., 1:256 are selectable. Section 7.3 details the operation of the prescaler.

7.1 TMR0 Interrupt

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The TMR0 interrupt is generated when the register (TMR0) overflows from FFh to 00h. This overflow sets interrupt flag bit T0IF (INTCON<2>). The interrupt can be masked by clearing enable bit T0IE (INTCON<5>). Flag bit T0IF must be cleared in software by the TImer0 interrupt service routine before re-enabling this interrupt. The TMR0 interrupt cannot wake the processor from SLEEP since the timer is shut off during SLEEP. Figure 7-4 displays the Timer0 interrupt timing.

FIGURE 7-1: TIMERO BLOCK DIAGRAM

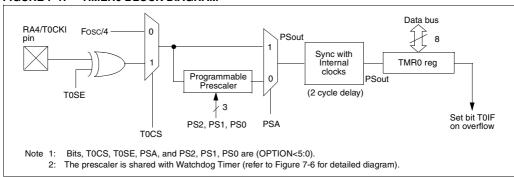
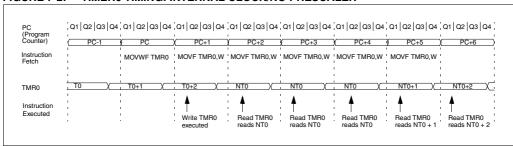


FIGURE 7-2: TIMERO TIMING: INTERNAL CLOCK/NO PRESCALER



TIMERO TIMING: INTERNAL CLOCK/PRESCALE 1:2 FIGURE 7-3:

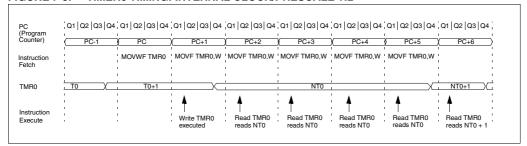
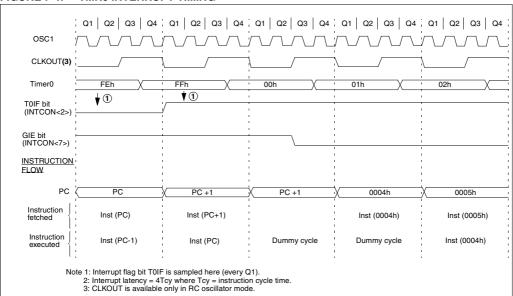


FIGURE 7-4: TMR0 INTERRUPT TIMING



7.2 <u>Using Timer0 with External Clock</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

When an external clock input is used for Timer0, it must meet certain requirements. The requirements ensure the external clock can be synchronized with the internal phase clock (Tosc). Also, there is a delay in the actual incrementing of Timer0 after synchronization.

7.2.1 EXTERNAL CLOCK SYNCHRONIZATION

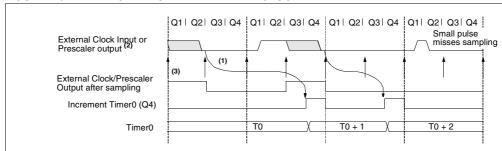
When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of TOCKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 7-5). Therefore, it is necessary for TOCKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for TOCKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on TOCKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

7.2.2 TIMERO INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 7-5 shows the delay from the external clock edge to the timer incrementing.

FIGURE 7-5: TIMERO TIMING WITH EXTERNAL CLOCK



- Note 1: Delay from clock input change to Timer0 increment is 3Tosc to 7Tosc. (Duration of Q = Tosc).
 - Therefore, the error in measuring the interval between two edges on Timer0 input = ± 4 Tosc max.
 - 2: External clock if no prescaler selected, prescaler output otherwise.
 - 3: The arrows indicate the points in time where sampling occurs.

7.3 Prescaler

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

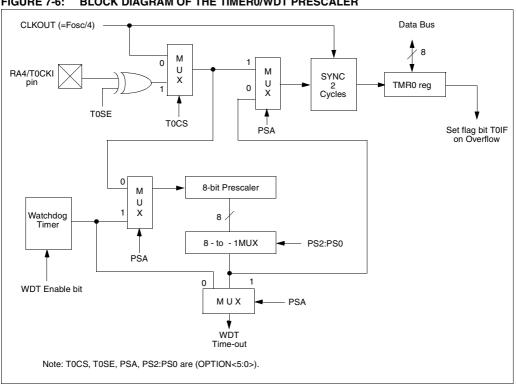
An 8-bit counter is available as a prescaler for the Timer0 module or as a postscaler for the Watchdog Timer (WDT), respectively (Figure 7-6). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer, and vice-versa.

The PSA and PS2:PS0 bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g. CLRF TMR0, MOVWF TMR0, BSF TMR0,bitx) will clear the prescaler count. When assigned to the Watchdog Timer, a CLRWDT instruction will clear the Watchdog Timer and the prescaler count. The prescaler is not readable or writable.

Note: Writing to TMR0 when the prescaler is assigned to Timer0 will clear the prescaler count, but will not change the prescaler assignment.

FIGURE 7-6: BLOCK DIAGRAM OF THE TIMERO/WDT PRESCALER



7.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control, i.e., it can be changed "on the fly" during program execution.

Note: To avoid an unintended device RESET, the following instruction sequence (shown in Example 7-1) must be executed when changing the prescaler assignment from Timer0 to the WDT. This precaution must

EXAMPLE 7-1: CHANGING PRESCALER (TIMER0→WDT)

be followed even if the WDT is disabled.

Lines 2 and 3 do NOT have to be included if the final desired prescale value is other than 1:1. If 1:1 is final desired value, then a temporary prescale value is set in lines 2 and 3 and the final prescale value will be set in lines 10 and 11.

```
1) BSF
          STATUS, RPO
   MOVLW b'xx0x0xxx'
                         ;Select clock source and prescale value of
3) MOVWF OPTION REG
                         ;other than 1:1
          STATUS, RPO
   BCF
                         ;Bank 0
5)
                         ;Clear TMR0 and prescaler
   CLRF
          TMR0
   BSF
          STATUS, RP1
                        ;Bank 1
7)
   MOVLW b'xxxx1xxx'
                        ;Select WDT, do not change prescale value
8) MOVWF OPTION REG
9) CLRWDT
                         ;Clears WDT and prescaler
10) MOVLW b'xxxx1xxx'
                        ;Select new prescale value and WDT
11) MOVWF OPTION REG
          STATUS, RPO
                        :Bank 0
12) BCF
```

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 7-2.

EXAMPLE 7-2: CHANGING PRESCALER (WDT→TIMER0)

```
CLRWDT ;Clear WDT and prescaler

BSF STATUS, RPO ;Bank 1

MOVLW b'xxxx0xxx';Select TMRO, new prescale value and clock source
MOVWF OPTION_REG ;

BCF STATUS, RPO ;Bank 0
```

TABLE 7-1: REGISTERS ASSOCIATED WITH TIMERO

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other resets
01h, 101h	TMR0	Timer0	module's r	egister						xxxx xxxx	uuuu uuuu
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE ⁽¹⁾	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
81h, 181h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRISA	_	_	PORTA Data	Direction F	Register ⁽¹⁾		•	•	11 1111	11 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

Note 1: TRISA<5> and bit PEIE are not implemented on the PIC16C61, read as '0'.

PIC16C6X

NOTES:

8.0 TIMER1 MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer1 is a 16-bit timer/counter consisting of two 8-bit registers (TMR1H and TMR1L) which are readable and writable. Register TMR1 (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR1 Interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit TMR1IF (PIR1<0>). This interrupt can be enabled/disabled by setting/clearing the TMR1 interrupt enable bit TMR1IE (PIE1<0>).

Timer1 can operate in one of two modes:

- · As a timer
- · As a counter

The operating mode is determined by clock select bit, TMR1CS (T1CON<1>) (Figure 8-2).

In timer mode, Timer1 increments every instruction cycle. In counter mode, it increments on every rising edge of the external clock input.

Timer1 can be enabled/disabled by setting/clearing control bit TMR1ON (T1CON<0>).

Timer1 also has an internal "reset input". This reset can be generated by CCP1 or CCP2 (Capture/Compare/PWM) module. See Section 10.0 for details. Figure 8-1 shows the Timer1 control register.

For the PIC16C62A/R62/63/R63/64A/R64/65A/R65/R66/67, when the Timer1 oscillator is enabled (T10SCEN is set), the RC1 and RC0 pins become inputs. That is, the TRISC<1:0> value is ignored.

For the PIC16C62/64/65, when the Timer1 oscillator is enabled (T1OSCEN is set), RC1 pin becomes an input, however the RC0 pin will have to be configured as an input by setting the TRISC<0> bit.

The Timer1 module also has a software programmable prescaler.

FIGURE 8-1: T1CON: TIMER1 CONTROL REGISTER (ADDRESS 10h)

U-0	U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 — T1CKPS1 T1CKPS0 T1OSCEN T1SYNC TMR1CS TMR1ON R = Readable bit							
<u>-</u> t7	bit0 W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset							
it 7-6:	Unimplemented: Read as '0'							
oit 5-4:	T1CKPS1:T1CKPS0: Timer1 Input Clock Prescale Select bits 11 = 1:8 Prescale value 10 = 1:4 Prescale value 01 = 1:2 Prescale value 00 = 1:1 Prescale value							
oit 3:	T10SCEN: Timer1 Oscillator Enable Control bit 1 = Oscillator is enabled 0 = Oscillator is shut off Note: The oscillator inverter and feedback resistor are turned off to eliminate power drain.							
bit 2:	T1SYNC: Timer1 External Clock Input Synchronization Control bit							
	TMR1CS = 1 1 = Do not synchronize external clock input 0 = Synchronize external clock input							
	$\overline{\text{IMR1CS}} = 0$ This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.							
bit 1:	TMR1CS: Timer1 Clock Source Select bit 1 = External clock from T1OSI (on the rising edge) (See pinouts for pin with T1OSI function) 0 = Internal clock (Fosc/4)							
bit 0:	TMR1ON: Timer1 On bit 1 = Enables Timer1 0 = Stops Timer1							

8.1 <u>Timer1 Operation in Timer Mode</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer mode is selected by clearing bit TMR1CS (T1CON<1>). In this mode, the input clock to the timer is Fosc/4. The synchronize control bit T1SYNC (T1CON<2>) has no effect since the internal clock is always in sync.

8.2 <u>Timer1 Operation in Synchronized</u> Counter Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Counter mode is selected by setting bit TMR1CS. In this mode the timer increments on every rising edge of clock input on T1OSI when enable bit T1OSCEN is set or pin with T1CKI when bit T1OSCEN is cleared.

Note:

The T1OSI function is multiplexed to different pins, depending on the device. See the pinout descriptions to see which pin has the T1OSI function.

If T1SYNC is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if an external clock is present, since the synchronization circuit is shut off. The prescaler, however, will continue to increment.

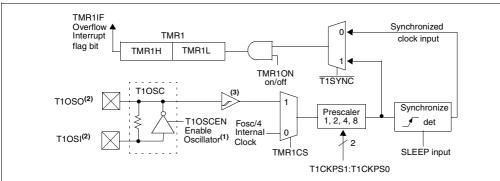
8.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in synchronized counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of TMR1 after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to appropriate electrical specification section, parameters 45, 46, and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to applicable electrical specification section, parameters 40, 42, 45, 46, and 47.

FIGURE 8-2: TIMER1 BLOCK DIAGRAM



- Note 1: When enable bit T1OSCEN is cleared, the inverter and feedback resistor are turned off. This eliminates power drain.
 - 2: See pinouts for pins with T1OSO and T1OSI functions.
 - 3: For the PIC16C62/64/65, the Schmitt Trigger is not implemented in external clock mode.

8.3 <u>Timer1 Operation in Asynchronous</u> Counter Mode

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

If control bit T1SYNC (T1CON<2>) is set, the external clock input is not synchronized. The timer continues to increment asynchronous to the internal phase clocks. The timer will continue to run during SLEEP and generate an interrupt on overflow which will wake the processor. However, special precautions in software are needed to read-from or write-to the Timer1 register pair, TMR1L and TMR1H (Section 8.3.2).

In asynchronous counter mode, Timer1 cannot be used as a time-base for capture or compare operations.

8.3.1 EXTERNAL CLOCK INPUT TIMING WITH UNSYNCHRONIZED CLOCK

If control bit T1SYNC is set, the timer will increment completely asynchronously. The input clock must meet certain minimum high time and low time requirements, as specified in timing parameters (45 - 47).

8.3.2 READING AND WRITING TMR1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L, while the timer is running from an external asynchronous clock, will ensure a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself poses certain problems since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers while the register is incrementing. This may produce an unpredictable value in the timer register.

Reading the 16-bit value requires some care. Example 8-1 is an example routine to read the 16-bit timer value. This is useful if the timer cannot be stopped.

EXAMPLE 8-1: READING A 16-BIT FREE-RUNNING TIMER

```
; All Interrupts are disabled
   MOVF
          TMR1H, W
                         ;Read high byte
   MOVWF
          TMPH
   MOVF
           TMR1L, W
                        ;Read low byte
   MOVWF
          TMPL
           TMR1H, W
   MOVF
                        ;Read high byte
   SUBWF
          TMPH, W
                        ;Sub 1st read
                        :with 2nd read
                        ;is result = 0
   BTFSC STATUS.Z
   GOTO CONTINUE
                        ;Good 16-bit read
; TMR1L may have rolled over between the read
; of the high and low bytes. Reading the high
; and low bytes now will read a good value.
          TMR1H, W
                        ;Read high byte
   MOVE
   MOVWF
          TMPH
          TMR1L, W
   MOVF
                        ;Read low byte
   MOVWF TMPL
   Re-enable Interrupt (if required)
CONTINUE
                         :Continue with
                         ;your code
```

8.4 Timer1 Oscillator

Αp	pli	cable	e Dev	/ice	es								
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

A crystal oscillator circuit is built in-between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting control bit T1OSCEN (T1CON<3>). The oscillator is a low power oscillator rated up to 200 kHz. It will continue to run during SLEEP. It is primarily intended for a 32 kHz crystal. Table 8-1 shows the capacitor selection for the Timer1 oscillator.

The Timer1 oscillator is identical to the LP oscillator. The user must allow a software time delay to ensure proper oscillator start-up.

TABLE 8-1: CAPACITOR SELECTION FOR THE TIMER1 OSCILLATOR

Osc Type	Freq	C1	C2					
LP	32 kHz	33 pF	33 pF					
	100 kHz	15 pF	15 pF					
	200 kHz	15 pF	15 pF					
These v	alues are for o	design guidan	ice only.					
Crystals Tes	sted:							
32.768 kHz	Epson C-00	1R32.768K-A	± 20 PPM					
100 kHz	Epson C-2 1	\pm 20 PPM						
200 kHz	STD XTL 20	± 20 PPM						
Note 1. High	nar aanaaitan							

- Note 1: Higher capacitance increases the stability of oscillator but also increases the start-up
 - Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.

8.5 Resetting Timer1 using a CCP Trigger Output

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

CCP2 is implemented on the PIC16C63/R63/65/65A/ R65/66/67 only.

If CCP1 or CCP2 module is configured in Compare mode to generate a "special event trigger" (CCPxM3:CCPxM0 = 1011), this signal will reset Timer1.

Note: The "special event trigger" from the CCP1 and CCP2 modules will not set interrupt flag bit TMR1IF(PIR1<0>).

Timer1 must be configured for either timer or synchronized counter mode to take advantage of this feature. If the Timer1 is running in asynchronous counter mode, this reset operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1 or CCP2, the write will take precedence.

In this mode of operation, the CCPRxH:CCPRxL registers pair effectively becomes the period register for the Timer1 module.

8.6 Resetting of TMR1 Register Pair (TMR1H:TMR1L)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The TMR1H and TMR1L registers are not reset to 00h on a POR or any other reset except by the CCP1 or CCP2 special event trigger.

The T1CON register is reset to 00h on a Power-on Reset or a Brown-out Reset, which shuts off the timer and leaves a 1:1 prescaler. In all other resets, the register is unaffected.

8.7 Timer1 Prescaler

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The prescaler counter is cleared on writes to the TMR1H or TMR1L registers.

TABLE 8-2: REGISTERS ASSOCIATED WITH TIMER1 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value PC BC	R,	all c	e on other ets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
0Eh	TMR1L	Holding re	Holding register for the Least Significant Byte of the 16-bit TMR1 register							xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding re	Holding register for the Most Significant Byte of the 16-bit TMR1 register								xxxx	uuuu	uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as '0'. Shaded cells are not used by the Timer1 module.

- Note 1: The USART is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.
 - 2: Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.
 - 3: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

9.0 TIMER2 MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timer2 is an 8-bit timer with a prescaler and a postscaler. It is especially suitable as PWM time-base for PWM mode of CCP module(s). TMR2 is a readable and writable register, and is cleared on any device reset.

The input clock (FOSC/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits T2CKPS1:T2CKPS0 (T2CON<1:0>).

The Timer2 module has an 8-bit period register, PR2. Timer2 increments from 00h until it matches PR2 and then resets to 00h on the next increment cycle. PR2 is a readable and writable register. The PR2 register is initialized to FFh upon reset.

The match output of the TMR2 register goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling, inclusive) to generate a TMR2 interrupt (latched in flag bit TMR2IF (PIR1<1>)).

The Timer2 module can be shut off by clearing control bit TMR2ON (T2CON<2>) to minimize power consumption.

Figure 9-2 shows the Timer2 control register. T2CON is cleared upon reset which initializes Timer2 as shut off with the prescaler and postscaler at a 1:1 value.

9.1 Timer2 Prescaler and Postscaler

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The prescaler and postscaler counters are cleared when any of the following occurs:

- · a write to the TMR2 register
- · a write to the T2CON register
- any device reset (POR, BOR, MCLR Reset, or WDT Reset).

TMR2 is not cleared when T2CON is written.

9.2 Output of TMR2

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The output of TMR2 (before the postscaler) is fed to the Synchronous Serial Port module which optionally uses it to generate shift clock.

FIGURE 9-1: TIMER2 BLOCK DIAGRAM

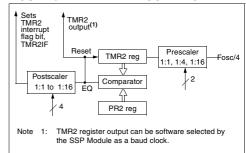


FIGURE 9-2: T2CON: TIMER2 CONTROL REGISTER (ADDRESS 12h)

U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 TOUTPS3 TOUTPS2 TOUTPS1 TOUTPS0 TMR2ON T2CKPS1 T2CKPS0 = Readable bit W = Writable bit hit7 U = Unimplemented bit, read as '0' - n = Value at POR reset bit 7: Unimplemented: Read as '0' TOUTPS3:TOUTPS0: Timer2 Output Postscale Select bits 0000 = 1:1 postscale 0001 = 1:2 postscale 1111 = 1:16 postscale bit 2: TMR2ON: Timer2 On bit 1 = Timer2 is on 0 = Timer2 is off bit 1-0: T2CKPS1:T2CKPS0: Timer2 Clock Prescale Select bits 00 = 1:1 prescale 01 = 1:4 prescale 1x = 1:16 prescale

TABLE 9-1: REGISTERS ASSOCIATED WITH TIMER2 AS A TIMER/COUNTER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value PC BC	,	Valu all o res	
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
11h	TMR2	Timer2 m	Timer2 module's register								0000	0000	0000
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000	0000	-000	0000
92h	PR2	Timer2 Pe	imer2 Period register								1111	1111	1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer2. Note 1: The USART is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

^{2:} Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

^{3:} PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

10.0 CAPTURE/COMPARE/PWM (CCP) MODULE(s)

Applicable Devices														
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	CCP1
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	CCP2

Each CCP (Capture/Compare/PWM) module contains a 16-bit register which can operate as a 16-bit capture register, as a 16-bit compare register, or as a PWM master/slave duty cycle register. Both the CCP1 and CCP2 modules are identical in operation, with the exception of the operation of the special event trigger. Table 10-1 and Table 10-2 show the resources and interactions of the CCP modules(s). In the following sections, the operation of a CCP module is described with respect to CCP1. CCP2 operates the same as CCP1, except where noted.

CCP1 module:

Capture/Compare/PWM Register1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. All are readable and writable.

CCP2 module:

Capture/Compare/PWM Register2 (CCPR2) is comprised of two 8-bit registers: CCPR2L (low byte) and CCPR2H (high byte). The CCP2CON register controls the operation of CCP2. All are readable and writable.

For use of the CCP modules, refer to the *Embedded Control Handbook*, "Using the CCP Modules" (AN594).

TABLE 10-1: CCP MODE - TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1
Compare	Timer1
PWM	Timer2

TABLE 10-2: INTERACTION OF TWO CCP MODULES

CCPx Mode	CCPy Mode	Interaction
Capture	Capture	Same TMR1 time-base.
Capture	Compare	The compare should be configured for the special event trigger, which clears TMR1.
Compare	Compare	The compare(s) should be configured for the special event trigger, which clears TMR1.
PWM	PWM	The PWMs will have the same frequency, and update rate (TMR2 interrupt).
PWM	Capture	None
PWM	Compare	None

FIGURE 10-1: CCP1CON REGISTER (ADDRESS 17h) / CCP2CON REGISTER (ADDRESS 1Dh)

U-0 U-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 R/W-0 CCPxM0 R = Readable bit CCPxX **CCPxY** CCPxM3 CCPxM2 CCPxM1 W = Writable bit bit0 bit7 U = Unimplemented bit, read as '0' - n =Value at POR reset bit 7-6: Unimplemented: Read as '0' bit 5-4: CCPxX:CCPxY: PWM Least Significant bits Capture Mode Linused Compare Mode Unused PWM Mode These bits are the two LSbs of the PWM duty cycle. The eight MSbs are found in CCPRxL. bit 3-0: CCPxM3:CCPxM0: CCPx Mode Select bits 0000 = Capture/Compare/PWM off (resets CCPx module) 0100 = Capture mode, every falling edge 0101 = Capture mode, every rising edge 0110 = Capture mode, every 4th rising edge 0111 = Capture mode, every 16th rising edge 1000 = Compare mode, set output on match (bit CCPxIF is set) 1001 = Compare mode, clear output on match (bit CCPxIF is set) 1010 = Compare mode, generate software interrupt on match (bit CCPxIF is set, CCPx pin is unaffected)

1011 = Compare mode, trigger special event (CCPxIF bit is set; CCP1 resets TMR1; CCP2 resets TMR1)

10.1 Capture Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

11xx = PWM mode

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 register when an event occurs on pin RC2/CCP1 (Figure 10-2). An event is defined as:

- · Every falling edge
- · Every rising edge
- · Every 4th rising edge
- · Every 16th rising edge

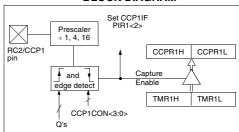
An event is selected by control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR1<2>) is set. It must be cleared in software. If another capture occurs before the value in register CCPR1 is read, the old captured value will be lost.

10.1.1 CCP PIN CONFIGURATION

In Capture mode, the RC2/CCP1 pin should be configured as an input by setting the TRISC<2> bit.

Note: If the RC2/CCP1 pin is configured as an output, a write to PORTC can cause a capture condition.

FIGURE 10-2: CAPTURE MODE OPERATION BLOCK DIAGRAM



10.1.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work consistently.

10.1.3 SOFTWARE INTERRUPT

When the Capture event is changed, a false capture interrupt may be generated. The user should clear enable bit CCP1IE (PIE1<2>) to avoid false interrupts and should clear flag bit CCP1IF following any such change in operating mode.

10.1.4 CCP PRESCALER

There are four prescaler settings, specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, therefore the first capture may be from a non-zero prescaler. Example 10-1 shows the recomended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 10-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
CLRF CCP1CON ; Turn CCP module off
MOVLW NEW_CAPT_PS; Load the W reg with
; the new prescaler
; mode value and CCP ON
MOVWF CCP1CON ; Load CCP1CON with
; this value
```

10.2 Compare Mode

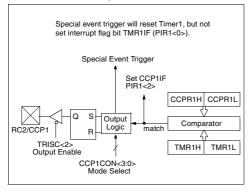
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RC2/CCP1 pin is:

- · Driven High
- · Driven Low
- · Remains Unchanged

The action on the pin is based on the value of control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). At the same time interrupt flag bit CCP1IF is set.

FIGURE 10-3: COMPARE MODE OPERATION BLOCK DIAGRAM



10.2.1 CCP PIN CONFIGURATION

The user must configure the RC2/CCP1 pin as an output by clearing the TRISC<2> bit.

Note: Clearing the CCP1CON register will force the RC2/CCP1 compare output latch to the default low level. This is not the data latch.

10.2.1 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode if the CCP module is using the compare feature. In Asynchronous Counter mode, the compare operation may not work.

10.2.2 SOFTWARE INTERRUPT MODE

When Generate Software Interrupt is chosen, the CCP1 pin is not affected. Only a CCP interrupt is generated (if enabled).

10.2.3 SPECIAL EVENT TRIGGER

In this mode, an internal hardware trigger is generated which may be used to initiate an action.

The special event trigger output of CCP1 and CCP2 resets the TMR1 register pair. This allows the CCPR1H:CCPR1L and CCPR2H:CCPR2L registers to effectively be 16-bit programmable period register(s) for Timer1.

For compatibility issues, the special event trigger output of CCP1 (<u>PIC16C72</u>) and CCP2 (all other PIC16C7X devices) also starts an A/D conversion.

Note: The "special event trigger" from the CCP1 and CCP2 modules will not set interrupt flag bit TMR1IF (PIR1<0>).

10.3 PWM Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

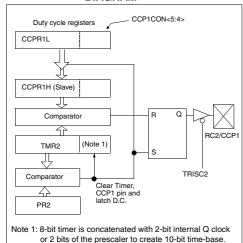
In Pulse Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note: Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data

Figure 10-4 shows a simplified block diagram of the CCP module in PWM mode.

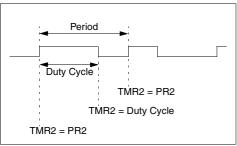
For a step by step procedure on how to set up the CCP module for PWM operation, see Section 10.3.3.

FIGURE 10-4: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 10-5) has a time base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 10-5: PWM OUTPUT



10.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- · TMR2 is cleared
- The PWM duty cycle is latched from CCPR1L into CCPR1H
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)

The Timer2 postscaler (see Section 9.1) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

10.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available: the CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

When the CCPR1H and 2-bit latch match TMR2 concatenated with an internal 2-bit Q clock or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

Maximum PWM resolution (bits) for a given PWM frequency:

$$= \frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period the CCP1 pin will not be forced to the low level.

EXAMPLE 10-2: PWM PERIOD AND DUTY CYCLE CALCULATION

Desired PWM frequency is 78.125 kHz, Fosc = 20 MHz

TMR2 prescale = 1

 $1/78.125 \text{ kHz} = [(PR2) + 1] \cdot 4 \cdot 1/20 \text{ MHz} \cdot 1$

 $= [(PR2) + 1] \cdot 4 \cdot 50 \text{ ns} \cdot 1$

PR2 = 63

Find the maximum resolution of the duty cycle that can be used with a 78.125 kHz frequency and 20 MHz oscillator:

 $1/78.125 \text{ kHz} = 2^{\text{PWM RESOLUTION}} \cdot 1/20 \text{ MHz} \cdot 1$

12.8 μs = $2^{\text{PWM RESOLUTION}} \cdot 50 \text{ ns} \cdot 1$

 $= 2^{\text{PWM RESOLUTION}}$

log(256) = (PWM Resolution) • log(2)

8.0 = PWM Resolution

At most, an 8-bit resolution duty cycle can be obtained from a 78.125 kHz frequency and a 20 MHz oscillator, i.e., $0 \le \text{CCPR1L:CCP1CON} < 5.4 > \le 255$. Any value greater than 255 will result in a 100% duty cycle.

In order to achieve higher resolution, the PWM frequency must be decreased. In order to achieve higher PWM frequency, the resolution must be decreased.

Table 10-3 lists example PWM frequencies and resolutions for Fosc = 20 MHz. The TMR2 prescaler and PR2 values are also shown.

10.3.3 SET-UP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

- Set the PWM period by writing to the PR2 register.
- Set the PWM duty cycle by writing to the CCPR1L register and CCP1CON<5:4> bits.
- Make the CCP1 pin an output by clearing the TRISC<2> bit.
- 4. Set the TMR2 prescale value and enable Timer2 by writing to T2CON.
- 5. Configure the CCP1 module for PWM operation.

TABLE 10-3: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS AT 20 MHz

PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12 kHz	156.3 kHz	208.3 kHz
Timer Prescaler (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0x3F	0x1F	0x17
Maximum Resolution (bits)	10	10	10	8	7	5.5

TABLE 10-4: REGISTERS ASSOCIATED WITH TIMER1, CAPTURE AND COMPARE

Add	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	PC	e on: DR, DR	all c	e on other sets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
0Dh ⁽⁴⁾	PIR2	_	_	_	_	_	_	_	CCP2IF		0		0
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
8Dh ⁽⁴⁾	PIE2	_	_			_	_	-	CCP2IE		0		0
87h	TRISC	PORTC D	ata Dire	ction registe	er	•				1111	1111	1111	1111
0Eh	TMR1L	Holding re	egister fo	r the Least	Significant	Byte of the	16-bit TMI	R1 register	•	xxxx	xxxx	uuuu	uuuu
0Fh	TMR1H	Holding re	egister fo	r the Most S	Significant	Byte of the	16-bit TMF	11 register		xxxx	xxxx	uuuu	uuuu
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T10SCEN	T1SYNC	TMR1CS	TMR10N	00	0000	uu	uuuu
15h	CCPR1L	Capture/C	Compare/	PWM1 (LS	B)					xxxx	xxxx	uuuu	uuuu
16h	CCPR1H	Capture/C	Compare/	PWM1 (MS	SB)					xxxx	xxxx	uuuu	uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00	0000	00	0000
1Bh ⁽⁴⁾	CCPR2L	Capture/Compare/PWM2 (LSB)									xxxx	uuuu	uuuu
1Ch ⁽⁴⁾	CCPR2H	Capture/Compare/PWM2 (MSB)								xxxx	xxxx	uuuu	uuuu
1Dh ⁽⁴⁾	CCP2CON	_	_	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00	0000	00	0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used in these modes.

- Note 1: These bits are associated with the USART module, which is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.
 - 2: Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.
 - 3: The PIR1<6> and PIE1<6> bits are reserved, always maintain these bits clear.
 - 4: These registers are associated with the CCP2 module, which is only implemented on the PIC16C63/R63/65/65A/R65/66/67.

PIC16C6X

TABLE 10-5: REGISTERS ASSOCIATED WITH PWM AND TIMER2

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000
0Dh ⁽⁴⁾	PIR2	_	_	_	_	_	_	_	CCP2IF	0	0
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000
8Dh ⁽⁴⁾	PIE2	_	_	-	_	_	_	-	CCP2IE	0	0
87h	TRISC	PORTC I	Data Direction	on register			ı			1111 1111	1111 1111
11h	TMR2	Timer2 m	odule's reg		0000	0000					
92h	PR2	Timer2 m	odule's Per	iod register						1111 1111	1111 1111
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	-000 0000
15h	CCPR1L	Capture/0	Compare/P\	WM1 (LSB)		ı	l			xxxx	uuuu uuuu
16h	CCPR1H	Capture/0	Compare/P\	WM1 (MSB)					xxxx	uuuu uuuu
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	00 0000
1Bh ⁽⁴⁾	CCPR2L	Capture/Compare/PWM2 (LSB)									uuuu uuuu
1Ch ⁽⁴⁾	CCPR2H	Capture/Compare/PWM2 (MSB)									uuuu uuuu
1Dh ⁽⁴⁾	CCP2CON	_	_	CCP2X	CCP2Y	ССР2М3	CCP2M2	CCP2M1	ССР2М0	00 0000	00 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used in this mode.

Note 1: These bits are associated with the USART module, which is implemented on the PIC16C63/R63/65/65A/R65/66/67 only.

^{2:} Bits PSPIE and PSPIF are reserved on the PIC16C62/62A/R62/63/R63/66, always maintain these bits clear.

^{3:} The PIR1<6> and PIE1<6> bits are reserved, always maintain these bits clear.

^{4:} These registers are associated with the CCP2 module, which is only implemented on the PIC16C63/R63/65/65A/R65/66/67.

11.0 SYNCHRONOUS SERIAL PORT (SSP) MODULE

11.1 SSP Module Overview

The Synchronous Serial Port (SSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be Serial EEPROMs, shift registers, display drivers, A/D converters, etc. The SSP module can operate in one of two modes:

- · Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C)

The SSP module in I²C mode works the same in all PIC16C6X devices that have an SSP module. However the SSP Module in SPI mode has differences between the PIC16C66/67 and the other PIC16C6X devices.

The register definitions and operational description of SPI mode has been split into two sections because of the differences between the PIC16C66/67 and the other PIC16C6X devices. The default reset values of both the SPI modules is the same regardless of the device:

11.2	SPI Mode for PIC16C62/62A/R62/63/R63/6	4/
	64A/R64/65/65A/R65	34
11.3	SPI Mode for PIC16C66/67	39
11.4	I ² C™ Overview9	95
11.5	SSP I ² C Operation	99

Refer to Application Note AN578, "Use of the SSP Module in the I²C Multi-Master Environment."

11.2 <u>SPI Mode for PIC16C62/62A/R62/63/</u> R63/64/64A/R64/65/65A/R65

This section contains register definitions and operational characteristics of the SPI module for the PIC16C62, PIC16C62A, PIC16CR62, PIC16C63, PIC16CR64, PIC16CR64, PIC16CR64, PIC16CR65, PIC16CR65,

FIGURE 11-1: SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS 94h)

U-0	U-0	R-0	R-0	R-0	R-0	R-0	R-0
_	_	D/A	Р	S	R/W	UA	BF
bit7							bit0

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'- n = Value at POR reset

- bit 7-6: Unimplemented: Read as '0'
- bit 5: **D/A**: Data/Address bit (I²C mode only)
 - 1 = Indicates that the last byte received or transmitted was data
 - 0 = Indicates that the last byte received or transmitted was address
- bit 4: P: Stop bit (I²C mode only. This bit is cleared when the SSP module is disabled, SSPEN is cleared)
 - 1 = Indicates that a stop bit has been detected last (this bit is '0' on RESET)
 - 0 = Stop bit was not detected last
- bit 3: S: Start bit (I²C mode only. This bit is cleared when the SSP module is disabled, SSPEN is cleared)
 - 1 = Indicates that a start bit has been detected last (this bit is '0' on RESET)
 - 0 = Start bit was not detected last
- bit 2: **R/W**: Read/Write bit information (I²C mode only)

This bit holds the R/W bit information following the last address match. This bit is valid from the address match to the next start bit, stop bit, or $\overline{\text{ACK}}$ bit.

- 1 = Read
- 0 = Write
- bit 1: **UA**: Update Address (10-bit I²C mode only)
 - 1 = Indicates that the user needs to update the address in the SSPADD register
 - 0 = Address does not need to be updated
- bit 0: BF: Buffer Full Status bit

Receive (SPI and I²C modes)

- 1 = Receive complete, SSPBUF is full
- 0 = Receive not complete, SSPBUF is empty

Transmit (I²C mode only)

- 1 = Transmit in progress, SSPBUF is full
- 0 = Transmit complete, SSPBUF is empty

FIGURE 11-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)

R/W-0								
WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	R = Readable bit
bit7							bit0	W = Writable bit
								U = Unimplemented bit, read as '0'
								- n =Value at POR reset

bit 7: WCOL: Write Collision Detect bit

1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)

0 = No collision

bit 6: SSPOV: Receive Overflow Detect bit

In SPI mode

1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR register is lost. Overflow can only occur in slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. In master mode the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register.

0 = No overflow

In I²C mode

1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care" in transmit mode. SSPOV must be cleared in software in either mode.

0 = No overflow

bit 5: SSPEN: Synchronous Serial Port Enable bit

In SPI mode

- 1 = Enables serial port and configures SCK, SDO, and SDI as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

In I²C mode

- 1 = Enables the serial port and configures the SDA and SCL pins as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

In both modes, when enabled, these pins must be properly configured as input or output.

bit 4: CKP: Clock Polarity Select bit

In SPI mode

- 1 = Idle state for clock is a high level. Transmit happens on falling edge, receive on rising edge.
- 0 = Idle state for clock is a low level. Transmit happens on rising edge, receive on falling edge.

In I²C mode

SCK release control

- 1 = Enable clock
- 0 = Holds clock low (clock stretch) (Used to ensure data setup time)

bit 3-0: SSPM3:SSPM0: Synchronous Serial Port Mode Select bits

- 0000 = SPI master mode, clock = Fosc/4
- 0001 = SPI master mode, clock = Fosc/16
- 0010 = SPI master mode, clock = Fosc/64
- 0011 = SPI master mode, clock = TMR2 output/2
- 0100 = SPI slave mode, clock = SCK pin. SS pin control enabled.
- 0101 = SPI slave mode, clock = SCK pin. SS pin control disabled. SS can be used as I/O pin.
- $0110 = I^2C$ slave mode, 7-bit address
- $0111 = I^2C$ slave mode, 10-bit address
- $1011 = I^2C$ firmware controlled Master Mode (slave idle)
- $1110 = I^2C$ slave mode, 7-bit address with start and stop bit interrupts enabled
- $1111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled

11.2.1 OPERATION OF SSP MODULE IN SPI MODE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The SPI mode allows 8-bits of data to be synchronously transmitted and received simultaneously. To accomplish communication, typically three pins are used:

- · Serial Data Out (SDO)
- · Serial Data In (SDI)
- · Serial Clock (SCK)

Additionally a fourth pin may be used when in a slave mode of operation:

Slave Select (SS)

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits in the SSPCON register (SSPCON<5:0>). These control bits allow the following to be specified:

- · Master Mode (SCK is the clock output)
- · Slave Mode (SCK is the clock input)
- Clock Polarity (Output/Input data on the Rising/ Falling edge of SCK)
- · Clock Rate (Master mode only)
- Slave Select Mode (Slave mode only)

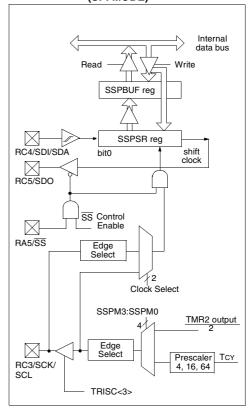
The SSP consists of a transmit/receive Shift Register (SSPSR) and a Buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR, until the received data is ready. Once the 8-bits of data have been received, that byte is moved to the SSPBUF register. Then the Buffer Full bit, BF (SSPSTAT<0>) and flag bit SSPIF are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit, WCOL (SSPCON<7>) will be set. User software must clear bit WCOL so that it can be determined if the following write(s) to the SSPBUF completed successfully. When the application software is expecting to receive valid data, the SSPBUF register should be read before the next byte of data to transfer is written to the SSPBUF register. The Buffer Full bit BF (SSPSTAT<0>) indicates when the SSPBUF register has been loaded with the received data (transmission is complete). When the SSPBUF is read, bit BF is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally the SSP Interrupt is used to determine when the transmission/reception has completed. The SSPBUF register must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 11-1 shows the loading of the SSPBUF (SSPSR) register for data transmission. The shaded instruction is only required if the received data is meaningful.

EXAMPLE 11-1: LOADING THE SSPBUF (SSPSR) REGISTER

	BSF	STATUS,	RP0	;Specify Bank 1
LOOP	BTFSS	SSPSTAT	, BF	;Has data been
				;received
				;(transmit
				;complete)?
	GOTO	LOOP		;No
	BCF	STATUS,	RP0	;Specify Bank 0
	MOVF	SSPBUF,	W	;W reg = contents
				;of SSPBUF
	MOVWF	RXDATA		;Save in user RAM
	MOVF	TXDATA,	W	;W reg = contents
				; of TXDATA
	MOVWE	SSDBIIE		·New data to xmit

The block diagram of the SSP module, when in SPI mode (Figure 11-3), shows that the SSPSR register is not directly readable or writable, and can only be accessed from addressing the SSPBUF register. Additionally, the SSP status register (SSPSTAT) indicates the various status conditions.

FIGURE 11-3: SSP BLOCK DIAGRAM (SPI MODE)



To enable the serial port, SSP enable bit SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear enable bit SSPEN, re-initialize SSPCON register, and then set enable bit SSPEN. This configures the SDI, SDO, SCK, and \$\overline{SP}\$ pins as serial port pins. For the pins to behave as the serial port function, they must have their data direction bits (in the TRIS register) appropriately programmed. That is:

- · SDI must have TRISC<4> set
- · SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- SS must have TRISA<5> set (if implemented)

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value. An example would be in master mode where you are only sending data (to a display driver), then both SDI and SS could be used as general purpose outputs by clearing their corresponding TRIS register bits.

Figure 11-4 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to the same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application software. This leads to three scenarios for data transmission:

- Master sends data Slave sends dummy data
- Master sends data Slave sends data
- · Master sends dummy data Slave sends data

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2) is to broadcast data by the software protocol.

In master mode the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SCK output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor" mode.

In slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched interrupt flag bit SSPIF (PIR1<3>) is set

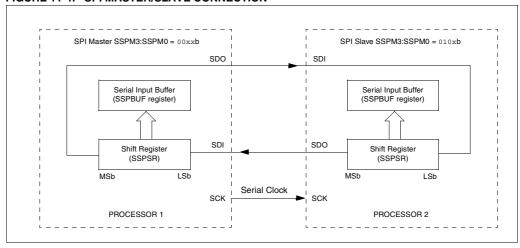
The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 11-5 and Figure 11-6 where the MSB is transmitted first. In master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- · Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5 MHz. When in slave mode the external clock must meet the minimum high and low times.

In sleep mode, the slave can transmit and receive data and wake the device from sleep.

FIGURE 11-4: SPI MASTER/SLAVE CONNECTION



The \overline{SS} pin allows a synchronous slave mode. The SPI must be in slave mode (SSPCON<3:0> = 04h) and the TRISA<5> bit must be set the for synchronous slave mode to be enabled. When the \overline{SS} pin is low, transmission and reception are enabled and the SDO pin is driven. When the \overline{SS} pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. If the \overline{SS} pin is taken low without resetting SPI mode, the transmission will continue from the

point at which it was taken high. External pull-up/ pull-down resistors may be desirable, depending on the application.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.

FIGURE 11-5: SPI MODE TIMING, MASTER MODE OR SLAVE MODE W/O SS CONTROL

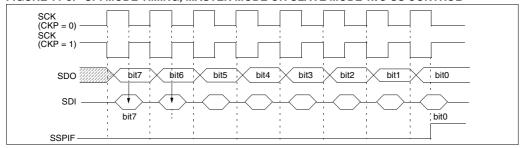


FIGURE 11-6: SPI MODE TIMING, SLAVE MODE WITH SS CONTROL

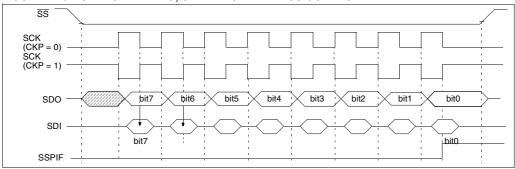


TABLE 11-1: REGISTERS ASSOCIATED WITH SPI OPERATION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
0Bh,8Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	PSPIF ⁽²⁾	(3)	RCIF ⁽¹⁾	TXIF ⁽¹⁾	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽²⁾	(3)	RCIE ⁽¹⁾	TXIE ⁽¹⁾	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
13h	SSPBUF	Synchrono	us Serial	Port Rece	ive Buffer	Transmit	Register			xxxx xxxx	uuuu uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
85h	TRISA	_	_	PORTA Da	PORTA Data Direction Register						11 1111
87h	TRISC	PORTC D	ata Directi	on Registe	er			1111 1111	1111 1111		
94h	SSPSTAT	_	_	D/Ā	Р	S	R/W	UA	BF	00 0000	00 0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by SSP module in SPI mode.

- Note 1: These bits are associated with the USART which is implemented on the PIC16C63/R63/65/65A/R65 only.
 - 2: PSPIF and PSPIE are reserved on the PIC16C62/62A/R62/63/R63, always maintain these bits clear.
 - 3: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

11.3 SPI Mode for PIC16C66/67

This section contains register definitions and operational characterisitics of the SPI module on the PIC16C66 and PIC16C67 only.

FIGURE 11-7: SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS 94h)(PIC16C66/67)

R/W-	0 R/W-0	R/W-0 R-0	R-0	R-0	R-0	R-0	R-0	
SMF	CKE	CKE D/A	Р	S	R/W	UA	BF	R = R
bit7							bit0	W = W U = Uı

R = Readable bit W = Writable bit

U = Unimplemented bit, read as '0' - n =Value at POR reset

bit 7: SMP: SPI data input sample phase

SPI Master Mode

- 1 = Input data sampled at end of data output time
- 0 = Input data sampled at middle of data output time

SPI Slave Mode

SMP must be cleared when SPI is used in slave mode

bit 6: CKE: SPI Clock Edge Select (Figure 11-11, Figure 11-12, and Figure 11-13)

CKP = 0

- 1 = Data transmitted on rising edge of SCK
- 0 = Data transmitted on falling edge of SCK

CKP = 1

- 1 = Data transmitted on falling edge of SCK
- 0 = Data transmitted on rising edge of SCK
- bit 5: D/A: Data/Address bit (I²C mode only)
 - 1 = Indicates that the last byte received or transmitted was data
 - 0 = Indicates that the last byte received or transmitted was address
- bit 4: **P**: Stop bit (I²C mode only. This bit is cleared when the SSP module is disabled, or when the Start bit is detected last, SSPEN is cleared)
 - 1 = Indicates that a stop bit has been detected last (this bit is '0' on RESET)
 - 0 = Stop bit was not detected last
- bit 3: Start bit (I²C mode only. This bit is cleared when the SSP module is disabled, or when the Stop bit is detected last, SSPEN is cleared)
 - 1 = Indicates that a start bit has been detected last (this bit is '0' on RESET)
 - 0 = Start bit was not detected last
- bit 2: **R/W**: Read/Write bit information (I²C mode only)

This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next start bit, stop bit, or \overline{ACK} bit.

- 1 = Read
- 0 = Write
- bit 1: **UA**: Update Address (10-bit I²C mode only)
 - 1 = Indicates that the user needs to update the address in the SSPADD register
 - 0 = Address does not need to be updated
- bit 0: **BF**: Buffer Full Status bit

Receive (SPI and I²C modes)

- 1 = Receive complete, SSPBUF is full
- 0 = Receive not complete. SSPBUF is empty

Transmit (I²C mode only)

- 1 = Transmit in progress, SSPBUF is full
- 0 = Transmit complete, SSPBUF is empty

FIGURE 11-8: SSPCON: SYNC SERIAL PORT CONTROL REGISTER (ADDRESS 14h)(PIC16C66/67)

R/W-0								
WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	R = Readable bit
bit7							bit0	W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR reset

bit 7: WCOL: Write Collision Detect bit

1 = The SSPBUF register is written while it is still transmitting the previous word (must be cleared in software)

0 = No collision

bit 6: SSPOV: Receive Overflow Indicator bit

In SPI mode

1 = A new byte is received while the SSPBUF register is still holding the previous data. In case of overflow, the data in SSPSR is lost. Overflow can only occur in slave mode. The user must read the SSPBUF, even if only transmitting data, to avoid setting overflow. In master mode the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPBUF register.

0 = No overflow

In I²C mode

1 = A byte is received while the SSPBUF register is still holding the previous byte. SSPOV is a "don't care" in transmit mode. SSPOV must be cleared in software in either mode.

0 = No overflow

bit 5: SSPEN: Synchronous Serial Port Enable bit

In SPI mode

- 1 = Enables serial port and configures SCK, SDO, and SDI as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

In I²C mode

- 1 = Enables the serial port and configures the SDA and SCL pins as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

In both modes, when enabled, these pins must be properly configured as input or output.

bit 4: CKP: Clock Polarity Select bit

In SPI mode

- 1 = Idle state for clock is a high level
- 0 = Idle state for clock is a low level

In I²C mode

SCK release control

- 1 = Enable clock
- 0 = Holds clock low (clock stretch) (Used to ensure data setup time)

bit 3-0: SSPM3:SSPM0: Synchronous Serial Port Mode Select bits

- 0000 = SPI master mode. clock = Fosc/4
- 0001 = SPI master mode, clock = Fosc/16
- 0010 = SPI master mode, clock = Fosc/64
- 0011 = SPI master mode, clock = TMR2 output/2
- 0100 = SPI slave mode, clock = SCK pin. \overline{SS} pin control enabled.
- 0101 = SPI slave mode, clock = SCK pin. SS pin control disabled. SS can be used as I/O pin
- $0110 = I^2C$ slave mode, 7-bit address
- $0111 = I^2C$ slave mode. 10-bit address
- $1011 = I^2C$ firmware controlled master mode (slave idle)
- $1110 = I^2C$ slave mode, 7-bit address with start and stop bit interrupts enabled
- $1111 = I^2C$ slave mode, 10-bit address with start and stop bit interrupts enabled

11.3.1 SSP MODULE IN SPI MODE FOR PIC16C66/67

The SPI mode allows 8-bits of data to be synchronously transmitted and received simultaneously. To accomplish communication, typically three pins are used:

- Serial Data Out (SDO) RC5/SDO
- · Serial Data In (SDI) RC4/SDI/SDA
- Serial Clock (SCK) RC3/SCK/SCL

Additionally a fourth pin may be used when in a slave mode of operation:

Slave Select (SS) RA5/SS

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits in the SSPCON register (SSPCON<5:0>) and SSPSTAT<7:6>. These control bits allow the following to be specified:

- · Master Mode (SCK is the clock output)
- · Slave Mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Clock edge (output data on rising/falling edge of SCK)
- · Clock Rate (Master mode only)
- · Slave Select Mode (Slave mode only)

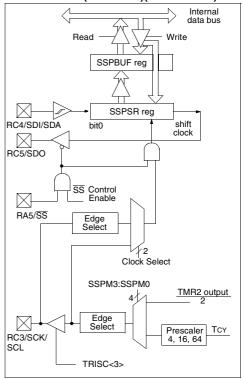
The SSP consists of a transmit/receive Shift Register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device. MSb first. The SSPBUF holds the data that was written to the SSPSR until the received data is ready. Once the 8-bits of data have been received, that byte is moved to the SSPBUF register. Then the buffer full detect bit BF (SSPSTAT<0>) and interrupt flag bit SSPIF (PIR1<3>) are set. This double buffering of the received data (SSPBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPBUF register during transmission/reception of data will be ignored, and the write collision detect bit WCOL (SSPCON<7>) will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully. When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. Buffer full bit BF (SSPSTAT<0>) indicates when SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, bit BF is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally the SSP Interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 11-2 shows the loading of the SSPBUF (SSPSR) for data transmission. The shaded instruction is only required if the received data is meaningful.

EXAMPLE 11-2: LOADING THE SSPBUF (SSPSR) REGISTER (PIC16C66/67)

```
BCF
           STATUS, RP1
                           ;Specify Bank 1
     BSF
           STATUS, RP0
LOOP BTESS SSPSTAT, BE
                           ·Has data been
                           :received
                           :(transmit
                           ;complete)?
     GOTO LOOP
                           :No
     BCF
           STATUS RPO
                           ;Specify Bank 0
                           ;W reg = contents
     MOVE
          SSPBUF, W
                           : of SSPBUF
     MOVWE RYDATA
                           ;Save in user RAM
     MOVE
           TYDATA. W
                           ;W reg = contents
                           ; of TXDATA
     MOVWF SSPBUF
                           ; New data to xmit
```

The block diagram of the SSP module, when in SPI mode (Figure 11-9), shows that the SSPSR is not directly readable or writable, and can only be accessed from addressing the SSPBUF register. Additionally, the SSP status register (SSPSTAT) indicates the various status conditions.

FIGURE 11-9: SSP BLOCK DIAGRAM (SPI MODE)(PIC16C66/67)



To enable the serial port, SSP Enable bit, SSPEN (SSPCON<5>) must be set. To reset or reconfigure SPI mode, clear bit SSPEN, re-initialize the SSPCON register, and then set bit SSPEN. This configures the SDI, SDO, SCK, and $\overline{\rm SS}$ pins as serial port pins. For the pins to behave as the serial port function, they must have their data direction bits (in the TRISC register) appropriately programmed. That is:

- · SDI must have TRISC<4> set
- · SDO must have TRISC<5> cleared
- SCK (Master mode) must have TRISC<3> cleared
- SCK (Slave mode) must have TRISC<3> set
- SS must have TRISA<5> set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value. An example would be in master mode where you are only sending data (to a display driver), then both SDI and SS could be used as general purpose outputs by clearing their corresponding TRIS register bits.

Figure 11-10 shows a typical connection between two microcontrollers. The master controller (Processor 1) initiates the data transfer by sending the SCK signal. Data is shifted out of both shift registers on their programmed clock edge, and latched on the opposite edge of the clock. Both processors should be programmed to same Clock Polarity (CKP), then both controllers would send and receive data at the same time. Whether the data is meaningful (or dummy data) depends on the application firmware. This leads to three scenarios for data transmission:

- · Master sends data Slave sends dummy data
- Master sends data Slave sends data
- Master sends dummy data Slave sends data

The master can initiate the data transfer at any time because it controls the SCK. The master determines when the slave (Processor 2) is to broadcast data by the firmware protocol.

In master mode the data is transmitted/received as soon as the SSPBUF register is written to. If the SPI is only going to receive, the SCK output could be disabled (programmed as an input). The SSPSR register will continue to shift in the signal present on the SDI pin at the programmed clock rate. As each byte is received, it will be loaded into the SSPBUF register as if a normal received byte (interrupts and status bits appropriately set). This could be useful in receiver applications as a "line activity monitor" mode.

In slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched the interrupt flag bit SSPIF (PIR1<3>) is set.

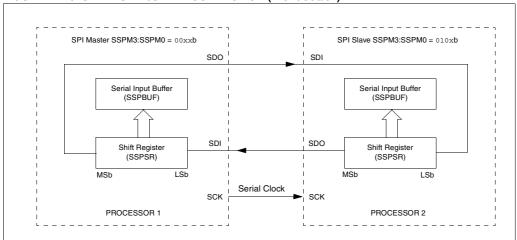
The clock polarity is selected by appropriately programming bit CKP (SSPCON<4>). This then would give waveforms for SPI communication as shown in Figure 11-11, Figure 11-12, and Figure 11-13 where the MSB is transmitted first. In master mode, the SPI clock rate (bit rate) is user programmable to be one of the following:

- Fosc/4 (or Tcy)
- Fosc/16 (or 4 Tcy)
- Fosc/64 (or 16 Tcy)
- Timer2 output/2

This allows a maximum bit clock frequency (at 20 MHz) of 5 MHz. When in slave mode the external clock must meet the minimum high and low times.

In sleep mode, the slave can transmit and receive data and wake the device from sleep.

FIGURE 11-10: SPI MASTER/SLAVE CONNECTION (PIC16C66/67)



The SS pin allows a synchronous slave mode. The SPI must be in slave mode (SSPCON<3:0> = 04h) and the TRISA<5> bit must be set for the synchronous slave mode to be enabled. When the SS pin is low, transmission and reception are enabled and the SDO pin is driven. When the $\overline{\text{SS}}$ pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte, and becomes a floating output. If the SS pin is taken low without resetting SPI mode, the transmission will continue from the point at which it was taken high. External pull-up/ pull-down resistors may be desirable, depending on the application.

Note: When the SPI is in Slave Mode with SS pin control enabled, (SSPCON<3:0> = 0100) the SPI module will reset if the SS pin is set to VDD.

If the SPI is used in Slave Mode with Note: CKE = '1', then the \overline{SS} pin control must be enabled.

To emulate two-wire communication, the SDO pin can be connected to the SDI pin. When the SPI needs to operate as a receiver the SDO pin can be configured as an input. This disables transmissions from the SDO. The SDI can always be left as an input (SDI function) since it cannot create a bus conflict.

FIGURE 11-11: SPI MODE TIMING, MASTER MODE (PIC16C66/67)

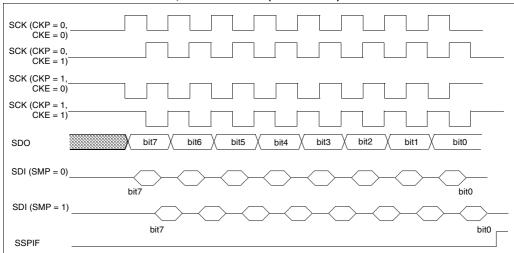


FIGURE 11-12: SPI MODE TIMING (SLAVE MODE WITH CKE = 0) (PIC16C66/67)

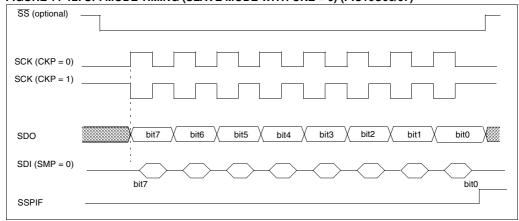


FIGURE 11-13: SPI MODE TIMING (SLAVE MODE WITH CKE = 1) (PIC16C66/67)

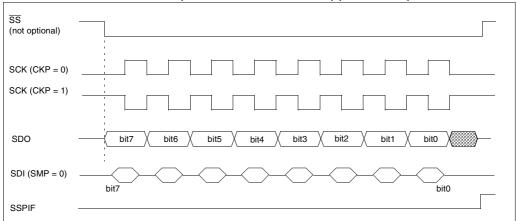


TABLE 11-2: REGISTERS ASSOCIATED WITH SPI OPERATION (PIC16C66/67)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Pow	e on er-on set		on all
0Bh,8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
13h	SSPBUF	Synchron	ous Serial	Port Rec	eive Buffe	r/Transmit	Register			xxxx	xxxx	uuuu	uuuu
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000	0000	0000	0000
85h	TRISA	_	_	PORTA D	PORTA Data Direction register						1111	11	1111
87h	TRISC	PORTC D	ata Direct	ion registe	on register							1111	1111
94h	SSPSTAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000	0000	0000	0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'.

Shaded cells are not used by SSP module in SPI mode.

Note 1: PSPIF and PSPIE are reserved on the PIC16C66, always maintain these bits clear.

^{2:} PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

11.4 I²C™ Overview

This section provides an overview of the Inter-Integrated Circuit (I²C) bus, with Section 11.5 discussing the operation of the SSP module in I²C mode.

The I²C bus is a two-wire serial interface developed by the Philips[®] Corporation. The original specification, or standard mode, was for data transfers of up to 100 Kbps. The enhanced specification (fast mode) is also supported. This device will communicate with both standard and fast mode devices if attached to the same bus. The clock will determine the data rate.

The I²C interface employs a comprehensive protocol to ensure reliable transmission and reception of data. When transmitting data, one device is the "master" which initiates transfer on the bus and generates the clock signals to permit that transfer, while the other device(s) acts as the "slave." All portions of the slave protocol are implemented in the SSP module's hardware, except general call support, while portions of the master protocol need to be addressed in the PIC16CXX software. Table 11-3 defines some of the I²C bus terminology. For additional information on the I²C interface specification, refer to the Philips document "The I²C bus and how to use it." #939839340011, which can be obtained from the Philips Corporation.

In the I²C interface protocol each device has an address. When a master wishes to initiate a data transfer, it first transmits the address of the device that it wishes to "talk" to. All devices "listen" to see if this is their address. Within this address, a bit specifies if the master wishes to read-from/write-to the slave device. The master and slave are always in opposite modes (transmitter/receiver) of operation during a data transfer. That is they can be thought of as operating in either of these two relations:

- · Master-transmitter and Slave-receiver
- · Slave-transmitter and Master-receiver

In both cases the master generates the clock signal.

The output stages of the clock (SCL) and data (SDA) lines must have an open-drain or open-collector in order to perform the wired-AND function of the bus. External pull-up resistors are used to ensure a high level when no device is pulling the line down. The number of devices that may be attached to the I²C bus is limited only by the maximum bus loading specification of 400 pF.

11.4.1 INITIATING AND TERMINATING DATA TRANSFER

During times of no data transfer (idle time), both the clock line (SCL) and the data line (SDA) are pulled high through the external pull-up resistors. The START and STOP conditions determine the start and stop of data transmission. The START condition is defined as a high to low transition of the SDA when the SCL is high. The STOP condition is defined as a low to high transition of the SDA when the SCL is high. Figure 11-14 shows the START and STOP conditions. The master generates these conditions for starting and terminating data transfer. Due to the definition of the START and STOP conditions, when data is being transmitted, the SDA line can only change state when the SCL line is low.

FIGURE 11-14: START AND STOP CONDITIONS

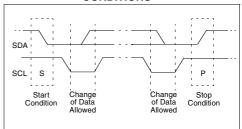


TABLE 11-3: I²C BUS TERMINOLOGY

Term	Description
Transmitter	The device that sends the data to the bus.
Receiver	The device that receives the data from the bus.
Master	The device which initiates the transfer, generates the clock and terminates the transfer.
Slave	The device addressed by a master.
Multi-master	More than one master device in a system. These masters can attempt to control the bus at the same time without corrupting the message.
Arbitration	Procedure that ensures that only one of the master devices will control the bus. This ensure that the transfer data does not get corrupted.
Synchronization	Procedure where the clock signals of two or more devices are synchronized.

11.4.2 ADDRESSING I2C DEVICES

There are two address formats. The simplest is the 7-bit address format with a $R\overline{W}$ bit (Figure 11-15). The more complex is the 10-bit address with a $R\overline{W}$ bit (Figure 11-16). For 10-bit address format, two bytes must be transmitted with the first five bits specifying this to be a 10-bit address.

FIGURE 11-15: 7-BIT ADDRESS FORMAT

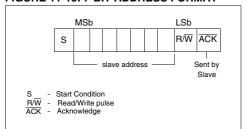
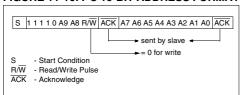


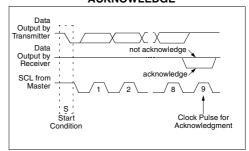
FIGURE 11-16: I2C 10-BIT ADDRESS FORMAT



11.4.3 TRANSFER ACKNOWLEDGE

All data must be transmitted per byte, with no limit to the number of bytes transmitted per data transfer. After each byte, the slave-receiver generates an acknowledge bit (\overline{ACK}) (Figure 11-17). When a slave-receiver doesn't acknowledge the slave address or received data, the master must abort the transfer. The slave must leave SDA high so that the master can generate the STOP condition (Figure 11-14).

FIGURE 11-17: SLAVE-RECEIVER ACKNOWLEDGE



If the master is receiving the data (master-receiver), it generates an acknowledge signal for each received byte of data, except for the last byte. To signal the end of data to the slave-transmitter, the master does not generate an acknowledge (not acknowledge). The slave then releases the SDA line so the master can generate the STOP condition. The master can also generate the STOP condition during the acknowledge pulse for valid termination of data transfer.

If the slave needs to delay the transmission of the next byte, holding the SCL line low will force the master into a wait state. Data transfer continues when the slave releases the SCL line. This allows the slave to move the received data or fetch the data it needs to transfer before allowing the clock to start. This wait state technique can also be implemented at the bit level, Figure 11-18. The slave will inherently stretch the clock, when it is a transmitter, but will not when it is a receiver. The slave will have to clear the SSPCON<4> bit to enable clock stretching when it is a receiver.

FIGURE 11-18: DATA TRANSFER WAIT STATE

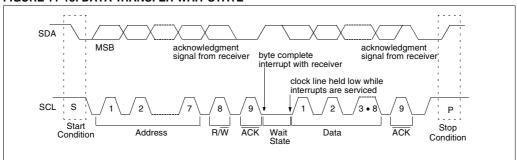


Figure 11-19 and Figure 11-20 show Master-transmitter and Master-receiver data transfer sequences.

When a master does not wish to relinquish the bus (by generating a STOP condition), a repeated START condition (Sr) must be generated. This condition is identical to the start condition (SDA goes high-to-low while

SCL is high), but occurs after a data transfer acknowledge pulse (not the bus-free state). This allows a master to send "commands" to the slave and then receive the requested information or to address a different slave device. This sequence is shown in Figure 11-21.

FIGURE 11-19: MASTER-TRANSMITTER SEQUENCE

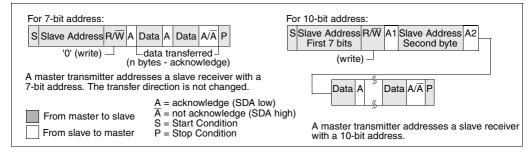


FIGURE 11-20: MASTER-RECEIVER SEQUENCE

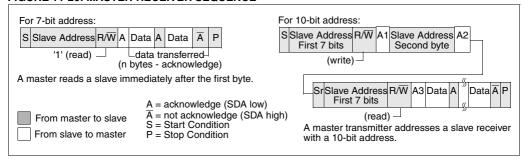
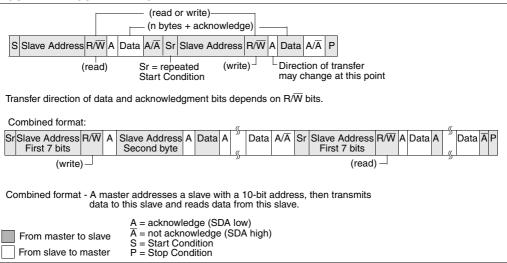


FIGURE 11-21: COMBINED FORMAT



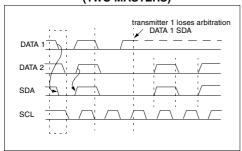
11.4.4 MULTI-MASTER

The I²C protocol allows a system to have more than one master. This is called multi-master. When two or more masters try to transfer data at the same time, arbitration and synchronization occur.

11.4.4.1 ARBITRATION

Arbitration takes place on the SDA line, while the SCL line is high. The master which transmits a high when the other master transmits a low loses arbitration (Figure 11-22), and turns off its data output stage. A master which lost arbitration can generate clock pulses until the end of the data byte where it lost arbitration. When the master devices are addressing the same device, arbitration continues into the data.

FIGURE 11-22: MULTI-MASTER ARBITRATION (TWO MASTERS)



Masters that also incorporate the slave function, and have lost arbitration must immediately switch over to slave-receiver mode. This is because the winning master-transmitter may be addressing it.

Arbitration is not allowed between:

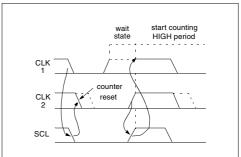
- · A repeated START condition
- · A STOP condition and a data bit
- A repeated START condition and a STOP condition

Care needs to be taken to ensure that these conditions do not occur.

11.2.4.2 Clock Synchronization

Clock synchronization occurs after the devices have started arbitration. This is performed using a wired-AND connection to the SCL line. A high to low transition on the SCL line causes the concerned devices to start counting off their low period. Once a device clock has gone low, it will hold the SCL line low until its SCL high state is reached. The low to high transition of this clock may not change the state of the SCL line, if another device clock is still within its low period. The SCL line is held low by the device with the longest low period. Devices with shorter low periods enter a high waitstate, until the SCL line comes high. When the SCL line comes high, all devices start counting off their high periods. The first device to complete its high period will pull the SCL line low. The SCL line high time is determined by the device with the shortest high period, Figure 11-23.

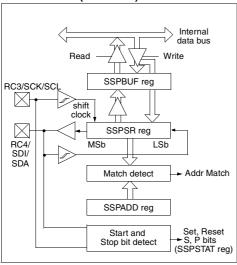
FIGURE 11-23: CLOCK SYNCHRONIZATION



11.5 SSP I²C Operation

The SSP module in $\rm I^2C$ mode fully implements all slave functions, except general call support, and provides interrupts on start and stop bits in hardware to facilitate firmware implementations of the master functions. The SSP module implements the standard mode specifications as well as 7-bit and 10-bit addressing. Two pins are used for data transfer. These are the RC3/SCK/SCL pin, which is the clock (SCL), and the RC4/SDI/SDA pin, which is the data (SDA). The user must configure these pins as inputs or outputs through the TRISC<4:3> bits. The SSP module functions are enabled by setting SSP Enable bit SSPEN (SSP-CON<5>).

FIGURE 11-24: SSP BLOCK DIAGRAM (I²C MODE)



The SSP module has five registers for I²C operation. These are the:

- SSP Control Register (SSPCON)
- · SSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) Not directly accessible
- · SSP Address Register (SSPADD)

The SSPCON register allows control of the I²C operation. Four mode selection bits (SSPCON<3:0>) allow one of the following I²C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Slave mode (7-bit address), with start and stop bit interrupts enabled
- I²C Slave mode (10-bit address), with start and stop bit interrupts enabled
- I²C Firmware controlled Master Mode, slave is idle

Selection of any I²C mode, with the SSPEN bit set, forces the SCL and SDA pins to be open drain, provided these pins are programmed to inputs by setting the appropriate TRISC bits.

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START or STOP bit, specifies if the received byte was data or address if the next byte is the completion of 10-bit address, and if this will be a read or write data transfer. The SSPSTAT register is read only.

The SSPBUF is the register to which transfer data is written to or read from. The SSPSR register shifts the data in or out of the device. In receive operations, the SSPBUF and SSPSR create a doubled buffered receiver. This allows reception of the next byte to begin before reading the last byte of received data. When the complete byte is received, it is transferred to the SSPBUF register and flag bit SSPIF is set. If another complete byte is received before the SSPBUF register is read, a receiver overflow has occurred and bit SSPOV (SSPCON<6>) is set and the byte in the SSPSR is lost.

The SSPADD register holds the slave address. In 10-bit mode, the user first needs to write the high byte of the address (1111 0 A9 A8 0). Following the high byte address match, the low byte of the address needs to be loaded (A7:A0).

11.5.1 SLAVE MODE

In slave mode, the SCL and SDA pins must be configured as inputs (TRISC<4:3> set). The SSP module will override the input state with the output data when required (slave-transmitter).

When an address is matched or the data transfer after an address match is received, the hardware automatically will generate the acknowledge (ACK) pulse, and then load the SSPBUF register with the received value currently in the SSPSR register.

There are certain conditions that will cause the SSP module not to give this \overline{ACK} pulse. These are if either (or both):

- a) The buffer full bit BF (SSPSTAT<0>) was set before the transfer was received.
- b) The overflow bit SSPOV (SSPCON<6>) was set before the transfer was received.

In this case, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF (PIR1<3>) is set. Table 11-4 shows what happens when a data transfer byte is received, given the status of bits BF and SSPOV. The shaded cells show the condition where user software did not properly clear the overflow condition. Flag bit BF is cleared by reading the SSPBUF register while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low for proper operation. The high and low times of the I²C specification as well as the requirement of the SSP module is shown in timing parameter #100 and parameter #101.

11.5.1.1 ADDRESSING

Once the SSP module has been enabled, it waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The

address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register.
- b) The buffer full bit, BF is set.
- c) An ACK pulse is generated.
- d) SSP interrupt flag bit, SSPIF (PIR1<3>) is set (interrupt is generated if enabled) - on the falling edge of the ninth SCL pulse.

In 10-bit address mode, two address bytes need to be received by the slave (Figure 11-16). The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address. The sequence of events for 10-bit address is as follows, with steps 7-9 for slave-transmitter:

- Receive first (high) byte of Address (bits SSPIF, BF, and bit UA (SSPSTAT<1>) are set).
- Update the SSPADD register with second (low) byte of Address (clears bit UA and releases the SCL line).
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- Receive second (low) byte of Address (bits SSPIF, BF, and UA are set).
- Update the SSPADD register with the first (high) byte of Address, if match releases SCL line, this will clear bit UA
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- Receive repeated START condition.
- Receive first (high) byte of Address (bits SSPIF and BF are set).
- Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

TABLE 11-4: DATA TRANSFER RECEIVED BYTE ACTIONS

	s Bits as Data er is Received			Set bit SSPIF
BF	SSPOV	$SSPSR \to SSPBUF$	Generate ACK Pulse	(SSP Interrupt occurs if enabled)
0	0	Yes	Yes	Yes
1	0	No	No	Yes
1	1	No	No	Yes
0	1	No	No	Yes

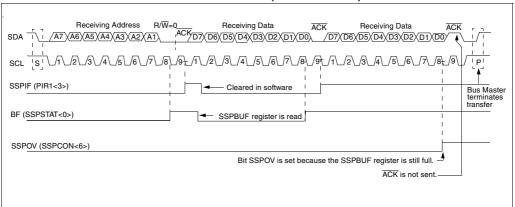
11.5.1.2 RECEPTION

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set or bit SSPOV (SSPCON<6>) is set.

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the byte.

FIGURE 11-25: I²C WAVEFORMS FOR RECEPTION (7-BIT ADDRESS)



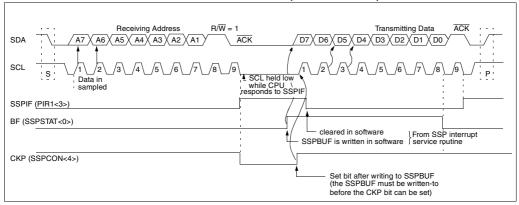
11.5.1.3 TRANSMISSION

When the $R\overline{W}$ bit of the incoming address byte is set and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is set. The received address is loaded into the SSPBUF register. The \overline{ACK} pulse will be sent on the ninth bit, and pin RC3/SCK/SCL is held low. The transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then pin RC3/SCK/SCL should be enabled by setting bit CKP (SSPCON<4>). The master must monitor the SCL pin prior to asserting another clock pulse. The slave devices may be holding off the master by stretching the clock. The eight data bits are shifted out on the falling edge of the SCL input. This ensures that the SDA signal is valid during the SCL high time (Figure 11-26).

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF must be cleared in software, and the SSPSTAT register is used to determine the status of the byte. Flag bit SSPIF is set on the falling edge of the ninth clock pulse.

As a slave-transmitter, the \overline{ACK} pulse from the master-receiver is latched on the rising edge of the ninth SCL input pulse. If the SDA line was high (not \overline{ACK}), then the data transfer is complete. When the \overline{ACK} is latched by the slave, the slave logic is reset (resets SSPSTAT register) and the slave then monitors for another occurrence of the START bit. If the SDA line was low (\overline{ACK}) , the transmit data must be loaded into the SSPBUF register, which also loads the SSPSR register. Then pin RC3/SCK/SCL should be enabled by setting bit CKP.

FIGURE 11-26: I²C WAVEFORMS FOR TRANSMISSION (7-BIT ADDRESS)



11.5.2 MASTER MODE

Master mode of operation is supported in firmware using interrupt generation on the detection of the START and STOP conditions. The STOP (P) and START (S) bits are cleared from a reset or when the SSP module is disabled. The STOP (P) and START (S) bits will toggle based on the START and STOP conditions. Control of the I²C bus may be taken when the P bit is set, or the bus is idle and both the S and P bits are clear

In master mode the SCL and SDA lines are manipulated by clearing the corresponding TRISC<4:3> bit(s). The output level is always low, irrespective of the value(s) in PORTC<4:3>. So when transmitting data, a '1' data bit must have the TRISC<4> bit set (input) and a '0' data bit must have the TRISC<4> bit cleared (output). The same scenario is true for the SCL line with the TRISC<3> bit.

The following events will cause SSP Interrupt Flag bit, SSPIF, to be set (SSP Interrupt if enabled):

- · START condition
- STOP condition
- · Data transfer byte transmitted/received

Master mode of operation can be done with either the slave mode idle (SSPM3:SSPM0 = 1011) or with the slave active. When both master and slave modes are enabled, the software needs to differentiate the source(s) of the interrupt.

11.5.3 MULTI-MASTER MODE

In multi-master mode, the interrupt generation on the detection of the START and STOP conditions allows the determination of when the bus is free. The STOP (P) and START (S) bits are cleared from a reset or when the SSP module is disabled. The STOP (P) and START (S) bits will toggle based on the START and STOP conditions. Control of the I²C bus may be taken when bit P (SSPSTAT<4>) is set, or the bus is idle and both the S and P bits clear. When the bus is busy, enabling the SSP Interrupt will generate the interrupt when the STOP condition occurs.

In multi-master operation, the SDA line must be monitored to see if the signal level is the expected output level. This check only needs to be done when a high level is output. If a high level is expected and a low level is present, the device needs to release the SDA and SCL lines (set TRISC<4:3>). There are two stages where this arbitration can be lost, these are:

- · Address Transfer
- Data Transfer

When the slave logic is enabled, the slave continues to receive. If arbitration was lost during the address transfer stage, communication to the device may be in progress. If addressed an \overline{ACK} pulse will be generated. If arbitration was lost during the data transfer stage, the device will need to re-transfer the data at a later time.

TABLE 11-5: REGISTERS ASSOCIATED WITH I²C OPERATION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	PC	e on DR, DR	Value other	on all resets
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000	000x	0000	000u
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000	0000	0000	0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000	0000	0000	0000
13h	SSPBUF	Synchrono	us Serial	Port Rece	ive Buffe	r/Transmit	Register			xxxx	xxxx	uuuu	uuuu
93h	SSPADD	Synchrono	us Serial	Port (I ² C ı	mode) Ad	ldress Re	gister			0000	0000	0000	0000
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000	0000	0000	0000
94h	SSPSTAT	SMP ⁽³⁾	CKE ⁽³⁾	D/A	Р	S	R/W	UA	BF	0000	0000	0000	0000
87h	TRISC	PORTC Da		1111	1111	1111	1111						

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'.Shaded cells are not used by SSP module in SPI mode.

- Note 1: PSPIF and PSPIE are reserved on the PIC16C66, always maintain these bits clear.
 - 2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.
 - The SMP and CKE bits are implemented on the PIC16C66/67 only. All other PIC16C6X devices have these two bits unimplemented, read as '0'.

FIGURE 11-27: OPERATION OF THE I²C MODULE IN IDLE_MODE, RCV_MODE OR XMIT_MODE

```
IDLE_MODE (7-bit):
if (Addr_match)
                                          Set interrupt;
                                          if (R/\overline{W} = 1)
                                                                  Send \overline{ACK} = 0:
                                                                  set XMIT_MODE;
                                          else if (R/\overline{W} = 0) set RCV MODE;
RCV MODE:
if ((SSPBUF=Full) OR (SSPOV = 1))
                  Set SSPOV:
                  Do not acknowledge;
                   transfer SSPSR → SSPBUF:
else
                  send \overline{ACK} = 0;
Receive 8-bits in SSPSR;
Set interrupt;
XMIT MODE:
While ((SSPBUF = Empty) AND (CKP=0)) Hold SCL Low;
Send byte;
Set interrupt;
if ( ACK Received = 1)
                                          End of transmission;
                                          Go back to IDLE_MODE;
else if ( ACK Received = 0) Go back to XMIT_MODE;
IDLE_MODE (10-Bit):
If (High_byte_addr_match AND (R/\overline{W} = 0))
                   PRIOR_ADDR_MATCH = FALSE;
                  Set interrupt;
                  if ((SSPBUF = Full) OR ((SSPOV = 1))
                          {
                                   Set SSPOV;
                                  Do not acknowledge;
                                  Set UA = 1;
                  else
                                  Send \overline{ACK} = 0;
                                  While (SSPADD not updated) Hold SCL low;
                                  Clear UA = 0;
                                  Receive Low_addr_byte;
                                  Set interrupt;
                                  Set UA = 1:
                                  If (Low_byte_addr_match)
                                                  PRIOR_ADDR_MATCH = TRUE;
                                                  Send \overline{ACK} = 0;
                                                  while (SSPADD not updated) Hold SCL low;
                                                  Clear UA = 0;
                                                  Set RCV_MODE;
                                          }
                          }
else if (High_byte_addr_match AND (R/\overline{W} = 1)
                  if (PRIOR_ADDR_MATCH)
                                  send \overline{ACK} = 0;
                                  set XMIT MODE:
          else PRIOR_ADDR_MATCH = FALSE;
          }
```

12.0 UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART) MODULE

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI) The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT ter-

minals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits. Serial EEPROMs etc.

The USART can be configured in the following modes:

- · Asynchronous (full duplex)
- Synchronous Master (half duplex)
- Synchronous Slave (half duplex)

Bit SPEN (RCSTA<7>) and bits TRISC<7:6> have to be set in order to configure pins RC6/TX/CK and RC7/RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter.

FIGURE 12-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER (ADDRESS 98h)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D
bit7							bit0

R = Readable bit W = Writable bit

U = Unimplemented bit, read as '0' - n = Value at POR reset

bit 7: CSRC: Clock Source Select bit

Asynchronous mode

Don't care

Synchronous mode

- 1 = Master mode (Clock generated internally from BRG)
- 0 = Slave mode (Clock from external source)

bit 6: TX9: 9-bit Transmit Enable bit

1 = Selects 9-bit transmission

0 = Selects 8-bit transmission

bit 5: TXEN: Transmit Enable bit

1 = Transmit enabled

0 = Transmit disabled

Note: SREN/CREN overrides TXEN in SYNC mode.

bit 4: SYNC: USART Mode Select bit

1 = Synchronous mode

0 = Asynchronous mode

bit 3: Unimplemented: Read as '0'

bit 2: BRGH: High Baud Rate Select bit

Asynchronous mode

1 = High speed

Note:

For the PIC16C63/R63/65/65A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

0 = Low speed

Synchronous mode
Unused in this mode

bit 1: TRMT: Transmit Shift Register Status bit

1 = TSR empty

0 = TSR full

bit 0: TX9D: 9th bit of transmit data. Can be parity bit.

FIGURE 12-2: RCSTA: RECEIVE STATUS AND CONTROL REGISTER (ADDRESS 18h)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R-0	R-0	R-x	
SPEN bit7	RX9	SREN	CREN	_	FERR	OERR	RX9D bit0	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0' - n = Value at POR res x = unknown
bit 7:	SPEN: Ser (Configures 1 = Serial p 0 = Serial p	s RC7/RX/ port enable	DT and RC	6/TX/CK p	oins as ser	ial port pins	s when bits	TRISC<7:6> are set)
bit 6:	RX9 : 9-bit 1 1 = Selects 0 = Selects	9-bit rece	ption					
bit 5:	SREN: Sin	gle Receiv	e Enable b	it				
	Asynchrone Don't care	ous mode						
	Synchrono 1 = Enable 0 = Disable This bit is o	s single ree es single re	ceive ceive	n is comple	ete.			
	Synchrono Unused in		<u>slave</u>					
bit 4:	CREN: Cor	ntinuous R	eceive Ena	ıble bit				
	Asynchrono 1 = Enable 0 = Disable	s continuo						
	Synchrono 1 = Enable 0 = Disable	s continuo		until enabl	e bit CREN	l is cleared	(CREN ov	errides SREN)
bit 3:	Unimplem	ented: Re	ad as '0'					
bit 2:	FERR : France 1 = Framing 0 = No france	g error (Ca		ed by read	ding RCRE	G register	and receive	e next valid byte)
bit 1:	OERR: Overrue 0 = No ove	n error (Ca		ed by clear	ring bit CR	EN)		
bit 0:	RX9D : 9th	bit of recei	ved data (0	Can be pai	rity bit)			
			,	•	- '			

12.1 USART Baud Rate Generator (BRG)

Applicable Devices													
61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67

The BRG supports both the Asynchronous and Synchronous modes of the USART. It is a dedicated 8-bit baud rate generator. The SPBRG register controls the period of a free running 8-bit timer. In asynchronous mode bit BRGH (TXSTA<2>) also controls the baud rate. In synchronous mode bit BRGH is ignored. Table 12-1 shows the formula for computation of the baud rate for different USART modes which only apply in master mode (internal clock).

Given the desired baud rate and Fosc, the nearest integer value for the SPBRG register can be calculated using the formula in Table 12-1. From this, the error in baud rate can be determined.

Example 12-1 shows the calculation of the baud rate error for the following conditions:

Fosc = 16 MHz Desired Baud Rate = 9600 BRGH = 0 SYNC = 0

EXAMPLE 12-1: CALCULATING BAUD RATE FRROR

Desired Baud rate = Fosc / (64 (X + 1))

9600 = 16000000 / (64 (X + 1)) $X = \lfloor 25.042 \rfloor = 25$

Calculated Baud Rate=16000000 / (64 (25 + 1))

= 9615

Error = (Calculated Baud Rate - Desired Baud Rate)

Desired Baud Rate

= (9615 - 9600) / 9600

= 0.16%

It may be advantageous to use the high baud rate (BRGH = 1) even for slower baud clocks. This is because the FOSC/(16(X+1)) equation can reduce the baud rate error in some cases.

Note: For the PIC16C63/R63/65/65A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

Writing a new value to the SPBRG register, causes the BRG timer to be reset (or cleared), this ensures that the BRG does not wait for a timer overflow before outputting the new baud rate.

TABLE 12-1: BAUD RATE FORMULA

SYNC	BRGH = 0 (Low Speed)	BRGH = 1 (High Speed)
0	(Asynchronous) Baud Rate = Fosc/(64(X+1))	Baud Rate = Fosc/(16(X+1))
1	(Synchronous) Baud Rate = Fosc/(4(X+1))	N/A

X = value in SPBRG (0 to 255)

TABLE 12-2: REGISTERS ASSOCIATED WITH BAUD RATE GENERATOR

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets	
98h	TXSTA	CSRC	TX9	TXEN	SYNC	-	BRGH	TRMT	TX9D	0000 -010	0000 -010	
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x	
99h	SPBRG	Baud Rat	e Genera		0000 0000	0000 0000						

Legend: x = unknown, - = unimplemented read as '0'. Shaded cells are not used by the BRG.

TABLE 12-3: BAUD RATES FOR SYNCHRONOUS MODE

BAUD	FOSC = 20 MHz		SPBRG	16 MHz		SPBRG	10 MHz		SPBRG	7.15909 I	MHz	SPBRG
RATE (K)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	NA	-	-	NA	-	-	NA	-	-	NA	-	-
2.4	NA	-	-	NA	-	-	NA	-	-	NA	-	-
9.6	NA	-	-	NA	-	-	9.766	+1.73	255	9.622	+0.23	185
19.2	19.53	+1.73	255	19.23	+0.16	207	19.23	+0.16	129	19.24	+0.23	92
76.8	76.92	+0.16	64	76.92	+0.16	51	75.76	-1.36	32	77.82	+1.32	22
96	96.15	+0.16	51	95.24	-0.79	41	96.15	+0.16	25	94.20	-1.88	18
300	294.1	-1.96	16	307.69	+2.56	12	312.5	+4.17	7	298.3	-0.57	5
500	500	0	9	500	0	7	500	0	4	NA	-	-
HIGH	5000	-	0	4000	-	0	2500	-	0	1789.8	-	0
LOW	19.53	-	255	15.625	-	255	9.766	-	255	6.991	-	255

	FOSC = 5.0688 MHz			4 MHz			3.579545	MHz		1 MHz			32.768 kHz		
BAUD RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-	0.303	+1.14	26
1.2	NA	-	-	NA	-	-	NA	-	-	1.202	+0.16	207	1.170	-2.48	6
2.4	NA	-	-	NA	-	-	NA	-	-	2.404	+0.16	103	NA	-	-
9.6	9.6	0	131	9.615	+0.16	103	9.622	+0.23	92	9.615	+0.16	25	NA	-	-
19.2	19.2	0	65	19.231	+0.16	51	19.04	-0.83	46	19.24	+0.16	12	NA	-	-
76.8	79.2	+3.13	15	76.923	+0.16	12	74.57	-2.90	11	83.34	+8.51	2	NA	-	-
96	97.48	+1.54	12	1000	+4.17	9	99.43	+3.57	8	NA	-	-	NA	-	-
300	316.8	+5.60	3	NA	-	-	298.3	-0.57	2	NA	-	-	NA	-	-
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
HIGH	1267	-	0	100	-	0	894.9	-	0	250	-	0	8.192	-	0
LOW	4.950	-	255	3.906	-	255	3.496	-	255	0.9766	-	255	0.032	-	255

TABLE 12-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD	FOSC = 20 MHz		SPBRG	16 MHz		SPBRG	10 MHz		SPBRG	7.15909 I	SPBRG	
RATE (K)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)	KBAUD	% ERROR	value (decimal)
0.3	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1.2	1.221	+1.73	255	1.202	+0.16	207	1.202	+0.16	129	1.203	+0.23	92
2.4	2.404	+0.16	129	2.404	+0.16	103	2.404	+0.16	64	2.380	-0.83	46
9.6	9.469	-1.36	32	9.615	+0.16	25	9.766	+1.73	15	9.322	-2.90	11
19.2	19.53	+1.73	15	19.23	+0.16	12	19.53	+1.73	7	18.64	-2.90	5
76.8	78.13	+1.73	3	83.33	+8.51	2	78.13	+1.73	1	NA	-	-
96	104.2	+8.51	2	NA	-	-	NA	-	-	NA	-	-
300	312.5	+4.17	0	NA	-	-	NA	-	-	NA	-	-
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-
HIGH	312.5	-	0	250	-	0	156.3	-	0	111.9	-	0
LOW	1.221	-	255	0.977	-	255	0.6104	-	255	0.437	-	255

	FOSC = 5.0688 MHz			4 MHz			3.579545 MHz			1 MHz			32.768 kHz		
BAUD RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	0.31	+3.13	255	0.3005	-0.17	207	0.301	+0.23	185	0.300	+0.16	51	0.256	-14.67	1
1.2	1.2	0	65	1.202	+1.67	51	1.190	-0.83	46	1.202	+0.16	12	NA	-	-
2.4	2.4	0	32	2.404	+1.67	25	2.432	+1.32	22	2.232	-6.99	6	NA	-	-
9.6	9.9	+3.13	7	NA	-	-	9.322	-2.90	5	NA	-	-	NA	-	-
19.2	19.8	+3.13	3	NA	-	-	18.64	-2.90	2	NA	-	-	NA	-	-
76.8	79.2	+3.13	0	NA	-	-	NA	-	-	NA	-	-	NA	-	-
96	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
300	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
500	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
HIGH	79.2	-	0	62.500	-	0	55.93	-	0	15.63	-	0	0.512	-	0
LOW	0.3094	-	255	3.906	-	255	0.2185	-	255	0.0610	-	255	0.0020	-	255

TABLE 12-5: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD RATE (K)	Fosc = 2	% ERROR	SPBRG value (decimal)	16 MHz KBAUD	% ERROR	SPBRG value (decimal)	10 MHz KBAUD	% ERROR	SPBRG value (decimal)	7.16 MH KBAUD	z % ERROR	SPBRG value (decimal)
9.6	9.615	+0.16	129	9.615	+0.16	103	9.615	+0.16	64	9.520	-0.83	46
19.2	19.230	+0.16	64	19.230	+0.16	51	18.939	-1.36	32	19.454	+1.32	22
38.4	37.878	-1.36	32	38.461	+0.16	25	39.062	+1.7	15	37.286	-2.90	11
57.6	56.818	-1.36	21	58.823	+2.12	16	56.818	-1.36	10	55.930	-2.90	7
115.2	113.636	-1.36	10	111.111	-3.55	8	125	+8.51	4	111.860	-2.90	3
250	250	0	4	250	0	3	NA	-	-	NA	-	-
625	625	0	1	NA	-	-	625	0	0	NA	-	-
1250	1250	0	0	NA	-	-	NA	-	-	NA	-	-

BAUD RATE	Fosc = 5	.068 MHz %	SPBRG value	4 MHz	%	SPBRG value	3.579 MH	Hz %	SPBRG value	1 MHz	%	SPBRG value	32.768 k	KHz %	SPBRG value
(K)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)	KBAUD	ERROR	(decimal)
9.6	9.6	0	32	NA	-	-	9.727	+1.32	22	8.928	-6.99	6	NA	-	-
19.2	18.645	-2.94	16	1.202	+0.17	207	18.643	-2.90	11	20.833	+8.51	2	NA	-	-
38.4	39.6	+3.12	7	2.403	+0.13	103	37.286	-2.90	5	31.25	-18.61	1	NA	-	-
57.6	52.8	-8.33	5	9.615	+0.16	25	55.930	-2.90	3	62.5	+8.51	0	NA	-	-
115.2	105.6	-8.33	2	19.231	+0.16	12	111.860	-2.90	1	NA	-	-	NA	-	-
250	NA	-	-	NA	-	-	223.721	-10.51	0	NA	-	-	NA	-	-
625	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-
1250	NA	-	-	NA	-	-	NA	-	-	NA	-	-	NA	-	-

Note: For the PIC16C63/R63/656A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

12.1.1 SAMPLING

The data on the RC7/RX/DT pin is sampled three times by a majority detect circuit to determine if a high or a low level is present at the RX pin. If bit BRGH (TXSTA<2>) is clear (i.e., at the low baud rates), the sampling is done on the seventh, eighth and ninth falling edges of a x16 clock (Figure 12-3). If bit BRGH is

set (i.e., at the high baud rates), the sampling is done on the 3 clock edges preceding the second rising edge after the first falling edge of a x4 clock (Figure 12-4 and Figure 12-5).

FIGURE 12-3: RX PIN SAMPLING SCHEME (BRGH = 0) PIC16C63/R63/65/65A/R65)

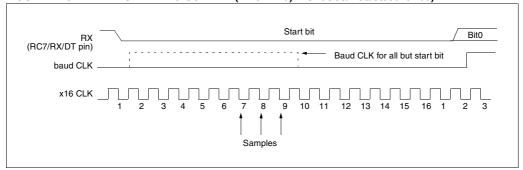


FIGURE 12-4: RX PIN SAMPLING SCHEME (BRGH = 1) (PIC16C63/R63/65/65A/R65)

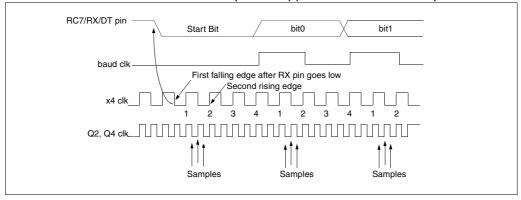
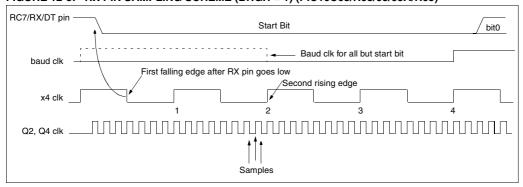
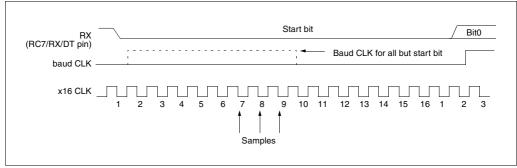


FIGURE 12-5: RX PIN SAMPLING SCHEME (BRGH = 1) (PIC16C63/R63/65/65A/R65)







12.2 USART Asynchronous Mode

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

In this mode, the USART uses standard nonreturn-to-zero (NRZ) format (one start bit, eight or nine data bits and one stop bit). The most common data format is 8-bits. An on-chip dedicated 8-bit baud rate generator can be used to derive standard baud rate frequencies from the oscillator. The USART transmits and receives the LSb first. The USART's transmitter and receiver are functionally independent but use the same data format and baud rate. The baud rate generator produces a clock either x16 or x64 of the bit shift rate, depending on bit BRGH (TXSTA<2>). Parity is not supported by the hardware, but can be implemented in software (and stored as the ninth data bit). Asynchronous mode is stopped during SLEEP.

Asynchronous mode is selected by clearing bit SYNC (TXSTA<4>).

The USART Asynchronous module consists of the following important elements:

- Baud Rate Generator
- · Sampling Circuit
- · Asynchronous Transmitter
- · Asynchronous Receiver

12.2.1 USART ASYNCHRONOUS TRANSMITTER

The USART transmitter block diagram is shown in Figure 12-7. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer, TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the STOP bit has been transmitted from the previous load. As soon as the STOP bit is transmitted, the TSR is loaded with new data from the TXREG (if available). Once the TXREG register transfers the data to the TSR register (occurs in one Tcy) the TXREG register is empty and flag bit TXIF (PIR1<4>) is set. This interrupt is enabled/dis-

abled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set regardless of the state of enable bit TXIE and cannot be cleared in software. It will reset only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit, TRMT (TXSTA<1>) shows the status of the TSR register. Status bit TRMT is a read only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty.

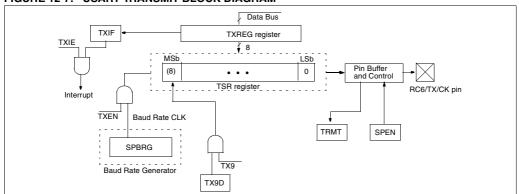
Note 1: The TSR register is not mapped in data memory so it is not available to the user.

Note 2: Flag bit TXIF is set when enable bit TXEN is set.

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data and the baud rate generator (BRG) has produced a shift clock (Figure 12-7). The transmission can also be started by first loading the TXREG register and then setting enable bit TXEN. Normally when transmission is first started, the TSR register is empty, so a transfer to the TXREG register will result in an immediate transfer to TSR register resulting in an empty TXREG register. A back-to-back transfer is thus possible (Figure 12-9). Clearing enable bit TXEN during a transmission will cause the transmission to be aborted and will reset the transmitter. As a result the RC6/TX/CK pin will revert to hi-impedance.

In order to select 9-bit transmission, transmit bit TX9 (TXSTA<6>) should be set and the ninth bit should be written to bit TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG register can result in an immediate transfer of the data to the TSR register (if the TSR is empty). In such a case, an incorrect ninth data bit maybe loaded in the TSR register.

FIGURE 12-7: USART TRANSMIT BLOCK DIAGRAM



Steps to follow when setting up an Asynchronous Transmission:

- Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, then set bit BRGH. (Section 12.1).
- Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- If interrupts are desired, then set enable bit TXIE.
- If 9-bit transmission is desired, then set transmit bit TX9.

- Enable the transmission by setting bit TXEN, which will also set bit TXIF.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Load data to the TXREG register (starts transmission).

FIGURE 12-8: ASYNCHRONOUS MASTER TRANSMISSION

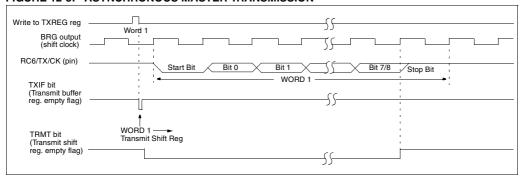


FIGURE 12-9: ASYNCHRONOUS MASTER TRANSMISSION (BACK TO BACK)

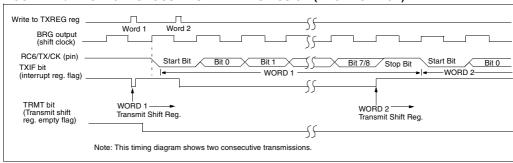


TABLE 12-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	-	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	ansmit R	egister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC		BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Genera	tor Registe	er					0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Transmission.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

12.2.2 USART ASYNCHRONOUS RECEIVER

The receiver block diagram is shown in Figure 12-10. The data comes in the RC7/RX/DT pin and drives the data recovery block. The data recovery block is actually a high speed shifter operating at x16 times the baud rate, whereas the main receive serial shifter operates at the bit rate or at Fosc.

Once Asynchronous mode is selected, reception is enabled by setting bit CREN (RCSTA<4>).

The heart of the receiver is the receive (serial) shift register (RSR). After sampling the STOP bit, the received data in the RSR is transferred to the RCREG register (if it is empty). If the transfer is complete, flag bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit which is cleared by the hardware. It is cleared when the RCREG register has been read and is empty. The RCREG is double buffered register, i.e., it is a two deep FIFO. It is

possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte begin shifting to the RSR register. On the detection of the STOP bit of the third byte, if the RCREG is still full, then the overrun error bit, OERR (RCSTA<1>) will be set. The word in the RSR register will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun bit OERR has to be cleared in software. This is done by resetting the receive logic (CREN is cleared and then set). If bit OERR is set, transfers from the RSR register to the RCREG register are inhibited, so it is essential to clear overrun bit OERR if it is set. Framing error bit FERR (RCSTA<2>) is set if a stop bit is detected as clear. Error bit FERR and the 9th receive bit are buffered the same way as the receive data. Reading the RCREG register will load bits RX9D and FERR with new values. Therefore it is essential for the user to read the RCSTA register before reading RCREG in order not to lose the old FERR and RX9D information.

FIGURE 12-10: USART RECEIVE BLOCK DIAGRAM

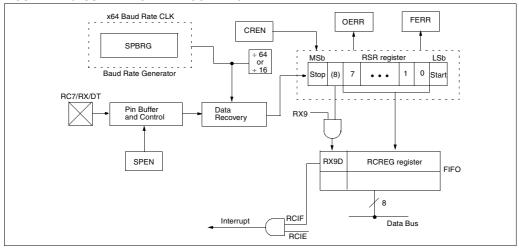
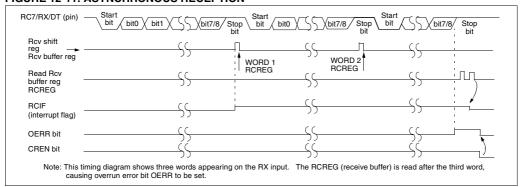


FIGURE 12-11: ASYNCHRONOUS RECEPTION



Steps to follow when setting up an Asynchronous Reception:

- Initialize the SPBRG register for the appropriate baud rate. If a high speed baud rate is desired, set bit BRGH (Section 12.1).
- 2. Enable the asynchronous serial port by clearing bit SYNC and setting bit SPEN.
- If interrupts are desired, then set enable bit RCIE.
- 4. If 9-bit reception is desired, then set bit RX9.
- Enable the reception by setting enable bit CREN.

- Flag bit RCIF will be set when reception is complete, and an interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing enable bit CREN.

TABLE 12-7: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value o POR, BOR	n	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 00	00	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -0	0x	0000 -00x
1Ah	RCREG	USART R	eceive Re	egister						0000 00	00	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 00	00	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -0	10	0000 -010
99h	SPBRG	Baud Rate	Genera	tor Registe	er					0000 00	00	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Asynchronous Reception.

Note 1: PSPIE and PSPIF are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIE1<6> and PIR1<6> are reserved, always maintain these bits clear.

12.3 <u>USART Synchronous Master Mode</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

In Synchronous Master mode the data is transmitted in a half-duplex manner i.e., transmission and reception do not occur at the same time. When transmitting data the reception is inhibited and vice versa. Synchronous mode is entered by setting bit SYNC (TXSTA<4>). In addition enable bit SPEN (RCSTA<7>) is set in order to configure the RC6 and RC7 I/O pins to CK (clock) and DT (data) lines respectively. The Master mode indicates that the processor transmits the master clock on the CK line. The Master mode is entered by setting bit CSRC (TXSTA<7>).

12.3.1 USART SYNCHRONOUS MASTER TRANSMISSION

The USART transmitter block diagram is shown in Figure 12-7. The heart of the transmitter is the transmit (serial) shift register (TSR). The shift register obtains its data from the read/write transmit buffer register, TXREG. The TXREG register is loaded with data in software. The TSR register is not loaded until the last bit has been transmitted from the previous load. As soon as the last bit is transmitted, the TSR register is loaded with new data from the TXREG register (if available). Once the TXREG register transfers the data to the TSR register (occurs in one Tcycle), the TXREG register is empty and interrupt flag bit TXIF (PIR1<4>) is set. This interrupt can be enabled/disabled by setting/clearing enable bit TXIE (PIE1<4>). Flag bit TXIF will be set regardless of the status of enable bit TXIE and cannot be cleared in software. It will clear only when new data is loaded into the TXREG register. While flag bit TXIF indicates the status of the TXREG register, another bit, TRMT (TXSTA<1>), shows the status of the TSR register. Status bit TRMT is a read only bit which is set when the TSR register is empty. No interrupt logic is tied to this bit, so the user has to poll this bit in order to determine if the TSR register is empty. The TSR register is not mapped in data memory so it is not available to the user.

Transmission is enabled by setting enable bit TXEN (TXSTA<5>). The actual transmission will not occur until the TXREG register has been loaded with data. The first data bit will be shifted out on the next available rising edge of the clock on the CK line. Data out is stable around the falling edge of the synchronous clock (Figure 12-12). The transmission can also be started by first loading the TXREG register and then setting enable bit TXEN (Figure 12-13). This is advantageous when slow baud rates are selected, since the BRG is kept in reset when bits TXEN, CREN, and SREN are clear. Setting enable bit TXEN will start the BRG, creating a shift clock immediately. Normally when transmission is first started, the TSR register is empty, so a transfer to the TXREG register will result in an immediate transfer to TSR resulting in an empty TXREG register. Back-to-back transfers are possible.

Clearing enable bit TXEN, during a transmission, will cause the transmission to be aborted and will reset the transmitter. The DT and CK pins will revert to hi-impedance. If, during a transmission, either bit CREN or bit SREN is set the transmission is aborted and the DT pin reverts to a hi-impedance state (for a reception). The CK pin will remain an output if bit CSRC is set (internal clock). The transmitter logic however, is not reset although it is disconnected from the pins. In order to reset the transmitter, the user has to clear enable bit TXEN. If enable bit SREN is set (to interrupt an on going transmission and receive a single word), then after the single word is received, enable bit SREN will be cleared, and the serial port will revert back to transmitting since enable bit TXEN is still set. The DT line will immediately switch from hi-impedance receive mode to transmit and start driving. To avoid this, enable bit TXEN should be cleared.

In order to select 9-bit transmission, bit TX9 (TXSTA<6>) should be set and the ninth bit should be written to bit TX9D (TXSTA<0>). The ninth bit must be written before writing the 8-bit data to the TXREG register. This is because a data write to the TXREG register can result in an immediate transfer of the data to the TSR register (if the TSR is empty). If the TSR register was empty and the TXREG register was written before writing the "new" TX9D, the "present" value of bit TX9D is loaded.

Steps to follow when setting up a Synchronous Master Transmission:

- Initialize the SPBRG register for the appropriate baud rate (Section 12.1).
- Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set bit TX9.
- Enable the transmission by setting enable bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREG register.

TABLE 12-8: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	ansmit Re	egister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Regist	ter	•				0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Master Transmission.

Note 1: PSPIE and PSPIF are reserved on the PIC16C63/R63/66, always maintain these bits clear.

2: PIE1<6> and PIR1<6> are reserved, always maintain these bits clear.

FIGURE 12-12: SYNCHRONOUS TRANSMISSION

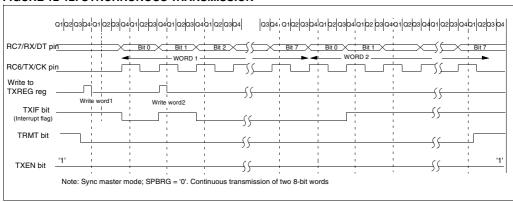
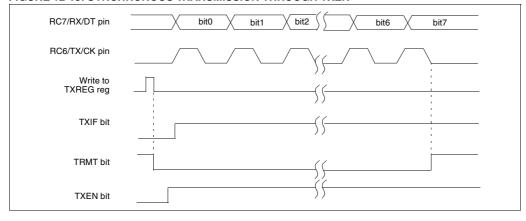


FIGURE 12-13: SYNCHRONOUS TRANSMISSION THROUGH TXEN



12.3.2 USART SYNCHRONOUS MASTER RECEPTION

Once Synchronous Mode is selected, reception is enabled by setting either enable bit SREN (RCSTA<5>) bit or enable bit CREN (RCSTA<4>). Data is sampled on the DT pin on the falling edge of the clock. If enable bit SREN is set, then only a single word is received. If enable bit CREN is set, the reception is continuous until bit CREN is cleared. If both the bits are set then bit CREN takes precedence. After clocking the last bit, the received data in the Receive Shift Register (RSR) is transferred to the RCREG register (if it is empty). When the transfer is complete, interrupt bit RCIF (PIR1<5>) is set. The actual interrupt can be enabled/disabled by setting/clearing enable bit RCIE (PIE1<5>). Flag bit RCIF is a read only bit which is reset by the hardware. In this case, it is reset when the RCREG register has been read and is empty. The RCREG is a double buffered register, i.e., it is a two deep FIFO. It is possible for two bytes of data to be received and transferred to the RCREG FIFO and a third byte to begin shifting into the RSR register. On the clocking of the last bit of the third byte, if the RCREG register is still full, then overrun error bit, OERR (RCSTA<1>) is set. The word in the RSR register will be lost. The RCREG register can be read twice to retrieve the two bytes in the FIFO. Overrun error bit OERR has to be cleared in software (by clearing bit CREN). If bit OERR is set, transfers from the RSR to the RCREG are inhibited, so it is essential to clear bit OERR if it is set. The 9th receive bit is buffered the same way as the receive data. Reading the RCREG register will load bit RX9D with a new value. Therefore it is essential for the user to read the RCSTA register before reading the RCREG register in order not to lose the old RX9D bit information.

Steps to follow when setting up Synchronous Master Reception:

- Initialize the SPBRG register for the appropriate baud rate (Section 12.1).
- Enable the synchronous master serial port by setting bits SYNC, SPEN, and CSRC.
- Ensure bits CREN and SREN are clear.
- 4. If interrupts are desired, then set enable bit BCIF
- 5. If 9-bit reception is desired, then set bit RX9.
- If a single reception is required, set enable bit SREN. For continuous reception set enable bit CREN.
- Flag bit RCIF will be set when reception is complete and an interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing enable bit CREN.

TABLE 12-9: REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION

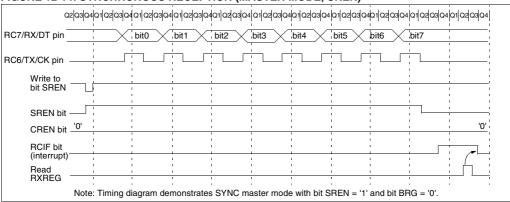
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
1Ah	RCREG	USART Re	ceive Re	gister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Regist	ter					0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Master Reception.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

^{2:} PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

FIGURE 12-14: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)



12.4 <u>USART Synchronous Slave Mode</u>

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Synchronous Slave Mode differs from Master Mode in the fact that the shift clock is supplied externally at the CK pin (instead of being supplied internally in master mode). This allows the device to transfer or receive data while in SLEEP mode. Slave mode is entered by clearing bit CSRC (TXSTA<7>).

12.4.1 USART SYNCHRONOUS SLAVE TRANSMIT

The operation of the synchronous master and slave modes are identical except in the case of the SLEEP mode

If two words are written to the TXREG and then the SLEEP instruction is executed, the following will occur:

- The first word will immediately transfer to the TSR register and transmit.
- b) The second word will remain in TXREG register.
- c) Flag bit TXIF will not be set.
- d) When the first word has been shifted out of TSR, the TXREG register will transfer the second word to the TSR and flag bit TXIF will now be set
- If enable bit TXIE is set, the interrupt will wake the chip from SLEEP and if the global interrupt is enabled, the program will branch to the interrupt vector (0004h).

Steps to follow when setting up Synchronous Slave Transmission:

- Enable the synchronous slave serial port by setting bits SYNC and SPEN, and clearing bit CSRC.
- 2. Clear bits CREN and SREN.
- If interrupts are desired, then set enable bit TXIE.
- 4. If 9-bit transmission is desired, then set bit TX9.
- 5. Enable the transmission by setting bit TXEN.
- If 9-bit transmission is selected, the ninth bit should be loaded in bit TX9D.
- Start transmission by loading data to the TXREG register.

12.4.2 USART SYNCHRONOUS SLAVE RECEPTION

The operation of the synchronous master and slave modes is identical except in the case of the SLEEP mode. Also, enable bit SREN is a don't care in slave mode.

If receive is enabled by setting bit CREN prior to the SLEEP instruction, then a word may be received during SLEEP. On completely receiving the word, the RSR register will transfer the data to the RCREG register and if enable bit RCIE is set, the interrupt generated will wake the chip from SLEEP. If the global interrupt is enabled, the program will branch to the interrupt vector (0004h).

Steps to follow when setting up a Synchronous Slave Reception:

- Enable the synchronous master serial port by setting bits SYNC and SPEN, and clearing bit CSRC.
- If interrupts are desired, then set enable bit RCIE.
- 3. If 9-bit reception is desired, then set bit RX9.
- 4. To enable reception, set enable bit CREN.
- Flag bit RCIF will be set when reception is complete, and an interrupt will be generated if enable bit RCIE was set.
- Read the RCSTA register to get the ninth bit (if enabled) and determine if any error occurred during reception.
- Read the 8-bit received data by reading the RCREG register.
- If any error occurred, clear the error by clearing enable bit CREN.

TABLE 12-10: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
19h	TXREG	USART Tra	ansmit R	egister	,	•		•		0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Registe	er		•	•		0000 0000	0000 0000

Legend: x = unknown, x =

TABLE 12-11: REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
0Ch	PIR1	PSPIF ⁽¹⁾	(2)	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	_	FERR	OERR	RX9D	0000 -00x	0000 -00x
1Ah	RCREG	USART Re	eceive Re	gister	•					0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	(2)	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	_	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generat	or Regist	er					0000 0000	0000 0000

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for Synchronous Slave Reception.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

^{2:} PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

Note 1: PSPIF and PSPIE are reserved on the PIC16C63/R63/66, always maintain these bits clear.

^{2:} PIR1<6> and PIE1<6> are reserved, always maintain these bits clear.

PIC16C6X

NOTES:

13.0 SPECIAL FEATURES OF THE CPU

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC16CXX family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- · Oscillator selection
- Reset
 - Power-on Reset (POR)
- Power-up Timer (PWRT)
- Oscillator Start-up Timer (OST)
- Brown-out Reset (BOR)
- · Interrupts
- · Watchdog Timer (WDT)
- SLEEP mode
- · Code protection
- · ID locations
- · In-circuit serial programming

The PIC16CXX has a Watchdog Timer which can be shut off only through configuration bits. It runs off its own RC oscillator for added reliability. There are two

timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep the chip in RESET until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in reset while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

SLEEP mode is designed to offer a very low current power-down mode. The user can wake from SLEEP through external reset, Watchdog Timer Wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

13.1 Configuration Bits

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h - 3FFFh), which can be accessed only during programming.

FIGURE 13-1: CONFIGURATION WORD FOR PIC16C61

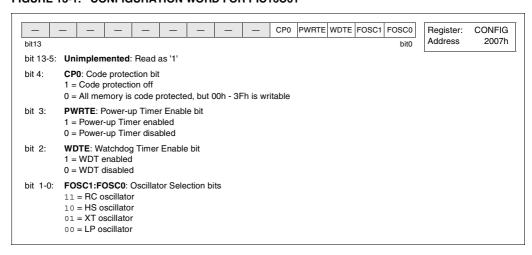


FIGURE 13-2: CONFIGURATION WORD FOR PIC16C62/64/65

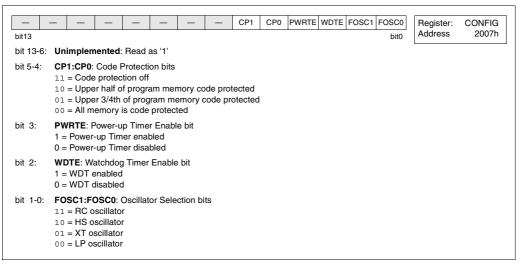
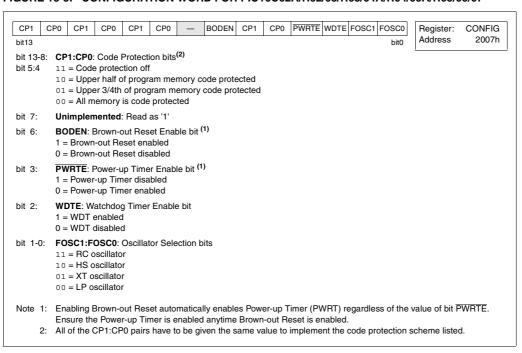


FIGURE 13-3: CONFIGURATION WORD FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67



13.2 Oscillator Configurations

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

13.2.1 OSCILLATOR TYPES

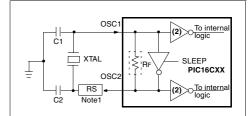
The PIC16CXX can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power CrystalXT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

13.2.2 CRYSTAL OSCILLATOR/CERAMIC RESONATORS

In LP, XT, or HS modes a crystal or ceramic resonator is connected to the OSC1/CLKIN and OSC2/CLKOUT pins to establish oscillation (Figure 13-4). The PIC16CXX oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in LP, XT, or HS modes, the device can have an external clock source to drive the OSC1/CLKIN pin (Figure 13-5).

FIGURE 13-4: CRYSTAL/CERAMIC RESONATOR OPERATION (HS, XT OR LP OSC CONFIGURATION)



See Table 13-1, Table 13-3, Table 13-2 and Table 13-4 for recommended values of C1 and C2.

- Note 1: A series resistor may be required for AT strip cut crystals.
 - For the PIC16C61 the buffer is on the OSC2 pin, all other devices have the buffer on the OSC1 pin.

FIGURE 13-5: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)

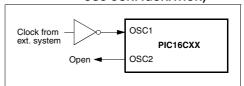


TABLE 13-1: CERAMIC RESONATORS PIC16C61

Ranges Tested:									
Mode	Freq	OSC1	OSC2						
XT	455 kHz	47 - 100 pF	47 - 100 pF						
	2.0 MHz 4.0 MHz	15 - 68 pF 15 - 68 pF	15 - 68 pF 15 - 68 pF						
HS 8.0 MHz 15 - 68 pF 15 - 68 pF									
	16.0 MHz	10 - 47 pF	10 - 47 pF						
	se values are for s at bottom of pa		nce only. See						
Resonator	s Used:								
455 kHz	Panasonic EF	O-A455K04B	± 0.3%						
2.0 MHz	Murata Erie CS	SA2.00MG	± 0.5%						
4.0 MHz Murata Erie CSA4.00MG ± 0.5%									
8.0 MHz	Murata Erie CS	SA8.00MT	± 0.5%						
16.0 MHz	Murata Erie CS	SA16.00MX	± 0.5%						
All resonators used did not have built-in capacitors.									

TABLE 13-2: CERAMIC RESONATORS PIC16C62/62A/R62/63/R63/64/ 64A/R64/65/65A/R65/66/67

Ranges Tested:									
Mode	Freq	OSC1	OSC2						
XT	455 kHz 2.0 MHz 4.0 MHz	68 - 100 pF 15 - 68 pF 15 - 68 pF	68 - 100 pF 15 - 68 pF 15 - 68 pF						
HS	8.0 MHz 16.0 MHz	10 - 68 pF 10 - 22 pF	10 - 68 pF 10 - 22 pF						
	se values are t es at bottom of p	for design guidar page.	nce only. See						
Resonator	rs Used:								
455 kHz	Panasonic E	FO-A455K04B	± 0.3%						
2.0 MHz	Murata Erie	CSA2.00MG	± 0.5%						
4.0 MHz Murata Erie CSA4.00MG ± 0.5%									
8.0 MHz Murata Erie CSA8.00MT ± 0.5%									
16.0 MHz	Murata Erie	CSA16.00MX	± 0.5%						
All resonators used did not have built-in capacitors.									

TABLE 13-3: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR FOR PIC16C61

Mode	Freq	OSC1	OSC2
LP	32 kHz	33 - 68 pF	33 - 68 pF
	200 kHz	15 - 47 pF	15 - 47 pF
XT	100 kHz	47 - 100 pF	47 - 100 pF
	500 kHz	20 - 68 pF	20 - 68 pF
	1 MHz	15 - 68 pF	15 - 68 pF
	2 MHz	15 - 47 pF	15 - 47 pF
	4 MHz	15 - 33 pF	15 - 33 pF
HS	8 MHz	15 - 47 pF	15 - 47 pF
	20 MHz	15 - 47 pF	15 - 47 pF
Th	ese values ar	e for design guid	lance only. See

notes at bottom of page.

TABLE 13-4: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR FOR PIC16C62/62A/R62/63/R63/64/64A/R64/65/65A/R65/66/67

	04A/1104/00/00A/1100/00/01									
Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2							
LP	32 kHz	33 pF	33 pF							
	200 kHz	15 pF	15 pF							
XT	200 kHz	47-68 pF	47-68 pF							
	1 MHz	15 pF	15 pF							
	4 MHz	15 pF	15 pF							
HS	4 MHz	15 pF	15 pF							
	8 MHz	15-33 pF	15-33 pF							
	20 MHz	15-33 pF	15-33 pF							
	e values are at bottom of	for design guidanc page.	e only. See							
	Crys	tals Used								
32 kHz	Epson C-00	01R32.768K-A	± 20 PPM							
200 kHz	STD XTL 2	00.000KHz	± 20 PPM							
1 MHz	ECS ECS-1	10-13-1	± 50 PPM							
4 MHz	ECS ECS-4	10-20-1	± 50 PPM							

EPSON CA-301 8.000M-C

EPSON CA-301 20.000M-C

± 30 PPM

± 30 PPM

- Note 1: Recommended values of C1 and C2 are identical to the ranges tested Table 13-1 and Table 13-2.
 - 2: Higher capacitance increases the stability of oscillator but also increases the start-up time.
 - 3: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components.

8 MHz

20 MHz

4: Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification.

13.2.3 EXTERNAL CRYSTAL OSCILLATOR CIRCUIT

Either a prepackaged oscillator can be used or a simple oscillator circuit with TTL gates can be built. Prepackaged oscillators provide a wide operating range and better stability. A well-designed crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used; one with series resonance, or one with parallel resonance.

Figure 13-6 shows implementation of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 $k\Omega$ resistor provides the negative feedback for stability. The 10 $k\Omega$ potentiometer biases the 74AS04 in the linear region. This could be used for external oscillator designs.

FIGURE 13-6: EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT

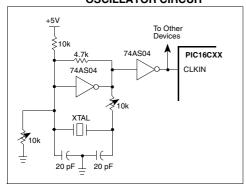
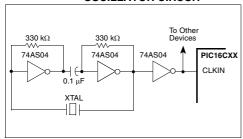


Figure 13-7 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.

FIGURE 13-7: EXTERNAL SERIES
RESONANT CRYSTAL
OSCILLATOR CIRCUIT



13.2.4 RC OSCILLATOR

For timing insensitive applications the RC device option offers additional cost savings. The RC oscillator frequency is a function of the supply voltage, the resistor (Rext) and capacitor (Cext) values, and the operating temperature. In addition to this, the oscillator frequency will vary from unit to unit due to normal process parameter variation. Furthermore, the difference in lead frame capacitance between package types will also affect the oscillation frequency, especially for low Cext values. The user also needs to take into account variation due to tolerance of external R and C components used. Figure 13-8 shows how the RC combination is connected to the PIC16CXX. For Rext values below $2.2 \text{ k}\Omega$, the oscillator operation may become unstable or stop completely. For very high Rext values (e.g. 1 M Ω), the oscillator becomes sensitive to noise, humidity and leakage. Thus, we recommend keeping Rext between 3 k Ω and 100 k Ω .

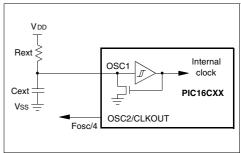
Although the oscillator will operate with no external capacitor (Cext = 0 pF), we recommend using values above 20 pF for noise and stability reasons. With no or small external capacitance, the oscillation frequency can vary dramatically due to changes in external capacitances, such as PCB trace capacitance or package lead frame capacitance.

See characterization data for desired device for RC frequency variation from part to part due to normal process variation. The variation is larger for larger R (since leakage current variation will affect RC frequency more for large R) and for smaller C (since variation of input capacitance will affect RC frequency more).

See characterization data for desired device for variation of oscillator frequency due to VDD for given Rext/ Cext values as well as frequency variation due to operating temperature for given R, C, and VDD values.

The oscillator frequency, divided by 4, is available on the OSC2/CLKOUT pin, and can be used for test purposes or to synchronize other logic (see Figure 3-5 for waveform).

FIGURE 13-8: RC OSCILLATOR MODE



PIC16C6X

13.3 Reset

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The PIC16CXX differentiates between various kinds of reset:

- · Power-on Reset (POR)
- MCLR reset during normal operation
- MCLR reset during SLEEP
- WDT Reset (normal operation)
- Brown-out Reset (BOR) Not on PIC16C61/62/ 64/65

Some registers are not affected in any reset condition, their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a "reset state" on Power-on Reset (POR), on MCLR or WDT Reset, on MCLR reset during SLEEP, and on Brownout Reset (BOR). They are not affected by a WDT Wake-up, which is viewed as the resumption of normal operation.

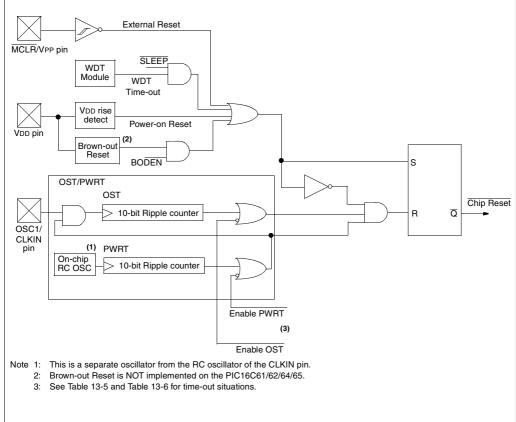
The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different reset situations as indicated in Table 13-7, Table 13-8, and Table 13-9. These bits are used in software to determine the nature of the reset. See Table 13-12 for a full description of reset states of all registers.

A simplified block diagram of the on-chip reset circuit is shown in Figure 13-9.

On the PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67, the MCLR reset path has a noise filter to detect and ignore small pulses. See parameter #34 for pulse width specifications.

It should be noted that a WDT Reset does not drive the MCLR pin low.

FIGURE 13-9: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



13.4 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Reset (BOR)

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

13.4.1 POWER-ON RESET (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.5V - 2.1V). To take advantage of the POR, just tie the MCLR/VPP pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, ...) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met. Brown-out Reset may be used to meet the startup conditions.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting."

13.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms nominal time-out on power-up only, from POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as PWRT is active. The PWRT's time delay allows VDD to rise to an acceptable level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip to chip due to VDD, temperature, and process variation. See DC parameters for details.

13.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures the crystal oscillator or resonator has started and stabilized.

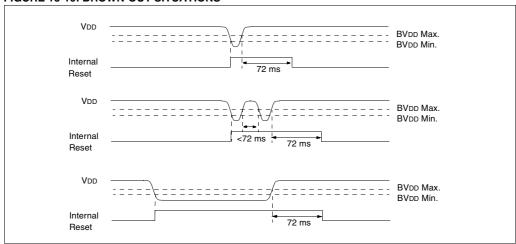
The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

13.4.4 BROWN-OUT RESET (BOR)

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

A configuration bit, BODEN, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V (parameter D005 in Electrical Specification section) for greater than parameter #34 (see Electrical Specification section), the brown-out situation will reset the chip. A reset may not occur if VDD falls below 4.0V for less than parameter #34. The chip will remain in Brown-out Reset until VDD rises above BVDD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms. If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be initialized. Once VDD rises above BVDD, the Power-up Timer will execute a 72 ms time delay. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 13-10 shows typical brown-out situations.

FIGURE 13-10: BROWN-OUT SITUATIONS



13.4.5 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First a PWRT time-out is invoked after the POR time delay has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode, with the PWRT disabled, there will be no time-out at all. Figure 13-11, Figure 13-12, and Figure 13-13 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if the MCLR/VPP pin is kept low long enough, the time-outs will expire. Then bringing the MCLR/VPP pin high will begin execution immediately (Figure 13-14). This is useful for testing purposes or to synchronize more than one PIC16CXX device operating in parallel.

Table 13-10 and Table 13-11 show the reset conditions for some special function registers, while Table 13-12 shows the reset conditions for all the registers.

13.4.6 POWER CONTROL/STATUS REGISTER (PCON)

Applicable Devices
61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Power Control/Status Register, PCON has up to two bits, depending upon the device. Bit0 is not implemented on the PIC16C62/64/65.

Bit0 is BOR (Brown-out Reset Status bit). BOR is unknown on Power-on Reset. It must then be set by the user and checked on subsequent resets to see if BOR cleared, indicating that a brown-out has occurred. The BOR status bit is a "Don't Care" and is not necessarily predictable if the Brown-out Reset circuitry is disabled (by clearing bit BODEN in the Configuration Word).

Bit1 is POR (Power-on Reset Status bit). It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

TABLE 13-5: TIME-OUT IN VARIOUS SITUATIONS, PIC16C61/62/64/65

Oscillator Configuration	Power	Wake-up from SLEEP	
	PWRTE = 1	PWRTE = 0	
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	1024 Tosc
RC	72 ms	_	_

TABLE 13-6: TIME-OUT IN VARIOUS SITUATIONS, PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

Oscillator Configuration	Power-	-up	Brown-out	Wake up from SLEEP	
Oscillator Configuration	PWRTE = 0	PWRTE = 1	Blowii-out		
XT, HS, LP	72 ms + 1024Tosc	1024Tosc	72 ms + 1024Tosc	1024 Tosc	
RC	72 ms	_	72 ms	_	

TABLE 13-7: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C61

TO	PD	
1	1	Power-on Reset or MCLR reset during normal operation
0	1	WDT Reset
0	0	WDT Wake-up
1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

TABLE 13-8: STATUS BITS AND THEIR SIGNIFICANCE, PIC16C62/64/65

POR	TO	PD	
0	1	1	Power-on Reset
0	0	х	Illegal, TO is set on a Power-on Reset
0	x	0	Illegal, PD is set on a Power-on Reset
1	0	1	WDT Reset
1	0	0	WDT Wake-up
1	u	u	MCLR reset during normal operation
1	1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

Legend: x = unknown, u = unchanged

TABLE 13-9: STATUS BITS AND THEIR SIGNIFICANCE FOR PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

POR	BOR	TO	PD	
0	x	1	1	Power-on Reset
0	x	0	x	Illegal, TO is set on a Power-on Reset
0	x	x	0	Illegal, PD is set on a Power-on Reset
1	0	x	x	Brown-out Reset
1	1	0	1	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	MCLR reset during normal operation
1	1	1	0	MCLR reset during SLEEP or interrupt wake-up from SLEEP

Legend: x = unknown, u = unchanged

TABLE 13-10: RESET CONDITION FOR SPECIAL REGISTERS ON PIC16C61/62/64/65

	Program Counter	STATUS	PCON ⁽²⁾
Power-on Reset	000h	0001 1xxx	0 -
MCLR reset during normal operation	000h	000u uuuu	u-
MCLR reset during SLEEP	000h	0001 0uuu	u-
WDT Reset	000h	0000 luuu	u-
WDT Wake-up	PC + 1	uuu0 0uuu	u-
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	u-

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

2: The PCON register is not implemented on the PIC16C61.

TABLE 13-11: RESET CONDITION FOR SPECIAL REGISTERS ON PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67

	Program Counter	STATUS	PCON
Power-on Reset	000h	0001 1xxx	0x
MCLR reset during normal operation	000h	000u uuuu	uu
MCLR reset during SLEEP	000h	0001 0uuu	uu
WDT Reset	000h	0000 luuu	uu
Brown-out Reset	000h	0001 1uuu	u0
WDT Wake-up	PC + 1	uuu0 0uuu	uu
Interrupt wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	uu

Legend: u = unchanged, x = unknown, - = unimplemented bit read as '0'.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

TABLE 13-12: INITIALIZATION CONDITIONS FOR ALL REGISTERS

Register		Applicable Devices													Power-on Re Brown-ou Reset		MCLR Reset during: – normal operation – SLEEP WDT Reset	Wake-up via interrupt or WDT Wake-up
W	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
INDF	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	N/A		N/A	N/A
TMR0	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
PCL	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000h		0000h	PC + 1 ⁽²⁾
STATUS	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0001 1xx	кx	000q quuu(3)	uuuq quuu(3)
FSR	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
DODTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	x xxx	кx	u uuuu	u uuuu
PORTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xx xxx	кx	uu uuuu	uu uuuu
PORTB	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
PORTC	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
PORTD	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
PORTE	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xx	кx	uuu	uuu
PCLATH	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0 000	0.0	0 0000	u uuuu
INTCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	ΣX	0000 000u	uuuu uuuu(1)
PIR1	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 000	0.0	00 0000	uu uuuu(1)
	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	0.0	0000 0000	uuuu uuuu(1)
PIR2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67		- 0	0	(2)
TMR1L	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
TMR1H	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кх	uuuu uuuu	uuuu uuuu
T1CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 000	0.0	uu uuuu	uu uuuu
TMR2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	0.0	0000 0000	uuuu uuuu
T2CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	-000 000	0.0	-000 0000	-uuu uuuu
SSPBUF	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кх	uuuu uuuu	uuuu uuuu
SSPCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	0.0	0000 0000	uuuu uuuu
CCPR1L	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
CCPR1H	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
CCP1CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 000	0.0	00 0000	uu uuuu
RCSTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 -00	хC	0000 -00x	uuuu -uuu
TXREG	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	0.0	0000 0000	uuuu uuuu
RCREG	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	0.0	0000 0000	uuuu uuuu
CCPR2L	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
CCPR2H	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	xxxx xxx	кx	uuuu uuuu	uuuu uuuu
CCP2CON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 000	0.0	0000 0000	uuuu uuuu
OPTION	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 111	11	1111 1111	uuuu uuuu
TRISA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1 111	11	1 1111	u uuuu
.1110/1	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	11 111	11	11 1111	uu uuuu
TRISB	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 111	11	1111 1111	uuuu uuuu
TRISC	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 111	11	1111 1111	uuuu uuuu

Legend: u = unchanged, x = unknown, -= unimplemented bit read as '0', <math>q = value depends on condition.

Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

^{2:} When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

^{3:} See Table 13-10 and Table 13-11 for reset value for specific conditions.

TABLE 13-12: INITIALIZATION CONDITIONS FOR ALL REGISTERS (Cont.'d)

Register		Applicable Devices													Power-on Reset Brown-out Reset	MCLR Reset during: - normal operation - SLEEP WDT Reset	Wake-up via interrupt or WDT Wake-up
TRISD	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 1111	1111 1111	uuuu uuuu
TRISE	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 -111	0000 -111	uuuu -uuu
PIE1	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0000	00 0000	uu uuuu
	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
PIE2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0	0	u
PCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0u	uu	uu
FCON	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0-	u-	u-
PR2	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	1111 1111	1111 1111	1111 1111
SSPADD	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu
SSPSTAT	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	00 0000	00 0000	uu uuuu
TXSTA	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 -010	0000 -010	uuuu -uuu
SPBRG	61	62	62A	R62	63	R63	64	64A	R64	65	65A	R65	66	67	0000 0000	0000 0000	uuuu uuuu

 $[\]label{eq:local_$

Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

^{2:} When the wake-up is due to an interrupt and the global enable bit, GIE is set, the PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

^{3:} See Table 13-10 and Table 13-11 for reset value for specific conditions.

FIGURE 13-11: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 1

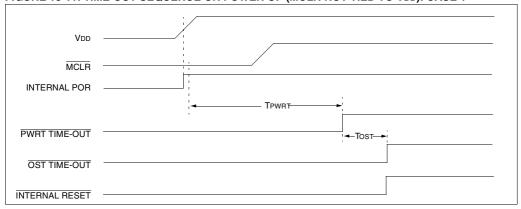


FIGURE 13-12: TIME-OUT SEQUENCE ON POWER-UP (MCLR NOT TIED TO VDD): CASE 2

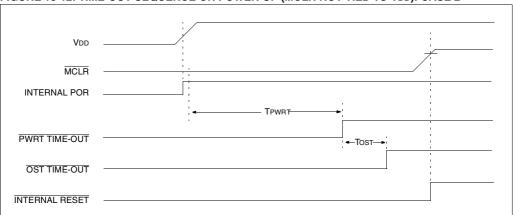


FIGURE 13-13: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD)

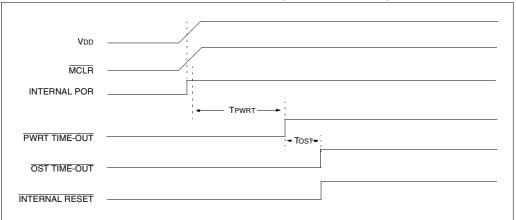
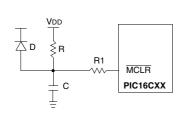
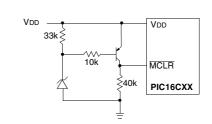


FIGURE 13-14: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



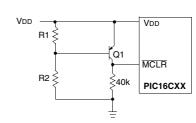
- Note 1: External Power-on Reset circuit is required only if VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.
 - 2: $R < 40 \text{ k}\Omega$ is recommended to make sure that voltage drop across R does not violate the devices electrical specifications.
 - R1 = 100Ω to 1 kΩ will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrostatic Overstress (EOS).

FIGURE 13-15: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



- Note 1: This circuit will activate reset when VDD goes below (Vz + 0.7V) where Vz = Zener voltage.
 - 2: Internal brown-out detection on the PIC16C62A/R62/63/R63/64A/R64/65A/ R65/66/67 should be disabled when using this circuit.
 - 3: Resistors should be adjusted for the characteristics of the transistors.

FIGURE 13-16: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



Note 1: This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \bullet \frac{R1}{R1 + R2} = 0.7V$$

- Internal brown-out detection on the PIC16C62A/R62/63/R63/64A/R64/65A/ R65/66/67 should be disabled when using this circuit.
- 3: Resistors should be adjusted for the characteristics of the transistors.

13.5 Interrupts

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The PIC16C6X family has up to 11 sources of interrupt. The interrupt control register (INTCON) records individual interrupt requests in flag bits. It also has individual and global interrupt enable bits.

Note: Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or global enable bit, GIE.

Global interrupt enable bit, GIE (INTCON<7>) enables (if set) all un-masked interrupts or disables (if cleared) all interrupts. When bit GIE is enabled, and an interrupt flag bit and mask bit are set, the interrupt will vector immediately. Individual interrupts can be disabled through their corresponding enable bits in the INTCON register. GIE is cleared on reset.

The "return from interrupt" instruction, RETFIE, exits the interrupt routine as well as sets the GIE bit, which re-enable interrupts.

The RB0/INT pin interrupt, the RB port change interrupt and the TMR0 overflow interrupt flag bits are contained in the INTCON register.

The peripheral interrupt flag bits are contained in special function registers PIR1 and PIR2. The corresponding interrupt enable bits are contained in special function registers PIE1 and PIE2 and the peripheral interrupt enable bit is contained in special function register INTCON.

When an interrupt is responded to, bit GIE is cleared to disable any further interrupts, the return address is pushed onto the stack and the PC is loaded with 0004h. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to avoid recursive interrupts.

For external interrupt events, such as the RB0/INT pin or RB port change interrupt, the interrupt latency will be three or four instruction cycles. The exact latency depends when the interrupt event occurs (Figure 13-19). The latency is the same for one or two cycle instructions. Once in the interrupt service routine the source(s) of the interrupt can be determined by polling the interrupt flag bits. The interrupt flag bit(s) must be cleared in software before re-enabling interrupts to

avoid infinite interrupt requests. Individual interrupt flag bits are set regardless of the status of their corresponding mask bit or the GIE bit.

Note:

For the PIC16C61/62/64/65, if an interrupt occurs while the Global Interrupt Enable bit, GIE is being cleared, bit GIE may unintentionally be re-enabled by the user's Interrupt Service Routine (the RETFIE instruction). The events that would cause this to occur are:

- An instruction clears the GIE bit while an interrupt is acknowledged
- The program branches to the Interrupt vector and executes the Interrupt Service Routine.
- The Interrupt Service Routine completes with the execution of the RET-FIE instruction. This causes the GIE bit to be set (enables interrupts), and the program returns to the instruction after the one which was meant to disable interrupts.
- 4. Perform the following to ensure that interrupts are globally disabled.

```
LOOP BCF INTCON,GIE ;Disable Global ;Interrupt bit
BTFSC INTCON,GIE ;Global Interrupt ;Disabled?
GOTO LOOP ;NO, try again ;Yes, continue ;with program flow
```

FIGURE 13-17: INTERRUPT LOGIC FOR PIC16C61

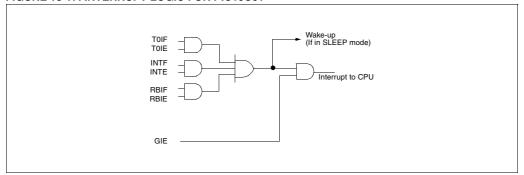
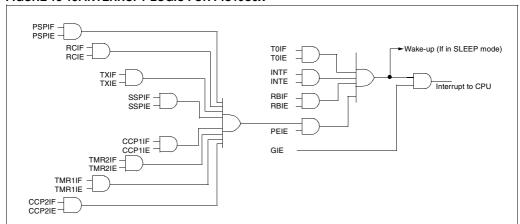


FIGURE 13-18: INTERRUPT LOGIC FOR PIC16C6X



The following table shows which devices have which interrupts.

Device	TOIF	INTF	RBIF	PSPIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	CCP2IF
PIC16C62	Yes	Yes	Yes		-	-	Yes	Yes	Yes	Yes	-
PIC16C62A	Yes	Yes	Yes	-	-	-	Yes	Yes	Yes	Yes	-
PIC16CR62	Yes	Yes	Yes	-	-	-	Yes	Yes	Yes	Yes	-
PIC16C63	Yes	Yes	Yes	-	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16CR63	Yes	Yes	Yes	-	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C64	Yes	Yes	Yes	Yes	-	-	Yes	Yes	Yes	Yes	-
PIC16C64A	Yes	Yes	Yes	Yes	-	-	Yes	Yes	Yes	Yes	-
PIC16C64	Yes	Yes	Yes	Yes	-	-	Yes	Yes	Yes	Yes	-
PIC16C65	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C65A	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16CR65	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C66	Yes	Yes	Yes		Yes	Yes	Yes	Yes	Yes	Yes	Yes
PIC16C67	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes

13.5.1 INT INTERRUPT

External interrupt on RB0/INT pin is edge triggered: either rising if edge select bit INTEDG (OPTION<6>) is set, or falling, if bit INTEDG is clear. When a valid edge appears on the RB0/INT pin, flag bit INTF (INTCON<1>) is set. This interrupt can be disabled by clearing enable bit INTE (INTCON<4>). The INTF bit must be cleared in software in the interrupt service routine before re-enabling this interrupt. The INT interrupt can wake the processor from SLEEP, if enable bit INTE was set prior to going into SLEEP. The status of global enable bit GIE decides whether or not the processor branches to the interrupt vector following wake-up. See Section 13.8 for details on SLEEP mode.

13.5.2 TMR0 INTERRUPT

Note:

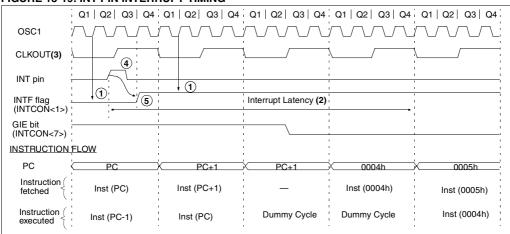
An overflow (FFh \rightarrow 00h) in the TMR0 register will set flag bit T0IF (INTCON<2>). The interrupt can be enabled/disabled by setting/clearing enable bit T0IE (INTCON<5>) (Section 7.0).

13.5.3 PORTB INTERRUPT ON CHANGE

An input change on PORTB<7:4> sets flag bit RBIF (INTCON<0>). The interrupt can be enabled/disabled by setting/clearing enable bit RBIE (INTCON<4>) (Section 5.2).

For the PIC16C61/62/64/65, if a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then flag bit RBIF may not get set.

FIGURE 13-19: INT PIN INTERRUPT TIMING



Note 1: INTF flag is sampled here (every Q1).

- 2: Interrupt latency = 3TCY for synchronous interrupt and 3-4TCY for asynchronous interrupt. Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.
- 3: CLKOUT is available only in RC oscillator mode.
- 4: For minimum width spec of INT pulse, refer to AC specs.
- 5: INTF can to be set anytime during the Q4-Q1 cycles.

13.6 Context Saving During Interrupts

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt i.e., W register and STATUS register. This will have to be implemented in software.

Example 13-1 stores and restores the STATUS and W registers. Example 13-2 stores and restores the STATUS, W, and PCLATH registers (Devices with paged program memory). For all PIC16C6X devices with greater than 1K of program memory (all devices except PIC16C61), the register, W_TEMP, must be

defined in all banks and must be defined at the same offset from the bank base address (i.e., if W_TEMP is defined at 0x20 in bank 0, it must also be defined at 0xA0 in bank 1. 0x120 in bank 2, and 0x1A0 in bank 3).

The examples:

- a) Stores the W register
- b) Stores the STATUS register in bank 0
- c) Stores PCLATH
- d) Executes ISR code
- e) Restores PCLATH
- f) Restores STATUS register (and bank select bit)
- g) Restores W register

EXAMPLE 13-1: SAVING STATUS AND W REGISTERS IN RAM (PIC16C61)

```
MOVWF
         W TEMP
                           ;Copy W to TEMP register, could be bank one or zero
SWAPF
         STATUS, W
                           ;Swap status to be saved into W
MOVWE
         STATUS TEMP
                           ; Save status to bank zero STATUS TEMP register
: (ISR)
SWAPF
         STATUS TEMP, W
                           ;Swap STATUS TEMP register into W
                           ; (sets bank to original state)
MOVWF
         STATUS
                           ; Move W into STATUS register
SWAPF
         W TEMP, F
                           ;Swap W TEMP
                           ;Swap W TEMP into W
SWAPF
         W TEMP, W
```

EXAMPLE 13-2: SAVING STATUS, W, AND PCLATH REGISTERS IN RAM (ALL OTHER PIC16C6X DEVICES)

```
;Copy W to TEMP register, could be bank one or zero
MOVWF
        W TEMP
SWAPF
        STATUS, W
                          ;Swap status to be saved into W
CLRF
        STATUS
                         ;bank 0, regardless of current bank, Clears IRP, RP1, RP0
MOVWF
        STATUS TEMP
                         ; Save status to bank zero STATUS TEMP register
        PCLATH, W
MOVE
                         ;Only required if using pages 1, 2 and/or 3
                         ;Save PCLATH into W
      PCLATH TEMP
MOVWF
CLRF
       PCLATH
                         ; Page zero, regardless of current page
BCF
       STATUS, IRP
                         ;Return to Bank 0
       FSR, W
                         ;Copy FSR to W
MOVWF
        FSR TEMP
                         ;Copy FSR from W to FSR TEMP
· (TSR)
MOVF
        PCLATH TEMP, W
                         ;Restore PCLATH
MOVWF
        PCLATH
                          ; Move W into PCLATH
SWAPF
        STATUS TEMP, W
                         ;Swap STATUS TEMP register into W
                          : (sets bank to original state)
MOVWF
        STATUS
                         ; Move W into STATUS register
SWAPF
        W TEMP,F
                         ;Swap W TEMP
        W_TEMP,W
SWAPF
                         ;Swap W TEMP into W
```

13.7 Watchdog Timer (WDT)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run, even if the clock on the OSC1/CLKIN and OSC2/CLKOUT pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT time-out generates a device reset. If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation (WDT Wake-up). The WDT can be permanently disabled by clearing configuration bit WDTE (Section 13.1).

13.7.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be

assigned to the WDT under software control by writing to the OPTION register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET condition

The TO bit in the STATUS register will be cleared upon a WDT time-out.

13.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler) it may take several seconds before a WDT time-out occurs.

Note: When a CLRWDT instruction is executed and the prescaler is assigned to the WDT, the prescaler count will be cleared, but the prescaler assignment is not changed.

FIGURE 13-20: WATCHDOG TIMER BLOCK DIAGRAM

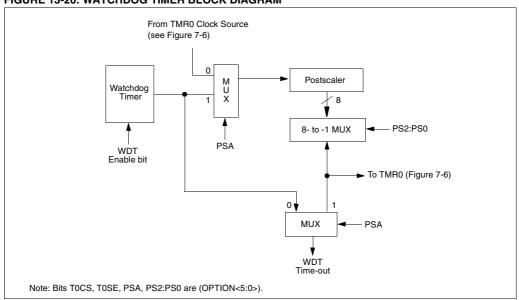


FIGURE 13-21: SUMMARY OF WATCHDOG TIMER REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
2007h	Config. bits	(1)	BODEN ⁽¹⁾	CP1	CP0	PWRTE ⁽¹⁾	WDTE	FOSC1	FOSC0
81h,181h	OPTION	RBPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0

Legend: Shaded cells are not used by the Watchdog Timer.

Note 1: See Figure 13-1, Figure 13-2, and Figure 13-3 for details of these bits for the specific device.

13.8 Power-down Mode (SLEEP)

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Power-down mode is entered by executing a ${\tt SLEEP}$ instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, status bit \overline{PD} (STATUS<3>) is cleared, status bit \overline{TO} (STATUS<4>) is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD, or Vss, ensure no external circuitry is drawing current from the I/O pin, and disable external clocks. Pull all I/O pins, that are hi-impedance inputs, high or low externally to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or Vss for lowest current consumption. The contribution from on-chip pull-ups on PORTB should be considered.

The $\overline{\text{MCLR}}/\text{VPP}$ pin must be at a logic high level (VIHMC).

13.8.1 WAKE-UP FROM SLEEP

The device can wake from SLEEP through one of the following events:

- External reset input on MCLR/VPP pin.
- Watchdog Timer Wake-up (if WDT was enabled).
- Interrupt from RB0/INT pin, RB port change, or some peripheral interrupts.

External $\overline{\text{MCLR}}$ Reset will cause a device reset. All other events are considered a continuation of program execution and cause a "wake-up". The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits in the STATUS register can be used to determine the cause of device reset. The $\overline{\text{PD}}$ bit, which is set on power-up is cleared when SLEEP is invoked. The $\overline{\text{TO}}$ bit is cleared if WDT time-out occurred (and caused wake-up).

The following peripheral interrupts can wake the device from SLEEP:

- TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 2. SSP (Start/Stop) bit detect interrupt.
- 3. SSP transmit or receive in slave mode (SPI/I²C).
- 4. CCP capture mode interrupt.
- 5. Parallel Slave Port read or write.
- 6. USART TX or RX (synchronous slave mode).

Other peripherals can not generate interrupts since during SLEEP, no on-chip Q clocks are present.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

13.8.2 WAKE-UP USING INTERRUPTS

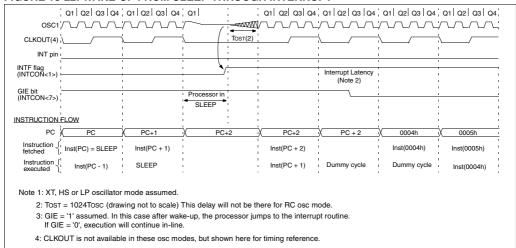
When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs before the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake up from sleep. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the \overline{PD} bit. If the \overline{PD} bit is set, the SLEEP instruction was executed as a NOP

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction

FIGURE 13-22: WAKE-UP FROM SLEEP THROUGH INTERRUPT



13.9 Program Verification/Code Protection

Applicable Devices

61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note: Microchip does not recommend code protecting windowed devices.

13.10 ID Locations

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Four memory locations (2000h - 2003h) are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. It is recommended that only the 4 least significant bits of the ID location are used.

For ROM devices, these values are submitted along with the ROM code.

13.11 <u>In-Circuit Serial Programming</u>

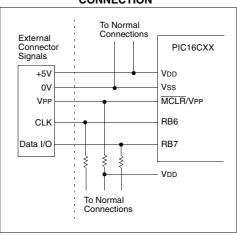
Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

The PIC16CXX microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

The device is placed into a program/verify mode by holding pins RB6 and RB7 low while raising the MCLR (VPP) pin from VIL to VIHH (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

After reset, to place the device in program/verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14-bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC16C6X/7X Programming Specifications (Literature #DS30228).

FIGURE 13-23: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION



14.0 INSTRUCTION SET SUMMARY

Each PIC16CXX instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16CXX instruction set summary in Table 14-2 lists **byte-oriented**, and **literal and control** operations. Table 14-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 14-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
M	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLATH	Program Counter High Latch
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
TO	Time-out bit
PD	Power-down bit
dest	Destination either the W register or the specified register file location
[]	Options
()	Contents
\rightarrow	Assigned to
<>	Register bit field
€	In the set of
italics	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- · Byte-oriented operations
- · Bit-oriented operations
- · Literal and control operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μs . If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μs .

Table 14-2 lists the instructions recognized by the MPASM assembler.

Figure 14-1 shows the general formats that the instructions can have.

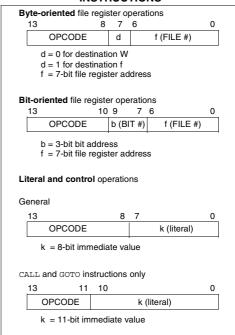
Note: To maintain upward compatibility with future PIC16CXX products, do not use the OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

Ωxhh

where h signifies a hexadecimal digit.

FIGURE 14-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16C6X

TABLE 14-2: PIC16CXX INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	14-Bit Opcode				Status	Notes
				MSb			LSb	Affected	
BYTE-ORIENTED FILE REGISTER OPERATIONS									
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2
ANDWF	f, d	AND W with f	1	0.0	0101	dfff	ffff	Z	1,2
CLRF	f	Clear f	1	0.0	0001	lfff	ffff	Z	2
CLRW	-	Clear W	1	0.0	0001	0xxx	xxxx	Z	
COMF	f, d	Complement f	1	0.0	1001	dfff	ffff	Z	1,2
DECF	f, d	Decrement f	1	0.0	0011	dfff	ffff	Z	1,2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	0.0	1011	dfff	ffff		1,2,3
INCF	f, d	Increment f	1	0.0	1010	dfff	ffff	Z	1,2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2
MOVWF	f	Move W to f	1	00	0000	lfff	ffff		
NOP	-	No Operation	1	0.0	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	0.0	1101	dfff	ffff	С	1,2
RRF	f, d	Rotate Right f through Carry	1	0.0	1100	dfff	ffff	С	1,2
SUBWF	f, d	Subtract W from f	1	0.0	0010	dfff	ffff	C,DC,Z	1,2
SWAPF	f, d	Swap nibbles in f	1	0.0	1110	dfff	ffff		1,2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3
LITERAL AND CONTROL OPERATIONS									
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	-	Clear Watchdog Timer	1	0.0	0000	0110	0100	TO,PD	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	-	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	-	Return from Subroutine	2	0.0	0000	0000	1000		
SLEEP	-	Go into standby mode	1	0.0	0000	0110	0011	TO,PD	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

Note 1: When an I/O register is modified as a function of itself (e.g., MOUF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

^{2:} If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

^{3:} If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

14.1 <u>Instruction Descriptions</u>

ADDLW	Add Literal and W	ANDLW	AND Literal with W
Syntax:	[<i>label</i>] ADDLW k	Syntax:	[label] ANDLW k
Operands:	$0 \leq k \leq 255$	Operands:	$0 \leq k \leq 255$
Operation:	$(W) + k \rightarrow (W)$	Operation:	(W) .AND. (k) \rightarrow (W)
Status Affected:	C, DC, Z	Status Affected:	Z
Encoding:	11 111x kkkk kkkk	Encoding:	11 1001 kkkk kkkk
Description:	The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.	Description:	The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.
Words:	1	Words:	1
Cycles:	1	Cycles:	1
Q Cycle Activity:	Q1 Q2 Q3 Q4	Q Cycle Activity:	Q1 Q2 Q3 Q4
	Decode Read Process Write to data W		Decode Read Process Write to data W
Example:	ADDLW 0x15	Example	ANDLW 0x5F
	Before Instruction W = 0x10 After Instruction W = 0x25		Before Instruction W = 0xA3 After Instruction W = 0x03

ADDWF	Add W and f	ANDWF	AND W with f		
Syntax:	[label] ADDWF f,d	Syntax:	[label] ANDWF f,d		
Operands:	$0 \le f \le 127$ $d \in [0,1]$	Operands:	$0 \le f \le 127$ $d \in [0,1]$		
Operation:	(W) + (f) \rightarrow (destination)	Operation:	(W) .AND. (f) \rightarrow (destination)		
Status Affected:	C, DC, Z	Status Affected:	Z		
Encoding:	00 0111 dfff ffff	Encoding:	00 0101 dfff ffff		
Description:	Add the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.	Description:	AND the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.		
Words:	1	Words:	1		
Cycles:	1	Cycles:	1		
Q Cycle Activity:	Q1 Q2 Q3 Q4	Q Cycle Activity:	Q1 Q2 Q3 Q4		
	Decode Read register data Write to destination		Decode Read register data Write to destination		
Example	ADDWF FSR, 0	Example	ANDWF FSR, 1		
	Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0xD9 FSR = 0xC2		Before Instruction W = 0x17 FSR = 0xC2 After Instruction W = 0x17 FSR = 0x02		

BCF	Bit Clea	r f			BTFSC	Bit Test,	Skip if C	lear		
Syntax:	[label] Bo	CF f,b			Syntax:	[label] B	ΓFSC f,b			
Operands:	$0 \le f \le 127$ $0 \le b \le 7$			Operands:	$0 \le f \le 12$ $0 \le b \le 7$					
Operation:	$0 \rightarrow (f < b)$	>)			Operation:	skip if (f<	(cb>) = 0			
Status Affected:	None				Status Affected:	None	None			
Encoding:	01	00bb	bfff	ffff	Encoding:	01	10bb	bfff	ffff	
Description:	Bit 'b' in re	egister 'f' i	s cleared.		Description:		register 'f' i		ne next	
Words:	1						n is execute register 'f',		the next	
Cycles:	1					instruction	is discarde	ed, and a N	IOP is	
Q Cycle Activity:	Q1	Q2	Q3	Q4		executed instruction	instead, ma n.	king this a	2Tcy	
	Decode	Read register	Process data	Write register 'f'	Words:	1				
		'f'			Cycles:	1(2)				
Example	BCF	FLAG	REG, 7		Q Cycle Activity:	Q1	Q2	Q3	Q4	
	Before Ir	_				Decode	Read register 'f'	Process data	No- Operation	
	After Ins	_	EG = 0xC7	7	If Skip:	(2nd Cyc				
	Aitei iiis		EG = 0x47		п ощр.	Q1	Q2	Q3	Q4	
						No- Operation	No- Operation	No- Operation	No- Operation	
					Example	HERE FALSE TRUE	BTFSC GOTO •	FLAG,1 PROCESS	_CODE	
						Before In	struction			

BSF	Bit Set f							
Syntax:	[label] BS	[label] BSF f,b						
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$							
Operation:	$1 \rightarrow (f < b >)$							
Status Affected:	None							
Encoding:	01	01bb	bfff	ffff				
Description:	Bit 'b' in re	gister 'f' is	s set.					
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Process data	Write register 'f'				

Before Instruction

After Instruction

BSF

FLAG_REG,

 $FLAG_REG = 0x0A$

FLAG_REG = 0x8A

Example

DS30234E-page 146

PC = address HERE

address TRUE

if FLAG<1> = 0, PC = addre

if FLAG<1>=1, PC = address FALSE

After Instruction

BTFSS	Bit Test	f, Skip if S	Set			CALL	Call Sub	routine			
Syntax:	[<i>label</i>] B1	TFSS f,b				Syntax:	[label]	CALL k			
Operands:	$0 \leq f \leq 127$				Operands:	$0 \le k \le 2$	047				
	$0 \le b < 7$					Operation:	(PC)+ 1-	→ TOS,			
Operation:	skip if (f<	:b>) = 1					$k \rightarrow PC < 10:0>$,				
Status Affected:	None					(PCLATH<4:3>			→ PC<12:11>		
Encoding:	01	11bb	bfff	ffff		Status Affected:	None				
Description:		register 'f' i		he next		Encoding:	10	0kkk	kkkk	kkkk	
Wordo	instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2Tcy instruction.				Description:	(PC+1) is eleven bit into PC bi	outine. Firs pushed or immediate ts <10:0>. e loaded fr	to the stace address is The upper	k. The s loaded bits of		
Words:	1							cle instruc		rii cribb	
Cycles:	1(2)					Words:	1				
Q Cycle Activity:	Q1	Q2	Q3	Q4		Cycles:	2				
	Decode	Read register 'f'	Process data	No- Operation		Q Cycle Activity:	Q1	Q2	Q3	Q4	
If Skip:	(2nd Cyc	ele)				1st Cycle	Decode	Read literal 'k',	Process data	Write to PC	
·	Q1	Q2	Q3	Q4				Push PC to Stack	data		
	No- Operation	No- Operation	No- Operation	No- Operation		2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation	
Example	HERE FALSE	BTFSC GOTO	FLAG,1 PROCESS	CODE		Example	HERE	CALL	THERE		
	TRUE	•	ткосцью	_CODE			Before Ir	struction			
		•					A (1 l		ddress HE	RE	
	D - f l -						After Ins	truction PC = A	ddress TH	ERE	
	Before In		address I	TERE					ddress HE		
	After Inst		2001000 1								
		if $FLAG<1>=0$,									

PC = address FALSEif FLAG<1> = 1, PC = address TRUE

CLRF Clear f Syntax: [label] CLRF Operands: $0 \le f \le 127$ Operation: $00h \rightarrow (f)$ $1 \rightarrow Z$ Status Affected: Ζ Encoding: 00 0001 1fff ffff The contents of register 'f' are cleared Description: and the Z bit is set. Words: 1 1

Cycles: 1
Q Cycle Activity: Q1 Q2 Q3 Q4

Decode Read Process Write register ff

Example CLRF FLAG_REG

Before Instruction

FLAG_REG = 0x5A After Instruction

FLAG_REG = 0x00 Z = 1 **CLRW** Clear W Syntax: [label] CLRW Operands: None Operation: $00h \rightarrow (W)$ $1 \rightarrow Z$ Status Affected: Z 0.0 0001 0xxx **Encoding:** xxxx Description: W register is cleared. Zero bit (Z) is Words: 1 Cycles: Q2 Q4 Q Cycle Activity: Q1 Q3 Decode Process Write to No-Operation data Example CLRW Before Instruction W 0x5A After Instruction W 0x00 Z 1

CLRWDT Clear Watchdog Timer Syntax: [label] CLRWDT Operands: None $00h \rightarrow WDT$ Operation: $0 \rightarrow WDT$ prescaler, $1 \rightarrow \overline{10}$ $1 \rightarrow \overline{PD}$ TO, PD Status Affected: Encoding: 00 0000 0110 0100 Description: CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are Words: 1 Cycles: Q Cycle Activity: Q1 Q2 Q3 Q4 Decode No-Process Clear Operation WDT data Counter CLRWDT Example Before Instruction WDT counter =

After Instruction

TO PD

WDT counter =

WDT prescaler=

0x00

0

COMF	Complement f	DECFSZ	Decrement f, Skip if 0			
Syntax:	[label] COMF f,d	Syntax:	[label] DECFSZ f,d			
Operands:	$0 \le f \le 127$ $d \in [0,1]$	Operands:	$0 \le f \le 127$ $d \in [0,1]$			
Operation:	$(\bar{f}) \rightarrow (destination)$	Operation:	(f) - 1 \rightarrow (destination);			
Status Affected:	Z		skip if result = 0			
Encoding:	00 1001 dfff ffff	Status Affected:	None			
Description:	The contents of register 'f' are comple-	Encoding:	00 1011 dfff ffff			
	mented. If 'd' is 0 the result is stored in W. If 'd' is 1 the result is stored back in register 'f'.	Description:	The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed			
Words:	1		back in register 'f'. If the result is 1, the next instruction, is			
Cycles:	1		executed. If the result is 0, then a NOP is			
Q Cycle Activity:	Q1 Q2 Q3 Q4		executed instead making it a 2Tcy instruction.			
	Decode Read Process Write to register data destination	Words:	1			
	'f' data desimation	Cycles:	1(2)			
		Q Cycle Activity:	Q1 Q2 Q3 Q4			
Example	COMF REG1, 0 Before Instruction		Decode Read Process Write to destination			
	REG1 = 0x13 After Instruction REG1 = 0x13		(2nd Cycle)			
			Q1 Q2 Q3 Q4			
	W = 0xEC		No- Operation			
DECF	Decrement f	Example	HERE DECFSZ CNT, 1			
Syntax:	[label] DECF f,d	Lxample	GOTO LOOP			
-	• •		GOTO LOOP			
Operands:	$0 \le f \le 127$ $d \in [0,1]$		CONTINUE •			
Operation:	0 ≤ f ≤ 127					
·	$0 \le f \le 127$ $d \in [0,1]$		CONTINUE • • • Before Instruction PC = address HERE			
Operation:	$0 \le f \le 127$ $d \in [0,1]$ (f) - 1 \rightarrow (destination)		CONTINUE Before Instruction PC = address HERE After Instruction			
Operation: Status Affected:	$0 \le f \le 127$ $d \in [0,1]$ (f) - 1 \rightarrow (destination)		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE			
Operation: Status Affected: Encoding:	$0 \le f \le 127$ $d \in [0,1]$ $(f) - 1 \rightarrow (destination)$ Z 00 0011 dfff ffff Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \\ (f) \text{-} 1 \rightarrow \text{(destination)} \end{array}$ Z $\begin{array}{ c c c c c c c c c c c c c c c c c c c$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description: Words:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \\ (f) - 1 \rightarrow (destination) \\ \hline Z \\ \hline \begin{array}{c c} 00 & 0011 & dfff & ffff \\ \hline \end{array} \\ \hline Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'. \\ \hline \end{array}$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description: Words: Cycles:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \\ (f) \text{-} 1 \rightarrow (destination) \\ Z \\ \hline \begin{array}{c c} 00 & 0011 & dfff & ffff \\ \hline \end{array} \\ \hline \text{Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.} \\ 1 \\ 1 \\ \end{array}$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description: Words: Cycles:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \\ (f) - 1 \rightarrow (destination) \\ \hline Z \\ \hline \begin{array}{c ccccccccccccccccccccccccccccccccccc$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in \left[0,1\right] \\ (f) - 1 \rightarrow (destination) \end{array}$ Z $\begin{array}{c ccccccccccccccccccccccccccccccccccc$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity:	$\begin{array}{llll} 0 \leq f \leq 127 \\ d \in [0,1] \\ (f) - 1 \rightarrow (destination) \\ Z \\ \hline \begin{array}{c ccccccccccccccccccccccccccccccccccc$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			
Operation: Status Affected: Encoding: Description: Words: Cycles: Q Cycle Activity:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \\ (f) - 1 \rightarrow (destination) \\ \hline Z \\ \hline \begin{array}{c ccccccccccccccccccccccccccccccccccc$		CONTINUE Before Instruction PC = address HERE After Instruction CNT = CNT - 1 if CNT = 0, PC = address CONTINUE if CNT ≠ 0,			

GOTO	Uncondi	tional Br	anch		INCF		Increme	nt f		
Syntax:	[label]	[label] GOTO k			Syntax:		[label] INCF f,d			
Operands:	$0 \le k \le 20$	$0 \leq k \leq 2047$			Operan	ıds:	$0 \le f \le 12$	$0 \leq f \leq 127$		
Operation:	$k \rightarrow PC <$	10:0>					d ∈ [0,1]	$d \in [0,1]$		
	PCLATH-	<4:3> → l	PC<12:11	>	Operati	on:	$(f) + 1 \rightarrow$	(f) + 1 \rightarrow (destination)		
Status Affected:	None				Status /	Affected:	Z			
Encoding:	10	1kkk	kkkk	kkkk	Encodir	ng:	0.0	1010	dfff	ffff
Description:	GOTO is an unconditional branch. The eleven bit immediate value is loaded into PC bits < 10:0>. The upper bits of PC are loaded from PCLATH<4:3>. GOTO is a two cycle instruction.		Descrip	otion:	mented. If the W reg	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.				
Words:	1				Words:		1			
Cycles:	2				Cycles:		1			
Q Cycle Activity:	Q1	Q2	Q3	Q4	Q Cycle	e Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	Read literal 'k'	Process data	Write to PC			Decode	Read register	Process data	Write to destination
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation						
	Орегалогі	Орегилогі	Орегалогі	Орегалогі	Exampl	le	INCF	CNT,	1	
Example	GOTO T	HERE					Before Ir	struction	1	
	After Inst	ruction						CNT 7	= 0xFl	F
		PC =	Address	THERE			After Ins	_	= 0	

CNT = 0x00 Z = 1

INCFSZ	Increme	nt f, Skip	if 0			
Syntax:	[label]	INCFSZ	f,d			
Operands:	$0 \le f \le 127$ $d \in [0,1]$					
Operation:	(f) + 1 \rightarrow (destination), skip if result = 0					
Status Affected:	None					
Encoding:	00 1111 dfff ffff					
Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 1, the next instruction is executed. If the result is 0, a NOP is executed instead making it a 2Tcy instruction.					
Words:	1					
Cycles:	1(2)					
Q Cycle Activity:	Q1	Q2	Q3	Q4		
	Decode	Read register 'f'	Process data	Write to destination		
If Skip:	(2nd Cyc	le)				
	Q1	Q2	Q3	Q4		
	No- Operation	No- Operation	No- Operation	No- Operation		
Example	HERE	INCFS GOTO UE •	Z CI LO	NT, 1 OP		
	Before In PC After Inst CNT if CNT PC if CNT PC	= add ruction = CN7 = 0, = add ≠ 0,	ress HERE + 1 ress CONT ress HERE			

IORLW	Inclusive OR Literal with W							
Syntax:	[label]	IORLW	k					
Operands:	$0 \leq k \leq 255$							
Operation:	(W) .OR. $k \rightarrow$ (W)							
Status Affected:	Z							
Encoding:	11	1000	kkkk	kkkk				
Description:	The conte OR'ed with result is pl	h the eigh	t bit literal	'k'. The				
Words:	1							
Cycles:	1							
Q Cycle Activity:	Q1	Q2	Q3	Q4				
	Decode	Read literal 'k'	Process data	Write to W				
Example	IORLW	0x35						

Before Instruction W =

After Instruction

0x9A

W = 0xBF Z = 1

IORWF	Inclusive	OR W	with f	
Syntax:	[label]	IORWF	f,d	
Operands:	$0 \le f \le 12$ $d \in [0,1]$	7		
Operation:	(W) .OR.	$(f) \rightarrow (de)$	estination)
Status Affected:	Z			
Encoding:	00	0100	dfff	ffff
Description:	Inclusive C ter 'f'. If 'd' W register back in reg	is 0 the re . If 'd' is 1	sult is plac	ed in the
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
Example	IORWF		RESULT,	0
		struction RESULT W		
	After Inst	ruction RESULT	= 0x13	3

W

0x93

MOVLW	Move Lit	eral to V	v	
Syntax:	[label]	MOVLW	/ k	
Operands:	$0 \le k \le 2$	55		
Operation:	$k\to(W)$			
Status Affected:	None			
Encoding:	11	00xx	kkkk	kkkk
Description:	The eight register. T as 0's.		k' is loaded ares will as	
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read literal 'k'	Process data	Write to W
Example	MOVLW	0x5A		
	After Inst		0.54	
		W =	0x5A	

MOVF	Move f								
Syntax:	[label]	[label] MOVF f,d							
Operands:	$0 \le f \le 127$ $d \in [0,1]$								
Operation:	$(f) \rightarrow (destination)$								
Status Affected:	Z								
Encoding:	0.0	1000	dfff	ffff					
Description:	The contents of register f is moved to a destination dependant upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flaq Z is affected.								
Words:	1								
Cycles:	1								
Q Cycle Activity:	Q1	Q2	Q3	Q4					
	Decode	Read register 'f'	Process data	Write to destination					
Example	MOVF	FSR,	0						
	After Inst		ie in FSR i	register					

Z = 1

MOVWF	Move W	to f		
Syntax:	[label]	MOVWI	F f	
Operands:	$0 \le f \le 12$.7		
Operation:	$(W) \rightarrow (f)$			
Status Affected:	None			
Encoding:	0.0	0000	1fff	ffff
Description:	Move data	from W r	egister to	register
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write register 'f'
Example	MOVWF	OPTIC	ON_REG	
	Before In			
		OPTION W	= 0xFi $=$ 0x4Fi	
	After Inst	• •	- UNTI	
		OPTION	• • • • • • • • • • • • • • • • • • • •	
	'	W	= 0x4F	-

NOP No Operation Syntax: [label] NOP Operands: None Operation: No operation Status Affected: None 0000 Encoding: 0xx0 0000 Description: No operation. Words: Cycles: 1 Q Cycle Activity: Q1 Q2 Q3 Q4 Decode No-Operation No-No-Operation Operation

NOP

Example

RETFIE	Return fi	rom Inter	rupt	
Syntax:	[label]	RETFIE		
Operands:	None			
Operation:	$TOS \rightarrow PC$, $1 \rightarrow GIE$			
Status Affected:	None			
Encoding:	0.0	0000	0000	1001
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two cycle instruction.			
Words:	1			
Cycles:	2			
Q Cycle Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	No- Operation	Set the GIE bit	Pop from the Stack
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation

Example RETFIE

After Interrupt

PC = TOS GIE = 1

OPTION	Load Op	tion Reg	gister	
Syntax:	[label]	OPTION	1	
Operands:	None			
Operation:	$(W) \rightarrow O$	PTION		
Status Affected:	None			
Encoding:	0.0	0000	0110	0010
Description: Words:	The conterloaded in tinstruction patibility w Since OPT register, thit.	the OPTIC is suppor ith PIC16 IION is a	ON registe rted for co C5X produ readable/v	r. This de com- ucts. vritable
Cycles: Example	1			
		re PIC160	rd compa CXX production.	

Syntax:	[label]	RFTI W	k	
Operands:	0 < k < 25		IX.	
•		55		
Operation:	$k \rightarrow (W);$ TOS $\rightarrow F$	C		
Status Affected:	None			
Encoding:	11	01xx	kkkk	kkkk
Description:	The W reg bit literal 'k loaded from return add instruction	t'. The proo m the top ress). This	gram coun of the stac	ter is k (the
Words:	1			
Cycles:	2			
Q Cycle Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	Read literal 'k'	No- Operation	Write to W, Pop from the Stack
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation
Example	CALL TABLE	;offse	tains tabl t value has table	
TABLE	ADDWF PC RETLW k1 RETLW k2	;W = 0: ;Begin ;		
	RETLW kn	; End	of table	
	Before In			
	After Inst		0x07	
			value of k8	

RETURN	Return fi	rom Subi	routine	
Syntax:	[label]	RETURI	V	
Operands:	None			
Operation:	$TOS \to F$	C		
Status Affected:	None			
Encoding:	0.0	0000	0000	1000
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two cycle instruction.			
Words:	1			
Cycles:	2			
Q Cycle Activity:	Q1	Q2	Q3	Q4
1st Cycle	Decode	No- Operation	No- Operation	Pop from the Stack
2nd Cycle	No- Operation	No- Operation	No- Operation	No- Operation
Example	RETURN After Inte	•	TOS	

RLF	Rotate Left f the	rough Ca	rry	RRF	Rotate F	Right f th	rough C	arry
Syntax:	[label] RLF	f,d		Syntax:	[label]	RRF f,	d	
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$			Operands:	$0 \le f \le 12$ $d \in [0,1]$			
Operation:	See description below		Operation:	See des	See description below			
Status Affected:	С			Status Affected:	С			
Encoding:	00 1101	dfff	ffff	Encoding:	0.0	1100	dfff	ffff
Description:	The contents of re one bit to the left ti Flag. If 'd' is 0 the W register. If 'd' is back in register 'f'.	nrough the result is pla	Carry ced in the	Description:	one bit to Flag. If 'd'	the right t is 0 the re r. If 'd' is 1 gister 'f'.	ister 'f' are hrough the esult is pla- the result Register f	e Carry ced in the
Words:	1			Words:	1			
Cycles:	1			Cycles:	1			
Q Cycle Activity:	Q1 Q2	Q3	Q4	Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode Read register 'f'	Process data	Write to destination		Decode	Read register 'f'	Process data	Write to destination
Example	RLF R	EG1,0		Example	RRF		REG1,0	
	Before Instruction	n			Before Ir	struction	1	
	REG1 C	= 111 = 0	0 0110			REG1		0 0110
	After Instruction	= 0			After Ins	C	= 0	
	REG1	= 111	0 0110		7 (113)	REG1	= 111	0 0110
	W	= 110	0 1100			W	= 011	1 0011
	С	= 1				С	= 0	

SLEEP Syntax:

[label] SLEEP

Operands: None

Operation: $00h \rightarrow WDT$,

 $0 \rightarrow WDT$ prescaler,

 $1 \to \overline{\overline{10}}, \\ 0 \to \overline{\overline{PD}}$

Status Affected: TO, PD

Encoding: 00

ding: 00 0000 0110 0011ription: The power-down status bit, \overline{PD} is

Description: The power-down status bit, \overline{PD} is cleared. Time-out status bit, \overline{TO} is

set. Watchdog Timer and its prescaler are cleared.

The processor is put into SLEEP mode with the oscillator stopped. See

Section 13.8 for more details.

Words: 1

Cycles:

Q Cycle Activity: Q1 Q2 Q3 Q4

Decode No-Operation No-Operation Sleep

Example: SLEEP

SUBLW Subtract W from Literal

Syntax: [label] SUBLW k Operands: $0 \le k \le 255$

Operation: $k - (W) \rightarrow (W)$ Status Affected: C. DC. Z

Franking:

Encoding: 11 110x kkkk kkkk

Description: The W register is subtracted (2's comple-

ment method) from the eight bit literal 'k'.

The result is placed in the W register.

Words: 1

Cycles: 1

 Q Cycle Activity:
 Q1
 Q2
 Q3
 Q4

 Decode
 Read literal 'k'
 Process data
 Write to W

Example 1: SUBLW 0x02

Before Instruction

W = 1 C = ? Z = ?

After Instruction

W = 1

C = 1; result is positive

Z =

Example 2: Before Instruction

W = 2 C = ?

Z =

After Instruction

W = 0

C = 1; result is zero

Z =

Example 3: Before Instruction

W = 3 C = ?

After Instruction

W = 0xFF

?

C = 0; result is negative

Z = 0

SUBWF	Subtract	W from f		
Syntax:	[label]	SUBWF	f,d	
Operands:	$0 \le f \le 127$ $d \in [0,1]$	7		
Operation:	(f) - (W) -	→ (destina	ition)	
Status Affected:	C, DC, Z			
Encoding:	00	0010	dfff	ffff
Description:	ister from restored in the	egister 'f'. l ne W regist	nent metho If 'd' is 0 the er. If 'd' is 1 n register 'f	result is the
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
Example 1:	SUBWF	REG1,1		
	Before Ins	struction		
	REG1 W C Z	= = = =	3 2 ?	
	After Instr	ruction		
	REG1 W C Z	= = =	1 2 1; result is	positive
Example 2:	Before Ins	struction		
	REG1 W C Z	= = = =	2 2 ? ?	
	After Instr		_	
	REG1 W C Z	= = = =	0 2 1; result is 1	zero
Example 3:	Before Ins	struction		
	REG1 W C Z	= = = =	1 2 ?	
	After Instr	ruction		
	REG1 W C Z	= = = =	0xFF 2 0; result is 0	negative

SWAPF	Swap Ni	bbles in	f	
Syntax:	[label]	SWAPF 1	,d	
Operands:	$0 \le f \le 12$ $d \in [0,1]$	27		
Operation:	,	$(f<3:0>) \rightarrow (destination<7:4>),$ $(f<7:4>) \rightarrow (destination<3:0>)$		
Status Affected:	None			
Encoding:	0.0	1110	dfff	ffff
Description:	'f' are excl placed in '	r and lower nanged. If W register. n register	'd' is 0 the	e result is
Words:	1			
Cycles:	1			
Q Cycle Activity:	Q1	Q2	Q3	Q4
	Decode	Read register 'f'	Process data	Write to destination
Example	SWAPF	REG,	0	
	Before In	struction		
		REG1	= 0x	4 5
	After Inst	ruction		
		REG1	= 0x	
		W	= 0x	5A

TRIS	Load TRIS Register		
Syntax:	[label] TRIS f		
Operands:	$5 \leq f \leq 7$		
Operation:	(W) \rightarrow TRIS register f;		
Status Affected:	None		
Encoding:	00 0000 0110 Offf		
Description:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.		
Words:	1		
Cycles:	1		
Example			
	To maintain upward compatibility with future PIC16CXX products, do not use this instruction.		

XORLW	Exclusive OR Literal with W	XORWF	Exclusive OR W with f
Syntax:	[<i>label</i>] XORLW k	Syntax:	[label] XORWF f,d
Operands:	$0 \le k \le 255$	Operands:	$0 \le f \le 127$ $d \in [0,1]$
Operation: Status Affected:	(W) .XOR. $k \rightarrow (W)$	Operation: Status Affected:	(W) .XOR. (f) \rightarrow (destination) Z
Encoding:	11 1010 kkkk kkkk	Encoding:	00 0110 dfff ffff
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.	Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.
Words:	1	Words:	1
Cycles: Q Cycle Activity:	1 Q1 Q2 Q3 Q4	Cycles: Q Cycle Activity:	1 Q1 Q2 Q3 Q4
	Decode Read Process Write to literal 'k' data W	Q Gyolo / lollvilly.	Decode Read Process Write to register data destination
Example:	XORLW 0xAF		T
	Before Instruction	Example	XORWF REG 1
	W = 0xB5		Before Instruction
	After Instruction $W = 0x1A$		REG = 0xAF W = 0xB5
	- 0////		After Instruction
			$ \begin{array}{rcl} REG & = & 0x1A \\ W & = & 0xB5 \end{array} $

15.0 ELECTRICAL CHARACTERISTICS FOR PIC16C61

Absolute Maximum Ratings †

• •	
Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to VSS (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	-0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 pin with respect to Vss	
Total power dissipation (Note 1)	800 mW
Maximum current out of Vss pin	150 mA
Maximum current into VDD pin	100 mA
Input clamp current, IiK (VI < 0 or VI > VDD)	± 20 mA
Output clamp current, Iok (Vo < 0 or Vo > VDD)	± 20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	20 mA
Maximum current sunk by PORTA	80 mA
Maximum current sourced by PORTA	50 mA
Maximum current sunk by PORTB	150 mA
Maximum current sourced by PORTB	100 mA

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - Σ IOH} + Σ {(VDD-VOH) x IOH} + Σ (VOI x IOL)

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 15-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C61-04	PIC16C61-20	PIC16LC61-04	JW Devices
RC	VDD: 4.0V to 6.0V	VDD: 4.5V to 5.5V	VDD: 3.0V to 6.0V	VDD: 4.0V to 6.0V
	IDD: 3.3 mA max. at 5.5V	IDD: 1.8 mA typ. at 5.5V	IDD: 1.4 mA typ. at 3.0V	IDD: 3.3 mA max. at 5.5V
	IPD: 14 μA max. at 4V	IPD: 1.0 μA typ. at 4V	IPD: 0.6 μA typ. at 3V	IPD: 14 μA max. at 4V
	Freq: 4 MHz max.	Freq: 4 MHz max.	Freq: 4 MHz max.	Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V	VDD: 4.5V to 5.5V	VDD: 3.0V to 6.0V	VDD: 4.0V to 6.0V
	IDD: 3.3 mA max. at 5.5V	IDD: 1.8 mA typ. at 5.5V	IDD: 1.4 mA typ. at 3.0V	IDD: 3.3 mA max. at 5.5V
	IPD: 14 μA max. at 4V	IPD: 1.0 μA typ. at 4V	IPD: 0.6 μA typ. at 3V	IPD: 14 μA max. at 4V
	Freq: 4 MHz max.	Freq: 4 MHz max.	Freq: 4 MHz max.	Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V	VDD: 4.5V to 5.5V		VDD: 4.5V to 5.5V
	IDD: 13.5 mA typ. at 5.5V	IDD: 30 mA max. at 5.5V	Not recommended for use in	IDD: 30 mA max. at 5.5V
	IPD: 1.0 μA typ. at 4.5V	IPD: 1.0 μA typ. at 4.5V	HS mode	IPD: 1.0 μA typ. at 4.5V
	Freq: 4 MHz max.	Freq: 20 MHz max.		Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V		VDD: 3.0V to 6.0V	VDD: 3.0V to 6.0V
	IDD: 15 μA typ. at 32 kHz,	Not recommended for	IDD: 32 μA max. at 32 kHz,	IDD: 32 μA max. at 32 kHz,
	4.0V	use in LP mode	3.0V	3.0V
	IPD: 0.6 μA typ. at 4.0V	use iii LP mode	IPD: 9 μA max. at 3.0V	IPD: 9 μA max. at 3.0V
	Freq: 200 kHz max.		Freq: 200 kHz max.	Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

15.1 DC Characteristics: PIC16C61-04 (Commercial, Industrial, Extended) PIC16C61-20 (Commercial, Industrial, Extended)

		Standar	rd Opei	rating (Condi	tions (ı	unless otherwise stated)
DC CHAR		Operatir		•			≤ Ta ≤ +125°C for extended,
DC CHARA	ACTENISTICS				-40)°C ≤	≤ Ta ≤ +85°C for industrial and
					0°(2 ≤	TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001	Supply Voltage	VDD	4.0	-	6.0	V	XT, RC and LP osc configuration
D001A			4.5	-	5.5	V	HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2)	IDD	-	1.8	3.3	mA	FOSC = 4 MHz, VDD = 5.5V (Note 4)
D013			-	13.5	30	mA	HS osc configuration FOSC = 20 MHz, VDD = 5.5V
D020	Power-down Current	IPD	-	7	28	μА	VDD = 4.0V, WDT enabled, -40°C to +85°C
D021	(Note 3)		-	1.0	14	μΑ	VDD = 4.0V, WDT disabled, -0°C to +70°C
D021A			-	1.0	16	μΑ	VDD = 4.0V, WDT disabled, -40°C to +85°C
D021B			-	1.0	20	μΑ	VDD = 4.0V, WDT disabled, -40°C to +125°C

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

15.2 DC Characteristics: PIC16LC61-04 (Commercial, Industrial)

DC CHA	ARACTERISTICS	Standa Operatii	•	•		°C ≤	Inless otherwise stated) TA ≤ +85°C for industrial and TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max	l	Conditions
D001	Supply Voltage	VDD	3.0	-	6.0	٧	XT, RC, and LP osc configuration
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2)	IDD	-	1.4	2.5	mA	Fosc = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	15	32	μΑ	FOSC = 32 kHz, VDD = 3.0V, WDT disabled, LP osc configuration
D020 D021 D021A	Power-down Current (Note 3)	IPD	- - -	5 0.6 0.6	20 9 12	μΑ μΑ μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C VDD = 3.0V, WDT disabled, 0°C to +70°C VDD = 3.0V, WDT disabled, -40°C to +85°C

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

15.3 DC Characteristics: PIC16C61-04 (Commercial, Industrial, Extended)

PIC16C61-20 (Commercial, Industrial, Extended)

PIC16LC61-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

Operating temperature -40°C \leq TA \leq +125°C for extended, -40°C \leq TA \leq +85°C for industrial and

DC CHARACTERISTICS $\begin{array}{ll}
-40^{\circ}\text{C} & \leq \text{Ta} \leq +85^{\circ}\text{C for industrial and} \\
0^{\circ}\text{C} & \leq \text{Ta} \leq +70^{\circ}\text{C for commercial}
\end{array}$

Operating voltage VDD range as described in DC spec Section 15.1 and

Section 15.2.

		Section	13.2.				
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
	Input Low Voltage						
	I/O ports	VIL					
D030	with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range
D030A			Vss	-	0.8V	V	$4.5V \le VDD \le 5.5V$
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	V	
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1
	Input High Voltage						
	I/O ports	VIH		-			
D040	with TTL buffer		2.0	-	VDD	V	$4.5V \le V_{DD} \le 5.5V$
D040A			0.25VDD	-	VDD	V	For entire VDD range
			+ 0.8V				
D041	with Schmitt Trigger buffer		0.85VDD	-	VDD	V	For entire VDD range
D042	MCLR		0.85VDD	-	VDD	V	
D042A	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	250	† 400	μА	VDD = 5V, VPIN = VSS
	Input Leakage Current (Notes 2, 3)						
D060	I/O ports	lıL	-	-	±1	μΑ	Vss ≤ VPIN ≤ VDD, Pin at himpedance
D061	MCLR, RA4/T0CKI		-	-	±5	μА	$Vss \le VPIN \le VDD$
D063	OSC1		-	-	±5	μА	Vss ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
	Output Low Voltage						0
D080	I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C

^{*} The parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended,

-40°C \leq TA \leq +85°C for industrial and 0°C \leq TA \leq +70°C for commercial

Operating voltage VDD range as described in DC spec Section 15.1 and Section 15.2

		Section	15.2.				
Param	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
No.							
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA,
							$VDD = 4.5V, -40^{\circ}C \text{ to } +85^{\circ}C$
D090A			VDD-0.7	-	-	V	IOH = -2.5 mA,
							$VDD = 4.5V, -40^{\circ}C \text{ to } +125^{\circ}C$
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA,
							$VDD = 4.5V, -40^{\circ}C \text{ to } +85^{\circ}C$
D092A			VDD-0.7	-	-	V	IOH = -1.0 mA,
							$VDD = 4.5V, -40^{\circ}C \text{ to } +125^{\circ}C$
D150*	Open-Drain High Voltage	VOD	-		14	V	RA4 pin
	Capacitive Loading Specs on						
	Output Pins						
D100	OSC2 pin	Cosc ₂			15	pF	In XT, HS and LP modes when
							external clock is used to drive
							OSC1.
D101	All I/O pins and OSC2 (in RC mode)	Cio			50	pF	

* The parameters are characterized but not tested.

DC CHARACTERISTICS

- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

15.4 **Timing Parameter Symbology**

The timing parameter symbols have been created following one of the following formats:

1. TppS2p	pS	3. Tcc:st	(I ² C specifications only)	
2. TppS		4. Ts	(I ² C specifications only)	
T				
F	Frequency	Т	Time	
Lowerca	ase letters (pp) and their meanings:			
рр				
СС	CCP1	osc	OSC1	
ck	CLKOUT	rd	RD	
cs	CS	rw	RD or WR	
di	SDI	sc	SCK	
do	SDO	SS	SS	
dt	Data in	t0	T0CKI	
io	I/O port	t1	T1CKI	
mc	MCLR	wr	WR	
Upperca	ase letters and their meanings:	·		
S				
F	Fall	P	Period	
Н	High	R	Rise	
I	Invalid (Hi-impedance)	V	Valid	
L	Low	Z	Hi-impedance	
I ² C only				

Bus free Tcc:st (I²C specifications only)

output access

AA

BUF

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

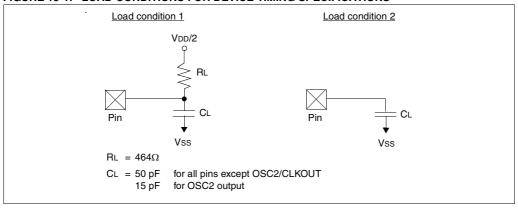
High

Low

High

Low

FIGURE 15-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



15.5 <u>Timing Diagrams and Specifications</u>

FIGURE 15-2: EXTERNAL CLOCK TIMING

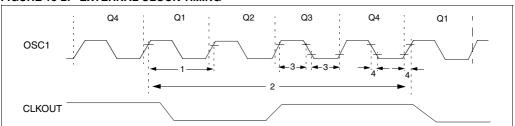


TABLE 15-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			1	_	4	MHz	HS osc mode (-04)
			1		20	MHz	HS osc mode (-20)
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	1,000	ns	HS osc mode (-04)
			50	_	1,000	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	TCY	Instruction Cycle Time (Note 1)	1.0	Tcy	DC	μS	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	50	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μS	LP oscillator
			10	_	_	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	25		_	ns	XT oscillator
	TosF	Fall Time	50		_	ns	LP oscillator
			15	_	_	ns	HS oscillator

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 15-3: CLKOUT AND I/O TIMING

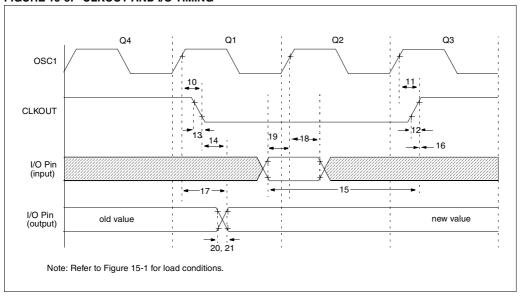


TABLE 15-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	15	30	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	15	30	ns	Note 1
12*	TckR	CLKOUT rise time		_	5	15	ns	Note 1
13*	TckF	CLKOUT fall time		_	5	15	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	d	_	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOU	Port in valid before CLKOUT ↑		_	_	ns	Note 1
16*	TckH2ioI	Port in hold after CLKOUT ↑		0	_	_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid		_	_	80 - 100	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to Port (I/O in hold time)	input invalid	TBD	_	_	ns	
19*	TioV2osH	Port input valid to OSC1↑ (time)	(I/O in setup	TBD		_	ns	
20*	TioR	Port output rise time	PIC16 C 61	_	10	25	ns	
			PIC16 LC 61	_	_	60	ns	
21*	TioF	Port output fall time	PIC16 C 61	_	10	25	ns	
			PIC16 LC 61	_	_	60	ns	
22††*	Tinp	RB0/INT pin high or low tin	ne	20		_	ns	
23††*	Trbp	RB7:RB4 change int high	or low time	20		_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{††} These parameters are asynchronous events not related to any internal clock edges.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

FIGURE 15-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

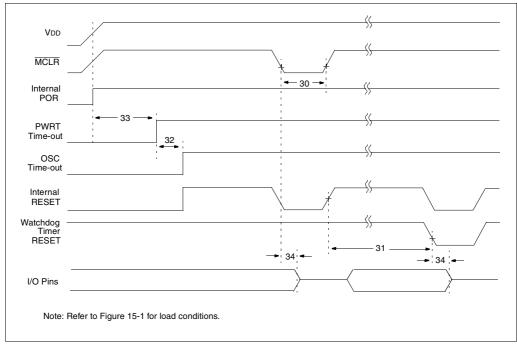


TABLE 15-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30*	TmcL	MCLR Pulse Width (low)	200	_	_	ns	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	_		TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34*	Tıoz	I/O Hi-impedance from MCLR Low	_	_	100	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 15-5: TIMERO EXTERNAL CLOCK TIMINGS

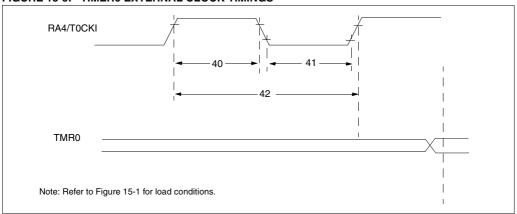


TABLE 15-5: TIMERO EXTERNAL CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions	
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet	
			With Prescaler	10	_	_	ns	parameter 42	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet	
			With Prescaler	10	_	_	ns	parameter 42	
42*	Tt0P	T0CKI Period	No Prescaler	Tcy + 40	_	_	ns	N = prescale value	
			With Prescaler	Greater of: 20 ns or TCY + 40 N	_		ns	(2, 4,, 256)	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

16.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES FOR PIC16C61

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

In some graphs or tables the data presented are outside specified operating range (i.e., outside specified VDD range). This is for information only and devices are guaranteed to operate properly only within the specified range.

Note: The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution while 'max' or 'min' represents (mean +3σ) and (mean -3σ) respectively where σ is standard deviation.

FIGURE 16-1: TYPICAL RC OSCILLATOR FREQUENCY vs. TEMPERATURE

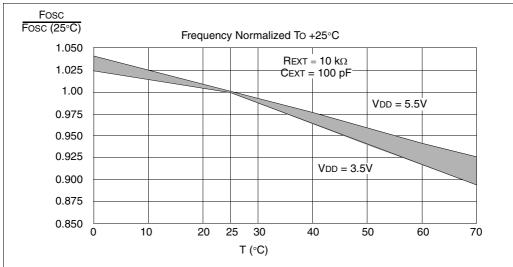


TABLE 16-1: RC OSCILLATOR FREQUENCIES

Cext	Rext	Average Fosc @ 5V, 25°C			
20 pF	4.7k	4.52 MHz	± 17.35%		
	10k	2.47 MHz	± 10.10%		
	100k	290.86 kHz	± 11.90%		
100 pF	3.3k	1.92 MHz	± 9.43%		
	4.7k	1.48 MHz	± 9.83%		
	10k	788.77 kHz	± 10.92%		
	100k	88.11 kHz	± 16.03%		
300 pF	3.3k	726.89 kHz	± 10.97%		
	4.7k	573.95 kHz	± 10.14%		
	10k	307.31 kHz	± 10.43%		
	100k	33.82 kHz	± 11.24%		

The percentage variation indicated here is part to part variation due to normal process distribution. The variation indicated is ±3 standard deviation from average value for VDD = 5V.

FIGURE 16-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

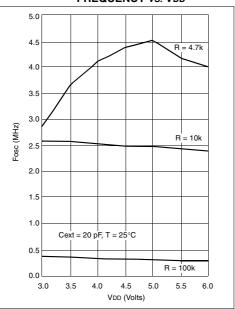


FIGURE 16-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

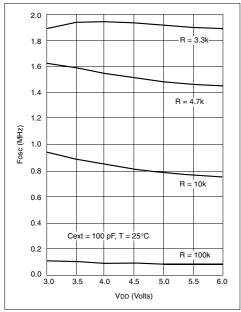


FIGURE 16-4: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

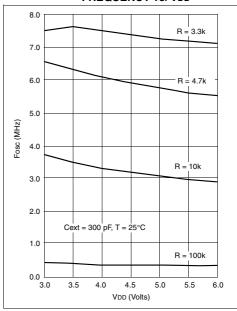


FIGURE 16-5: TYPICAL IPD VS. VDD WATCHDOG TIMER DISABLED 25°C

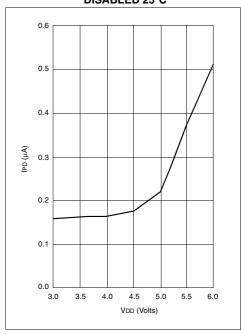


FIGURE 16-6: TYPICAL IPD VS. VDD
WATCHDOG TIMER ENABLED
25°C

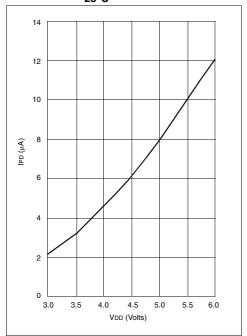
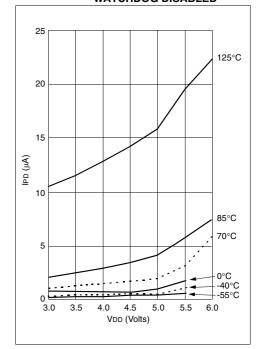
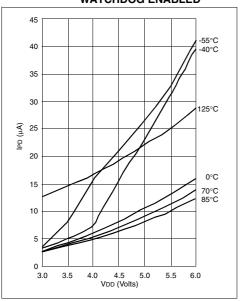


FIGURE 16-7: MAXIMUM IPD vs. VDD WATCHDOG DISABLED



Data based on matrix samples. See first page of this section for details.

FIGURE 16-8: MAXIMUM IPD VS. VDD WATCHDOG ENABLED*



*IPD, with Watchdog Timer enabled, has two components: The leakage current which increases with higher temperature and the operating current of the Watchdog Timer logic which increases with lower temperature. At -40°C, the latter dominates explaining the apparently anomalous behavior.

FIGURE 16-9: VTH (INPUT THRESHOLD VOLTAGE) OF I/O PINS vs.

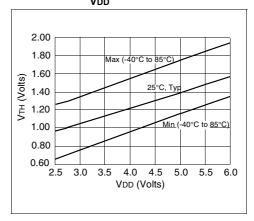


FIGURE 16-10: VIH, VIL OF MCLR, TOCKI AND OSC1 (IN RC MODE) vs. VDD

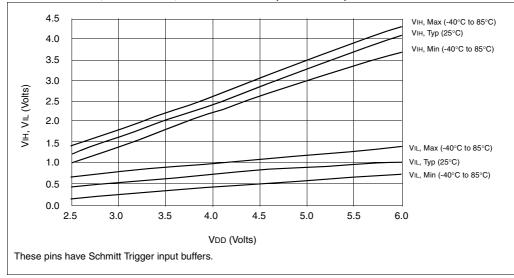


FIGURE 16-11: VTH (INPUT THRESHOLD VOLTAGE) OF OSC1 INPUT (IN XT, HS, AND LP MODES) vs. VDD

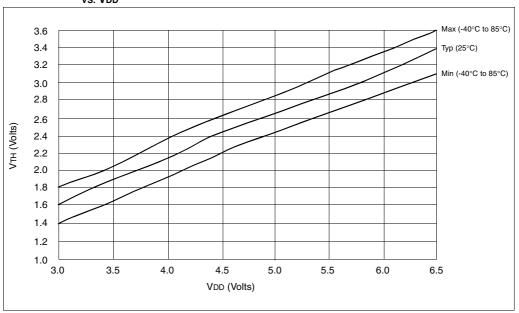


FIGURE 16-12: TYPICAL IDD VS. FREQUENCY (EXTERNAL CLOCK, 25°C)

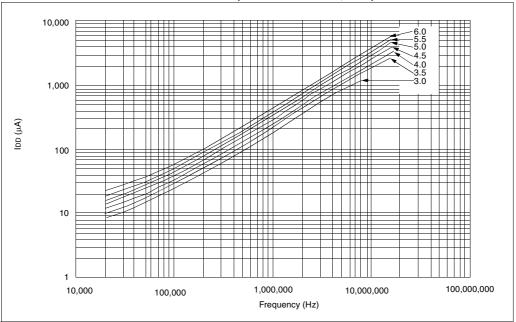


FIGURE 16-13: MAXIMUM IDD vs. FREQUENCY (EXTERNAL CLOCK, -40° TO +85°C)

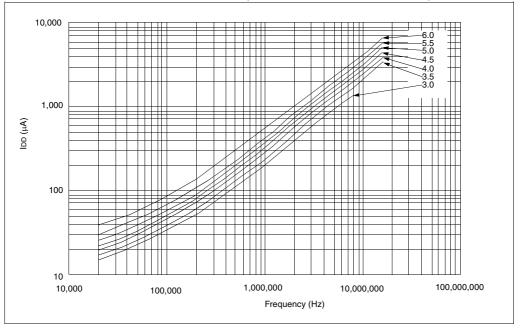


FIGURE 16-14: MAXIMUM IDD vs. FREQUENCY (EXTERNAL CLOCK, -55° TO +125°C)

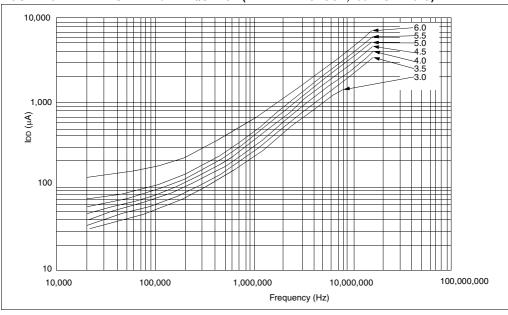


FIGURE 16-15: WDT TIMER TIME-OUT PERIOD vs. VDD

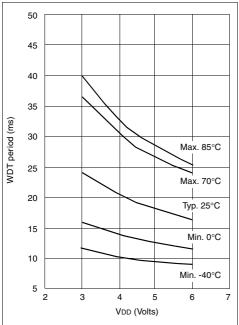
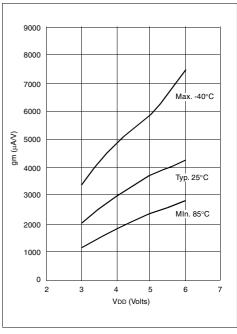


FIGURE 16-16: TRANSCONDUCTANCE (gm)
OF HS OSCILLATOR vs. VDD



Data based on matrix samples. See first page of this section for details.

FIGURE 16-17: TRANSCONDUCTANCE (gm)
OF LP OSCILLATOR vs. VDD

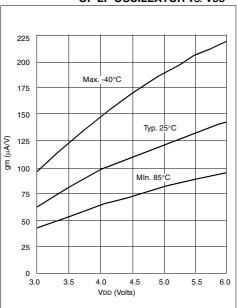


FIGURE 16-18: TRANSCONDUCTANCE (gm)
OF XT OSCILLATOR vs. VDD

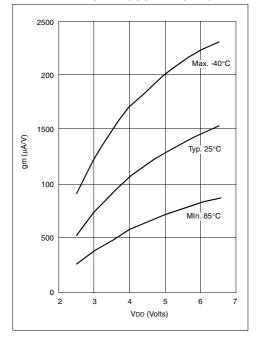


FIGURE 16-19: IOH VS. VOH, VDD = 3V

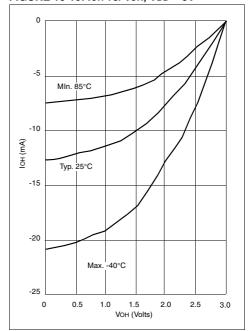


FIGURE 16-20: IOH VS. VOH, VDD = 5V

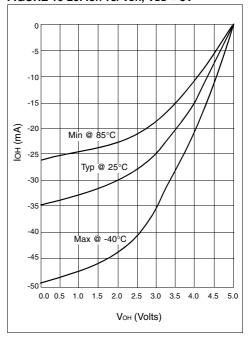


FIGURE 16-21: IOL VS. VOL, VDD = 3V

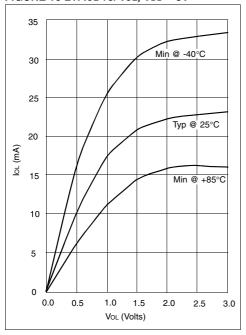


FIGURE 16-22: IOL VS. VOL, VDD = 5V

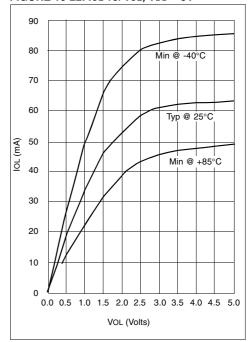


TABLE 16-2: INPUT CAPACITANCE*

Pin Name	Typical Cap	acitance (pF)
	18L PDIP	18L SOIC
RA port	5.0	4.3
RB port	5.0	4.3
MCLR	17.0	17.0
OSC1/CLKIN	4.0	3.5
OSC2/CLKOUT	4.3	3.5
TOCKI	3.2	2.8

*All capacitance values are typical at 25°C. A part to part variation of $\pm 25\%$ (three standard deviations) should be taken into account.

| Applicable Devices | 61 | 62 | 62A | R62 | 63 | R63 | 64 | 64A | R64 | 65 | 65A | R65 | 66 | 67 | NOTES:

17.0 ELECTRICAL CHARACTERISTICS FOR PIC16C62/64

Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +85°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current, IIK (VI < 0 or VI > VDD)	±20 mA
Output clamp current, lok (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE* (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE* (combined)	200 mA
Maximum current sunk by PORTC and PORTD* (combined)	200 mA
Maximum current sourced by PORTC and PORTD* (combined)	200 mA
* PORTD and PORTE not available on the PIC16C62	

^{*} PORTD and PORTE not available on the PIC16C62.

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 17-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C62-04 PIC16C64-04	PIC16C62-10 PIC16C64-10	PIC16C62-20 PIC16C64-20	PIC16LC62-04 PIC16LC64-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μ A max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq:4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 µA max. at 4V Freq:4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 3.8 mA max. at 5.5V IPD: 21 μ A max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq:4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 13.5 μA max. at 3.0V Freq: 4 MHz max.	
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq:4 MHz max.	VDD: $4.5V$ to $5.5V$ IDD: 15 mA max. at $5.5V$ IPD: 1.5 μ A typ. at $4.5V$ Freq: 10 MHz max.	VDD: $4.5V$ to $5.5V$ IDD: 30 mA max. at $5.5V$ IPD: 1.5 μ A typ. at $4.5V$ Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 μ A typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq:200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 13.5 μA max. at 3.0V Freq:200 kHz max.	VDD: 3.0V to 6.0V IDD: 48 μ A max. at 32 kHz, 3.0V IPD:13.5 μ A max. at 3.0V Freq:200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - \sum IOH} + \sum {(VDD-VOH) x IOH} + \sum (Vol x IOL)

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

17.1 DC Characteristics: PIC16C62/64-04 (Commercial, Industrial)

PIC16C62/64-10 (Commercial, Industrial) PIC16C62/64-20 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

DC CHARACTERISTICS Standard Operating Conditions (unless otherwise stated)

Operating temperature -40° C $\leq TA \leq +85^{\circ}$ C for industrial and

Sportating to				0° C \leq TA \leq +70°C for commercial			
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-		V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5.0	mA	XT, RC, osc configuration FOSC = 4 MHz, VDD = 5.5V (Note 4)
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V
D020 D021 D021A	Power-down Current (Note 3, 5)	IPD	- - -	10.5 1.5 1.5	42 21 24	μΑ μΑ μΑ	VDD = 4.0V, WDT enabled, -40°C to +85°C VDD = 4.0V, WDT disabled, -0°C to +70°C VDD = 4.0V, WDT disabled, -40°C to +85°C

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

17.2 DC Characteristics: PIC16LC62/64-04 (Commercial, Industrial)

DC CHA	ARACTERISTICS	Standa Operatir	•	•	-40	°C ≤	Inless otherwise stated) TA ≤ +85°C for industrial and
Param	Characteristic	Sym Min Typ†			0°C Max	; ≤ Units	Ta ≤ +70°C for commercial Conditions
No.		-					
D001	Supply Voltage	VDD	3.0	-	6.0	٧	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	٧	
D003	VDD start voltage to ensure internal Power- on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration Fosc = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μΑ	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled
D020	Power-down Current	IPD	-	7.5	30	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021	(Note 3, 5)		-	0.9	13.5	μA	VDD = 3.0V, WDT disabled, 0°C to +70°C
D021A			-	0.9	18	μΑ	VDD = 3.0V, WDT disabled, -40°C to +85°C

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

17.3 DC Characteristics: PIC16C62/64-04 (Commercial, Industrial)

> PIC16C62/64-10 (Commercial, Industrial) PIC16C62/64-20 (Commercial, Industrial) PIC16LC62/64-04 (Commercial, Industrial)

> > Standard Operating Conditions (unless otherwise stated)

Operating temperature -40°C \leq TA \leq +85°C for industrial and

0°C

 \leq TA \leq +70°C for commercial Operating voltage VDD range as described in DC spec Section 17.1

		and Sec	tion 17.2				
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions
No.				†			
	Input Low Voltage						
	I/O ports	VIL					
D030	with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range
D030A			Vss	-	V8.0	V	$4.5V \le V$ DD $\le 5.5V$
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	V	
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1
	Input High Voltage						
	I/O ports	VIH					
D040	with TTL buffer		2.0	-	VDD	V	$4.5V \le V_{DD} \le 5.5V$
D040A			0.25VDD	-	VDD	V	For entire VDD range
			+ 0.8V				
D041	with Schmitt Trigger buffer		0.8VDD	-	VDD		For entire VDD range
D042	MCLR		0.8VDD	-	VDD	V	
D042A	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	200	400	μΑ	VDD = 5V, VPIN = VSS
	Input Leakage Current (Notes 2, 3)						
D060	I/O ports	lı∟	-	-	±1	μА	$Vss \leq VPIN \leq VDD, \ Pin \ at \ hi-impedance$
D061	MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \le VPIN \le VDD$
D063	OSC1		-	-	±5	μΑ	$Vss \le VPIN \le VDD$, XT, HS and
							LP osc configuration
	Output Low Voltage						
D080	I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin

These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial and DC CHARACTERISTICS 0°C < TA < +70°C for commercial Operating voltage VDD range as described in DC spec Section 17.1 and Section 17.2 Param Characteristic Sym Min Max Units Conditions Typ No. t Capacitive Loading Specs on Output D100 OSC2 pin рF In XT, HS and LP modes Cosc₂ 15 when external clock is used to drive OSC1. Cio рF D101 All I/O pins and OSC2 (in RC mode) 50 D102 Cb 400 pF SCL. SDA in I²C mode

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

17.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS	3. Tcc:st	(I ² C specifications only)
2. TppS	4 Ts	(I ² C specifications only)

T Time

Lowercase letters (pp) and their meanings:

	3-		
pp			
СС	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	\overline{WR}

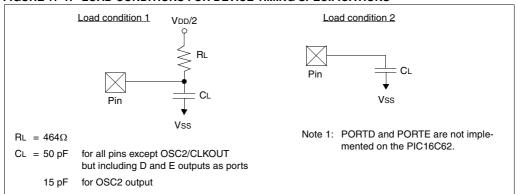
Uppercase letters and their meanings:

S			
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low

Tcc:st (I²C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 17-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



17.5 Timing Diagrams and Specifications

FIGURE 17-2: EXTERNAL CLOCK TIMING

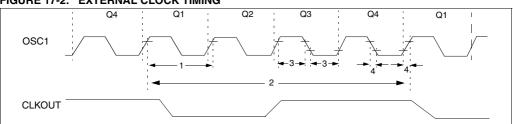


TABLE 17-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	-	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	1,000	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High	100	_	_	ns	XT oscillator
	TosH	or Low Time	2.5	_	_	μS	LP oscillator
			15			ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise	_	_	25	ns	XT oscillator
	TosF	or Fall Time	_	_	50	ns	LP oscillator
			_	_	15	ns	HS oscillator

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 17-3: CLKOUT AND I/O TIMING

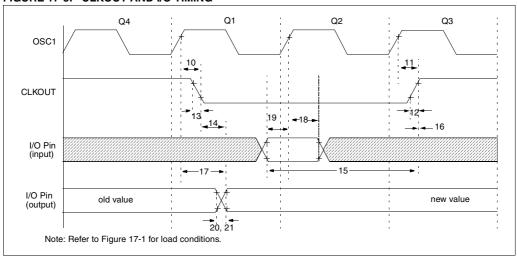


TABLE 17-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameters	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑	_	75	200	ns	Note 1	
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time	_	35	100	ns	Note 1	
14*	TckL2ioV	CLKOUT ↓ to Port out valid	_	_	0.5Tcy + 20	ns	Note 1	
15*	TioV2ckH	Port in valid before CLKOUT	Tosc + 200	_	_	ns	Note 1	
16*	TckH2ioI	Port in hold after CLKOUT ↑	0	_	_	ns	Note 1	
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out	_	50	150	ns		
18*	18* TosH2ioI OSC1↑ (Q2 o	OSC1↑ (Q2 cycle) to Port	PIC16 C 62/64	100	_	_	ns	
		input invalid (I/O in hold time)	PIC16 LC 62/64	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1↑ (I/O in setup time)		0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 62/64	_	10	40	ns	
			PIC16 LC 62/64	_	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 62/64	_	10	40	ns	
			PIC16 LC 62/64	_	_	80	ns	
22††*	Tinp	INT pin high or low time		Tcy	_		ns	
23††*	Trbp	RB7:RB4 change INT high or	low time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{††} These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

FIGURE 17-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

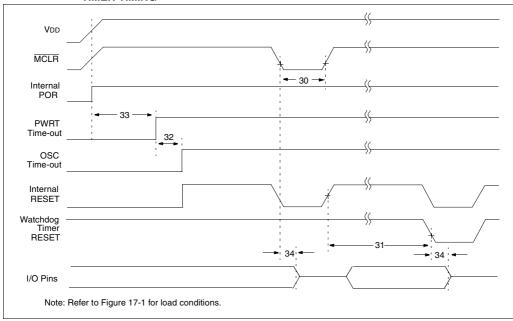


TABLE 17-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30*	TmcL	MCLR Pulse Width (low)	100	_	_	ns	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	_	_	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +85°C
34*	Tıoz	I/O Hi-impedance from MCLR Low	_	_	100	ns	

^{*} These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-5: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

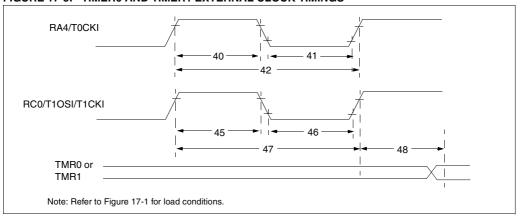


TABLE 17-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
				L					
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	l —	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler		_	_	ns	N = prescale value
					20 or TCY + 40				(2, 4,, 256)
					N				
45*	Tt1H	T1CKI High Time	Synchronous, P		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	46* Tt1L		Synchronous, P	rescaler = 1	0.5TCY + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_		ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	-	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100	_	_	ns	
	Ft1		put frequency range		DC	_	200	kHz	
		*	by setting bit T1OSCEN)						
48	TCKEZtmr1	Delay from external	•		2Tosc	_	7Tosc	-	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-6: CAPTURE/COMPARE/PWM TIMINGS (CCP1)

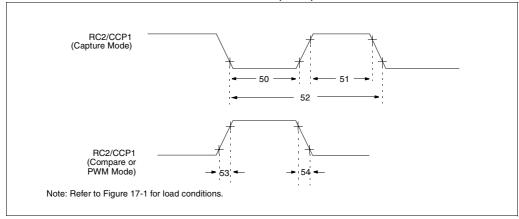


TABLE 17-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*			No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time	With Prescaler	PIC16 C 62/64	10	_	_	ns	
				PIC16 LC 62/64	20	_	_	ns	
51*			No Prescaler		0.5Tcy + 20	_	_	ns	
	input high time	input high time	With Prescaler	PIC16 C 62/64	10	_	_	ns	
				PIC16 LC 62/64	20	_	_	ns	
52*	TccP	CCP1 input period			3Tcy + 40 N	_	_	ns	N = prescale value (1,4 or 16)
53	TccR	CCP1 output rise time	9	PIC16 C 62/64		10	25	ns	
				PIC16 LC 62/64	_	25	45	ns	
54	54 TccF CCP1 output fall time		PIC16 C 62/64	_	10	25	ns		
				PIC16 LC 62/64	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-7: PARALLEL SLAVE PORT TIMING (PIC16C64)

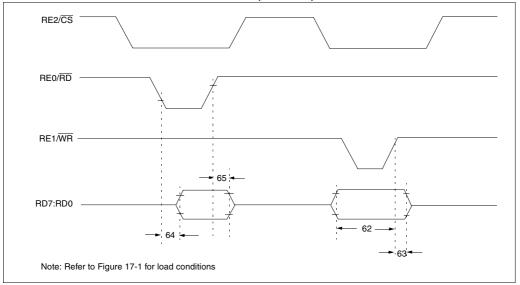


TABLE 17-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C64)

Parameter No.	Sym	Characteristic			Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before WR↑ or CS	20	_	_	ns		
63*	TwrH2dtl	WR↑ or CS↑ to data–in invalid	PIC16 C 64	20	_	_	ns	
		(hold time)	PIC16 LC 64	35	_	_	ns	
64	TrdL2dtV	RD↓ and CS↓ to data-out valid	_	_	80	ns		
65	TrdH2dtl	RD↑ or CS↑ to data-out invalid		10	_	30	ns	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-8: SPI MODE TIMING

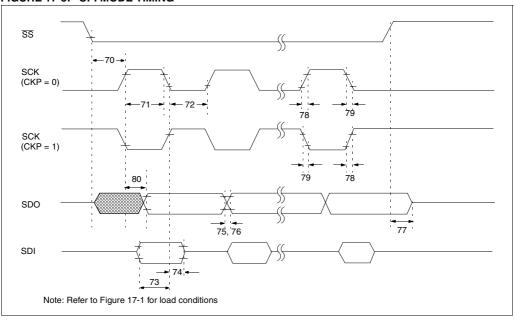


TABLE 17-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
70	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	_	_	ns	
71	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	_	_	ns	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	_	_	ns	
75	TdoR	SDO data output rise time	_	10	25	ns	
76	TdoF	SDO data output fall time	I	10	25	ns	
77	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78	TscR	SCK output rise time (master mode)	I	10	25	ns	
79	TscF	SCK output fall time (master mode)	ı	10	25	ns	
80	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 17-9: I²C BUS START/STOP BITS TIMING

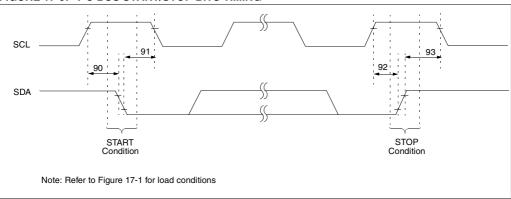


TABLE 17-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90	Tsu:sta	START condition	100 kHz mode	4700	_	_		Only relevant for repeated START
		Setup time	400 kHz mode	600	_	_	ns	condition
91	THD:STA	START condition	100 kHz mode	4000	_	_		After this period the first clock
		Hold time	400 kHz mode	600	_	_	ns	pulse is generated
92	Tsu:sto	STOP condition	100 kHz mode	4700	_	_		
		Setup time	400 kHz mode	600	_	_	ns	
93	THD:STO	STOP condition	100 kHz mode	4000	_	_		
		Hold time	400 kHz mode	600	_	_	ns	

FIGURE 17-10: I²C BUS DATA TIMING

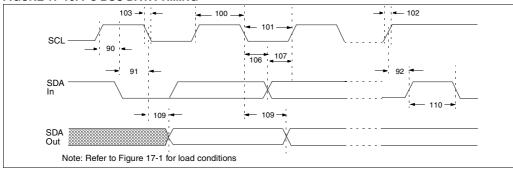


TABLE 17-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100	THIGH	Clock high time	100 kHz mode	4.0	_	μS	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
101	TLOW	Clock low time	100 kHz mode	4.7	_	μS	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
102	TR	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10 to 400 pF
103	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10 to 400 pF
90	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μS	START condition
91	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock
		time	400 kHz mode	0.6	_	μS	pulse is generated
106	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2
			400 kHz mode	100	_	ns	
92	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μs	
		time	400 kHz mode	0.6	_	μS	
109	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode	_	_	ns	
110	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3	_	μS	before a new transmission can start
	Cb	Bus capacitive loading		_	400	pF	defined region (min. 200 no) of

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max. + tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

PIC16C6X

 Applicable Devices
 61
 62
 62A
 R62
 63
 R63
 64
 64A
 R64
 65
 65A
 R65
 66
 67

NOTES:

18.0 ELECTRICAL CHARACTERISTICS FOR PIC16C62A/R62/64A/R64

Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	
Maximum current into VDD pin	250 mA
Input clamp current, IiK (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loκ (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sunk by PORTC and PORTD (combined)	200 mA
Maximum current sourced by PORTC and PORTD (combined)	200 mA

Note 1: Power dissipation is calculated as follows: Pdis = VDD $x \{IDD - \sum IOH\} + \sum \{(VDD-VOH) \ x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VDD-VOH) x \ IOH\} + \sum (VOI \ x \ IOL) \} = VDD x \{IDD - \sum IOH\} + \sum (VOI \ x \ IOH) + \sum ($

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 18-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C62A-04 PIC16CR62-04 PIC16C64A-04 PIC16CR64-04	PIC16C62A-10 PIC16CR62-10 PIC16C64A-10 PIC16CR64-10	PIC16C62A-20 PIC16CR62-20 PIC16C64A-20 PIC16CR64-20	PIC16LC62A-04 PIC16LCR62-04 PIC16LC64A-04 PIC16LCR64-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq:4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq:4 MHz max.
XT	VDD: $4.0V$ to $6.0V$ IDD: 5 mA max. at $5.5V$ IPD: $16~\mu A$ max. at $4V$ Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.0 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: $5 \mu A$ max. at 3.0V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 4 MHz max.		VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

DC Characteristics:

18.1

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

TP -----

PIC16C62A/R62/64A/R64-04 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-10 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-20 (Commercial, Industrial, Extended)

				•		•	unless otherwise stated)			
DC CHA	RACTERISTICS	Operatir	ng temp	erature			\leq TA \leq +125°C for extended,			
DC CITA	INACTERISTICS	-40°C \leq TA \leq +85°C for industrial and								
					0°0	2 ≤	≤ TA ≤ +70°C for commercial			
Param	Characteristic	Sym	Min	Typ†	Max	Units	Conditions			
No.										
D001	Supply Voltage	VDD	4.0	-	6.0	V	XT, RC and LP osc configuration			
D001A			4.5	-	5.5	V	HS osc configuration			
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V				
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details			
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details			
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	V	BODEN bit in configuration word enabled			
			3.7	4.0	4.4	V	Extended Range Only			
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC, osc configuration Fosc = 4 MHz, VDD = 5.5V (Note 4)			
D013			-	10	20	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V			
D015*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μА	BOR enabled, VDD = 5.0V			
D020	Power-down Current (Note	IPD	-	10.5	42	μА	VDD = 4.0V, WDT enabled, -40°C to +85°C			
D021	3, 5)		-	1.5	16	μΑ	VDD = 4.0V, WDT disabled, -0°C to +70°C			
D021A			-	1.5	19	μΑ	VDD = 4.0V, WDT disabled, -40°C to +85°C			
D021B			-	2.5	19	μA	VDD = 4.0V, WDT disabled, -40°C to +125°C			
D023*	Brown-out Reset Current (Note 6)	Δ IBOR	-	350	425	μА	BOR enabled, VDD = 5.0V			

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

18.2 DC Characteristics: PIC16LC62A/R62/64A/R64-04 (Commercial, Industrial)

			•	-		•	ınless otherwise stated)
DC CHA	RACTERISTICS	Operatir	ng temp	perature			TA ≤ +85°C for industrial and
	1	1		1	0°C		TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D001	Supply Voltage	VDD	2.5	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	٧	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	٧	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	V	BODEN bit in configuration word enabled
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μΑ	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μΑ	BOR enabled, VDD = 5.0V
D020	Power-down Current	IPD	-	7.5	30	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021	(Note 3, 5)		-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, 0°C to +70°C
D021A			-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, -40°C to +85°C
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μΑ	BOR enabled, VDD = 5.0V

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD
 - MCLR = VDD; WDT enabled/disabled as specified.
 - 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
 - 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

18.3 DC Characteristics:

DC CHARACTERISTICS

PIC16C62A/R62/64A/R64-04 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-10 (Commercial, Industrial, Extended) PIC16C62A/R62/64A/R64-20 (Commercial, Industrial, Extended) PIC16LC62A/R62/64A/R64-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended,

-40°C \leq TA \leq +85°C for industrial and 0°C \leq TA \leq +70°C for commercial

Operating voltage VDD range as described in DC spec Section 18.1 and

		Section	18.2				
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions
No.				†			
	Input Low Voltage						
	I/O ports	VIL					
D030	with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range
D030A			Vss	-	V8.0	V	$4.5V \le VDD \le 5.5V$
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	V	
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1
	Input High Voltage						
	I/O ports	VIH		-			
D040	with TTL buffer		2.0	-	VDD	V	$4.5V \le V_{DD} \le 5.5V$
D040A			0.25VDD	-	VDD	V	For entire VDD range
			+ 0.8V				
D041	with Schmitt Trigger buffer		0.8VDD	-	VDD	V	For entire VDD range
D042	MCLR		0.8VDD	-	VDD	V	
D042A	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	250	400	μΑ	VDD = 5V, VPIN = VSS
	Input Leakage Current (Notes 2, 3)						
D060	I/O ports	lıL	-	-	±1	μА	Vss \leq VPIN \leq VDD, Pin at hi-impedance
D061	MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \le VPIN \le VDD$
D063	OSC1		-	-	±5	μA	$Vss \le VPIN \le VDD$, XT, HS and LP
							osc configuration
	Output Low Voltage						
D080	I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$
D080A			-	-	0.6	V	IOL = 7.0 mA, VDD = 4.5V, -40°C to +125°C
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V, -40°C to +125°C

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended,

-40°C \leq TA \leq +85°C for industrial and 0°C \leq TA \leq +70°C for commercial

Operating voltage VDD range as described in DC spec Section 18.1 and

Section 18.2

		Occion	10.2				
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions
No.				†			
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C
D090A			VDD-0.7	-	-	V	$IOH = -2.5 \text{ mA}, VDD = 4.5V, -40^{\circ}C \text{ to } +125^{\circ}C$
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = $4.5V$, -40° C to $+85^{\circ}$ C
D092A			VDD-0.7	-	-	V	$IOH = -1.0 \text{ mA}, VDD = 4.5V, $ $-40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}$
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin
	Capacitive Loading Specs on Output Pins						
D100	OSC2 pin	Cosc ₂	-	-	15		In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF	
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF	

^{*} These parameters are characterized but not tested.

DC CHARACTERISTICS

- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - 2: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

Timing Parameter Symbology 18.4

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS	3. Tcc:st	(I ² C specifications only)
2. TppS	4. Ts	(I ² C specifications only)

				(
1	Γ			
	F	Frequency	Т	Time

Lowerd	case letters (p	p) and their meanings:	
pp			
CC	CCP1		

pp			
СС	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	t0	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
	1.0. 1.0.1.		

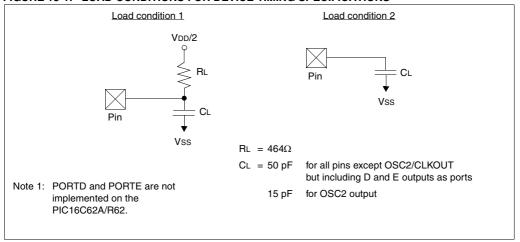
Uppercase letters and their meanings:

S			
F	Fall	Р	Period
Н	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low

Tcc:st (I²C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 18-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



18.5 <u>Timing Diagrams and Specifications</u>

FIGURE 18-2: EXTERNAL CLOCK TIMING

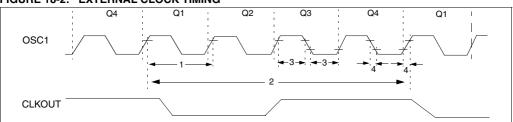


TABLE 18-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency					
		(Note 1)	DC	_	4	MHz	XT and RC osc mode
			DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	100	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μS	LP oscillator
			15	_	_	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
			_	_	15	ns	HS oscillator

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 18-3: CLKOUT AND I/O TIMING

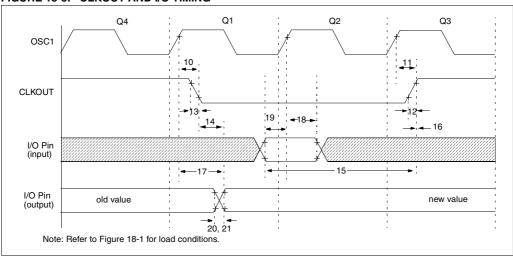


TABLE 18-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameters	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	75	200	ns	Note 1
12*	TckR	CLKOUT rise time	_	35	100	ns	Note 1	
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid		_	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		Tosc + 200	_	_	ns	Note 1
16*	TckH2ioI	Port in hold after CLKOUT ↑		0	-		ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out va	lid	_	50	150	ns	
18*	TosH2ioI	OSC1 [↑] (Q2 cycle) to Port input invalid (I/O in hold time)	PIC16 C 62A/ R62/64A/R64	100			ns	
			PIC16 LC 62A/ R62/64A/R64	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in	setup time)	0	_	_	ns	
20*	TioR	Port output rise time	PIC16 C 62A/ R62/64A/R64	_	10	40	ns	
			PIC16 LC 62A/ R62/64A/R64	_	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 62A/ R62/64A/R64	_	10	40	ns	
			PIC16 LC 62A/ R62/64A/R64	_	-	80	ns	
22††*	Tinp	RB0/INT pin high or low time		Tcy	_	_	ns	
23††*	Trbp	RB7:RB4 change int high or low	time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{††} These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x TOSC.

FIGURE 18-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

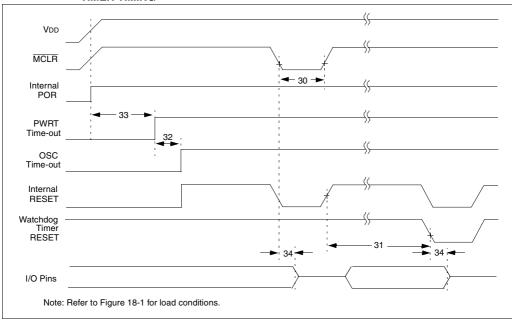


FIGURE 18-5: BROWN-OUT RESET TIMING



TABLE 18-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	1	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	_	_	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT Reset	_	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	_	_	μs	VDD ≤ BVDD (param. D005)

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 18-6: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

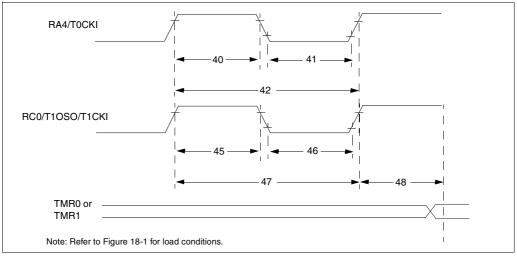


TABLE 18-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic				Тур†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	TtOL	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	_	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	rescaler = 1	0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100	_	_	ns	
	Ft1	Timer1 oscillator inp (oscillator enabled by			DC	_	200	kHz	
48	TCKEZtmr	Delay from external			2Tosc	 	7Tosc	<u> </u>	

^{*} These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 18-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1)

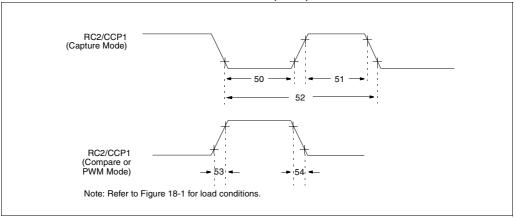


TABLE 18-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1)

Parameter No.	Sym	Characteristic				Тур†	Max	Units	Conditions
50*	TccL	CCP1	No Prescaler		0.5Tcy + 20	_		ns	
		input low time	With Prescaler	PIC16 C 62A/R62/ 64A/R64	10	_	1	ns	
				PIC16 LC 62A/R62/ 64A/R64	20	_	1	ns	
51*	ТссН	CCP1	No Prescaler		0.5Tcy + 20	_	-	ns	
	input high time		With Prescaler	PIC16 C 62A/R62/ 64A/R64	10	_	1	ns	
				PIC16 LC 62A/R62/ 64A/R64	20	_	-	ns	
52*	TccP	CCP1 input period	t		3Tcy + 40 N	_	1	ns	N = prescale value (1,4 or 16)
53*	TccR	CCP1 output rise	time	PIC16 C 62A/R62/ 64A/R64	_	10	25	ns	
				PIC16 LC 62A/R62/ 64A/R64	_	25	45	ns	
54*	TccF			PIC16 C 62A/R62/ 64A/R64	-	10	25	ns	
				PIC16 LC 62A/R62/ 64A/R64	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 18-8: PARALLEL SLAVE PORT TIMING (PIC16C64A/R64)

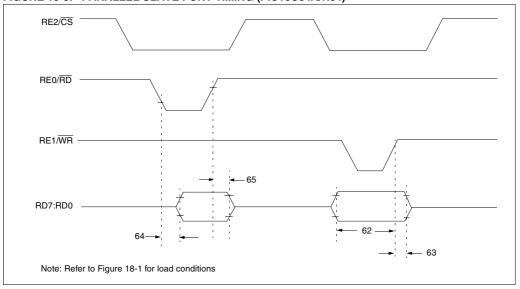


TABLE 18-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C64A/R64)

Parameter No.	Sym	Characteristic			Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before WR↑ or CS↑ (setup time)		20	_	_	ns	
				25	_	_	ns	Extended Range Only
63*	TwrH2dtl	WR↑ or CS↑ to data–in invalid (hold	PIC16 C 64A/R64	20	_	_	ns	
		time)	PIC16 LC 64A.R64	35	_	_	ns	
64	TrdL2dtV	RD↓ and CS↓ to data–out valid		_	_	80	ns	
				_	_	90	ns	Extended Range Only
65*	TrdH2dtl	RD↑ or CS↑ to data-out invalid		10	_	30	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 18-9: SPI MODE TIMING

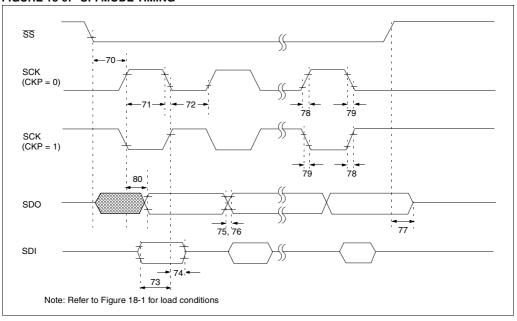


TABLE 18-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Sym Characteristic Min		Тур†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	_	_	ns	
71*	TscH	SCK input high time (slave mode)		ns			
72*	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK 50 — — edge		ns			
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK 50 — — edge		_	ns		
75*	TdoR	SDO data output rise time	1	10	25	ns	
76*	TdoF	SDO data output fall time	I	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)	I	10	25	ns	
79*	TscF	SCK output fall time (master mode)	ı	10	25	ns	
80*	TscH2doV, SDO data output valid after SCK TscL2doV edge		_	_	50	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 18-10: I²C BUS START/STOP BITS TIMING

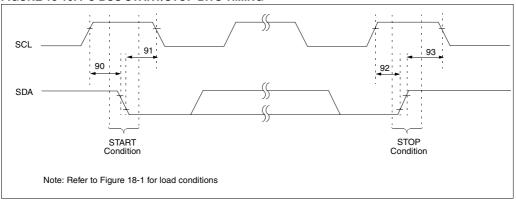


TABLE 18-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90*	Tsu:sta	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	_	_		condition
91*	THD:STA	START condition	100 kHz mode	4000	_	_	ns	After this period the first clock
		Hold time	400 kHz mode	600	_	_	113	pulse is generated
92*	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns	
		Setup time	400 kHz mode	600	_	_	113	
93*	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns	
		Hold time	400 kHz mode	600	_	_	113	

^{*}These parameters are characterized but not tested.

FIGURE 18-11: I²C BUS DATA TIMING

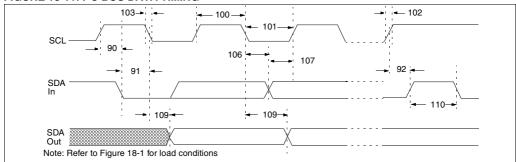


TABLE 18-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	Thigh	Clock high time	100 kHz mode	4.0	_	μs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Device must operate at a minimum of 10 MHz
			SSP Module	1.5Tcy	_		
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	_	μS	Device must operate at a minimum of 10 MHz
			SSP Module	1.5Tcy	_		
102*	TR	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μS	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock
		time	400 kHz mode	0.6	_	μS	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2
			400 kHz mode	100	_	ns	
92*	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μS	
		time	400 kHz mode	0.6	_	μS	
109*	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode	_	_	ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3	_	μS	before a new transmission can start
	Cb	Bus capacitive loading			400	pF	

^{*} These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

NOTES:

19.0 ELECTRICAL CHARACTERISTICS FOR PIC16C65

Absolute Maximum Ratings †

Ambient temperature under bias	55°C to +85°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	0V to +14V
Total power dissipation (Note 1)	1.0W
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	
Input clamp current, IiK (VI < 0 or VI > VDD)	±20 mA
Output clamp current, lok (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (combined)	200 mA
Maximum current sunk by PORTC and PORTD (combined)	200 mA
Maximum current sourced by PORTC and PORTD (combined)	200 mA

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - Σ IOH} + Σ {(VDD-VOH) x IOH} + Σ (VOI x IOL)

Note 2: Voltage spikes below Vss at the MCLR pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR pin rather than pulling this pin directly to Vss.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 19-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C65-04	PIC16C65-10	PIC16C65-20	PIC16LC65-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3V IPD: 800 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 μ A max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 6.0V IDD: 3.8 mA max. at 3V IPD: 800 µA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V IPD: 1.5 μA typ. at 4.5V	VDD: 4.5V to 5.5V IDD: 15 mA max. at 5.5V IPD 1.0 μA typ. at 4.5V	5.5V IPD: 1.5 μA typ. at 4.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 30 mA max. at 5.5V IPD: 1.5 μA typ. at 4.5V
LP	Freq: 4 MHz max. VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Freq: 20 MHz max. Not recommended for use in LP mode	VDD: 3.0V to 6.0V IDD: 105 μA max. at 32 kHz, 3.0V IPD: 800 μA max. at 3.0V Freq: 200 kHz max.	Freq: 20 MHz max. VDD: 3.0V to 6.0V IDD: 105 µA max. at 32 kHz, 3.0V IPD: 800 µA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

19.1 DC Characteristics: PIC16C65-04 (Commercial, Industrial)

PIC16C65-10 (Commercial, Industrial) PIC16C65-20 (Commercial, Industrial)

DC CHARACTERISTICS Standard Operating Conditions (unless otherwise stated)

Operating temperature -40°C $\leq \text{TA} \leq +85^{\circ}\text{C}$ for industrial and 0°C $< \text{TA} < +70^{\circ}\text{C}$ for commercial

		0°C ≤ IA ≤ +70°C for commercial							
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions		
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	6.0 5.5	V	XT, RC and LP osc configuration HS osc configuration		
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V			
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details		
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details		
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 5.5V (Note 4)		
D013			-	13.5	30	mA	HS osc configuration Fosc = 20 MHz, VDD = 5.5V		
D020 D021 D021A	Power-down Current (Note 3, 5)	IPD		10.5 1.5 1.5	800 800 800	μ Α μ Α μ Α	VDD = 4.0V, WDT enabled,-40°C to +85°C VDD = 4.0V, WDT disabled,-0°C to +70°C VDD = 4.0V, WDT disabled,-40°C to +85°C		

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

19.2 DC Characteristics: PIC16LC65-04 (Commercial, Industrial)

		Standar	d Ope	rating (Condi	tions (u	inless otherwise stated)	
DC CHARACTERISTICS Operating temperature -40°C ≤ TA ≤ +85°C for industrial and								
0°C ≤ Ta ≤ +70°C for commercial								
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions	
D001	Supply Voltage	VDD	3.0	-	6.0	V	LP, XT, RC osc configuration (DC - 4 MHz)	
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V		
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details	
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details	
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)	
D010A			-	22.5	105	μА	LP osc configuration FOSC = 32 kHz, VDD = 4.0V, WDT disabled	
D020	Power-down Current	IPD	-	7.5	800	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C	
D021	(Note 3, 5)		-	0.9	800	μΑ	VDD = 3.0V, WDT disabled, 0°C to +70°C	
D021A			-	0.9	800	μΑ	VDD = 3.0V, WDT disabled, -40°C to +85°C	

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,
 - MCLR = VDD; WDT enabled/disabled as specified.
 - 3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

19.3 DC Characteristics: PIC16C65-04 (Commercial, Industrial)

PIC16C65-10 (Commercial, Industrial) PIC16C65-20 (Commercial, Industrial) PIC16LC65-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

Operating temperature -40°C ≤ TA ≤ +85°C for industrial and

 $0^{\circ}C \leq TA \leq +70^{\circ}C$ for commercial Operating voltage VDD range as described in DC spec Section 19.1 and

		Section	19.2				
Param No.	Characteristic	Sym	Min	Typ †	Max	Units	Conditions
	Input Low Voltage						
	I/O ports	VIL					
D030	with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range
D030A			Vss	-	V8.0	V	$4.5V \le V_{DD} \le 5.5V$
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	V	
D032	MCLR, OSC1(in RC mode)		Vss	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1
	Input High Voltage						
	I/O ports	VIH		-			
D040	with TTL buffer		2.0	-	VDD	V	$4.5V \leq V_{DD} \leq 5.5V$
D040A			0.25VDD+ 0.8V	•	VDD	V	For entire VDD range
D041	with Schmitt Trigger buffer		0.8VDD	_	VDD		For entire VDD range
D042	MCLR		0.8VDD	-	VDD	٧	9
D042A	OSC1 (XT, HS and LP)		0.7 VDD	-	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	٧	
D070	PORTB weak pull-up current	IPURB	50	250	400	μА	VDD = 5V, VPIN = VSS
	Input Leakage Current						
	(Notes 2, 3)						
D060	I/O ports	lıL	-	-	±1	μΑ	$Vss \leq VPIN \leq VDD, \ Pin \ at \ hiimpedance$
D061	MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \le VPIN \le VDD$
D063	OSC1		-	-	±5	μА	Vss ≤ VPIN ≤ VDD, XT, HS, and LP osc configuration
	Output Low Voltage						
D080	I/O ports	Vol	-	-	0.6	V	IOL = 8.5 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5 V, -40 °C to $+85$ °C
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C
D150*	Open-Drain High Voltage	VOD	-	-	14	V	RA4 pin

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

DC CHA	RACTERISTICS	Operatir	ng tempera	ature	-40°C 0°C	` ≤ T. ≤ T.	ss otherwise stated) A ≤ +85°C for industrial and A ≤ +70°C for commercial ed in DC spec Section 19.1 and
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions
	Capacitive Loading Specs on Output Pins			•			
D100	OSC2 pin	Cosc ₂	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF	
D102	SCL. SDA in I ² C mode	Cb	-	-	400	pF	

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

19.4 **Timing Parameter Symbology**

The timing parameter symbols have been created following one of the following formats:

1. TppS2p	opS	3. Tcc:st	(I ² C specifications only)	
2. TppS		4. Ts	(I ² C specifications only)	
Т				
F	Frequency	Т	Time	
Lowerc	ase letters (pp) and their meanings:			
pp				
СС	CCP1	osc	OSC1	
ck	CLKOUT	rd	RD	
cs	CS	rw	RD or WR	
di	SDI	sc	SCK	
do	SDO	SS	SS	
dt	Data in	t0	T0CKI	
io	I/O port	t1	T1CKI	
mc	MCLR	wr	WR	
Upperc	ase letters and their meanings:	·		
S				
F	Fall	P	Period	
Н	High	R	Rise	
1	Invalid (Hi-impedance)	V	Valid	
L	Low	Z	Hi-impedance	
I ² C only				

Bus free Tcc:st (I²C specifications only)

output access

AA

BUF

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

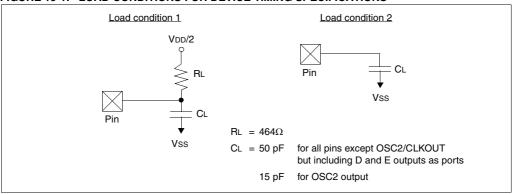
High

Low

High

Low

FIGURE 19-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



19.5 Timing Diagrams and Specifications

FIGURE 19-2: EXTERNAL CLOCK TIMING

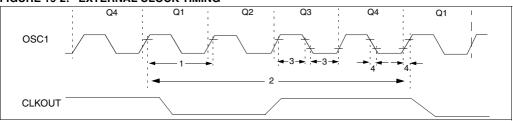


TABLE 19-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC	_	4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	50	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μS	LP oscillator
			15			ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or	_		25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
			_		15	ns	HS oscillator

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 19-3: CLKOUT AND I/O TIMING

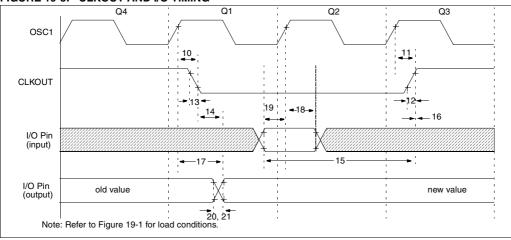


TABLE 19-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid		_		0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		0.25Tcy + 25		_	ns	Note 1
16*	TckH2ioI	Port in hold after CLKOUT ↑		0	_	_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out v	/alid	_	50	150	ns	
18*	TosH2ioI	OSC1↑ (Q2 cycle) to Port	PIC16 C 65	100	_	_	ns	
		input invalid (I/O in hold time)	PIC16 LC 65	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O	in setup time)	0	-	_	ns	
20*	TioR	Port output rise time	PIC16 C 65	_	10	25	ns	
			PIC16 LC 65	_		60	ns	
21*	TioF	Port output fall time	PIC16 C 65	_	10	25	ns	
			PIC16 LC 65	_		60	ns	
22††*	Tinp	RB0/INT pin high or low time		Tcy	_	_	ns	
23††*	Trbp	RB7:RB4 change int high or lo	w time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested

^{††} These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

FIGURE 19-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

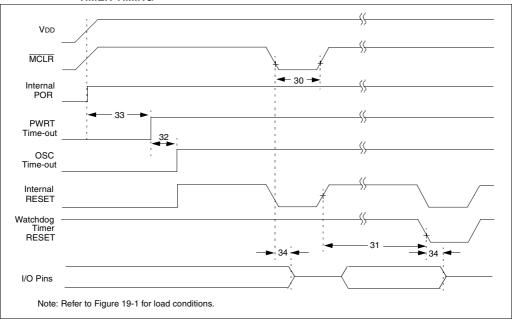


TABLE 19-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
30*	TmcL	MCLR Pulse Width (low)	100	_	_	ns	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024Tosc	_	_	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period or WDT reset	28	72	132	ms	VDD = 5V, -40°C to +85°C
34	Tıoz	I/O Hi-impedance from MCLR Low	_	_	100	ns	

^{*} These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-5: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

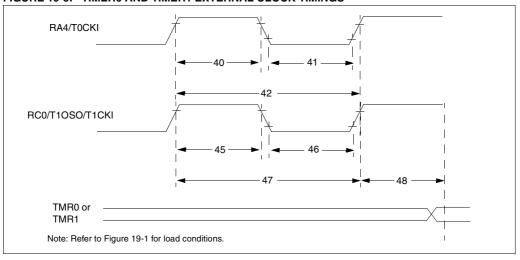


TABLE 19-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	/idth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	_	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	rescaler = 1	0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100	-	_	ns	
	Ft1	Timer1 oscillator inp			DC	_	200	kHz	
48	TOVEZIMAN	(oscillator enabled to 1 Delay from external			2Tosc		7Tosc	1	
48	ICKEZIMI	Delay from external			∠ iosc		/ 10SC	_	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-6: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

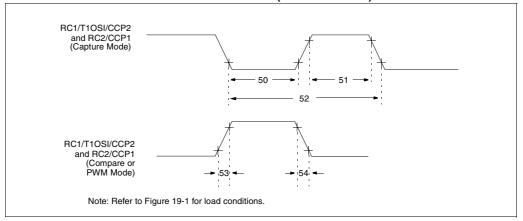


TABLE 19-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time	With Prescaler	PIC16 C 65	10	_		ns	
				PIC16 LC 65	20	_		ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_		ns	
		input high time	With Prescaler	PIC16 C 65	10	_		ns	
				PIC16 LC 65	20	_	_	ns	
52*	TccP	CCP1 and CCP2 in	nput period		3Tcy + 40 N	_	-	ns	N = prescale value (1,4, or 16)
53	TccR	CCP1 and CCP2 of	utput rise time	PIC16 C 65	_	10	25	ns	
				PIC16 LC 65	_	25	45	ns	
54	TccF	CCP1 and CCP2 of	utput fall time	PIC16 C 65	_	10	25	ns	
				PIC16 LC 65	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-7: PARALLEL SLAVE PORT TIMING

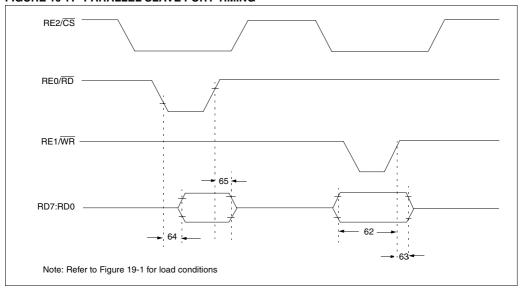


TABLE 19-7: PARALLEL SLAVE PORT REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
62	TdtV2wrH	Data in valid before WR↑ or CS↑ (setup time)		20	_	_	ns	
63*	TwrH2dtl	WR↑ or CS↑ to data–in invalid (hold	WR↑ or CS↑ to data–in invalid (hold PIC16C65		_	_	ns	
		time)	PIC16 LC 65	35	_	_	ns	
64	TrdL2dtV	RD↓ and CS↓ to data–out valid		_	_	80	ns	
65	TrdH2dtl	RD↑ or CS↑ to data–out invalid		10	_	30	ns	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-8: SPI MODE TIMING

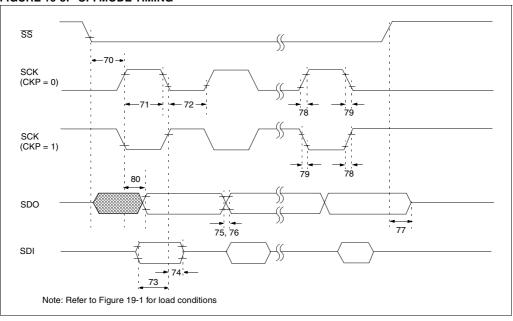


TABLE 19-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70	TssL2scH, TssL2scL	, , , , , , , , , , , , , , , , , , , ,		_	_	ns	
71	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	_	_	ns	
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	_	_	ns	
75	TdoR	SDO data output rise time	1	10	25	ns	
76	TdoF	SDO data output fall time	I	10	25	ns	
77	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78	TscR	SCK output rise time (master mode)	I	10	25	ns	
79	TscF	SCK output fall time (master mode)	ı	10	25	ns	
80	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 19-9: I²C BUS START/STOP BITS TIMING

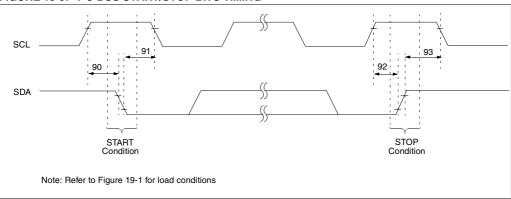


TABLE 19-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90	Tsu:sta	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	_	_	115	condition
91	THD:STA	START condition	100 kHz mode	4000	_	_	ns	After this period the first clock
		Hold time	400 kHz mode	600	_	_	115	pulse is generated
92	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns	
		Setup time	400 kHz mode	600	_	_	113	
93	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns	
		Hold time	400 kHz mode	600	_	_	115	

FIGURE 19-10: I²C BUS DATA TIMING

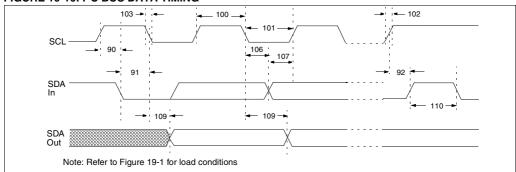


TABLE 19-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100	THIGH	Clock high time	100 kHz mode	4.0	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Devce must operate at a minimum of 10 MHz
			SSP Module	1.5Tcy	_		
101	TLOW	Clock low time	100 kHz mode	4.7	_	μs	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
102	TR	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μS	START condition
91	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock
		time	400 kHz mode	0.6	_	μs	pulse is generated
106	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μs	
107	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2
			400 kHz mode	100	_	ns	
92	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μs	
		time	400 kHz mode	0.6	_	μs	
109	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode	_	_	ns	
110	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3	_	μS	before a new transmission can start
	Cb	Bus capacitive loading			400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

2: A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement tsu;DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

FIGURE 19-11: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

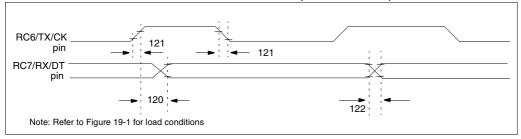


TABLE 19-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic			Тур†	Max	Units	Conditions
120	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 C 65	_	_	80	ns	
		Clock high to data out valid	PIC16 LC 65	-	_	100	ns	
121	Tckrf	Clock out rise time and fall time	PIC16 C 65		_	45	ns	
		(Master Mode)	PIC16 LC 65	-	_	50	ns	
122	Tdtrf	Data out rise time and fall time	PIC16 C 65	_	_	45	ns	
			PIC16 LC 65		_	50	ns	

t: Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 19-12: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

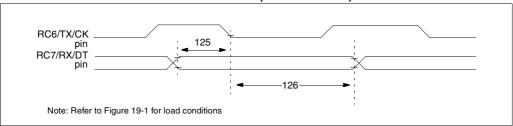


TABLE 19-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
125	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK ↓ (DT setup time)	15	_	_	ns	
126	TckL2dtl	Data hold after CK ↓ (DT hold time)	15	_	_	ns	

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

20.0 ELECTRICAL CHARACTERISTICS FOR PIC16C63/65A

Absolute Maximum Ratings (†)

•	
Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	-0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	
Total power dissipation (Note 1)	
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	
Input clamp current, Iικ (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loκ (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sunk by PORTC and PORTD (Note 3) (combined)	200 mA
Maximum current sourced by PORTC and PORTD (Note 3) (combined)	200 mA

- Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD \sum IOH} + \sum {(VDD-VOH) x IOH} + \sum (Vol x IOL)
- Note 2: Voltage spikes below Vss at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up.

 Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP pin rather than pulling this pin directly to Vss.
- Note 3: PORTD and PORTE not available on the PIC16C63.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 20-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C63-04 PIC16C65A-04	PIC16C63-10 PIC16C65A-10	PIC16C63-20 PIC16C65A-20	PIC16LC63-04 PIC16LC65A-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μ A max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V
	IPD: $1.5 \mu A$ typ. at $4.5 V$ Freq: $4 MHz$ max.	IPD 1.5 μA typ. at 4.5V Freq: 10 MHz max.	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	use iii no iiiode	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	$\begin{array}{c} \text{VDD: } 2.5\text{V to } 6.0\text{V} \\ \text{IDD: } 48~\mu\text{A max.} \\ \text{at } 32~\text{kHz, } 3.0\text{V} \\ \text{IPD: } 5~\mu\text{A max. at } 3.0\text{V} \\ \text{Freq: } 200~\text{kHz max.} \end{array}$

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

20.1 DC Characteristics: PIC16C63/65A-04 (Commercial, Industrial, Extended)

PIC16C63/65A-10 (Commercial, Industrial, Extended)

PIC16C63/65A-20 (Commercial, Industrial, Extended)

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended,

-40°C \leq TA \leq +85°C for industrial and

0° C \leq TA \leq +70 $^{\circ}$ C for commercial									
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions		
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration		
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V			
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details		
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details		
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	V	BODEN configuration bit is enabled		
			3.7	4.0	4.4	٧	Extended Range Only		
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC, osc config Fosc = 4 MHz, VDD = 5.5V (Note 4)		
D013			-	10	20	mA	HS osc config Fosc = 20 MHz, VDD = 5.5V		
D015*	Brown-out Reset Current (Note 6)	∆lbor	-	350	425	μА	BOR enabled, VDD = 5.0V		
D020	Power-down Current	IPD	-	10.5	42	μΑ	VDD = 4.0V, WDT enabled,-40°C to +85°C		
D021	(Note 3, 5)		-	1.5	16	μA	VDD = 4.0V, WDT disabled,-0°C to +70°C		
D021A			-	1.5	19	μA	VDD = 4.0V, WDT disabled, -40°C to +85°C		
D021B			-	2.5	19	μА	VDD = 4.0V, WDT disabled,-40°C to +125°C		
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μА	BOR enabled, VDD = 5.0V		

- These parameters are characterized but not tested.
- Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD.

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

20.2 DC Characteristics: PIC16LC63/65A-04 (Commercial, Industrial)

DC CHA	RACTERISTICS	Inless otherwise stated) TA ≤ +85°C for industrial and TA ≤ +70°C for commercial					
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001	Supply Voltage	VDD	2.5		6.0	٧	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	V	BODEN configuration bit is enabled
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μА	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μА	BOR enabled, VDD = 5.0V
D020	Power-down Current	IPD	-	7.5	30	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021	(Note 3, 5)		-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, 0°C to +70°C
D021A			-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, -40°C to +85°C
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μА	BOR enabled, VDD = 5.0V

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,
 - MCLR = VDD; WDT enabled/disabled as specified.
 - 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
 - 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

20.3 DC Characteristics: PIC16C63/65A-04 (Commercial, Industrial, Extended)

PIC16C63/65A-10 (Commercial, Industrial, Extended)

PIC16C63/65A-20 (Commercial, Industrial, Extended)

PIC16LC63/65A-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended,

 -40° C \leq TA \leq +85°C for industrial and 0° C < TA < +70°C for commercial

Operating voltage $\mbox{\em VDD}$ range as described in DC spec Section 20.1 and

Section 20.2

Section 20.2 Param Characteristic Sym Min Typ Max Units Conditions								
Characteristic	Sym	Min		Max	Units	Conditions		
			†					
Input Low Voltage								
I/O ports	VIL							
with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range		
		Vss	-	V8.0	V	$4.5V \le V_{DD} \le 5.5V$		
with Schmitt Trigger buffer		Vss	-	0.2VDD	V			
MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD	V			
OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1		
Input High Voltage								
I/O ports	VIH		-					
with TTL buffer		2.0	-	VDD	V	$4.5V \le V_{DD} \le 5.5V$		
		0.25VDD	-	VDD	V	For entire VDD range		
		+ 0.8V						
with Schmitt Trigger buffer		0.8Vpp	_	Vpp	V	For entire VDD range		
		0.8Vpp	_	Vpp	V	3		
			_	VDD	V	Note1		
,		0.9Vpp	_	VDD	V			
PORTB weak pull-up current	IPURB	50	250	400	μΑ	VDD = 5V, VPIN = VSS		
Input Leakage Current (Notes 2, 3)								
I/O ports	lı∟	-	-	±1	μΑ	Vss ≤ VPIN ≤ VDD, Pin at hi-		
					-	impedance		
MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \le VPIN \le VDD$		
OSC1		-	-	±5	μΑ	Vss ≤ VPIN ≤ VDD, XT, HS and		
						LP osc configuration		
Output Low Voltage								
I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V,		
					.,	-40°C to +85°C		
		-	-	0.6	V	IOL = 7.0 mA , VDD = 4.5V , -40°C to $+125^{\circ}\text{C}$		
OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA, VDD = 4.5V,		
						-40°C to +85°C		
		-	-	0.6	V	IOL = 1.2 mA , VDD = 4.5V , -40°C to $+125^{\circ}\text{C}$		
	Input Low Voltage I/O ports with TTL buffer with Schmitt Trigger buffer MCLR, OSC1 (in RC mode) OSC1 (in XT, HS and LP) Input High Voltage I/O ports with TTL buffer with Schmitt Trigger buffer MCLR OSC1 (XT, HS and LP) OSC1 (in RC mode) PORTB weak pull-up current Input Leakage Current (Notes 2, 3) I/O ports MCLR, RA4/T0CKI OSC1 Output Low Voltage I/O ports	Input Low Voltage I/O ports with TTL buffer with Schmitt Trigger buffer MCLR, OSC1 (in RC mode) OSC1 (in XT, HS and LP) Input High Voltage I/O ports with TTL buffer with Schmitt Trigger buffer MCLR OSC1 (XT, HS and LP) OSC1 (in RC mode) PORTB weak pull-up current Input Leakage Current (Notes 2, 3) I/O ports MCLR, RA4/T0CKI OSC1 Output Low Voltage I/O ports VIL VIL VIH VIH VIH VIH VIH VIH	Characteristic Sym Min	Characteristic Sym Min Typ	Characteristic Sym Min Typ Max	Characteristic Sym Min Typ Max Units		

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended, $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial and

0°C ≤ TA ≤ +70°C for commercial

Operating voltage VDD range as described in DC spec Section 20.1 and

	Section 20.2									
Param	n Characteristic Sym Min Typ Ma			Max	Units	Conditions				
No.				†						
	Output High Voltage									
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5 V, -40 °C to $+85$ °C			
D090A			VDD-0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5 V, -40 °C to $+125$ °C			
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5 V, -40 °C to $+85$ °C			
D092A			VDD-0.7	-	-	V	IOH = -1.0 mA, VDD = 4.5V, -40°C to +125°C			
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin			
	Capacitive Loading Specs on Output Pins									
D100	OSC2 pin	Cosc ₂	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.			
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF				
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF				

^{*} These parameters are characterized but not tested.

DC CHARACTERISTICS

- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

20.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS	3. Tcc:st	(I ² C specifications only)
2. TppS	4. Ts	(I ² C specifications only)
Т		
F Frequency	Т	Time
Lowercase letters (pp) and their meanings:		

	saco iottoro (pp) ana trion moarningo.		
pp			
СС	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	tO	T0CKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR

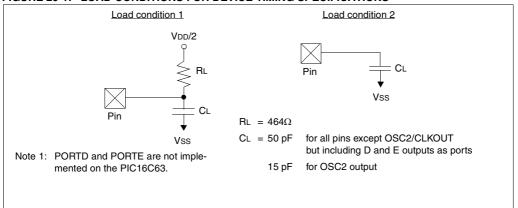
Uppercase letters and their meanings:

S			
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low

Tcc:st (I²C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 20-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



20.5 Timing Diagrams and Specifications

FIGURE 20-2: EXTERNAL CLOCK TIMING

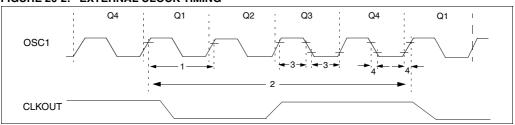


TABLE 20-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC		4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC		4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250		_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
3*	TosL,	External Clock in (OSC1) High or	100	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μS	LP oscillator
			15	_	_	ns	HS oscillator
4*	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
			_	_	15	ns	HS oscillator

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 20-3: CLKOUT AND I/O TIMING

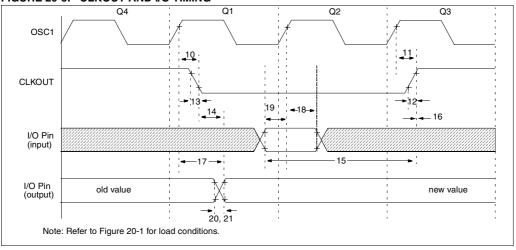


TABLE 20-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓		_	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid		_	-	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT ↑		Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑	Port in hold after CLKOUT ↑			_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out val	lid	_	50	150	ns	
18*	TosH2iol	OSC1↑ (Q2 cycle) to Port input	PIC16 C 63/65A	100		_	ns	
		invalid (I/O in hold time)	PIC16 LC 63/65A	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in	setup time)	0		_	ns	
20*	TioR	Port output rise time	PIC16 C 63/65A	_	10	40	ns	
			PIC16 LC 63/65A	_	_	80	ns	
21*	TioF	Port output fall time	Port output fall time PIC16 C 63/65A		10	40	ns	
			PIC16 LC 63/65A	_	_	80	ns	
22††*	Tinp	INT pin high or low time		Tcy	-	_	ns	
23††*	Trbp	RB7:RB4 change INT high or low	time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{††} These parameters are asynchronous events not related to any internal clock edge.

FIGURE 20-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

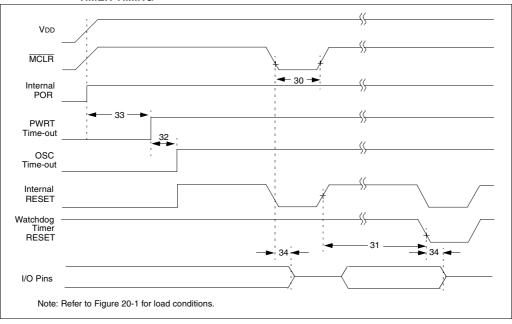


FIGURE 20-5: BROWN-OUT RESET TIMING

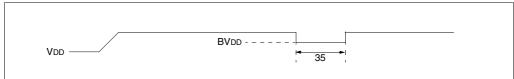


TABLE 20-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	_		μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc		_	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	_	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	_	_	μs	VDD ≤ BVDD (D005)

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-6: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

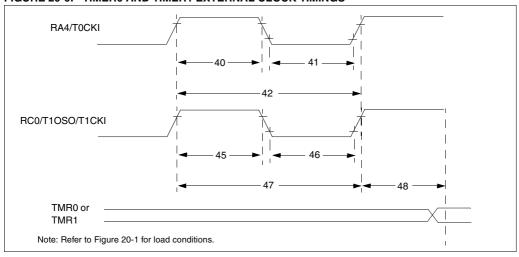


TABLE 20-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W			0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	-	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F	rescaler = 1	0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	rescaler = 1	0.5TCY + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	-	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16LC6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100			ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b			DC	_	200	kHz	
48	TCKEZtmr1	Delay from external	clock edge to tir	ner increment	2Tosc	_	7Tosc	_	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

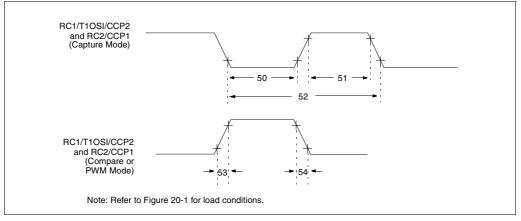


TABLE 20-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time	With Prescaler	PIC16 C 63/65A	10	_	_	ns	
				PIC16 LC 63/65A	20	_	_	ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input high time	With Prescaler	PIC16 C 63/65A	10	_	_	ns	
				PIC16 LC 63/65A	20		_	ns	
52*	TccP	CCP1 and CCP2 in	nput period		3Tcy + 40 N		-	ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 and CCP2 o	utput rise time	PIC16 C 63/65A	_	10	25	ns	
				PIC16 LC 63/65A	_	25	45	ns	
54*	TccF	CCP1 and CCP2 o	utput fall time	PIC16 C 63/65A	_	10	25	ns	
				PIC16 LC 63/65A	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-8: PARALLEL SLAVE PORT TIMING (PIC16C65A)

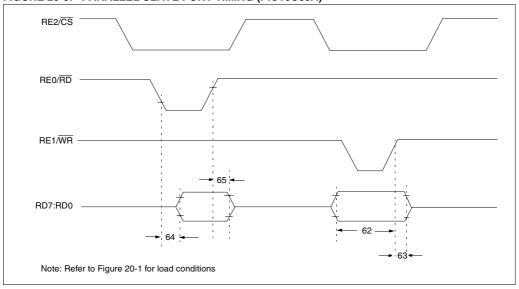


TABLE 20-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C65A)

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before WR↑ or CS↑ (setu	ıp time)	20	_	_	ns	
				25	_	_	ns	Extended Range Only
63*	TwrH2dtl	WR↑ or CS↑ to data–in invalid (hold	PIC16 C 65A	20	_	_	ns	
		time)	PIC16 LC 65A	35	_	_	ns	
64	TrdL2dtV	RD↓ and CS↓ to data–out valid		_	_	80	ns	
				-	_	90	ns	Extended Range Only
65*	TrdH2dtl	RD↑ or CS↑ to data–out invalid		10	_	30	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 20-9: SPI MODE TIMING

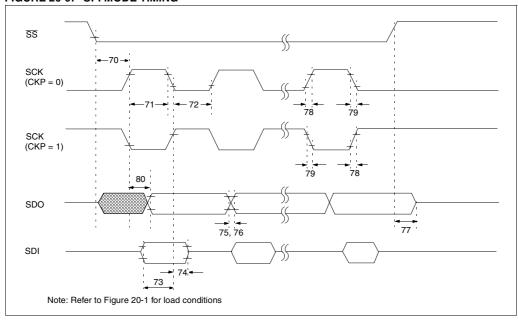


TABLE 20-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	_	_	ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	_	_	ns	
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	_	_	ns	
75*	TdoR	SDO data output rise time	_	10	25	ns	
76*	TdoF	SDO data output fall time	_	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)	_	10	25	ns	
79*	TscF	SCK output fall time (master mode)	_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 20-10: I²C BUS START/STOP BITS TIMING

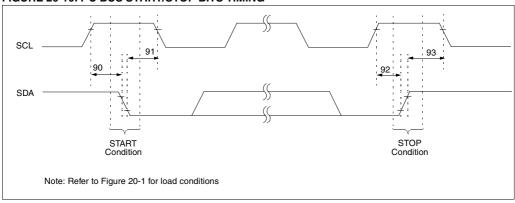


TABLE 20-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions
90*	Tsu:sta	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated START
		Setup time	400 kHz mode	600	_	_	113	condition
91*	THD:STA	START condition	100 kHz mode	4000	_	_	ns	After this period the first clock
		Hold time	400 kHz mode	600	_	_	113	pulse is generated
92*	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns	
		Setup time	400 kHz mode	600	_	-	113	
93	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns	
		Hold time	400 kHz mode	600	_	_	113	

^{*} These parameters are characterized but not tested.

FIGURE 20-11: I²C BUS DATA TIMING

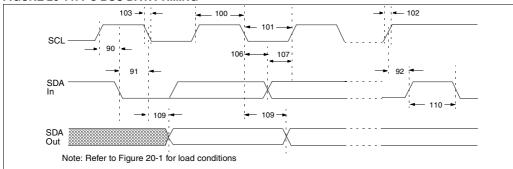


TABLE 20-10: I²C BUS DATA REQUIREMENTS

Parameter	Sym	Characteristic		Min	Max	Units	Conditions
No.							
100*	THIGH	Clock high time	100 kHz mode	4.0	_	μS	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μS	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
102*	TR	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μS	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock
		time	400 kHz mode	0.6	_	μS	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2
			400 kHz mode	100	_	ns	
92*	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μS	
		time	400 kHz mode	0.6	_	μS	
109*	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode			ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3		μS	before a new transmission can start
	Cb	Bus capacitive loading		_	400	pF	

These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

FIGURE 20-12: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

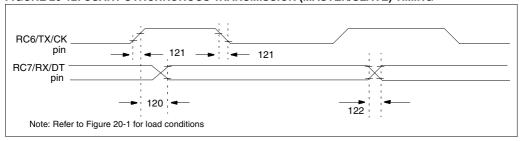


TABLE 20-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
120*	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 C 63/65A		_	80	ns	
		Clock high to data out valid	PIC16 LC 63/65A	_	_	100	ns	
121*	Tckrf	Clock out rise time and fall time	PIC16 C 63/65A		_	45	ns	
		(Master Mode)	PIC16 LC 63/65A	_	_	50	ns	
122*	Tdtrf	Data out rise time and fall time	PIC16 C 63/65A		_	45	ns	
			PIC16 LC 63/65A		_	50	ns	

These parameters are characterized but not tested.

FIGURE 20-13: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

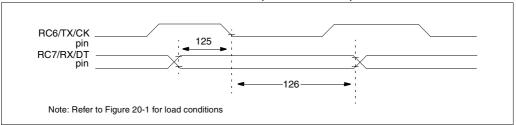


TABLE 20-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
125*	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK ↓ (DT setup time)	15	_	_	ns	
126*	TckL2dtl	Data hold after CK ↓ (DT hold time)	15	_	_	ns	

^{*} These parameters are characterized but not tested.

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

21.0 ELECTRICAL CHARACTERISTICS FOR PIC16CR63/R65

Absolute Maximum Ratings (†) Ambient temperature under bias-55°C to +125°C Storage temperature-65°C to +150°C Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)......-...-...-0.3V to (VDD + 0.3V) Voltage on VDD with respect to Vss-0.3V to +7.5V Input clamp current. IIK (VI < 0 or VI > VDD)..... Output clamp current, lox (Vo < 0 or Vo > VDD) Maximum output current sunk by any I/O pin.......25 mA Maximum output current sourced by any I/O pin Maximum current sunk by PORTA, PORTB, and PORTE (Note 3) (combined)...... Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined) Maximum current sunk by PORTC and PORTD (Note 3) (combined) Maximum current sourced by PORTC and PORTD (Note 3) (combined)......

Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD - ∑ION} + ∑ {VDD-VOH) x IOH} + ∑(VOI x IOL)

Note 2: Voltage spikes below Vss at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP pin rather than pulling this pin directly to Vss.

Note 3: PORTD and PORTE not available on the P(C16CR63).

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 21-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16CR63-04 PIC16CR65-04	PIC16CR63-10 PIC16CR65-10	PIC16CR63-20 PIC16CR65-20	PIC16LCR63-04 PIC16LCR65-04	JW Devices
RC	VDD: 4.0V to 5.5V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max)	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IRD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 5.5V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 5.5V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 5.5V IDD: 5 mA max. at 5.5V IPD: 16 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μA typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 3.0V to 5.5V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 5.5V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V
	IPD: $1.5 \mu A$ typ. at $4.5 V$ Freq: 4 MHz max.	IPD 1.5 μA typ. at 4.5V Freq: 10 MHz max.	IPD: $1.5 \mu A$ typ. at $4.5 V$ Freq: 20 MHz max.	use in the mode	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 5.5V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 3.0V to 5.5V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	$\begin{array}{c} \text{VDD: } 3.0 \text{V to } 5.5 \text{V} \\ \text{IDD: } 48 \ \mu\text{A max.} \\ \text{at } 32 \ \text{kHz, } 3.0 \text{V} \\ \text{IPD: } 5 \ \mu\text{A max. at } 3.0 \text{V} \\ \text{Freq: } 200 \ \text{kHz max.} \end{array}$

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

21.1 DC Characteristics: PIC16CR63/R65-04 (Commercial, Industrial)

PIC16CR63/R65-10 (Commercial, Industrial) PIC16CR63/R65-20 (Commercial, Industrial)

DC CH		Standaı Operatir		•)°C ≤	unless otherwise stated) TA ≤ +85°C for industrial and
Param No.	Characteristic	Sym	Min	Тур†		_	ETA ≤ +70°C for commercial Conditions
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	5.5 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	٧	BODEN configuration bit is enabled
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA~	XT, RC, osc config Fosc = 4 MHz, VDD = 5:5V (Note 4)
D013			-	10	20	mA	HS osc config Fosc = 20 MHz, VDD = 5.5V
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μA	BOR enabled, VDD = 5.0V
D020 D021 D021A	Power-down Current (Note 3, 5)	IPD	-	10.5 1.5 1.5	42 16 19	μ Α μ Α μ Α	VDD = 4.0V, WDT enabled,-40°C to +85°C VDD = 4.0V, WDT disabled,-0°C to +70°C VDD = 4.0V, WDT disabled,-40°C to +85°C
D023*	Brown-out Reset Current	ΔİBOR	- /	^350	425	μΑ	BOR enabled, VDD = 5.0V

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 8V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which Vop can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1/= external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,
 - MCLR / VDD; WDT enabled/disabled as specified.
 - 3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
 - 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

21.2 DC Characteristics: PIC16LCR63/R65-04 (Commercial, Industrial)

DC CHA		Standa Operatir	•	•		°C ≤	Inless otherwise stated) TA ≤ +85°C for industrial and TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D001	Supply Voltage	VDD	3.0	-	5.5	٧	LP, XT, RC osc configuration (DC - 4 MHz)
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	٧	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	٧	BODEN configuration bit is enabled
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)
D010A			-	22.5	48	μΑ	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μΑ	BOR enabled, VDD = 5.0V
D020	Power-down Current	IPD	-	7.5	30	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C
D021	(Note 3, 5)		-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, 0°C to +70°C
D021A			-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, -40°C to +85°C
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μΑ	BOR enabled, VDD = 5.0V

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,
 - MCLR = VDD; WDT enabled/disabled as specified.
 - 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
 - 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

21.3 DC Characteristics: PIC16CR63/R65-04 (Commercial, Industrial)

> PIC16CR63/R65-10 (Commercial, Industrial) PIC16CR63/R65-20 (Commercial, Industrial)

PIC16LCR63/R65-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

Operating temperature -40°C \leq TA \leq +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial

Operating voltage VDD range as described in DC spec Section 21.1 and

		Section	21.2				
Param No.	Characteristic	Sym	Min	Typ †	Max	Units	Conditions
	Input Low Voltage						
	I/O ports	VIL					
D030	with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range
D030A			Vss	-	V8.0	V	$4.5V \le V$ DD $\le 5.5V$
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	V	
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2VDD	V	
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1
	Input High Voltage						
	I/O ports	VIH		-			
D040	with TTL buffer		2.0	-	VDD	V	$4.5V \le V_{DD} \le 5.5V$
D040A			0.25VDD	-	VDD	V	For entire VDD range
			+ 0.8V				
D041	with Schmitt Trigger buffer		0.8VDD	_	VDD	V	For entire VDD range
D042	MCLR		0.8Vpp	_	VDD	V	l or order of the control of the con
D042A	OSC1 (XT, HS and LP)		0.7VDD	_	VDD	V	Note1
D043	OSC1 (in RC mode)		0.9Vpp	_	VDD	V	
D070	PORTB weak pull-up current	IPURB	50	250	400	μА	VDD = 5V, VPIN = VSS
	Input Leakage Current (Notes 2, 3)						
D060	I/O ports	II∟	-	-	±1	μА	Vss ≤ VPIN ≤ VDD, Pin at himpedance
D061	MCLR, RA4/T0CKI		-	-	±5	μА	Vss ≤ Vpin ≤ Vdd
D063	OSC1		-	-	±5	μ A	Vss ≤ VPIN ≤ VDD, XT, HS and LP osc configuration
	Output Low Voltage						
D080	I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$
D083	OSC2/CLKOUT (RC osc config)		-	-	0.6	V	IOL = 1.6 mA , VDD = 4.5V , -40°C to $+85^{\circ}\text{C}$
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5V, -40°C to +85°C
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C
D150*	Open-Drain High Voltage	VOD	-	-	14	V	RA4 pin

These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

^{2:} The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input volt-

^{3:} Negative current is defined as current sourced by the pin.

		Standard Operating Conditions (unless otherwise stated)								
		Operatir	ature	-40°C	S ≤ T.	A ≤ +85°C for industrial and				
DC CHA	ARACTERISTICS				0°C	≤ T.	A ≤ +70°C for commercial			
	Operating voltage VDD range as described in DC spec Section						ed in DC spec Section 21.1 and			
		Section	21.2							
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions			
No.				†						
	Capacitive Loading Specs on Out-									
	put Pins									
D100	OSC2 pin	Cosc ₂	-	-	15	pF	In XT, HS and LP modes wher			
							external clock is used to drive			
							OSC1.			
D101	All I/O pins and OSC2 (in RC mode)	CIO	-	-	50	pF				
D102	SCL. SDA in I ² C mode	Cb	-	-	400	pF				

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

21.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

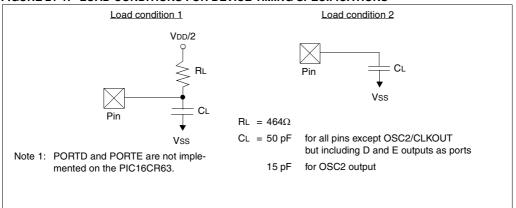
1. TppS2	ppS	3. Tcc:st	(I ² C specifications only)	
2. TppS		4. Ts	(I ² C specifications only)	
T				
F	Frequency	Т	Time	
Lowerd	ase letters (pp) and their meaning	ngs:		
рр				
СС	CCP1	osc	OSC1	
ck	CLKOUT	rd	RD	
cs	CS	rw	RD or WR	
di	SDI	sc	SCK	
do	SDO	ss	SS	
dt	Data in	tO	T0CKI	
io	I/O port	t1	T1CKI	
mc	MCLR	wr	WR	
Upperd	ase letters and their meanings:			
S				

-			
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
	_		

Tcc:st (I²C specifications only)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 21-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



21.5 <u>Timing Diagrams and Specifications</u>

FIGURE 21-2: EXTERNAL CLOCK TIMING

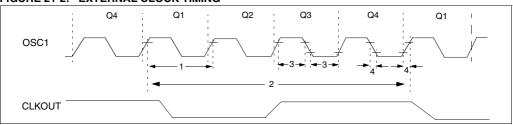


TABLE 21-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC		4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC	_	4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250	_	_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
3*	TosL,	External Clock in (OSC1) High or	100	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μS	LP oscillator
			15	_	_	ns	HS oscillator
4*	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
			_	_	15	ns	HS oscillator

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

FIGURE 21-3: CLKOUT AND I/O TIMING

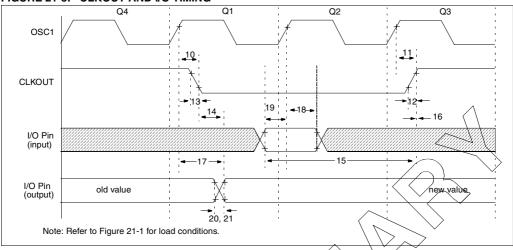


TABLE 21-3: CLKOUT AND I/O TIMING REQUIREMENTS

Param	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
No.	-,							
10*	TosH2ckL	OSC1↑ to CLKOUT↓	^	1	75	200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		$\backslash - \!$	75	200	ns	Note 1
12*	TckR	CLKOUT rise time	~	\searrow	35	100	ns	Note 1
13*	TckF	CLKOUT fall time			35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	1////	_	_	0.5Tcy + 20	ns	Note 1
15*	TioV2ckH	Port in valid before CLKOUT		Tosc + 200	_	_	ns	Note 1
16*	TckH2iol	Port in hold after CLKOUT ↑		0	_	_	ns	Note 1
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out val	id		50	150	ns	
18*	TosH2ioI	OSC1↑ (Q2 cycle) to Port input	P1C16CR63/R65	100	_	_	ns	
		invalid (I/O in hold time)	PIC16 LCR 63/R65	200	_	_	ns	
19*	TioV2osH	Port input valid to OSC11 (I/Q in	setup time)	0	_	_	ns	
20*	TioR	Port output rise time	PIC16 CR 63/R65		10	40	ns	
			PIC16 LCR 63/R65	1	_	80	ns	
21*	TioF	Port output fall time	PIC16 CR 63/R65		10	40	ns	
			PIC16 LCR 63/R65		_	80	ns	
22††*	Tinp	INT pin high or low time		Tcy	_	_	ns	
23††*	Trbp	RB7:RB4 change INT high or low	time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{††} These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

FIGURE 21-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

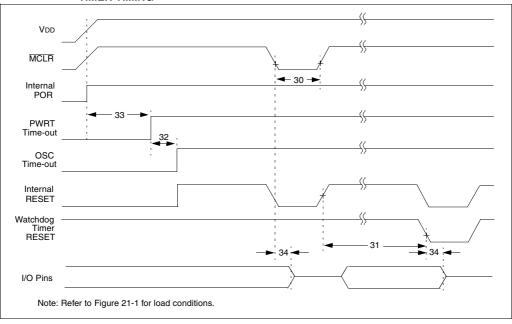


FIGURE 21-5: BROWN-OUT RESET TIMING



TABLE 21-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	_		μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period		1024 Tosc		_	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	-	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	_	_	μs	VDD ≤ BVDD (D005)

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 21-6: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

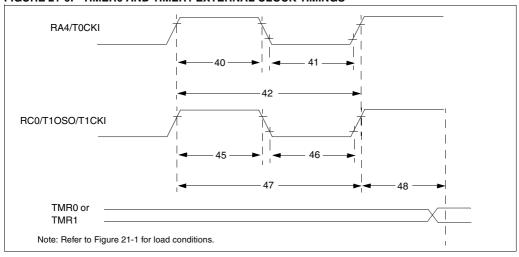


TABLE 21-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	TtOL	T0CKI Low Pulse Width		No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of: 20 or <u>Tcy + 40</u> N	_	_	ns	N = prescale value (2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, Prescaler = 1		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16LC6X	25	-	-	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, Prescaler = 1		0.5Tcy + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100			ns	
	Ft1	Timer1 oscillator inp (oscillator enabled b			DC		200	kHz	
48	TCKEZtmr1	Delay from external	y from external clock edge to timer increment			_	7Tosc	_	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 21-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

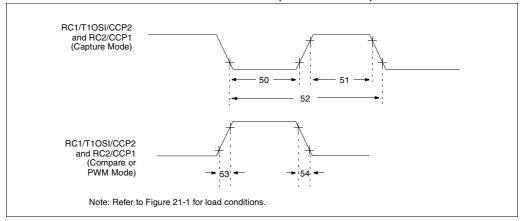


TABLE 21-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Param No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time	With Prescaler	PIC16 CR 63/R65	10	_	_	ns	
				PIC16 LCR 63/R65	20	_	_	ns	
51*	TccH	CCP1 and CCP2	No Prescaler	No Prescaler		_	_	ns	
		input high time	With Prescaler	PIC16 CR 63/R65	10	_	_	ns	
				PIC16 LCR 63/R65	20	_	_	ns	
52*	TccP	CCP1 and CCP2 in	put period		3Tcy + 40 N	_	_	ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 and CCP2 of	utput rise time	PIC16 CR 63/R65	_	10	25	ns	
				PIC16 LCR 63/R65	_	25	45	ns	
54*	TccF	CCP1 and CCP2 o	utput fall time	tput fall time PIC16 CR 63/R65		10	25	ns	
				PIC16 LCR 63/R65	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 21-8: PARALLEL SLAVE PORT TIMING (PIC16CR65)

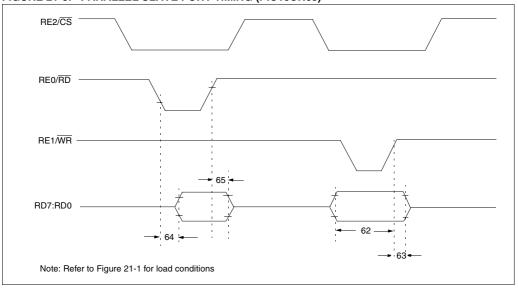


TABLE 21-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16CR65)

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions	
62*	TdtV2wrH	Data in valid before WR↑ or CS↑ (setu	ata in valid before WR↑ or CS↑ (setup time)				ns	
63*	TwrH2dtl	WR↑ or CS↑ to data-in invalid (hold	20	_	_	ns		
		time)	PIC16LCR65	35	_	_	ns	
64	TrdL2dtV	RD↓ and CS↓ to data–out valid	_	_	80	ns		
65*	TrdH2dtl	RD↑ or CS↑ to data–out invalid		10	_	30	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 21-9: SPI MODE TIMING

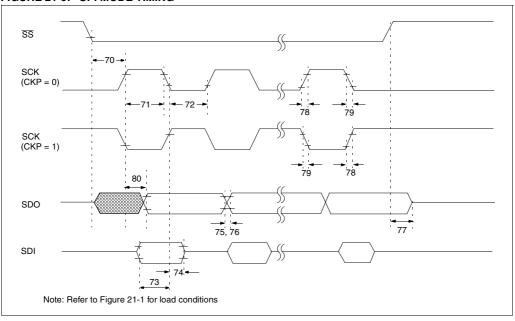


TABLE 21-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	_	_	ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20	_	_	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20	_	_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	50	_	_	ns	
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	50	_	_	ns	
75*	TdoR	SDO data output rise time	l	10	25	ns	
76*	TdoF	SDO data output fall time	I	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance	10	_	50	ns	
78*	TscR	SCK output rise time (master mode)	l	10	25	ns	
79*	TscF	SCK output fall time (master mode)		10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	_	50	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 21-10: I²C BUS START/STOP BITS TIMING

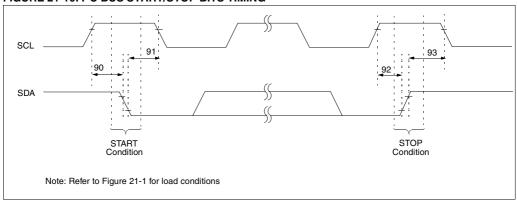


TABLE 21-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions	
90*	Tsu:sta	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated START	
		Setup time	400 kHz mode	600	_	_	113	condition	
91*	THD:STA	START condition	100 kHz mode	4000	_	_	ns	After this period the first clock	
		Hold time	400 kHz mode	600	_	_	113	pulse is generated	
92*	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns		
		Setup time	400 kHz mode	600	_	-	113		
93	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns		
		Hold time	400 kHz mode	600	_	_	113		

^{*} These parameters are characterized but not tested.

FIGURE 21-11: I²C BUS DATA TIMING

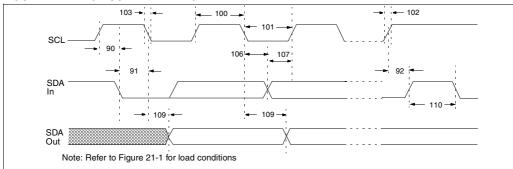


TABLE 21-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	THIGH	Clock high time	100 kHz mode	4.0	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5TcY	_		
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	_	μS	Device must operate at a minimum of 10 MHz
			SSP Module	1.5Tcy	_		
102*	TR	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μS	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock
		time	400 kHz mode	0.6	_	μS	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2
			400 kHz mode	100	_	ns	
92*	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μS	
		time	400 kHz mode	0.6	_	μS	
109*	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode	_	_	ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3	_	μS	before a new transmission can start
	Cb	Bus capacitive loading		_	400	pF	

These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

FIGURE 21-12: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

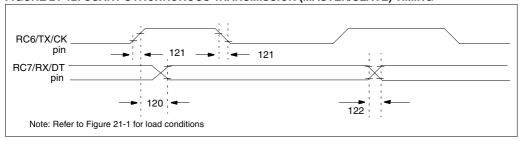


TABLE 21-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Param No.	Sym	Characteristic	teristic				Units	Conditions
120*	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 CR 63/R65	_	_	80	ns	
		Clock high to data out valid	PIC16LCR63/R65	_	_	100	ns	
121*	Tckrf	Clock out rise time and fall time	PIC16CR63/R65	_	_	45	ns	
		(Master Mode)	PIC16LCR63/R65	_	_	50	ns	
122*	Tdtrf	Data out rise time and fall time	PIC16CR63/R65	_	_	45	ns	
			PIC16LCR63/R65	_	_	50	ns	

These parameters are characterized but not tested.

FIGURE 21-13: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

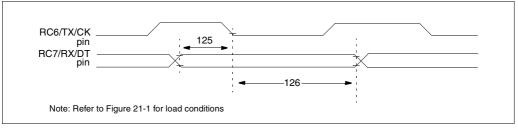


TABLE 21-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
125*	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK ↓ (DT setup time)	15	_	_	ns	
126*	TckL2dtl	Data hold after CK ↓ (DT hold time)	15	_	_	ns	

^{*} These parameters are characterized but not tested.

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

22.0 ELECTRICAL CHARACTERISTICS FOR PIC16C66/67

Absolute Maximum Ratings (†)

•	
Ambient temperature under bias	55°C to +125°C
Storage temperature	65°C to +150°C
Voltage on any pin with respect to Vss (except VDD, MCLR, and RA4)	0.3V to (VDD + 0.3V)
Voltage on VDD with respect to Vss	-0.3V to +7.5V
Voltage on MCLR with respect to Vss (Note 2)	0V to +14V
Voltage on RA4 with respect to Vss	
Total power dissipation (Note 1)	
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin	
Input clamp current, Iικ (VI < 0 or VI > VDD)	±20 mA
Output clamp current, loκ (Vo < 0 or Vo > VDD)	±20 mA
Maximum output current sunk by any I/O pin	
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sourced by PORTA, PORTB, and PORTE (Note 3) (combined)	200 mA
Maximum current sunk by PORTC and PORTD (Note 3) (combined)	200 mA
Maximum current sourced by PORTC and PORTD (Note 3) (combined)	200 mA

- Note 1: Power dissipation is calculated as follows: Pdis = VDD x {IDD \sum IOH} + \sum {(VDD-VOH) x IOH} + \sum (Vol x IOL)
- Note 2: Voltage spikes below Vss at the MCLR/VPP pin, inducing currents greater than 80 mA, may cause latch-up.

 Thus, a series resistor of 50-100Ω should be used when applying a "low" level to the MCLR/VPP pin rather than pulling this pin directly to Vss.
- Note 3: PORTD and PORTE not available on the PIC16C66.

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 22-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

osc	PIC16C66-04 PIC16C67-04	PIC16C66-10 PIC16C67-10	PIC16C66-20 PIC16C67-20	PIC16LC66-04 PIC16LC67-04	JW Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μ A max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 μ A typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3V IPD: 5 μA max. at 3V Freq: 4 MHz max.	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 16 μA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 13.5 mA typ. at 5.5V	VDD: 4.5V to 5.5V IDD: 10 mA max. at 5.5V	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V	Not recommended for use in HS mode	VDD: 4.5V to 5.5V IDD: 20 mA max. at 5.5V
	IPD: $1.5 \mu A$ typ. at $4.5 V$ Freq: $4 MHz$ max.	IPD 1.5 μA typ. at 4.5V Freq: 10 MHz max.	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.	use iii no iiiode	IPD: 1.5 μA typ. at 4.5V Freq: 20 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 52.5 μA typ. at 32 kHz, 4.0V IPD: 0.9 μA typ. at 4.0V Freq: 200 kHz max.	Not recommended for use in LP mode	Not recommended for use in LP mode	VDD: 2.5V to 6.0V IDD: 48 μA max. at 32 kHz, 3.0V IPD: 5 μA max. at 3.0V Freq: 200 kHz max.	$\begin{array}{c} \text{VDD: } 2.5\text{V to } 6.0\text{V} \\ \text{IDD: } 48~\mu\text{A max.} \\ \text{at } 32~\text{kHz, } 3.0\text{V} \\ \text{IPD: } 5~\mu\text{A max. at } 3.0\text{V} \\ \text{Freq: } 200~\text{kHz max.} \end{array}$

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

22.1 DC Characteristics: PIC16C66/67-04 (Commercial, Industrial, Extended)

PIC16C66/67-10 (Commercial, Industrial, Extended)

PIC16C66/67-20 (Commercial, Industrial, Extended)

Standard Operating Conditions (unless otherwise stated)

Operating temperature -40° C $\leq TA \leq +125^{\circ}$ C for extended,

 -40° C ≤ TA ≤ +85°C for industrial and

					0°(≤ TA ≤ +65 C for industrial and ≤ TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Тур†	Max	Units	Conditions
D001 D001A	Supply Voltage	VDD	4.0 4.5	-	6.0 5.5	V V	XT, RC and LP osc configuration HS osc configuration
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	V	See section on Power-on Reset for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	V	BODEN configuration bit is enabled
			3.7	4.0	4.4	V	Extended Range Only
D010	Supply Current (Note 2, 5)	IDD	-	2.7	5	mA	XT, RC, osc config Fosc = 4 MHz, VDD = 5.5V (Note 4)
D013			-	10	20	mA	HS osc config FOSC = 20 MHz, VDD = 5.5V
D015*	Brown-out Reset Current (Note 6)	Δlbor	-	350	425	μА	BOR enabled, VDD = 5.0V
D020	Power-down Current	IPD	-	10.5	42	μА	VDD = 4.0V, WDT enabled,-40°C to +85°C
D021	(Note 3, 5)		-	1.5	16	μA	VDD = 4.0V, WDT disabled, -0°C to +70°C
D021A D021B			-	1.5 2.5	19 19	μ A μ A	VDD = 4.0V, WDT disabled,-40°C to +85°C VDD = 4.0V, WDT disabled,-40°C to +125°C
D023*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μА	BOR enabled, VDD = 5.0V

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

- 3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
- 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
- 5: Timer1 oscillator (when enabled) adds approximately 20 µA to the specification. This value is from characterization and is for design guidance only. This is not tested.
- 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

22.2 DC Characteristics: PIC16LC66/67-04 (Commercial, Industrial)

DC CHA		Standard Operating Conditions (unless otherwise stated) Operating temperature -40° C $\leq TA \leq +85^{\circ}$ C for industrial and 0° C $\leq TA \leq +70^{\circ}$ C for commercial								
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions			
D001	Supply Voltage	VDD	2.5		6.0	٧	LP, XT, RC osc configuration (DC - 4 MHz)			
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V				
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	Vss	-	٧	See section on Power-on Reset for details			
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	See section on Power-on Reset for details			
D005	Brown-out Reset Voltage	BVDD	3.7	4.0	4.3	٧	BODEN configuration bit is enabled			
D010	Supply Current (Note 2, 5)	IDD	-	2.0	3.8	mA	XT, RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)			
D010A			-	22.5	48	μΑ	LP osc configuration FOSC = 32 kHz, VDD = 3.0V, WDT disabled			
D015*	Brown-out Reset Current (Note 6)	ΔIBOR	-	350	425	μΑ	BOR enabled, VDD = 5.0V			
D020	Power-down Current	IPD	-	7.5	30	μΑ	VDD = 3.0V, WDT enabled, -40°C to +85°C			
D021	(Note 3, 5)		-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, 0°C to +70°C			
D021A			-	0.9	5	μΑ	VDD = 3.0V, WDT disabled, -40°C to +85°C			
D023*	Brown-out Reset Current (Note 6)	$\Delta IBOR$	-	350	425	μΑ	BOR enabled, VDD = 5.0V			

- * These parameters are characterized but not tested.
- † Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.
- Note 1: This is the limit to which VDD can be lowered without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.
 - The test conditions for all IDD measurements in active operation mode are:
 - OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD,
 - MCLR = VDD; WDT enabled/disabled as specified.
 - 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and Vss.
 - 4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kOhm.
 - 5: Timer1 oscillator (when enabled) adds approximately 20 μA to the specification. This value is from characterization and is for design guidance only. This is not tested.
 - 6: The ∆ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

DC CHARACTERISTICS

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

22.3 DC Characteristics: PIC16C66/67-04 (Commercial, Industrial, Extended)

PIC16C66/67-10 (Commercial, Industrial, Extended)

PIC16C66/67-20 (Commercial, Industrial, Extended)

PIC16LC66/67-04 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended,

-40°C \leq TA \leq +85°C for industrial and 0°C < TA < +70°C for commercial

Operating voltage VDD range as described in DC spec Section 22.1

and Section 22.2

	and Section 22.2											
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions					
No.				†								
	Input Low Voltage											
	I/O ports	VIL										
D030	with TTL buffer		Vss	-	0.15VDD	V	For entire VDD range					
D030A			Vss	-	V8.0	V	$4.5V \le VDD \le 5.5V$					
D031	with Schmitt Trigger buffer		Vss	-	0.2VDD	V						
D032	MCLR, OSC1 (in RC mode)		Vss	-	0.2Vdd	V						
D033	OSC1 (in XT, HS and LP)		Vss	-	0.3VDD	V	Note1					
	Input High Voltage											
	I/O ports	VIH		-								
D040	with TTL buffer		2.0	-	VDD	V	$4.5V \le V_{DD} \le 5.5V$					
D040A			0.25VDD	-	VDD	V	For entire VDD range					
			+ 0.8V									
D041	with Schmitt Trigger buffer		0.8VDD	_	VDD	V	For entire VDD range					
D042	MCLR		0.8VDD	-	VDD	٧						
D042A	OSC1 (XT, HS and LP)		0.7VDD	-	VDD	٧	Note1					
D043	OSC1 (in RC mode)		0.9VDD	-	VDD	V						
D070	PORTB weak pull-up current	IPURB	50	250	400	μА	VDD = 5V, VPIN = VSS					
	Input Leakage Current (Notes 2, 3)											
D060	I/O ports	lıL	-	-	±1	μΑ	Vss ≤ VPIN ≤ VDD, Pin at hi-					
							impedance					
D061	MCLR, RA4/T0CKI		-	-	±5	μΑ	$Vss \leq VPIN \leq VDD$					
D063	OSC1		-	-	±5	μΑ	$Vss \le VPIN \le VDD$, XT, HS and					
							LP osc configuration					
	Output Low Voltage											
D080	I/O ports	VOL	-	-	0.6	V	IOL = 8.5 mA, VDD = 4.5V,					
							-40°C to +85°C					
D080A			-	-	0.6	V	IOL = 7.0 mA , VDD = 4.5V , -40°C to $+125^{\circ}\text{C}$					
D083	OSC2/CLKOUT (RC osc config)		1 _	_	0.6	V	IOL = 1.6 mA, VDD = 4.5V,					
2003	COOLICE (NO 050 colling)		_	_	0.0	V	-40°C to +85°C					
D083A			-	-	0.6	V	IOL = 1.2 mA, VDD = 4.5V,					
<u></u>							-40°C to +125°C					

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.

The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

^{3:} Negative current is defined as current sourced by the pin.

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended,

-40°C ≤ TA ≤ +85°C for industrial and

 0° C $\leq TA \leq +70^{\circ}$ C for commercial

Operating voltage VDD range as described in DC spec Section 22.1 and Section 22.2

		-					
Param	Characteristic	Sym	Min	Тур	Max	Units	Conditions
No.				†			
	Output High Voltage						
D090	I/O ports (Note 3)	Vон	VDD-0.7	-	-	V	IOH = -3.0 mA, VDD = 4.5 V, -40 °C to $+85$ °C
D090A			VDD-0.7	-	-	V	IOH = -2.5 mA, VDD = 4.5 V, -40 °C to $+125$ °C
D092	OSC2/CLKOUT (RC osc config)		VDD-0.7	-	-	V	IOH = -1.3 mA, VDD = 4.5V, -40°C to +85°C
D092A			VDD-0.7	-	-	V	IOH = -1.0 mA, VDD = $4.5V$, -40° C to $+125^{\circ}$ C
D150*	Open-Drain High Voltage	Vod	-	-	14	V	RA4 pin
	Capacitive Loading Specs on Output Pins					_	
D100	OSC2 pin	Cosc ₂	-	-	15	pF	In XT, HS and LP modes when external clock is used to drive OSC1.
D101	All I/O pins and OSC2 (in RC mode)	Cio	-	-	50	pF	
D102	SCL, SDA in I ² C mode	Cb	-	-	400	pF	

^{*} These parameters are characterized but not tested.

DC CHARACTERISTICS

- Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16C6X be driven with external clock in RC mode.
 - The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
 - 3: Negative current is defined as current sourced by the pin.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

1. TppS2ppS

F

Н

1

L

I²C only

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

22.4 <u>Timing Parameter Symbology</u>

The timing parameter symbols have been created following one of the following formats:

1.1.	rr -	0. 100.31	(1 O specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	T	Time
Lowerd	case letters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKOUT	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	ss	SS
dt	Data in	tO	TOCKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Upperd	case letters and their meanings:		
S	-		

Р

R

٧

Ζ

High

Low

Period

Rise

Valid

High

Low

Hi-impedance

3. Tcc:st

(I²C specifications only)

BUF	Bus free
Tcc:st	(I ² C specifications only)

output access

Fall

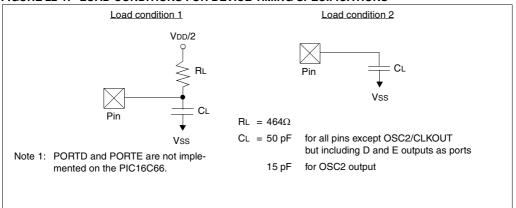
High

Low

Invalid (Hi-impedance)

CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	STOP condition
STA	START condition		

FIGURE 22-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS



22.5 Timing Diagrams and Specifications

FIGURE 22-2: EXTERNAL CLOCK TIMING

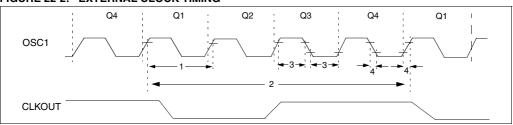


TABLE 22-2: EXTERNAL CLOCK TIMING REQUIREMENTS

Param	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
No.							
	Fosc	External CLKIN Frequency	DC		4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	_	200	kHz	LP osc mode
		Oscillator Frequency	DC		4	MHz	RC osc mode
		(Note 1)	0.1	_	4	MHz	XT osc mode
			4	_	20	MHz	HS osc mode
			5	_	200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250		_	ns	XT and RC osc mode
		(Note 1)	250	_	_	ns	HS osc mode (-04)
			100	_	_	ns	HS osc mode (-10)
			50	_	_	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
		Oscillator Period	250	_	_	ns	RC osc mode
		(Note 1)	250	_	10,000	ns	XT osc mode
			250	_	250	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	_	_	μS	LP osc mode
2	Tcy	Instruction Cycle Time (Note 1)	200	Tcy	DC	ns	Tcy = 4/Fosc
3*	TosL,	External Clock in (OSC1) High or	100	_	_	ns	XT oscillator
	TosH	Low Time	2.5	_	_	μS	LP oscillator
			15			ns	HS oscillator
4*	TosR,	External Clock in (OSC1) Rise or	_	_	25	ns	XT oscillator
	TosF	Fall Time	_	_	50	ns	LP oscillator
			_		15	ns	HS oscillator

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.

PIC16C6X

FIGURE 22-3: CLKOUT AND I/O TIMING

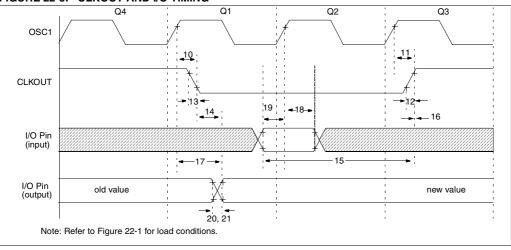


TABLE 22-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур†	Max	Units	Conditions
10*	TosH2ckL	OSC1↑ to CLKOUT↓	OSC1↑ to CLKOUT↓			200	ns	Note 1
11*	TosH2ckH	OSC1↑ to CLKOUT↑		_	75	200	ns	Note 1
12*	TckR	CLKOUT rise time		_	35	100	ns	Note 1
13*	TckF	CLKOUT fall time		_	35	100	ns	Note 1
14*	TckL2ioV	CLKOUT ↓ to Port out valid	_	_	0.5Tcy + 20	ns	Note 1	
15*	TioV2ckH	Port in valid before CLKOUT ↑	Tosc + 200	-	_	ns	Note 1	
16*	TckH2iol	Port in hold after CLKOUT ↑	0	-	_	ns	Note 1	
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out val	_	50	150	ns		
18*	TosH2iol	OSC1↑ (Q2 cycle) to Port input	PIC16 C 66/67	100	-	_	ns	
		invalid (I/O in hold time)	PIC16 LC 66/67	200	-	_	ns	
19*	TioV2osH	Port input valid to OSC1 [↑] (I/O in	setup time)	0	-	_	ns	
20*	TioR	Port output rise time	PIC16 C 66/67	_	10	40	ns	
			PIC16 LC 66/67	_	_	80	ns	
21*	TioF	Port output fall time	PIC16 C 66/67	_	10	40	ns	
			PIC16 LC 66/67	_	_	80	ns	
22††*	Tinp	INT pin high or low time		Tcy	-	_	ns	
23††*	Trbp	RB7:RB4 change INT high or low	time	Tcy	_	_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested

^{††} These parameters are asynchronous events not related to any internal clock edge.

Note 1: Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

FIGURE 22-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

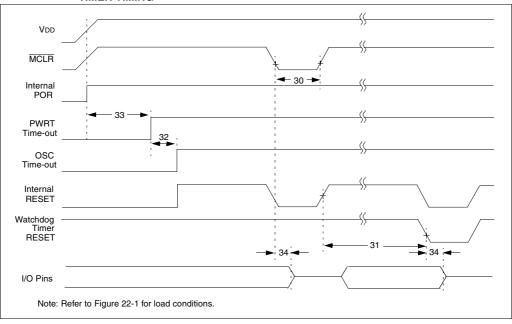


FIGURE 22-5: BROWN-OUT RESET TIMING



TABLE 22-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	_	_	μs	VDD = 5V, -40°C to +125°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +125°C
32	Tost	Oscillation Start-up Timer Period		1024 Tosc	_	_	TOSC = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +125°C
34	Tıoz	I/O Hi-impedance from MCLR Low or WDT reset	-	_	2.1	μs	
35	TBOR	Brown-out Reset Pulse Width	100	-	_	μs	VDD ≤ BVDD (D005)

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 22-6: TIMERO AND TIMER1 EXTERNAL CLOCK TIMINGS

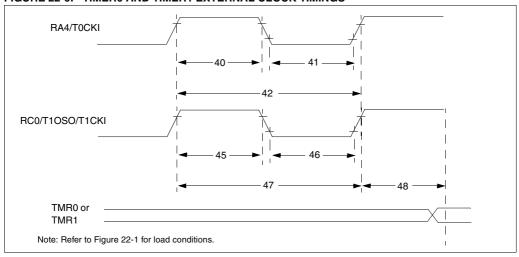


TABLE 22-5: TIMERO AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse V	Vidth	No Prescaler	0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
41*	Tt0L	T0CKI Low Pulse W	T0CKI Low Pulse Width		0.5Tcy + 20	_	_	ns	Must also meet
				With Prescaler	10	_	_	ns	parameter 42
42*	Tt0P	T0CKI Period		No Prescaler	Tcy + 40	_	_	ns	
				With Prescaler	Greater of:	_	_	ns	N = prescale value
					20 or <u>TCY + 40</u> N				(2, 4,, 256)
45*	Tt1H	T1CKI High Time	Synchronous, F	Proposior – 1	0.5Tcy + 20	_		ns	Must also meet
40	шп	TICKI HIGH TIME	Synchronous,	PIC16 C 6X	15	-		ns	parameter 47
			Prescaler =	PIC16 LC 6X	25			ns	paramoter 47
			2,4,8	110102000	25			113	
			Asynchronous	PIC16 C 6X	30	_	_	ns	1
				PIC16 LC 6X	50	_	_	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, F	a.	0.5TCY + 20	_	_	ns	Must also meet
			Synchronous,	PIC16 C 6X	15	_	_	ns	parameter 47
			Prescaler = 2,4,8	PIC16 LC 6X	25	_	_	ns	
			Asynchronous	PIC16 C 6X	30	_	_	ns	
				PIC16 LC 6X	50	_	_	ns	
47*	Tt1P	T1CKI input period	Synchronous	PIC16 C 6X	Greater of: 30 OR TCY + 40 N	_	_	ns	N = prescale value (1, 2, 4, 8)
				PIC16 LC 6X	Greater of: 50 OR TCY + 40 N				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16 C 6X	60	_	_	ns	
				PIC16 LC 6X	100	_	_	ns	
	Ft1	Timer1 oscillator inp			DC	-	200	kHz	
40	TOVET	(oscillator enabled b			O.T.				
48	I CKEZtmr	1 Delay from external	clock edge to tir	ner increment	2Tosc	l —	7Tosc	-	

These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 22-7: CAPTURE/COMPARE/PWM TIMINGS (CCP1 AND CCP2)

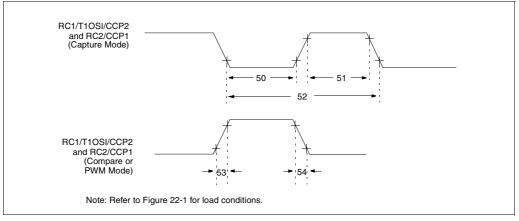


TABLE 22-6: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP1 AND CCP2)

Parameter No.	Sym	Characteristic			Min	Тур†	Max	Units	Conditions
50*	TccL	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_	_	ns	
		input low time	With Prescaler	PIC16 C 66/67	10	_		ns	
				PIC16 LC 66/67	20	_	-	ns	
51*	TccH	CCP1 and CCP2	No Prescaler		0.5Tcy + 20	_		ns	
		input high time	With Prescaler	PIC16 C 66/67	10	_		ns	
				PIC16 LC 66/67	20	_	_	ns	
52*	TccP	CCP1 and CCP2 in	put period		3Tcy + 40 N	_	-	ns	N = prescale value (1,4, or 16)
53*	TccR	CCP1 and CCP2 o	utput rise time	PIC16 C 66/67	_	10	25	ns	
			PIC16 LC 66/67	_	25	45	ns		
54*	TccF CCP1 and CCP2 output fall time		PIC16 C 66/67	_	10	25	ns		
				PIC16 LC 66/67	_	25	45	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

FIGURE 22-8: PARALLEL SLAVE PORT TIMING (PIC16C67)

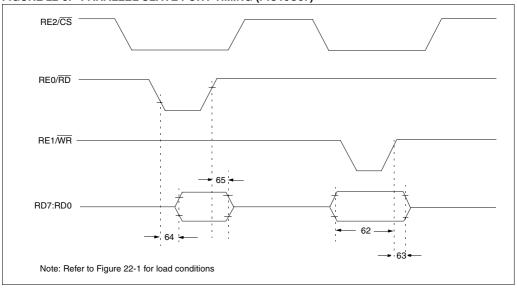


TABLE 22-7: PARALLEL SLAVE PORT REQUIREMENTS (PIC16C67)

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
62*	TdtV2wrH	Data in valid before WR↑ or CS↑ (setup time)		20	-	1	ns	
				25	_	_	ns	Extended Range Only
63*	TwrH2dtl	WR↑ or CS↑ to data–in invalid (hold	PIC16 C 67	20	_		ns	
		time)	PIC16 LC 67	35	_		ns	
64	TrdL2dtV	RD↓ and CS↓ to data–out valid		_	_	80	ns	
				_	_	90	ns	Extended Range Only
65*	TrdH2dtl	RD↑ or CS↑ to data–out invalid		10	ı	30	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 22-9: SPI MASTER MODE TIMING (CKE = 0)

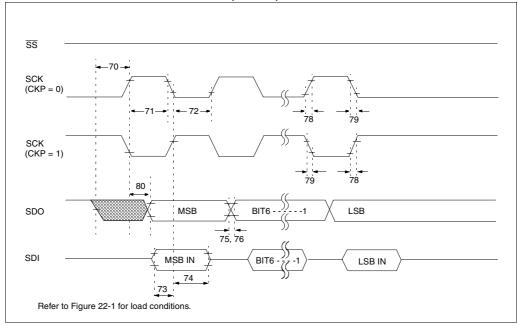
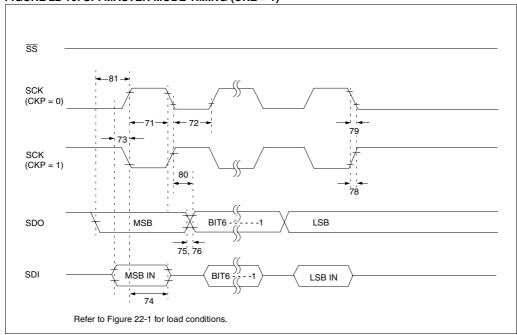


FIGURE 22-10: SPI MASTER MODE TIMING (CKE = 1)



PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 22-11: SPI SLAVE MODE TIMING (CKE = 0)

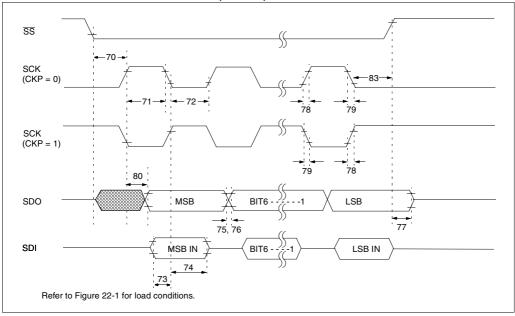


FIGURE 22-12: SPI SLAVE MODE TIMING (CKE = 1)

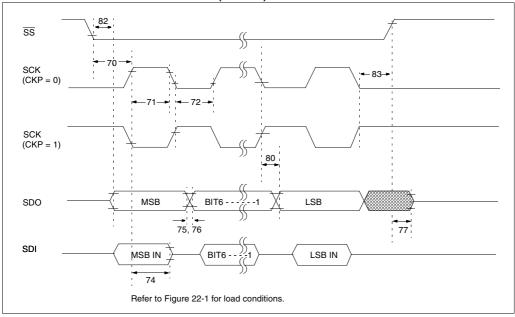


TABLE 22-8: SPI MODE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
70*	TssL2scH, TssL2scL	SS↓ to SCK↓ or SCK↑ input	Tcy	_	_	ns	
71*	TscH	SCK input high time (slave mode)	Tcy + 20		_	ns	
72*	TscL	SCK input low time (slave mode)	Tcy + 20		_	ns	
73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	100		_	ns	
74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	100	_	_	ns	
75*	TdoR	SDO data output rise time	_	10	25	ns	
76*	TdoF	SDO data output fall time	_	10	25	ns	
77*	TssH2doZ	SS↑ to SDO output hi-impedance	10	-	50	ns	
78*	TscR	SCK output rise time (master mode)	_	10	25	ns	
79*	TscF	SCK output fall time (master mode)	_	10	25	ns	
80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	_	1	50	ns	
81*	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge	Tcy	1	_	ns	
82*	TssL2doV	SDO data output valid after SS ↓ edge	_	_	50	ns	
83*	TscH2ssH, TscL2ssH	SS ↑ after SCK edge	1.5Tcy + 40	_	_	ns	

^{*} These parameters are characterized but not tested.

[†] Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C6X

Applicable Devices 61 62 62A R62 63 R63 64 64A R64 65 65A R65 66 67

FIGURE 22-13: I²C BUS START/STOP BITS TIMING

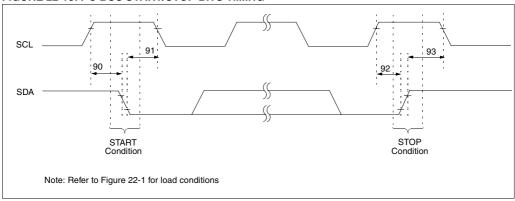


TABLE 22-9: I²C BUS START/STOP BITS REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Тур	Max	Units	Conditions	
90*	Tsu:sta	START condition	100 kHz mode	4700	_	_	ns	Only relevant for repeated START	
		Setup time	400 kHz mode	600	_	_	113	condition	
91*	THD:STA	START condition	100 kHz mode	4000	_	_	ne	After this period the first clock	
		Hold time	400 kHz mode	600	_	_	ns	pulse is generated	
92*	Tsu:sto	STOP condition	100 kHz mode	4700	_	_	ns		
		Setup time	400 kHz mode	600	_	_	115		
93	THD:STO	STOP condition	100 kHz mode	4000	_	_	ns		
		Hold time	400 kHz mode	600	_	_	115		

These parameters are characterized but not tested.

FIGURE 22-14: I²C BUS DATA TIMING

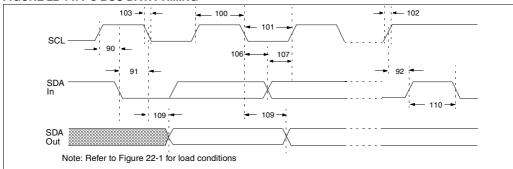


TABLE 22-10: I²C BUS DATA REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Max	Units	Conditions
100*	THIGH	Clock high time	100 kHz mode	4.0	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
101*	TLOW	Clock low time	100 kHz mode	4.7	_	μs	Device must operate at a mini- mum of 1.5 MHz
			400 kHz mode	1.3	_	μs	Device must operate at a mini- mum of 10 MHz
			SSP Module	1.5Tcy	_		
102*	TR	SDA and SCL rise	100 kHz mode	_	1000	ns	
		time	400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
103*	TF	SDA and SCL fall time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1Cb	300	ns	Cb is specified to be from 10-400 pF
90*	Tsu:sta	START condition	100 kHz mode	4.7	_	μS	Only relevant for repeated
		setup time	400 kHz mode	0.6	_	μS	START condition
91*	THD:STA	START condition hold	100 kHz mode	4.0	_	μS	After this period the first clock
		time	400 kHz mode	0.6	_	μS	pulse is generated
106*	THD:DAT	Data input hold time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107*	TSU:DAT	Data input setup time	100 kHz mode	250	_	ns	Note 2
			400 kHz mode	100	_	ns	
92*	Tsu:sto	STOP condition setup	100 kHz mode	4.7	_	μs	
		time	400 kHz mode	0.6	_	μS	
109*	TAA	Output valid from	100 kHz mode	_	3500	ns	Note 1
		clock	400 kHz mode	_	_	ns	
110*	TBUF	Bus free time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3	_	μs	before a new transmission can start
	Cb	Bus capacitive loading		_	400	pF	

These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.

^{2:} A fast-mode (400 kHz) I²C-bus device can be used in a standard-mode (100 kHz) I²C-bus system, but the requirement Tsu:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line TR max.+tsu;DAT = 1000 + 250 = 1250 ns (according to the standard-mode I²C bus specification) before the SCL line is released.

FIGURE 22-15: USART SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

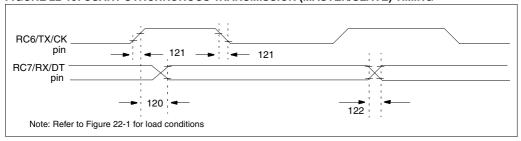


TABLE 22-11: USART SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic	tic			Max	Units	Conditions
120*	TckH2dtV	SYNC XMIT (MASTER & SLAVE)	PIC16 C 66/67	_	_	80	ns	
		Clock high to data out valid	PIC16 LC 66/67	_	_	100	ns	
121*	121* Tckrf Clock out rise time and fall time	PIC16 C 66/67	_	_	45	ns		
		(Master Mode)	PIC16 LC 66/67	_	_	50	ns	
122*	Tdtrf	trf Data out rise time and fall time		_	_	45	ns	
			PIC16 LC 66/67	_	_	50	ns	

These parameters are characterized but not tested.

FIGURE 22-16: USART SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

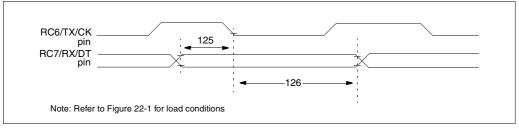


TABLE 22-12: USART SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
125*	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data setup before CK ↓ (DT setup time)	15	_	-	ns	
126*	TckL2dtl	Data hold after CK ↓ (DT hold time)	15	_	_	ns	

^{*} These parameters are characterized but not tested.

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

^{†:} Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

23.0 DC AND AC CHARACTERISTICS GRAPHS AND TABLES FOR: PIC16C62, PIC16C62A, PIC16CR62, PIC16C63, PIC16C64A, PIC16CR64, PIC16C65A, PIC16C66, PIC16C67

The graphs and tables provided in this section are for design guidance and are not tested or guaranteed.

In some graphs or tables the data presented are outside specified operating range (i.e., outside specified VDD range). This is for information only and devices are guaranteed to operate properly only within the specified range.

Note: The data presented in this section is a statistical summary of data collected on units from different lots over a period of time and matrix samples. 'Typical' represents the mean of the distribution at, 25°C, while 'max' or 'min' represents (mean +3σ) and (mean -3σ) respectively where σ is standard deviation.

FIGURE 23-1: TYPICAL IPD vs. VDD (WDT DISABLED, RC MODE)

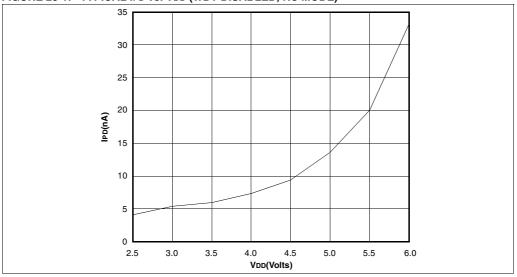


FIGURE 23-2: MAXIMUM IPD vs. VDD (WDT DISABLED, RC MODE)

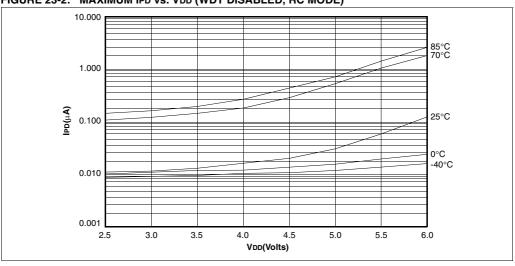


FIGURE 23-3: TYPICAL IPD vs. VDD @ 25°C (WDT ENABLED, RC MODE)

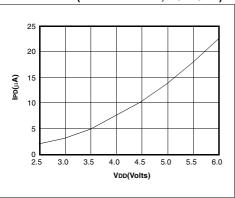


FIGURE 23-4: MAXIMUM IPD vs. VDD (WDT ENABLED, RC MODE)

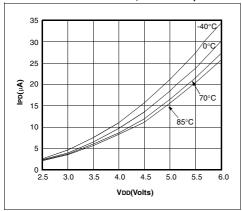


FIGURE 23-5: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

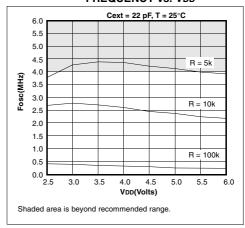


FIGURE 23-6: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

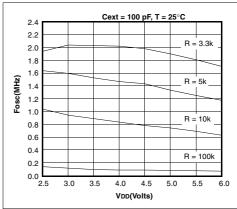


FIGURE 23-7: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

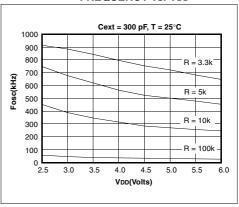


FIGURE 23-8: TYPICAL IPD vs. VDD BROWN-OUT DETECT ENABLED (RC MODE)

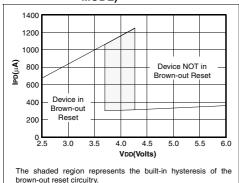


FIGURE 23-9: MAXIMUM IPD vs. VDD BROWN-OUT DETECT ENABLED (85°C TO -40°C, RC MODE)

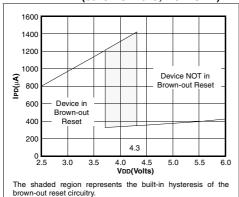


FIGURE 23-10: TYPICAL IPD vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, RC MODE)

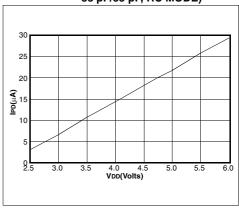


FIGURE 23-11: MAXIMUM IPD vs. TIMER1 ENABLED (32 kHz, RC0/RC1 = 33 pF/33 pF, 85°C TO -40°C, RC MODE)

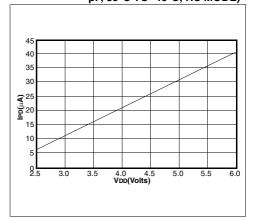


FIGURE 23-12: TYPICAL IDD vs. FREQUENCY (RC MODE @ 22 pF, 25°C)

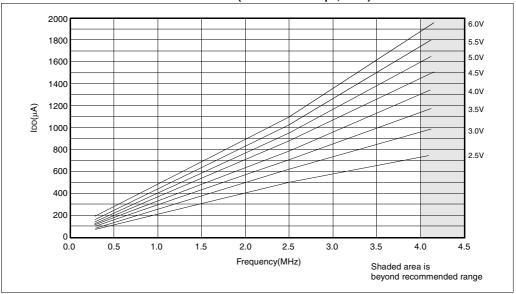


FIGURE 23-13: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 22 pF, -40°C TO 85°C)

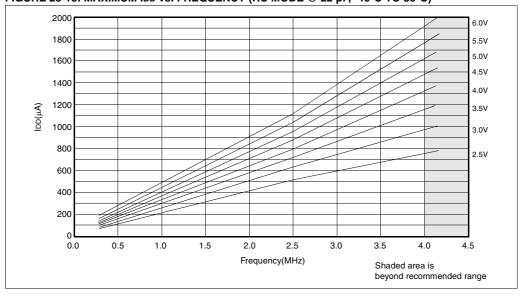


FIGURE 23-14: TYPICAL IDD vs. FREQUENCY (RC MODE @ 100 pF, 25°C)

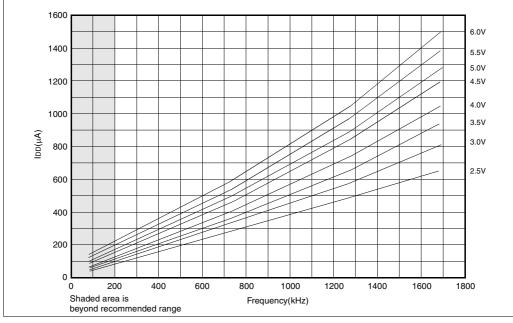


FIGURE 23-15: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 100 pF, -40°C TO 85°C)

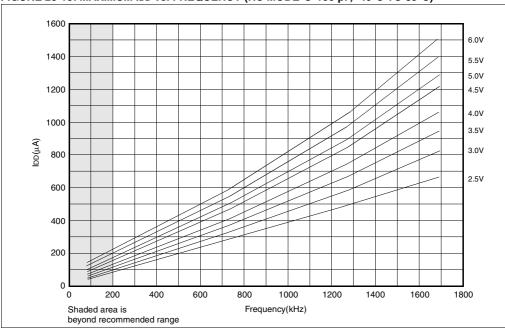


FIGURE 23-16: TYPICAL IDD vs. FREQUENCY (RC MODE @ 300 pF, 25°C)

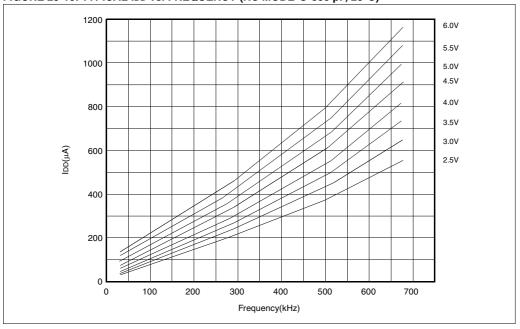


FIGURE 23-17: MAXIMUM IDD vs. FREQUENCY (RC MODE @ 300 pF, -40°C TO 85°C)

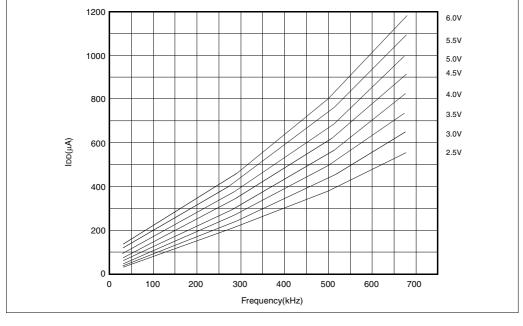


FIGURE 23-18: TYPICAL IDD vs.

CAPACITANCE @ 500 kHz

(RC MODE)

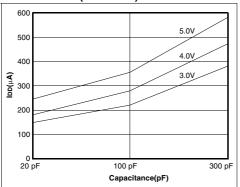


TABLE 23-1: RC OSCILLATOR FREQUENCIES

Cext	Rext	Average				
Cext	next	Fosc @ 5V, 25°C				
22 pF	5k	4.12 MHz	± 1.4%			
	10k	2.35 MHz	± 1.4%			
	100k	268 kHz	± 1.1%			
100 pF	3.3k	1.80 MHz	± 1.0%			
	5k	1.27 MHz	± 1.0%			
	10k	688 kHz	± 1.2%			
	100k	77.2 kHz	± 1.0%			
300 pF	3.3k	707 kHz	± 1.4%			
	5k	501 kHz	± 1.2%			
	10k	269 kHz	± 1.6%			
	100k	28.3 kHz	± 1.1%			

The percentage variation indicated here is part to part variation due to normal process distribution. The variation indicated is ±3 standard deviation from average value for VDD = 5V.

FIGURE 23-19: TRANSCONDUCTANCE(gm)
OF HS OSCILLATOR vs. VDD

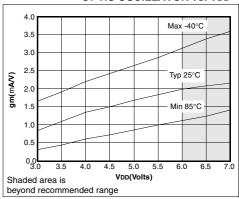


FIGURE 23-20: TRANSCONDUCTANCE(gm)
OF LP OSCILLATOR vs. VDD

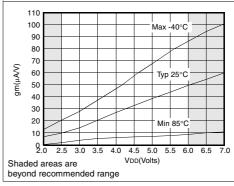


FIGURE 23-21: TRANSCONDUCTANCE(gm) OF XT OSCILLATOR vs. VDD

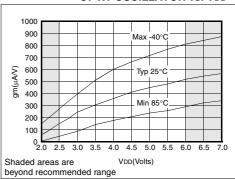


FIGURE 23-22: TYPICAL XTAL STARTUP TIME vs. VDD (LP MODE, 25°C)

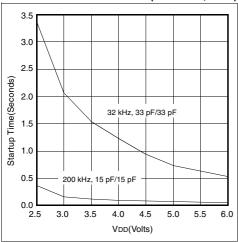


FIGURE 23-23: TYPICAL XTAL STARTUP TIME vs. VDD (HS MODE, 25°C)

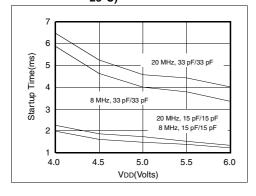


FIGURE 23-24: TYPICAL XTAL STARTUP TIME vs. VDD (XT MODE, 25°C)

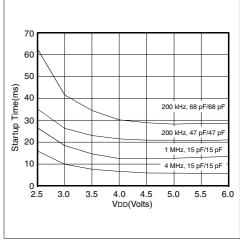


TABLE 23-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATORS

Osc Type	Crystal Freq	Cap. Range C1	Cap. Range C2	
LP	32 kHz	33 pF	33 pF	
	200 kHz	15 pF	15 pF	
XT	200 kHz	47-68 pF	47-68 pF	
	1 MHz	15 pF	15 pF	
	4 MHz	15 pF	15 pF	
HS	4 MHz	15 pF	15 pF	
	8 MHz	15-33 pF	15-33 pF	
	20 MHz	15-33 pF	15-33 pF	
			•	
Crystals Used				
32 kHz	Epson C-00	1R32.768K-A	± 20 PPM	
200 kHz	STD XTL 2	STD XTL 200.000KHz		
1 MHz	ECS ECS-1	± 50 PPM		
4 MHz	ECS ECS-4	± 50 PPM		
8 MHz	EPSON CA	± 30 PPM		
20 MHz	EPSON CA	± 30 PPM		

FIGURE 23-25: TYPICAL IDD vs. FREQUENCY (LP MODE, 25°C)

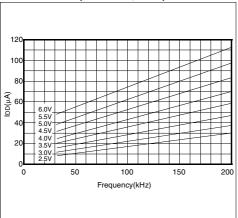


FIGURE 23-26: MAXIMUM IDD vs. FREQUENCY (LP MODE, 85°C TO -40°C)

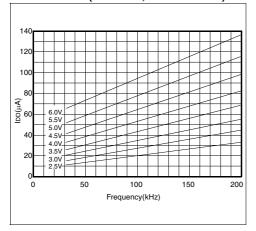


FIGURE 23-27: TYPICAL IDD vs. FREQUENCY (XT MODE, 25°C)

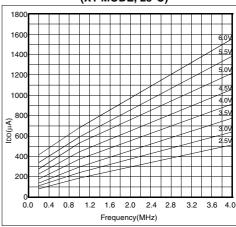


FIGURE 23-28: MAXIMUM IDD vs. FREQUENCY (XT MODE, -40°C TO 85°C)

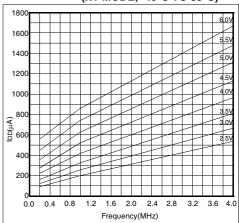


FIGURE 23-29: TYPICAL IDD vs. FREQUENCY (HS MODE, 25°C)

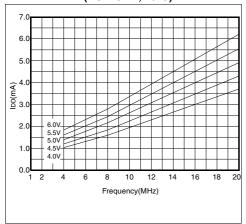
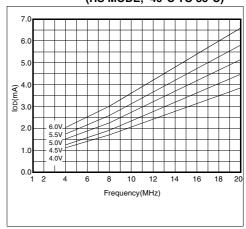


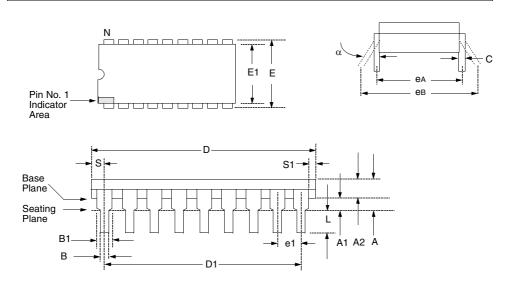
FIGURE 23-30: MAXIMUM IDD vs. FREQUENCY (HS MODE, -40°C TO 85°C)



24.0 PACKAGING INFORMATION

24.1 18-Lead Plastic Dual In-line (300 mil) (P)

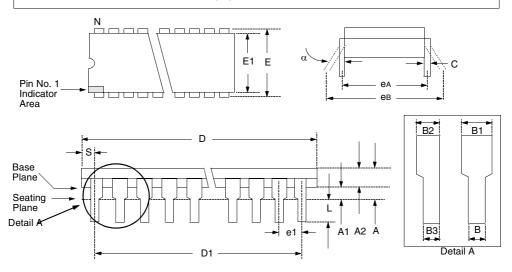
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Package Group: Plastic Dual In-Line (PLA)						
	Millimeters			Inches			
Symbol	Min	Max	Notes	Min	Max	Notes	
α	0°	10°		0°	10°		
Α	_	4.064		-	0.160		
A1	0.381	_		0.015	_		
A2	3.048	3.810		0.120	0.150		
В	0.355	0.559		0.014	0.022		
B1	1.524	1.524	Reference	0.060	0.060	Reference	
С	0.203	0.381	Typical	0.008	0.015	Typical	
D	22.479	23.495		0.885	0.925		
D1	20.320	20.320	Reference	0.800	0.800	Reference	
E	7.620	8.255		0.300	0.325		
E1	6.096	7.112		0.240	0.280		
e1	2.489	2.591	Typical	0.098	0.102	Typical	
eA	7.620	7.620	Reference	0.300	0.300	Reference	
eВ	7.874	9.906		0.310	0.390		
L	3.048	3.556		0.120	0.140		
N	18	18		18	18		
S	0.889	_		0.035	_		
S1	0.127	_		0.005	_		

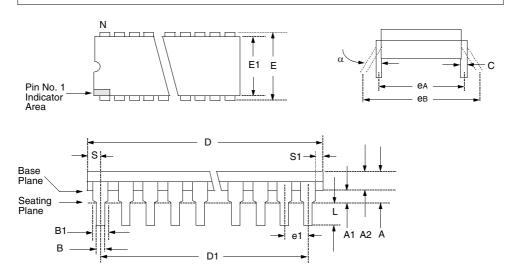
24.2 28-Lead Plastic Dual In-line (300 mil) (SP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



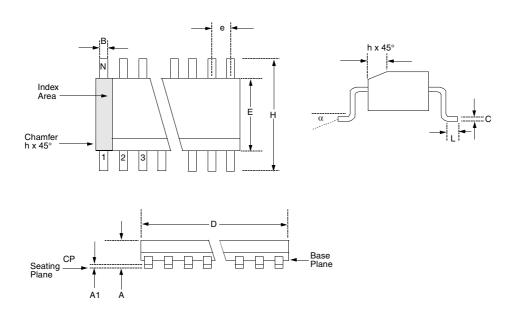
	Package Group: Plastic Dual In-Line (PLA)							
	Millimeters			Inches				
Symbol	Min	Max	Notes	Min	Max	Notes		
α	0°	10°		0°	10°			
Α	3.632	4.572		0.143	0.180			
A1	0.381	_		0.015	_			
A2	3.175	3.556		0.125	0.140			
В	0.406	0.559		0.016	0.022			
B1	1.016	1.651	Typical	0.040	0.065	Typical		
B2	0.762	1.016	4 places	0.030	0.040	4 places		
B3	0.203	0.508	4 places	0.008	0.020	4 places		
С	0.203	0.331	Typical	0.008	0.013	Typical		
D	34.163	35.179		1.385	1.395			
D1	33.020	33.020	Reference	1.300	1.300	Reference		
Е	7.874	8.382		0.310	0.330			
E1	7.112	7.493		0.280	0.295			
e1	2.540	2.540	Typical	0.100	0.100	Typical		
eA	7.874	7.874	Reference	0.310	0.310	Reference		
eВ	8.128	9.652		0.320	0.380			
L	3.175	3.683		0.125	0.145			
N	28	28		28	28			
S	0.584	1.220		0.023	0.048			

24.3 40-Lead Plastic Dual In-line (600 mil) (P)



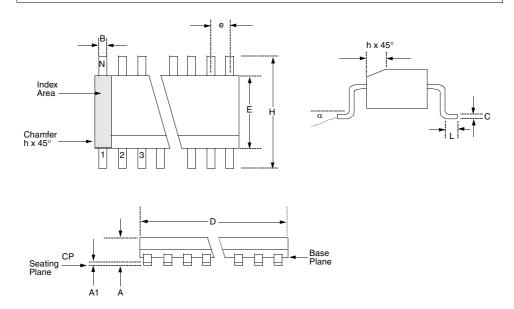
		Package Gro	up: Plastic Dual	In-Line (PLA)			
		Millimeters			Inches		
Symbol	Min	Max	Notes	Min	Max	Notes	
α	0°	10°		0°	10°		
Α	_	5.080		_	0.200		
A1	0.381	_		0.015	_		
A2	3.175	4.064		0.125	0.160		
В	0.355	0.559		0.014	0.022		
B1	1.270	1.778	Typical	0.050	0.070	Typical	
С	0.203	0.381	Typical	0.008	0.015	Typical	
D	51.181	52.197		2.015	2.055		
D1	48.260	48.260	Reference	1.900	1.900	Reference	
Е	15.240	15.875		0.600	0.625		
E1	13.462	13.970		0.530	0.550		
e1	2.489	2.591	Typical	0.098	0.102	Typical	
eA	15.240	15.240	Reference	0.600	0.600	Reference	
еВ	15.240	17.272		0.600	0.680		
L	2.921	3.683		0.115	0.145		
N	40	40		40	40		
S	1.270	_		0.050	_		
S1	0.508	_		0.020	-		

24.4 18-Lead Plastic Surface Mount (SOIC - Wide, 300 mil Body) (SO)



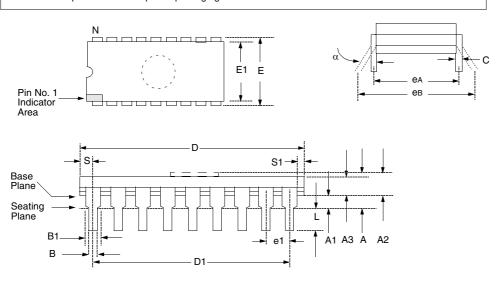
		Package Group: Plastic SOIC (SO)									
		Millimeters			Inches						
Symbol	Min	Max	Notes	Min	Max	Notes					
α	0°	8°		0°	8°						
Α	2.362	2.642		0.093	0.104						
A1	0.101	0.300		0.004	0.012						
В	0.355	0.483		0.014	0.019						
С	0.241	0.318		0.009	0.013						
D	11.353	11.735		0.447	0.462						
Е	7.416	7.595		0.292	0.299						
е	1.270	1.270	Reference	0.050	0.050	Reference					
Н	10.007	10.643		0.394	0.419						
h	0.381	0.762		0.015	0.030						
L	0.406	1.143		0.016	0.045						
N	18	18		18	18						
CP	_	0.102		_	0.004						

24.5 28-Lead Plastic Surface Mount (SOIC - Wide, 300 mil Body) (SO)



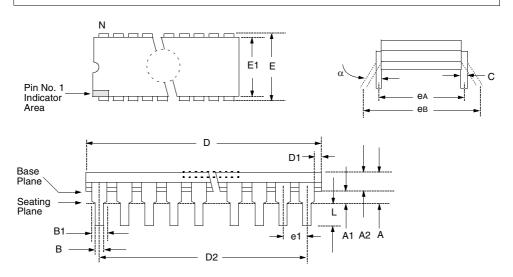
	Package Group: Plastic SOIC (SO)								
		Millimeters			Inches				
Symbol	Min	Max	Notes	Min	Max	Notes			
α	0°	8°		0°	8°				
Α	2.362	2.642		0.093	0.104				
A1	0.101	0.300		0.004	0.012				
В	0.355	0.483		0.014	0.019				
С	0.241	0.318		0.009	0.013				
D	17.703	18.085		0.697	0.712				
E	7.416	7.595		0.292	0.299				
е	1.270	1.270	Typical	0.050	0.050	Typical			
Н	10.007	10.643		0.394	0.419				
h	0.381	0.762		0.015	0.030				
L	0.406	1.143		0.016	0.045				
N	28	28		28	28				
CP	_	0.102		_	0.004				

24.6 18-Lead Ceramic CERDIP Dual In-line with Window (300 mil) (JW)



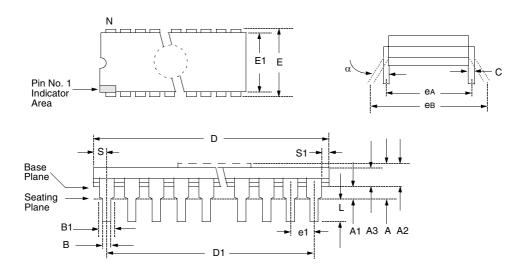
	Package Group: Ceramic CERDIP Dual In-Line (CDP)									
		Millimeters		Inches						
Symbol	Min	Max	Notes	Min	Max	Notes				
α	0°	10°		0°	10°					
Α	_	5.080		_	0.200					
A1	0.381	1.778		0.015	0.070					
A2	3.810	4.699		0.150	0.185					
А3	3.810	4.445		0.150	0.175					
В	0.355	0.585		0.014	0.023					
B1	1.270	1.651	Typical	0.050	0.065	Typical				
С	0.203	0.381	Typical	0.008	0.015	Typical				
D	22.352	23.622		0.880	0.930					
D1	20.320	20.320	Reference	0.800	0.800	Reference				
Е	7.620	8.382		0.300	0.330					
E1	5.588	7.874		0.220	0.310					
e1	2.540	2.540	Reference	0.100	0.100	Reference				
eA	7.366	8.128	Typical	0.290	0.320	Typical				
eB	7.620	10.160		0.300	0.400					
L	3.175	3.810		0.125	0.150					
N	18	18		18	18					
S	0.508	1.397		0.020	0.055					
S1	0.381	1.270		0.015	0.050					

24.7 28-Lead Ceramic CERDIP Dual In-line with Window (300 mil)) (JW)



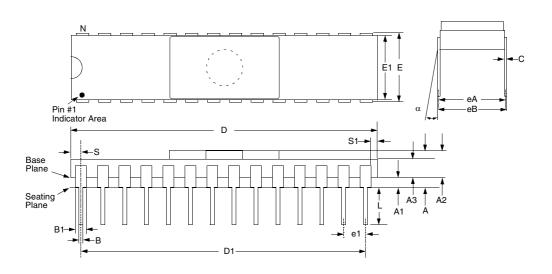
	Pa	ckage Group:	Ceramic CERDIP	Dual In-Line (C	DP)	
		Millimeters		Inches		
Symbol	Min	Max	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
Α	3.30	5.84		.130	0.230	
A1	0.38	_		0.015	_	
A2	2.92	4.95		0.115	0.195	
В	0.35	0.58		0.014	0.023	
B1	1.14	1.78	Typical	0.045	0.070	Typical
С	0.20	0.38	Typical	0.008	0.015	Typical
D	34.54	37.72		1.360	1.485	
D2	32.97	33.07	Reference	1.298	1.302	Reference
Е	7.62	8.25		0.300	0.325	
E1	6.10	7.87		0.240	0.310	
е	2.54	2.54	Typical	0.100	0.100	Typical
eA	7.62	7.62	Reference	0.300	0.300	Reference
eB	_	11.43		_	0.450	
L	2.92	5.08		0.115	0.200	
N	28	28		28	28	
D1	0.13	_		0.005	_	

24.8 40-Lead Ceramic CERDIP Dual In-line with Window (600 mil) (JW)



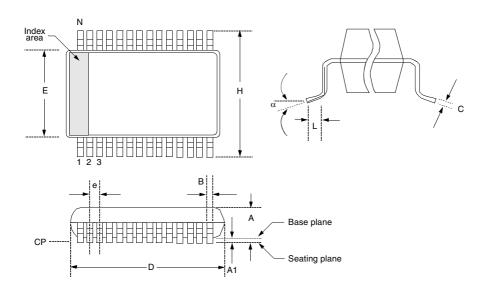
Package Group: Ceramic CERDIP Dual In-Line (CDP)								
		Millimeters		Inches				
Symbol	Min	Max	Notes	Min	Max	Notes		
α	0°	10°		0°	10°			
Α	4.318	5.715		0.170	0.225			
A1	0.381	1.778		0.015	0.070			
A2	3.810	4.699		0.150	0.185			
A3	3.810	4.445		0.150	0.175			
В	0.355	0.585		0.014	0.023			
B1	1.270	1.651	Typical	0.050	0.065	Typical		
С	0.203	0.381	Typical	0.008	0.015	Typical		
D	51.435	52.705		2.025	2.075			
D1	48.260	48.260	Reference	1.900	1.900	Reference		
Е	15.240	15.875		0.600	0.625			
E1	12.954	15.240		0.510	0.600			
e1	2.540	2.540	Reference	0.100	0.100	Reference		
eA	14.986	16.002	Typical	0.590	0.630	Typical		
eВ	15.240	18.034		0.600	0.710			
L	3.175	3.810		0.125	0.150			
N	40	40		40	40			
S	1.016	2.286		0.040	0.090			
S1	0.381	1.778		0.015	0.070			

24.9 28-Lead Ceramic Side Brazed Dual In-Line with Window (300 mil) (JW)



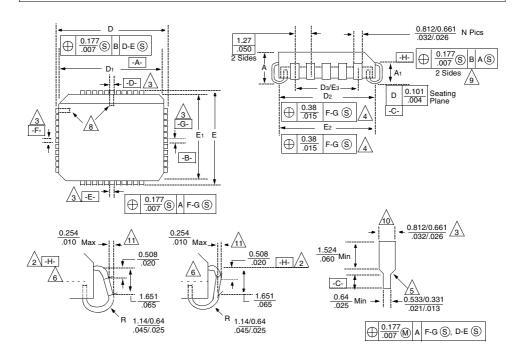
Package Group: Ceramic Side Brazed Dual In-Line (CER)								
0		Millimeters		Inches				
Symbol	Min	Max	Notes	Min	Max	Notes		
α	0°	10°		0°	10°			
Α	3.937	5.030		0.155	0.198			
A1	1.016	1.524		0.040	0.060			
A2	2.921	3.506		0.115	0.138			
A3	1.930	2.388		0.076	0.094			
В	0.406	0.508		0.016	0.020			
B1	1.219	1.321	Typical	0.048	0.052			
С	0.228	0.305	Typical	0.009	0.012			
D	35.204	35.916		1.386	1.414			
D1	32.893	33.147	Reference	1.295	1.305			
E	7.620	8.128		0.300	0.320			
E1	7.366	7.620		0.290	0.300			
e1	2.413	2.667	Typical	0.095	0.105			
eA	7.366	7.874	Reference	0.290	0.310			
eB	7.594	8.179		0.299	0.322			
L	3.302	4.064		0.130	0.160			
N	28	28		28	28			
S	1.143	1.397		0.045	0.055			
S1	0.533	0.737		0.021	0.029			

24.10 28-Lead Plastic Surface Mount (SSOP - 209 mil Body 5.30 mm) (SS)



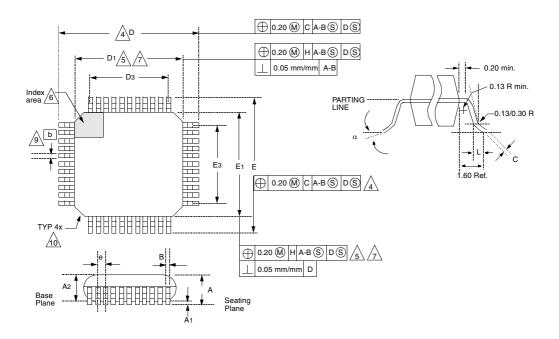
		Packaç	ge Group: Plasti	c SSOP			
		Millimeters		Inches			
Symbol	Min	Max	Notes	Min	Max	Notes	
α	0°	8°		0°	8°		
Α	1.730	1.990		0.068	0.078		
A1	0.050	0.210		0.002	0.008		
В	0.250	0.380		0.010	0.015		
С	0.130	0.220		0.005	0.009		
D	10.070	10.330		0.396	0.407		
E	5.200	5.380		0.205	0.212		
е	0.650	0.650	Reference	0.026	0.026	Reference	
Н	7.650	7.900		0.301	0.311		
L	0.550	0.950		0.022	0.037		
N	28	28		28	28		
CP	-	0.102		-	0.004		

24.11 44-Lead Plastic Leaded Chip Carrier (Square) (PLCC)



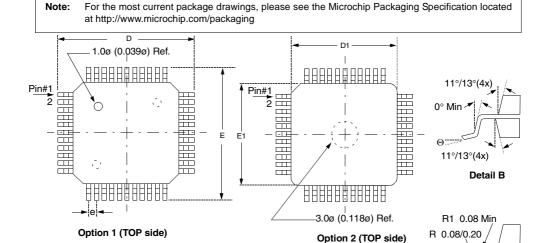
	Package Group: Plastic Leaded Chip Carrier (PLCC)									
		Millimeters			Inches					
Symbol	Min	Max	Notes	Min	Max	Notes				
Α	4.191	4.572		0.165	0.180					
A1	2.413	2.921		0.095	0.115					
D	17.399	17.653		0.685	0.695					
D1	16.510	16.663		0.650	0.656					
D2	15.494	16.002		0.610	0.630					
D3	12.700	12.700	Reference	0.500	0.500	Reference				
E	17.399	17.653		0.685	0.695					
E1	16.510	16.663		0.650	0.656					
E2	15.494	16.002		0.610	0.630					
E3	12.700	12.700	Reference	0.500	0.500	Reference				
N	44	44		44	44					
CP	_	0.102		_	0.004					
LT	0.203	0.381		0.008	0.015					

24.12 44-Lead Plastic Surface Mount (MQFP 10x10 mm Body 1.6/0.15 mm Lead Form) (PQ)



		Packag	je Group: Plastic	MQFP		
		Millimeters		Inches		
Symbol	Min	Max	Notes	Min	Max	Notes
α	0°	7°		0°	7°	
Α	2.000	2.350		0.078	0.093	
A1	0.050	0.250		0.002	0.010	
A2	1.950	2.100		0.768	0.083	
b	0.300	0.450	Typical	0.011	0.018	Typical
С	0.150	0.180		0.006	0.007	
D	12.950	13.450		0.510	0.530	
D1	9.900	10.100		0.390	0.398	
D3	8.000	8.000	Reference	0.315	0.315	Reference
E	12.950	13.450		0.510	0.530	
E1	9.900	10.100		0.390	0.398	
E3	8.000	8.000	Reference	0.315	0.315	Reference
е	0.800	0.800		0.031	0.032	
L	0.730	1.030		0.028	0.041	
N	44	44		44	44	
CP	0.102	-		0.004	_	

24.13 44-Lead Plastic Surface Mount (TQFP 10x10 mm Body 1.0/0.10 mm Lead Form) (TQ)



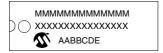
Detail B	A2 V A A2 V A Detail A 1.00 Ref.	Base Metal b c c + + + + + + + + + + + + + + + + +	Lead Finish	
	Packaç	ge Group: Plastic TQ	PP	
	Millimeters		Inches	

	Package Group: Plastic TQFP									
		Millimeters		Inches						
Symbol	Min	Max	Notes	Min	Max	Notes				
Α	1.00	1.20		0.039	0.047					
A1	0.05	0.15		0.002	0.006					
A2	0.95	1.05		0.037	0.041					
D	11.75	12.25		0.463	0.482					
D1	9.90	10.10		0.390	0.398					
Е	11.75	12.25		0.463	0.482					
E1	9.90	10.10		0.390	0.398					
L	0.45	0.75		0.018	0.030					
е	0.80	BSC		0.031 BSC						
b	0.30	0.45		0.012	0.018					
b1	0.30	0.40		0.012	0.016					
С	0.09	0.20		0.004	0.008					
c1	0.09	0.16		0.004	0.006					
N	44	44		44	44					
Θ	0°	7°		0°	7°					

- Note 1: Dimensions D1 and E1 do not include mold protrusion. Allowable mold protrusion is 0.25m/m (0.010") per side. D1 and E1 dimensions including mold mismatch.
 - 2: Dimension "b" does not include Dambar protrusion, allowable Dambar protrusion shall be 0.08m/m (0.003")max.
 - 3: This outline conforms to JEDEC MS-026.

24.14 Package Marking Information

18-Lead PDIP



Example



18-Lead SOIC



Example



18-Lead CERDIP Windowed



Example



28-Lead PDIP (.300 MIL)



Example



Legend:	MMM	Microchip part number information			
	XXX	Customer specific information*			
	AA	Year code (last 2 digits of calender year)			
	BB	Week code (week of January 1 is week '01')			
	С	Facility code of the plant at which wafer is manufactured. C = Chandler, Arizona, U.S.A. S = Tempe, Arizona, U.S.A.			
	D ₁	Mask revision number for microcontroller			
	D_2	Mask revision number for EEPROM			
	Е	Assembly code of the plant or country of origin in which part was assembled.			
Note:	line, it will b	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.			

Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

Package Marking Information (Cont'd)

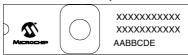


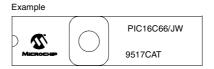
28-Lead CERDIP Skinny Windowed





28-Lead Side Brazed Skinny Windowed











40-Lead PDIP





Legend:	MMM	Microchip part number information
	XXX	Customer specific information*
	AA	Year code (last 2 digits of calender year)
	BB	Week code (week of January 1 is week '01')
	С	Facility code of the plant at which wafer is manufactured. C = Chandler, Arizona, U.S.A. S = Tempe, Arizona, U.S.A.
	D_1	Mask revision number for microcontroller
	E	Assembly code of the plant or country of origin in which part was assembled.
Note:	line, it will b	t the full Microchip part number cannot be marked on one be carried over to the next line thus limiting the number of paracters for customer specific information.

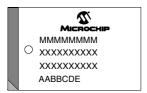
^{*} Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

Package Marking Information (Cont'd)

40-Lead CERDIP Windowed



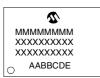
44-Lead PLCC



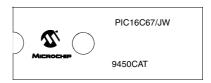
44-Lead MQFP



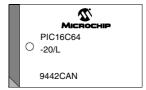
44-Lead TQFP



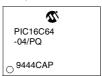
Example



Example



Example



Example



Legend:	MMM	Microchip part number information			
	XXX	Customer specific information*			
	AA	Year code (last 2 digits of calender year)			
	BB	Week code (week of January 1 is week '01')			
	С	Facility code of the plant at which wafer is manufactured. C = Chandler, Arizona, U.S.A. S = Tempe, Arizona, U.S.A.			
	D ₁ E	Mask revision number for microcontroller Assembly code of the plant or country of origin in which part was assembled.			
Note:	line, it will b	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.			

^{*} Standard OTP marking consists of Microchip part number, year code, week code, facility code, mask revision number, and assembly code. For OTP marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

APPENDIX A: MODIFICATIONS

The following are the list of modifications over the PIC16C5X microcontroller family:

- Instruction word length is increased to 14-bits.
 This allows larger page sizes both in program memory (2K now as opposed to 512 before) and register file (128 bytes now versus 32 bytes before).
- A PC high latch register (PCLATH) is added to handle program memory paging. PA2, PA1, PA0 bits are removed from STATUS register.
- Data memory paging is redefined slightly. STA-TUS register is modified.
- Four new instructions have been added: RETURN, RETFIE, ADDLW, and SUBLW.
 Two instructions TRIS and OPTION are being phased out although they are kept for compatibility with PIC16C5X.
- OPTION and TRIS registers are made addressable.
- Interrupt capability is added. Interrupt vector is at 0004h.
- 7. Stack size is increased to 8 deep.
- 8. Reset vector is changed to 0000h.
- Reset of all registers is revisited. Five different reset (and wake-up) types are recognized. Registers are reset differently.
- Wake-up from SLEEP through interrupt is added
- 11. Two separate timers, Oscillator Start-up Timer (OST) and Power-up Timer (PWRT), are included for more reliable power-up. These timers are invoked selectively to avoid unnecessary delays on power-up and wake-up.
- 12. PORTB has weak pull-ups and interrupt on change feature.
- 13. Timer0 pin is also a port pin (RA4/T0CKI) now.
- 14. FSR is made a full 8-bit register.
- "In-circuit programming" is made possible. The user can program PIC16CXX devices using only five pins: VDD, Vss, VPP, RB6 (clock) and RB7 (data in/out).
- Power Control register (PCON) is added with a Power-on Reset status bit (POR). (Not on the PIC16C61).
- Brown-out Reset has been added to the following devices:
 PIC16C62A/R62/63/R63/64A/R64/65A/R65/66/67.

APPENDIX B: COMPATIBILITY

To convert code written for PIC16C5X to PIC16CXX, the user should take the following steps:

- Remove any program memory page select operations (PA2, PA1, PA0 bits) for CALL, GOTO
- Revisit any computed jump operations (write to PC or add to PC, etc.) to make sure page bits are set properly under the new scheme.
- Eliminate any data memory page switching. Redefine data variables to reallocate them.
- 4. Verify all writes to STATUS, OPTION, and FSR registers since these have changed.
- 5. Change reset vector to 0000h.

APPENDIX C: WHAT'S NEW

Added PIC16CR63 and PIC16CR65 devices.

Added PIC16C66 and PIC16C67 devices. The PIC16C66/67 devices have 368 bytes of data memory distributed in 4 banks and 8K of program memory in 4 pages. These two devices have an enhanced SPI that supports both clock phase and polarity. The USART has been enhanced.

When upgrading to the PIC16C66/67 please note that the upper 16 bytes of data memory in banks 1,2, and 3 are mapped into bank 0. This may require relocation of data memory usage in the user application code.

Q-cycles for instruction execution were added to Section 14.0 Instruction Set Summary.

APPENDIX D: WHAT'S CHANGED

Minor changes, spelling and grammatical changes.

Divided SPI section into SPI for the PIC16C66/67 (Section 11.3) and SPI for all other devices (Section 11.2).

Added the following note for the USART. This applies to all devices except the PIC16C66 and PIC16C67.

For the PIC16C63/R63/65/65A/R65 the asynchronous high speed mode (BRGH = 1) may experience a high rate of receive errors. It is recommended that BRGH = 0. If you desire a higher baud rate than BRGH = 0 can support, refer to the device errata for additional information or use the PIC16C66/67.

APPENDIX E: REVISION E

January 2013 - Added a note to each package drawing.

APPENDIX F: PIC16/17 MICROCONTROLLERS

F.1 PIC12CXXX Family of Devices

		PIC12C508	PIC12C509	PIC12C671	PIC12C672
Clock	Maximum Frequency of Operation (MHz)	4	4	4	4
Memory	EPROM Program Memory	512 x 12	1024 x 12	1024 x 14	2048 x 14
Wellioty	Data Memory (bytes)	25	41	128	128
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
rempherais	A/D Converter (8-bit) Channels	_	_	4	4
	Wake-up from SLEEP on pin change	Yes	Yes	Yes	Yes
	I/O Pins	5	5	5	5
	Input Pins	1	1	1	1
Features	Internal Pull-ups	Yes	Yes	Yes	Yes
	Voltage Range (Volts)	2.5-5.5	2.5-5.5	2.5-5.5	2.5-5.5
	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Number of Instructions	33	33	35	35
	Packages	8-pin DIP, SOIC	8-pin DIP, SOIC	8-pin DIP, SOIC	8-pin DIP, SOIC

All PIC12C5XX devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC12C5XX devices use serial programming with data pin GP1 and clock pin GP0.

F.2 PIC14C000 Family of Devices

		PIC14C000			
Clock	Maximum Frequency of Operation (MHz)	20			
	EPROM Program Memory (x14 words)	4K			
Memory	Data Memory (bytes)	192			
memory	Timer Module(s)	TMR0 ADTMR			
Peripherals	Serial Port(s) (SPI/I ² C, USART)	I ² C with SMBus Support			
	Slope A/D Converter Channels	8 External; 6 Internal			
	Interrupt Sources	11			
	I/O Pins	22			
	Voltage Range (Volts)	2.7-6.0			
Features	In-Circuit Serial Programming	Yes			
	Additional On-chip Features	Internal 4MHz Oscillator, Bandgap Reference,Temperature Sensor, Calibration Factors, Low Voltage Detector, SLEEP, HIBERNATE, Comparators with Programmable References (2)			
	Packages	28-pin DIP (.300 mil), SOIC, SSOP			

F.3 PIC16C15X Family of Devices

		PIC16C154	PIC16CR154	PIC16C156	PIC16CR156	PIC16C158	PIC16CR158
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x12 words)	512	_	1K	_	2K	_
Memory	ROM Program Memory (x12 words)	_	512	_	1K	_	2K
	RAM Data Memory (bytes)	25	25	25	25	73	73
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0
	I/O Pins	12	12	12	12	12	12
	Voltage Range (Volts)	3.0-5.5	2.5-5.5	3.0-5.5	2.5-5.5	3.0-5.5	2.5-5.5
Features	Number of Instructions	33	33	33	33	33	33
	Packages	18-pin DIP, SOIC; 20-pin SSOP					

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

F.4 PIC16C5X Family of Devices

		PIC16C52	PIC16C54	PIC16C54A	PIC16CR54A	PIC16C55	PIC16C56
Clock	Maximum Frequency of Operation (MHz)	4	20	20	20	20	20
	EPROM Program Memory (x12 words)	384	512	512	_	512	1K
Memory	ROM Program Memory (x12 words)	_	_	_	512	_	_
	RAM Data Memory (bytes)	25	25	25	25	24	25
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0	TMR0
	I/O Pins	12	12	12	12	20	12
	Voltage Range (Volts)	2.5-6.25	2.5-6.25	2.0-6.25	2.0-6.25	2.5-6.25	2.5-6.25
Features	Number of Instructions	33	33	33	33	33	33
i caluics	Packages	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin DIP, SOIC, SSOP	18-pin DIP, SOIC; 20-pin SSOP

		PIC16C57	PIC16CR57B	PIC16C58A	PIC16CR58A
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20
	EPROM Program Memory (x12 words)	2K	_	2K	_
Memory	ROM Program Memory (x12 words)	_	2K	_	2K
	RAM Data Memory (bytes)	72	72	73	73
Peripherals	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
	I/O Pins	20	20	12	12
	Voltage Range (Volts)	2.5-6.25	2.5-6.25	2.0-6.25	2.5-6.25
Features	Number of Instructions	33	33	33	33
	Packages	28-pin DIP, SOIC, SSOP	28-pin DIP, SOIC, SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer (except PIC16C52), selectable code protect and high I/O current capability.

F.5 PIC16C55X Family of Devices

		PIC16C554	PIC16C556 ⁽¹⁾	PIC16C558
Clock	Maximum Frequency of Operation (MHz)	20	20	20
Memorv	EPROM Program Memory (x14 words)	512	1K	2K
	Data Memory (bytes)	80	80	128
	Timer Module(s)	TMR0	TMR0	TMR0
Peripherals	Comparators(s)	_	_	_
	Internal Reference Voltage	_	_	_
	Interrupt Sources	3	3	3
	I/O Pins	13	13	13
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0
Features	Brown-out Reset	_	_	_
	Packages	18-pin DIP,	18-pin DIP,	18-pin DIP,
		SOIC; 20-pin SSOP	SOIC; 20-pin SSOP	SOIC; 20-pin SSOP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C5XX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip sales office for availability of these devices.

F.6 PIC16C62X and PIC16C64X Family of Devices

		PIC16C620	PIC16C621	PIC16C622	PIC16C642	PIC16C662
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20
Memory	EPROM Program Memory (x14 words)	512	1K	2K	4K	4K
	Data Memory (bytes)	80	80	128	176	176
	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0
Peripherals	Comparators(s)	2	2	2	2	2
	Internal Reference Voltage	Yes	Yes	Yes	Yes	Yes
	Interrupt Sources	4	4	4	4	5
	I/O Pins	13	13	13	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	3.0-6.0	3.0-6.0
Footures	Brown-out Reset	Yes	Yes	Yes	Yes	Yes
Features	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin PDIP, SOIC, Windowed CDIP	40-pin PDIP, Windowed CDIP; 44-pin PLCC, MQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C62X and PIC16C64X Family devices use serial programming with clock pin RB6 and data pin RB7.

F.7 PIC16C7XX Family of Devces

		PIC16C710	PIC16C71	PIC16C711	PIC16C715	PIC16C72	PIC16CR72 ⁽¹⁾
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20	20	20
	EPROM Program Memory (x14 words)	512	1K	1K	2K	2K	_
Memory	ROM Program Memory (14K words)	_	_	_	_	_	2K
	Data Memory (bytes)	36	36	68	128	128	128
	Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/ PWM Module(s)	_	_	_	_	1	1
	Serial Port(s) (SPI/I ² C, USART)	_	_	_	_	SPI/I ² C	SPI/I ² C
	Parallel Slave Port	_	_	_	_	_	_
	A/D Converter (8-bit) Channels	4	4	4	4	5	5
	Interrupt Sources	4	4	4	4	8	8
	I/O Pins	13	13	13	13	22	22
	Voltage Range (Volts)	3.0-6.0	3.0-6.0	3.0-6.0	3.0-5.5	2.5-6.0	3.0-5.5
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	_	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin SDIP, SOIC, SSOP	28-pin SDIP, SOIC, SSOP

		PIC16C73A	PIC16C74A	PIC16C76	PIC16C77
Clock	Maximum Frequency of Operation (MHz)	20	20	20	20
Memory	EPROM Program Memory (x14 words)	4K	4K	8K	8K
	Data Memory (bytes)	192	192	368	368
	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
Peripherals	Capture/Compare/PWM Mod- ule(s)	2	2	2	2
	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART	SPI/I ² C, USART
	Parallel Slave Port	_	Yes	_	Yes
	A/D Converter (8-bit) Channels	5	8	5	8
	Interrupt Sources	11	12	11	12
	I/O Pins	22	33	22	33
	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
Features	In-Circuit Serial Programming	Yes	Yes	Yes	Yes
	Brown-out Reset	Yes	Yes	Yes	Yes
	Packages	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP	28-pin SDIP, SOIC	40-pin DIP; 44-pin PLCC, MQFP, TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C7XX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip sales office for availability of these devices.

F.8 PIC16C8X Family of Devices

		PIC16F83	PIC16CR83	PIC16F84	PIC16CR84
Clock	Maximum Frequency of Operation (MHz)	10	10	10	10
	Flash Program Memory	512	_	1K	_
	EEPROM Program Memory	_	_	_	_
Memory	ROM Program Memory	_	512	_	1K
	Data Memory (bytes)	36	36	68	68
	Data EEPROM (bytes)	64	64	64	64
Peripher- als	Timer Module(s)	TMR0	TMR0	TMR0	TMR0
	Interrupt Sources	4	4	4	4
	I/O Pins	13	13	13	13
Features	Voltage Range (Volts)	2.0-6.0	2.0-6.0	2.0-6.0	2.0-6.0
	Packages	18-pin DIP, SOIC	18-pin DIP, SOIC	18-pin DIP, SOIC	18-pin DIP, SOIC

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C8X Family devices use serial programming with clock pin RB6 and data pin RB7.

F.9 PIC16C9XX Family Of Devices

		PIC16C923	PIC16C924
Clock	Maximum Frequency of Operation (MHz)	8	8
Mamaur	EPROM Program Memory	4K	4K
Memory	Data Memory (bytes)	176	176
	Timer Module(s)	TMR0,	TMR0,
		TMR1, TMR2	TMR1, TMR2
	Capture/Compare/PWM Module(s)	1	1
Peripherals	Serial Port(s) (SPI/I ² C, USART)	SPI/I ² C	SPI/I ² C
	Parallel Slave Port	_	_
	A/D Converter (8-bit) Channels	_	5
	LCD Module	4 Com, 32 Seg	4 Com, 32 Seg
	Interrupt Sources	8	9
	I/O Pins	25	25
	Input Pins	27	27
	Voltage Range (Volts)	3.0-6.0	3.0-6.0
Features	In-Circuit Serial Programming	Yes	Yes
	Brown-out Reset	_	_
	Packages	64-pin SDIP ⁽¹⁾ ,	64-pin SDIP ⁽¹⁾ ,
		TQFP; 68-pin PLCC,	TQFP; 68-pin PLCC,
		Die	Die

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16C9XX Family devices use serial programming with clock pin RB6 and data pin RB7.

F.10 PIC17CXXX Family of Devices

		PIC17C42A	PIC17CR42	PIC17C43	PIC17CR43	PIC17C44
Clock	Maximum Frequency of Operation (MHz)	33	33	33	33	33
	EPROM Program Memory (words)	2K	_	4K	_	8K
Memory	ROM Program Memory (words)	_	2K	_	4K	_
	RAM Data Memory (bytes)	232	232	454	454	454
Peripherals	Timer Module(s)	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3
	Captures/PWM Module(s)	2	2	2	2	2
	Serial Port(s) (USART)	Yes	Yes	Yes	Yes	Yes
	Hardware Multiply	Yes	Yes	Yes	Yes	Yes
	External Interrupts	Yes	Yes	Yes	Yes	Yes
	Interrupt Sources	11	11	11	11	11
	I/O Pins	33	33	33	33	33
Features	Voltage Range (Volts)	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0	2.5-6.0
	Number of Instructions	58	58	58	58	58
	Packages	40-pin DIP; 44-pin PLCC, MQFP, TQFP				

		PIC17C752	PIC17C756
Clock	Maximum Frequency of Operation (MHz)	33	33
	EPROM Program Memory (words)	8K	16K
Memory	ROM Program Memory (words)	_	_
	RAM Data Memory (bytes)	454	902
Peripherals	Timer Module(s)	TMR0, TMR1, TMR2, TMR3	TMR0, TMR1, TMR2, TMR3
	Captures/PWM Module(s)	4/3	4/3
	Serial Port(s) (USART)	2	2
	Hardware Multiply	Yes	Yes
	External Interrupts	Yes	Yes
	Interrupt Sources	18	18
	I/O Pins	50	50
Features	Voltage Range (Volts)	3.0-6.0	3.0-6.0
	Number of Instructions	58	58
	Packages	64-pin DIP; 68-pin LCC, 68-pin TQFP	64-pin DIP; 68-pin LCC, 68-pin TQFP

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

PIN COMPATIBILITY

Devices that have the same package type and VDD, VSS and $\overline{\text{MCLR}}$ pin locations are said to be pin compatible. This allows these different devices to operate in the same socket. Compatible devices may only requires minor software modification to allow proper operation in the application socket (ex., PlC16C56 and PlC16C61 devices). Not all devices in the same package size are pin compatible; for example, the PlC16C62 is compatible with the PlC16C63, but not the PlC16C55.

Pin compatibility does not mean that the devices offer the same features. As an example, the PIC16C54 is pin compatible with the PIC16C71, but does not have an A/D converter, weak pull-ups on PORTB, or interrupts.

TABLE F-1: PIN COMPATIBLE DEVICES

Pin Compatible Devices	Package
PIC12C508, PIC12C509, PIC12C671, PIC12C672	8-pin
PIC16C154, PIC16CR154, PIC16C156, PIC16CR156, PIC16CR156, PIC16CS2, PIC16C54, PIC16CS4A, PIC16CS54A, PIC16CS54A, PIC16CS6, PIC16CS6, PIC16CS6A, PIC16CS6A, PIC16CS5A, PIC16CS5A, PIC16CS54, PIC16CS54, PIC16CS56, PIC16CS58 PIC16C620, PIC16C621, PIC16C622 PIC16C641, PIC16C642, PIC16C661, PIC16C661, PIC16C6710, PIC16C71, PIC16C711, PIC16C715 PIC16F83, PIC16CR83, PIC16F84A, PIC16CR84	18-pin, 20-pin
PIC16C55, PIC16C57, PIC16CR57B	28-pin
PIC16CR62, PIC16C62A, PIC16C63, PIC16CR63, PIC16C66, PIC16C72, PIC16C73A, PIC16C76	28-pin
PIC16CR64, PIC16C64A, PIC16C65A, PIC16CR65, PIC16C67, PIC16C74A, PIC16C77	40-pin
PIC17CR42, PIC17C42A, PIC17C43, PIC17CR43, PIC17C44	40-pin
PIC16C923, PIC16C924	64/68-pin
PIC17C756, PIC17C752	64/68-pin



NOTES:

SPI Master/Slave Connection...... 87 INDEX Numerics Timer0 65 9-bit Receive Enable bit, RX9......106 Timer1 72 9th bit of received data, RX9D.......106 Timer2 75 USART Receive 114 USART Transmit 112 Α Watchdog Timer 140 Absolute Maximum Ratings.......163, 183, 199, 215, 231, 247, 263 BOR 47. 131 ACK.......96, 100, 101 BRGH 105 ALU9 AN552 (Implementing Wake-up on Key Stroke) 53 Buffer Full Status bit, BF...... 84, 89 AN556 (Implementing a Table Read)48 AN594 (Using the CCP Modules)77 C Capture Baud Rate Formula......107 Block Diagram 78 **Baud Rates** Pin Configuration 78 Asynchronous Mode108 Error, Calculating107 RX Pin Sampling, Timing Diagrams......110, 111 Capture Interrupt 78 Sampling......110 Capture/Compare/PWM (CCP) Synchronous Mode......108 Capture Mode...... 78 Capture Mode Block Diagram 78 **Block Diagrams** CCP1......77 Capture Mode Operation78 CCP2......77 Compare Mode Block Diagram 79 Overview...... 63 External Parallel Resonant Crystal Circuit 127 PWM Block Diagram 80 External Series Resonant Crystal Circuit.......127 I²C Mode......99 PWM, Example Frequencies/Resolutions 81 In-circuit Programming Connections......142 Parallel Slave Port, PORTD-PORTE61 PIC16C62 11 PIC16C63 12 CCP1 Interrupt Flag bit, CCP1IF......41 PIC16C6411 CCP1 Mode Select bits......78 PIC16C64A11 CCP1CON......24, 26, 28, 30, 32, 34 CCP1IE 38 CCP1IF.......41 PIC16C66 13 CCP1M3:CCM1M0......78 CCP1X:CCP1Y.......78 PIC16CR62......11 CCP2 Interrupt Enable bit, CCP2IE.......45 PIC16CR63......12 CCP2 Interrupt Flag bit, CCP2IF.......46 PIC16CR64......11 CCP2 Mode Select bits......78 PIC16CR65......12 CCP2CON 24, 26, 28, 30, 32, 34 CCP2IE......45 PORTD (I/O Mode)57 PORTE (I/O Mode)58 PWM80 CCP2X:CCP2Y......78 RA3:RA0 pins51 CCPR1H......24, 26, 28, 30, 32, 34 RA4/T0CKI pin51 CCPR1L 24, 26, 28, 30, 32, 34 RA5 pin51 CCPR2L 24, 26, 28, 30, 32, 34 CKE 89 RC Oscillator Mode......127

CKP 85, 90

Clearing Interrupts53	44-Lead Plastic Surface Mount (MQFP
Clock Polarity Select bit, CKP85, 90	10x10 mm Body 1.6/0.15 mm Lead Form) 302, 303
Clock Polarity, SPI Mode87	Device Varieties
Clock Source Select bit, CSRC105	Digit Carry
Clocking Scheme18	Digit Carry bit
Code Examples	Direct Addressing 49
Changing Between Capture Prescalers79	-
Ensuring Interrupts are Globally Disabled136	E
Indirect Addressing49	Electrical Characteristics 163, 183, 199, 215, 231, 247, 263
Initializing PORTA51	External Clock Synchronization, TMR0 67
Initializing PORTB53	F
Initializing PORTC55	Г
Loading the SSPBUF Register86	Family of Devices
Loading the SSPBUF register91	PIC12CXXX309
Reading a 16-bit Free-running Timer73	PIC14C000
Read-Modify-Write on an I/O Port60	PIC16C15X310
Saving Status, W, and PCLATH Registers139	PIC16C55X31
Subroutine Call, Page0 to Page149	PIC16C5X310
Code Protection142	PIC16C62X and PIC16C64X31
Compare	PIC16C6X
Block Diagram79	PIC16C7XX
Mode79	PIC16C8X313
Pin Configuration79	PIC16C9XX313
Software Interrupt79	PIC17CXX
Special Event Trigger79	FERR100
Computed GOTO48	Framing Error bit, FERR106
Configuration Bits123	FSR24, 25, 26, 27, 28, 29, 30, 31, 32, 33, 34
Configuration Word, Diagram124	Fuzzy Logic Dev. System (fuzzyTECH®-MP) 159, 16
Connecting Two Microcontrollers87	0
Continuous Receive Enable bit, CREN106	G
CREN	General Description
CSRC	General Purpose Registers
	GIE
D	Global Interrupt Enable bit, GIE3
D/A84, 89	Graphs
Data/Address bit, D/A84, 89	PIC16C6X28
Data Memory	PIC16C61 173
Organization20	ш
Section	Н
Data Sheet	High Baud Rate Select bit, BRGH105
Compatibility307	1
Modifications307	•
What's New308	I/O Ports, Section
DC35	I ² C
DC CHARACTERISTICS 164, 184, 200, 216, 232, 248, 264	Addressing100
Development Support	Addressing I ² C Devices96
Development Tools	Arbitration
Device Drawings	Block Diagram99
18-Lead Ceramic CERDIP Dual In-line	Clock Synchronization98
with Window (300 mil)296	Combined Format9
18-Lead Plastic Dual In-line (300 mil)	I ² C Operation99
18-Lead Plastic Surface Mount	I ² C Overview99
(SOIC - Wide, 300 mil Body)294	Initiating and Terminating Data Transfer99
28-Lead Ceramic CERDIP Dual In-line with	Master Mode103
Window (300 mil))297	Master-Receiver Sequence97
28-Lead Ceramic Side Brazed Dual In-Line	Master-Transmitter Sequence9
	Mode99
with Window (300 mil)299 28-Lead Plastic Dual In-line (300 mil)292	Mode Selection99
, ,	Multi-master
28-Lead Plastic Surface Mount	Multi-Master Mode
(SOIC - Wide, 300 mil Body)295	Reception
28-Lead Plastic Surface Mount	Reception Timing Diagram
(SSOP - 209 mil Body 5.30 mm)300	SCL and SDA pins
40-Lead Ceramic CERDIP Dual In-line	Slave Mode
with Window (600 mil)	START99
40-Lead Plastic Dual In-line (600 mil)	STOP
44-Lead Plastic Leaded Chip Carrier (Square)301	50,00

Transfer Acknowledge96	
Transmission102	
ID Locations142	2
IDLE_MODE104	ļ
In-circuit Serial Programming142	2
INDF24, 26, 28, 30, 32, 34	
Indirect Addressing49	
Instruction Cycle	
Instruction Flow/Pipelining18	
Instruction Format	
Instruction Set	•
ADDLW145	-
ADDWF145	
ANDLW 145	
ANDWF 145	
BCF 146	
	-
BSF	
BTFSC	
BTFSS147	
CALL	
CLRF148	
CLRW148	
CLRWDT148	
COMF149	
DECF149	
DECFSZ149)
GOTO150)
INCF150)
INCFSZ151	ı
IORLW151	i
IORWF152	2
MOVF152	2
MOVLW152	2
MOVWF152	2
NOP153	3
OPTION	
RETFIE	
RETLW	
RETURN	
RLF	
RRF	
SLEEP	
SUBLW	
SUBWF157	
SWAPF 157	
TRIS	
XORLW	
XORWF	
Section	
Summary Table	
INTCON24, 25, 26, 27, 28, 29, 30, 31, 32, 33, 34	
INTE	
INTEDG	
Interrupt Edge Select bit, INTEDG36	;
Interrupt on Change Feature53	3
Interrupts	
Section	
CCP	3
CCP138	
CCP1 Flag bit41	
CCP2 Enable bit45	;
CCP2 Flag bit46	;
Context Saving139)
Parallel Slave Port Flag bit43	
Parallel Slave Prot Read/Write Enable bit	
Port RB	
RB0/INT	

RB0/INT Timing Diagram	
Receive Flag bit	
Timer0	
Timer0, Timing	
Timing Diagram, Wake-up from SLEEP	
TMR0	
USART Receive Enable bit USART Transmit Enable bit	
USART Transmit Flag bit	
Wake-up	
Wake-up from SLEEP	
INTF	
IRP	35
L	
Loading the Program Counter	48
М	
MPASM Assembler1	EO 160
MPLAB-C	
MPSIM Software Simulator 1	
IVII SIIVI SOITWATE SIITIUIATOT	33, 10
0	
OERR	106
One-Time-Programmable Devices	7
OPCODE	143
Open-Drain	
OPTION25, 27, 29, 31	
Oscillator Start-up Timer (OST)	23, 129
Oscillators	
Block Diagram, External Parallel Resonant Cryst	
Capacitor Selection Configuration	
External Crystal Circuit	
HS1	
LP1	
RC, Block Diagram	
RC, Section	
XT	125
Overrun Error bit, OERR	106
P	
•	04.00
PPackaging Information	
Parallel Slave Port	29
PORTD	57
Section	
Parallel Slave Port Interrupt Flag bit, PSPIF	
Parallel Slave Port Read/Write Interrupt Enable bit, PS	SPIE 39
PCL24, 25, 26, 27, 28, 29, 30, 31, 32	, 33, 34
PCLATH 24, 25, 26, 27, 28, 29, 30, 31, 32, 33	, 34, 48
<u>PC</u> ON 25, 27, 29, 31, 33,	
PD	
PEIE	
Peripheral Interrupt Enable bit, PEIE	
PICDEM-1 Low-Cost PIC16/17 Demo Board 1	
PICDEM-2 Low-Cost PIC16CXX Demo Board 1 PICDEM-3 Low-Cost PIC16C9XXX Demo Board	
PICMASTER In-Circuit Emulator	
PICSTART Low-Cost Development System	
PIE1	
PIE2	
Pin Compatible Devices	
Pin Functions	
MCLR/VPP	16

OSC1/CLKIN	
	16
	16
PORTA	
PORTB	
PORTC	
PORTD	
PORTE	59
RA4/T0CKI	16, 52
RA5/SS	16. 52
RB0/INT	
RB6	,
RB7	
RC0/T1OSI/T1CKI	
RC0/T1OSO/T1CKI	16, 55
RC1/T1OSI	55
RC1/T1OSI/CCP2	
RC1/T10S0	,
RC2/CCP1	, ,
RC3/SCK/SCL	16, 55, 56
RC4/SDI/SDA	16, 55, 56
RC5/SDO	16, 55, 56
RC6/TX/CK	
RC7/RX/DT	
RD7/PSP7:RD0/PSP0	
RE0/RD	
RE1/WR	
RE2/CS	17, 59, 61
SCK	86–88
SDI	
SDO	
SS	
VDD	17
Vss	17
PIR1	24, 26, 28, 30, 32, 34
PIR2	
POP	
POR	
POR Time-Out Sequence on Power	er-Up134
POR Time-Out Sequence on Power Port RB Interrupt	er-Up134
Port RB Interrupt	er-Up134 53
Port RB Interrupt	er-Up53 24, 26, 28, 30, 32, 34, 51
PORTAPORTB	er-Up
PORT RB InterruptPORTAPORTBPORTB Interrupt on Change	er-Up
Port RB Interrupt	er-Up
PORT RB InterruptPORTAPORTBPORTB Interrupt on Change	er-Up
Port RB Interrupt	er-Up
Port RB Interrupt	er-Up
Port RB Interrupt PORTA	er-Up
Port RB Interrupt PORTA PORTB PORTB Interrupt on Change PORTB Pull-up Enable bit, RBPU. PORTC PORTD PORTE Ports	er-Up
Port RB Interrupt	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change. PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTB. PORTE. Ports Bi-directional I/O Programming Considerati PORTA. PORTB. PORTB. PORTB. PORTB. PORTC.	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change. PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTE. PORTE. Bi-directional I/O Programming Considerati PORTA. PORTB. PORTB. PORTC PORTC PORTD	er-Up
Port RB Interrupt PORTA PORTB PORTB PORTB Interrupt on Change PORTB Pull-up Enable bit, RBPU PORTC PORTD PORTE PORTB Bi-directional I/O Programming Considerati PORTA PORTB PORTB PORTC PORTD PORTD PORTD PORTD PORTD	er-Up
Port RB Interrupt	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change. PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTE. PORTE Bi-directional I/O Programming Considerati PORTA. PORTB. PORTC PORTD PORTC PORTD PORTC PORTD PORTE Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change. PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTE. Ports Bi-directional I/O Programming Considerati PORTA. PORTB. PORTC. PORTD PORTC. PORTD PORTC. PORTD PORTC. PORTD PORTE. Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR)	er-Up
Port RB Interrupt PORTA PORTB PORTB PORTB Interrupt on Change PORTB Pull-up Enable bit, RBPU. PORTC PORTD PORTE Ports Bi-directional I/O Programming Considerati PORTA PORTB PORTC PORTD PORTD PORTC Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR) Power-on Reset Status bit, POR.	er-Up
Port RB Interrupt PORTA PORTB PORTB Interrupt on Change PORTB Pull-up Enable bit, RBPU. PORTC PORTD PORTE PORTE PORTB I/O Programming Considerati PORTA PORTB PORTB PORTD PORTD PORTD PORTD PORTD PORTD PORTD PORTD PORTD PORTB Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR) Power-on Reset Status bit, POR. Power-up Timer (PWRT)	er-Up
Port RB Interrupt PORTA. PORTB	er-Up
Port RB Interrupt PORTA PORTB PORTB Interrupt on Change PORTB Pull-up Enable bit, RBPU. PORTC PORTD PORTE PORTE PORTB I/O Programming Considerati PORTA PORTB PORTB PORTD PORTD PORTD PORTD PORTD PORTD PORTD PORTD PORTD PORTB Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR) Power-on Reset Status bit, POR. Power-up Timer (PWRT)	er-Up
Port RB Interrupt PORTA. PORTB	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change. PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTE. Ports Bi-directional I/O Programming Considerati PORTA. PORTB. PORTC PORTD PORTC PORTD PORTC PORTD PORTC PORTD PORTC PORTD PORTE Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR) Power-up Timer (PWRT) PR2 Prescaler Prescaler Prescaler	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTE. Ports Bi-directional I/O Programming Considerati PORTA. PORTB. PORTC. PORTD PORTC. PORTD PORTE. Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR) Power-up Timer (PWRT). PR2. Prescaler Prescaler Assignment bit, PSA. Prescaler Rate Select bits, PS2:PS	er-Up
Port RB Interrupt PORTA. PORTB. PORTB Interrupt on Change. PORTB Pull-up Enable bit, RBPU. PORTC. PORTD. PORTE. Ports Bi-directional I/O Programming Considerati PORTA. PORTB. PORTC PORTD PORTC PORTD PORTC PORTD PORTC PORTD PORTC PORTD PORTE Successive Operations on an Power/Control Status Register, PC Power-down bit Power-down Mode Power-on Reset (POR) Power-up Timer (PWRT) PR2 Prescaler Prescaler Prescaler	er-Up

Map	
Organization	
Paging	
Section	19
Programming While In-circuit	142
PS2:PS0	
PSA	
PSPIE	30
PSPIF	
Pull-ups	
PUSH	48
PWM	
Block Diagram	80
Calculations	81
Mode	80
Output Timing	80
PWM Least Significant bits	
VVVI Loudt Olgrinioant bito	
Q	
3 11 011	4.0
Quadrature Clocks	
Quick-Turnaround-Production	
R	
: -	
R/W bit 84, 89, 96,	
RA0 pin	51
RA1 pin	51
RA2 pin	51
RA3 pin	
RA4/T0CKI pin	
RA5 pin	
RB Port Change Interrupt Enable bit, RBIE	
RB Port Change Interrupt Flag bit, RBIF	
RB0	
RB0/INT	
RB0/INT External Interrupt Enable bit, INTE	37
RB0/INT External Interrupt Flag bit, INTF	37
RB1	
RB2	
RB3	
RB4	
RB5	
RB6	
RB7	53
RBIE	37
RBIF	37
RBPU	36. 53
RC Oscillator	
RCIE	
RCIF	
RCREG24, 26,	
RCSTA24, 26, 28, 3	
RCV_MODE	
Read Only Memory	
Read/Write bit Information, R/W	84, 89
Receive and Control Register	106
Receive Overflow Detect bit, SSPOV	
Receive Overflow Indicator bit, SSPOV	
Register Bank Select bit, Indirect	
Register Bank Select bits. Direct	35

gisters		PORTD	
CCP1CON		Section	57
Diagram	78	Summary	28, 30, 32
Section	78	PORTE	
Summary		Section	58
CCP2CON	2 1, 20, 20, 00, 02		28, 30, 32
Diagram	79	PR2	20, 00, 02
•			05 07 00 01 00
Section			25, 27, 29, 31, 33
Summary	26, 30, 32	RCREG	
CCPR1H		-	26, 30, 32
Summary	24, 26, 28, 30, 32	RCSTA	
CCPR1L		Diagram	106
Summary	24, 26, 28, 30, 32	Summary	26, 30, 32
CCPR2H		SPBRG	•
Summary	26 30 32		27, 31, 33
CCPR2L	20, 00, 02	•	
	00.00.00	SSPBUF	22
Summary	26, 30, 32		
FSR		Summary	24, 26, 28, 30, 32
Indirect Addressing	49	SSPCON	
Summary	24, 26, 28, 30, 32, 34	Diagram	85
INDF			24, 26, 28, 30, 32
Indirect Addressing	49	SSPSR	
			86
Summary	. 24, 26, 26, 30, 32, 34		
INTCON			89
Diagram	37	· ·	84
Section	37	Section	84
Summary	24, 26, 28, 30, 32, 34	Summary	25, 27, 29, 31, 33
OPTION		STATUS	
Diagram	36		35
Section		•	35
Summary	. 25, 27, 29, 31, 33, 34	•	24, 26, 28, 30, 32, 34
PCL		T1CON	
Section	48	Diagram	71
Summary	24, 26, 28, 30, 32, 34	Section	71
PCLATH		Summary	24, 26, 28, 30, 32
Section	48	T2CON	, -, -, -, -
Summary			75
	24, 20, 20, 30, 32, 34	· ·	
PCON	47		
Diagram		•	24, 26, 28, 30, 32
Section		TMR0	
Summary	25, 27, 29, 31, 33	Summary	24, 26, 28, 30, 32, 34
PIE1		TMR1H	
Diagram	40	Summary	24, 26, 28, 30, 32
Section		TMR1L	
			04 06 00 00 00
Summary	25, 27, 29, 31, 33	-	24, 26, 28, 30, 32
PIE2			75
Diagram			24, 26, 28, 30, 32
Section	45	TRISA	
Summary	27, 31, 33	Section	51
PIR1	, - ,		25, 27, 29, 31, 33
Diagram	44	TRISB	
•			
Section			53
Summary	24, 26, 28, 30, 32	Summary	25, 27, 29, 31, 33, 34
PIR2		TRISC	
Diagram	46	Section	55
Section			25, 27, 29, 31, 33
Summary		TRISD	2, =. , =2, 3., 00
PORTA	20, 00, 02		57
	F4		
Section		,	29, 31, 33
Summary	24, 26, 28, 30, 32	TRISE	
PORTB		Diagram	58
Section	53	Section	58
Summary			29, 31, 33
PORTC	, , , , , , ,	TXREG	20, 31, 00
			00 00 00
Section		Summary	26, 30, 32
Summary	24. 26. 28. 30. 32		

TXSTA	SSP in I ² C Mode - See I ² C
Diagram105	SSPADD25, 27, 29, 31, 33, 34, 9
Section105	SSPBUF 24, 26, 28, 30, 32, 34, 9
Summary31, 33	SSPCON24, 26, 28, 30, 32, 34, 85, 9
W9	SSPEN
Special Function Registers, Initialization	SSPIE
Conditions	SSPIF4
Special Function Registers, Reset Conditions131	SSPM3:SSPM0
Special Function Register Summary 24, 26, 28, 30, 32	•
	SSPOV
File Maps21	SSPSTAT 25, 27, 29, 31, 33, 34, 84, 9
Resets	SSPSTAT Register
ROM7	Stack4
RP0 bit	Start bit, S84, 8
RP1	STATUS24, 25, 26, 27, 28, 29, 30, 31, 32, 33, 3
RX9106	Status bits 130, 13
RX9D106	Status Bits During Various Resets
•	Stop bit, P84, 8
S	Switching Prescalers6
S84, 89	SYNC,USART Mode Select bit, SYNC
SCI - See Universal Synchronous Asynchronous Receiver	Synchronizing Clocks, TMR0
Transmitter (USART)	Synchronous Serial Port (SSP)
SCK86	Block Diagram, SPI Mode
SCL	CDI Manta (Claus Dia reserv
SDI	SPI Master/Slave Diagram
SDO	SPI Mode
	Synchronous Serial Port Enable bit, SSPEN85, 9
Serial Port Enable bit, SPEN	Synchronous Serial Port Interrupt Enable bit, SSPIE 3
Serial Programming142	Synchronous Serial Port Interrupt Flag bit, SSPIF 4
Serial Programming, Block Diagram142	Synchronous Serial Port Mode Select bits,
Serialized Quick-Turnaround-Production7	SSPM3:SSPM0 85, 9
Single Receive Enable bit, SREN106	Synchronous Serial Port Module
Slave Mode	Synchronous Serial Port Status Register
SCL100	
SDA100	T
SLEEP Mode123, 141	T0CS
SMP89	TOIE
Software Simulator (MPSIM)	TOIF
SPBRG25, 27, 29, 31, 33, 34	T0SE
Special Features, Section	T1CKPS1:T1CKPS0
SPEN	
SPI	T1CON
	T10SCEN
Block Diagram	T1SYNC
Master Mode92	T2CKPS1:T2CKPS0
Master Mode Timing93	T2CON 24, 26, 28, 30, 32, 34, 7
Mode86	TIme-out13
Serial Clock91	Time-out bit3
Serial Data In91	Time-out Sequence13
Serial Data Out91	Timer Modules
Slave Mode Timing94	Overview, all6
Slave Mode Timing Diagram93	Timer0
Slave Select91	Block Diagram
SPI clock92	Counter Mode
SPI Mode91	
SSPCON 90	External Clock
	Interrupt 6
SSPSTAT89	Overview6
SPI Clock Edge Select bit, CKE89	Prescaler 6
SPI Data Input Sample Phase Select bit, SMP89	Section 6
SPI Mode86	Timer Mode6
SREN106	Timing DiagramTilming Diagrams
SS 86	Timer0 6
SSP	TMR0 register6
Module Overview83	Timer1
Section	Block Diagram
SSPBUF 92	
SSPCON	Capacitor Selection
SSPSR	Counter Mode, Asynchronous
	Counter Mode, Synchronous
SSPSTAT89	External Clock
	Oscillator 7

Overview6	63	Watchdog Timer	20
Prescaler	72	PIC16C63	
Read/Write in Asynchronous Counter Mode		Brown-out Reset	239
Section		Capture/Compare/PWM	
		CLKOUT and I/O	
Synchronizing with External Clock			
Timer Mode		External Clock	
TMR1 Register Pair	71	I ² C Bus Data	
Timer2		I ² C Bus Start/Stop Bits	24
Block Diagram	75	Oscillator Start-up Timer	239
Overview	63	Power-up Timer	
Postscaler		Reset	
		SPI Mode	
Prescaler			
Timer0 Clock Synchronization, Delay		Timer0	
TImer0 Interrupt	38	Timer1	240
Timer1 Clock Source Select bit, TMR1CS	71	USART Synchronous Receive	
Timer1 External Clock Input Synchronization		(Master/Slave)	246
Control bit, T1SYNC	71	Watchdog Timer	
Timer1 Input Clock Prescale Select bits		PIC16C64	
Timer1 Mode Selection		Capture/Compare/PWM	10
Timer1 On bit, TMR1ON		CLKOUT and I/O	
Timer1 Oscillator Enable Control bit, T1OSCEN	71	External Clock	
Timer2 Clock Prescale Select bits,		I ² C Bus Data	197
T2CKPS1:T2CKPS0	75	I ² C Bus Start/Stop Bits	196
Timer2 Module	75	Oscillator Start-up Timer	19 [.]
Timer2 On bit, TMR2ON		Parallel Slave Port	
	13	Power-up Timer	
Timer2 Output Postscale Select bits,			
TOUTPS3:TOUTPS0	75	Reset	
Timing Diagrams		SPI Mode	
Brown-out Reset12	29	Timer0	192
I ² C Clock Synchronization	98	Timer1	192
I ² C Data Transfer Wait State		Watchdog Timer	19 [.]
I ² C Multi-Master Arbitration		PIC16C64A	
		Brown-out Reset	20.
I ² C Reception (7-bit Address)10	U I	Capture/Compare/PWM	
PIC16C61			
CLKOUT and I/O17		CLKOUT and I/O	
External Clock16	69	External Clock	
Oscillator Start-up Timer17	71	I ² C Bus Data	213
Power-up Timer17	71	I ² C Bus Start/Stop Bits	212
Reset		Oscillator Start-up Timer	20
Timer01		Parallel Slave Port	
		Power-up Timer	
Watchdog Timer	/ 1	Reset	
PIC16C62			
Capture/Compare/PWM19	93	SPI Mode	
CLKOUT and I/O19	90	Timer0	
External Clock18	89	Timer1	208
I ² C Bus Data19	97	Watchdog Timer	20
I ² C Bus Start/Stop Bits		PIC16C65	
Oscillator Start-up Timer		Capture/Compare/PWM	221
•		CLKOUT and I/O	22
Power-up Timer			
Reset19		External Clock	
SPI Mode19	95	I ² C Bus Data	
Timer019	92	I ² C Bus Start/Stop Bits	
Timer119	92	Oscillator Start-up Timer	223
Watchdog Timer19		Parallel Slave Port	226
PIC16C62A	01	Reset	
	07	SPI Mode	
Brown-out Reset			
Capture/Compare/PWM		Timer0	
CLKOUT and I/O20		Timer1	224
External Clock20		USART Synchronous Receive	
I ² C Bus Data2	13	(Master/Slave)	
I ² C Bus Start/Stop Bits2		Watchdog Timer	223
Oscillator Start-up Timer		PIC16C65A	
		Brown-out Reset	220
Power-up Timer			
Reset		Capture/Compare/PWM	
SPI Mode2		CLKOUT and I/O	
Timer020	08	External Clock	
Timer120	08	I ² C Bus Data	24

	I ² C Bus Start/Stop Bits244
	Oscillator Start-up Timer
	Parallel Slave Port242
	Power-up Timer
	Reset
	SPI Mode243
	Timer0240
	Timer1240
	USART Synchronous Receive
	(Master/Slave)246
	Watchdog Timer239
PIC	16C66
1 10	
	Brown-out Reset
	Capture/Compare/PWM273
	CLKOUT and I/O270
	External Clock269
	I ² C Bus Data279
	I ² C Bus Start/Stop Bits278
	Oscillator Start-up Timer
	•
	Power-up Timer271
	Reset271
	Timer0272
	Timer1272
	USART Synchronous Receive
	(Master/Slave)280
B10	Watchdog Timer271
PIC	16C67
	Brown-out Reset271
	Capture/Compare/PWM273
	CLKOUT and I/O270
	External Clock
	I ² C Bus Data
	I ² C Bus Start/Stop Bits
	Oscillator Start-up Timer271
	Parallel Slave Port274
	Power-up Timer271
	Power-up Timer
	•
	Reset
	Reset 271 Timer0 272 Timer1 272
	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive
	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) 280
	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) 280 Watchdog Timer 271
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) 280 Watchdog Timer 271 16CR62
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) 280 Watchdog Timer 271
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) 280 Watchdog Timer 271 16CR62 Capture/Compare/PWM 209
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 2 Capture/Compare/PWM 209 CLKOUT and I/O 206
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) Watchdog Timer 271 16CR62 209 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) Watchdog Timer 271 16CR62 209 CLKOUT and I/O 206 External Clock 205 I²C Bus Data 213
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 2 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I ² C Bus Data 213 I ² C Bus Start/Stop Bits 212
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) 280 Watchdog Timer 271 16CR62 26 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I ² C Bus Data 213 I ² C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 2 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 1 ² C Bus Data 213 I ² C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) Watchdog Timer 271 16CR62 20 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I²C Bus Data 213 I²C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207 Reset 207
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 2 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 1 ² C Bus Data 213 I ² C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) Watchdog Timer 271 16CR62 20 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I²C Bus Data 213 I²C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207 Reset 207
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 20 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I²C Bus Data 213 I²C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207 Reset 207 SPI Mode 211 Timer0 208
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 2 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I²C Bus Data 213 I²C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207 Reset 207 SPI Mode 211 Timer0 208 Timer1 208
PIC	Reset 271 Timer0 272 Timer1 272 USART Synchronous Receive (Master/Slave) (Master/Slave) 280 Watchdog Timer 271 16CR62 20 Capture/Compare/PWM 209 CLKOUT and I/O 206 External Clock 205 I²C Bus Data 213 I²C Bus Start/Stop Bits 212 Oscillator Start-up Timer 207 Power-up Timer 207 Reset 207 SPI Mode 211 Timer0 208

PIC16CR63	
Brown-out Reset	255
Capture/Compare/PWM	
CLKOUT and I/O	254
External Clock	
I ² C Bus Data	
I ² C Bus Start/Stop Bits	
Oscillator Start-up Timer	
Power-up Timer	
Reset	
SPI Mode	
Timer0 Timer1	
USART Synchronous Receive	250
(Master/Slave)	262
Watchdog Timer	
PIC16CR64	200
Capture/Compare/PWM	209
CLKOUT and I/O	
External Clock	
I ² C Bus Data	
I ² C Bus Start/Stop Bits	
Oscillator Start-up Timer	
Parallel Slave Port	
Power-up Timer	
Reset	
SPI Mode	
Timer0	
Timer1	
Watchdog Timer	
PIC16CR65	
Brown-out Reset	255
Capture/Compare/PWM	257
CLKOUT and I/O	254
External Clock	253
I ² C Bus Data	261
I ² C Bus Start/Stop Bits	260
Oscillator Start-up Timer	255
Parallel Slave Port	
Power-up Timer	
Reset	
SPI Mode	
Timer0	
Timer1	256
USART Synchronous Receive	
(Master/Slave)	
Watchdog Timer	
Power-up Timer	
PWM Output	
RB0/INT Interrupt	
RX Pin Sampling	
SPI Master Mode	93
No SS Control	00
SPI Mode, Slave Mode With SS Control	00
SPI Slave Mode (CKE = 1)	
SPI Slave Mode Timing (CKE = 0)	
Timer0 with External Clock	
TMR0 Interrupt Timing	
USART Asynchronous Master Transmission	
USART Asynchronous Master Transmission	
(Back to Back)	113
USART Asynchronous Reception	
USART Synchronous Reception in	
Master Mode	119
USART Synchronous Tranmission	
Wake-up from SLEEP Through Interrupts	

TMR024, 26, 28, 30, 32, 37 TMR0 Clock Source Select bit, T0CS	
TMR0 Interrupt	
TMR0 Overflow Interrupt Enable bit, T0IE	
TMR0 Overflow Interrupt Flag bit, T0IF	
TMR0 Prescale Selection Table	
TMR0 Source Edge Select bit, T0SE	
TMR1 Overflow Interrupt Enable bit, TMR1IE	
TMR1 Overflow Interrupt Flag bit, TMR1IF	
TMR1CS	
TMR1H24, 26, 28, 30, 32, 3	
TMR1IE	
TMR1IF	41
TMR1L24, 26, 28, 30, 32, 3	34
TMR1ON	71
TMR224, 26, 28, 30, 32, 3	34
TMR2 Register	75
TMR2 to PR2 Match Interrupt Enable bit, TMR2IE3	38
TMR2 to PR2 Match Interrupt Flag bit, TMR2IF	41
TMR2IE	38
TMR2IF	41
TMR2ON	75
TO35, 13	31
TOUTPS3:TOUTPS0	
Transmit Enable bit, TXEN10	
Transmit Shift Register Status bit, TRMT10	
Transmit Status and Control Register10	
TRISA25, 27, 29, 31, 33, 34, 5	
TRISB25, 27, 29, 31, 33, 34, 5	
TRISC25, 27, 29, 31, 33, 34, 55, 9	
TRISD25, 27, 29, 31, 33, 34, 5	
TRISE	
TRMT10	
TX910)5
TX9)5)5
TX9)5)5)5
TX9	05 05 05 39
TX9 10 TX9D 10 TXEN 10 TXIE 3 TXIF 4	05 05 05 39 42
TX9 10 TX9D 10 TXEN 10 TXIE 5 TXIF 2 TXREG 24, 26, 28, 30, 32, 3	05 05 05 39 42 34
TX9 10 TX9D 10 TXEN 10 TXIE 3 TXIF 4	05 05 05 39 42 34
TX9 10 TX9D 10 TXEN 10 TXIE 5 TXIF 2 TXREG 24, 26, 28, 30, 32, 3	05 05 05 39 42 34
TX9 10 TX9D 11 TXEN 10 TXIE 10 TXIE 24, 26, 28, 30, 32, 3 TXSTA 25, 27, 29, 31, 33, 34, 10 U	05 05 05 39 42 34 05
TX9 10 TX9D 11 TX9D 11 TXEN 10 TXIE 10 TXIE 24, 26, 28, 30, 32, 31 TXREG 25, 27, 29, 31, 33, 34, 10 U U U U U H 10 TX9D 11 TX9D 12 TX9D 12 TX9D 13 TX9D 13 TX9D 14 TX9D 15 TX9D 1	05 05 05 39 42 34 05
TX9 10 TX9D 11 TXEN 10 TXIE 2 TXIF 4 TXREG 24, 26, 28, 30, 32, 3 TXSTA 25, 27, 29, 31, 33, 34, 10 U UA UA 84, 8 Universal Synchronous Asynchronous Receiver Transmitt	05 05 05 39 42 34 05
TX9 10 TX9D 11 TX9D 11 TXEN 10 TXIE 10 TXIE 24, 26, 28, 30, 32, 31 TXREG 25, 27, 29, 31, 33, 34, 10 U U U U U H 10 TX9D 11 TX9D 12 TX9D 12 TX9D 13 TX9D 13 TX9D 14 TX9D 15 TX9D 1	05 05 05 39 42 34 05
TX9	05 05 39 42 34 05 89 er
TX9	05 05 05 39 42 34 05 89 er
TX9	05 05 05 39 42 34 05 89 er
TX9	05 05 05 39 42 34 05 89 er
TX9	05 05 39 42 34 05 89 er
TX9	05 05 05 39 42 34 05 89 er 13 13
TX9	05 05 05 39 42 34 05 89 er 13 13
TX9	05 05 05 39 42 34 05 39 er 13 14
TX9	05 05 05 39 42 34 05 39 er 13 14
TX9	05 05 05 39 42 34 05 39 er 13 14 14
TX9	05 05 05 05 39 42 34 05 89 er 13 14 14 14 15
TX9	05 05 05 05 39 42 34 05 89 er 13 14 14 14 15 18
TX9 10 TX9D 11 TXEN 11 TXIE 2 TXIF 4 TXREG 24, 26, 28, 30, 32, 3 TXSTA 25, 27, 29, 31, 33, 34, 10 U UA UA 84, 8 Universal Synchronous Asynchronous Receiver Transmitt (USART) Asynchronous Mode Setting Up Transmission 11 Timing Diagram, Master Transmission 11 Transmitter 11 Asynchronous Receiver 11 Setting Up Reception 11 Timing Diagram 11 Asynchronous Receiver Mode 11 Block Diagram 11 Section 11 Section 11 Synchronous Master Mode 11 Reception 11 Section 11 Section 11 Section 11	05 05 05 05 39 42 34 05 39 er 13 13 14 14 15 16
TX9	05 05 05 05 39 42 34 05 89 er 13 11 14 14 15 16 18
TX9	05 05 05 05 05 39 42 34 05 13 11 14 14 14 15 16 16 16 16 16 16 16 16 16 16 16 16 16
TX9	05 05 05 05 03 42 34 05 39 42 31 31 31 31 31 31 31 31 31 31 31 31 31
TX9	05 05 05 05 03 12 34 05 39 11 11 11 11 11 11 11 11 11 11 11 11 11

Synchronous Slave Mode	
Reception	120
Section	120
Setting Up Reception	120
Setting Up Transmission	120
Transmit	120
Transmit Block Diagram	112
Jpdate Address bit, UA	84, 89
JSART Receive Interrupt Enable bit, RCIE	39
JSART Receive Interrupt Flag bit, RCIF	42
JSART Transmit Interrupt Enable bit, TXIE	39
JSART Transmit Interrupt Flag bit, TXIF	42
JV Erasable Devices	7
W	
••	
Wake-up from Sleep	
Wake-up on Key Depression	
Wake-up Using Interrupts	141
Watchdog Timer (WDT)	
Block Diagram	
Period	
Programming Considerations	
Section	
WCOL	
Weak Internal Pull-ups	
Write Collision Detect bit, WCOL	85, 90
x	
XMIT MODE	104
XT	
z	
Z	35
Zero bit	
	0, 00

LIST OF	EQUATION AND EXAMPLES	Figure 4-15:	PIE1 Register for PIC16C65/65A/R65/67 (Address 8Ch)	40
Example 3-1:	Instruction Pipeline Flow18	Figure 4-16:	PIR1 Register for PIC16C62/62A/R62	. 40
•	Call of a Subroutine in Page 1		(Address 0Ch)	. 41
	from Page 049	Figure 4-17:	PIR1 Register for PIC16C63/R63/66	
Example 4-2:	Indirect Addressing49		Address 0Ch)	. 42
	Initializing PORTA51	Figure 4-18:	PIR1 Register for PIC16C64/64A/R64	
Example 5-2:	Initializing PORTB53		(Address 0Ch)	. 43
Example 5-3:	Initializing PORTC55	Figure 4-19:	PIR1 Register for PIC16C65/65A/R65/67	
Example 5-4:	Read-Modify-Write Instructions on an		(Address 0Ch)	. 44
	I/O Port60	Figure 4-20:	PIE2 Register (Address 8Dh)	. 45
Example 7-1:	Changing Prescaler (Timer0→WDT)69	Figure 4-21:	PIR2 Register (Address 0Dh)	. 46
Example 7-2:	Changing Prescaler (WDT→Timer0)69	Figure 4-22:	PCON Register for PIC16C62/64/65	
Example 8-1:	Reading a 16-bit		(Address 8Eh)	. 47
	Free-running Timer73	Figure 4-23:	PCON Register for PIC16C62A/R62/63/	
Example 10-1:	: Changing Between		R63/64A/R64/65A/R65/66/67	
	Capture Prescalers79		(Address 8Eh)	
Example 10-2:	: PWM Period and Duty	Figure 4-24:	Loading of PC in Different Situations	
	Cycle Calculation81	Figure 4-25:	Direct/Indirect Addressing	. 49
Example 11-1:	: Loading the SSPBUF	Figure 5-1:	Block Diagram of the	
	(SSPSR) Register86	= = = = =	RA3:RA0 Pins and the RA5 Pin	
Example 11-2:	: Loading the SSPBUF	Figure 5-2:	Block Diagram of the RA4/T0CKI Pin	. 51
	(SSPSR) Register (PIC16C66/67)91	Figure 5-3:	Block Diagram of the	
	: Calculating Baud Rate Error107	E: E 4	RB7:RB4 Pins for PIC16C61/62/64/65	. 53
Example 13-1:	: Saving Status and W	Figure 5-4:	Block Diagram of the	
	Registers in RAM139		RB7:RB4 Pins for PIC16C62A/63/R63/	- 4
Example 13-2:	: Saving Status, W, and	Fig 5 F.	64A/65A/R65/66/67	. 54
	PCLATH Registers in RAM	Figure 5-5:	Block Diagram of the	- 4
	(All other PIC16C6X devices)139	Figure F 6.	RB3:RB0 Pins	
		Figure 5-6:	PORTC Block Diagram	. ၁၁
LIST OF	EICHDEC	Figure 5-7:	PORTD Block Diagram (In I/O Port Mode)	57
LIST OF	FIGURES	Figure 5-8:	PORTE Block Diagram	. 37
Figure 3-1:	PIC16C61 Block Diagram10	rigure 5-6.	(In I/O Port Mode)	58
Figure 3-1:	PIC16C62/62A/R62/64/64A/R64	Figure 5-9:	TRISE Register (Address 89h)	
riguic o z.	Block Diagram11	Figure 5-10:	Successive I/O Operation	
Figure 3-3:	PIC16C63/R63/65/65A/R65	Figure 5-11:	PORTD and PORTE as a Parallel	. 00
ga. 0 0 0.	Block Diagram12	ga. 0 0 1 11	Slave Port	61
Figure 3-4:	PIC16C66/67 Block Diagram13	Figure 5-12:	Parallel Slave Port Write Waveforms	
Figure 3-5:	Clock/Instruction Cycle	Figure 5-13:	Parallel Slave Port Read Waveforms	
Figure 4-1:	PIC16C61 Program Memory Map	Figure 7-1:	Timer0 Block Diagram	
3	and Stack19	Figure 7-2:	Timer0 Timing: Internal Clock/No	
Figure 4-2:	PIC16C62/62A/R62/64/64A/	· ·	Prescaler	. 65
Ü	R64 Program Memory Map and Stack 19	Figure 7-3:	Timer0 Timing: Internal	
Figure 4-3:	PIC16C63/R63/65/65A/R65 Program	•	Clock/Prescale 1:2	. 66
	Memory Map and Stack19	Figure 7-4:	TMR0 Interrupt Timing	
Figure 4-4:	PIC16C66/67 Program Memory	Figure 7-5:	Timer0 Timing With External Clock	. 67
	Map and Stack20	Figure 7-6:	Block Diagram of the Timer0/WDT	
Figure 4-5:	PIC16C61 Register File Map20		Prescaler	. 68
Figure 4-6:	PIC16C62/62A/R62/64/64A/	Figure 8-1:	T1CON: Timer1 Control Register	
	R64 Register File Map21		(Address 10h)	. 71
Figure 4-7:	PIC16C63/R63/65/65A/R65	Figure 8-2:	Timer1 Block Diagram	. 72
	Register File Map21	Figure 9-1:	Timer2 Block Diagram	. 75
Figure 4-8:	PIC16C66/67 Data Memory Map22	Figure 9-2:	T2CON: Timer2 Control Register	
Figure 4-9:	STATUS Register		(Address 12h)	. 75
	(Address 03h, 83h, 103h, 183h)35	Figure 10-1:	CCP1CON Register (Address 17h) /	
Figure 4-10:	OPTION Register		CCP2CON Register (Address 1Dh)	. 78
	(Address 81h, 181h)36	Figure 10-2:	Capture Mode Operation	
Figure 4-11:	INTCON Register		Block Diagram	. 78
	(Address 0Bh, 8Bh, 10Bh 18Bh)37	Figure 10-3:	Compare Mode Operation	
Figure 4-12:	PIE1 Register for PIC16C62/62A/R62	_	Block Diagram	
	(Address 8Ch)38	Figure 10-4:	Simplified PWM Block Diagram	
Figure 4-13:	PIE1 Register for PIC16C63/R63/66	Figure 10-5:	PWM Output	. 80
E1	(Address 8Ch)	Figure 11-1:	SSPSTAT: Sync Serial Port Status	٠,
Figure 4-14:	PIE1 Register for PIC16C64/64A/R64		Register (Address 94h)	. 84
	(Address 8Ch)39			

Figure 11-2:	SSPCON: Sync Serial Port Control Register (Address 14h)85	Figure 13-2:	Configuration Word for PIC16C62/64/65	124
Figure 11-3:	SSP Block Diagram (SPI Mode) 86	Figure 13-3:	Configuration Word for	
Figure 11-4:	SPI Master/Slave Connection 87	· ·	PIC16C62A/R62/63/R63/64A/R64/	
Figure 11-5:	SPI Mode Timing, Master Mode or		65A/R65/66/67	124
3	Slave Mode w/o SS Control88	Figure 13-4:	Crystal/Ceramic Resonator Operation	
Figure 11-6:	SPI Mode Timing, Slave Mode with		(HS, XT or LP OSC Configuration)	125
ga	SS Control88	Figure 13-5:	External Clock Input Operation	0
Figure 11-7:	SSPSTAT: Sync Serial Port Status	rigulo 10 0.	(HS, XT or LP OSC Configuration)	125
rigule 11-7.	•	Figure 12 Cu	External Parallel Resonant	123
Fi 44.0	Register (Address 94h)(PIC16C66/67) 89	Figure 13-6:		407
Figure 11-8:	SSPCON: Sync Serial Port Control	F' 40 7	Crystal Oscillator Circuit	127
	Register (Address 14h)(PIC16C66/67)90	Figure 13-7:	External Series Resonant	
Figure 11-9:	SSP Block Diagram (SPI Mode)		Crystal Oscillator Circuit	
	(PIC16C66/67)91	Figure 13-8:	RC Oscillator Mode	127
Figure 11-10:	SPI Master/Slave Connection	Figure 13-9:	Simplified Block Diagram of	
	(PIC16C66/67)92		On-chip Reset Circuit	
Figure 11-11:	SPI Mode Timing, Master Mode	Figure 13-10:	Brown-out Situations	129
	(PIC16C66/67)93	Figure 13-11:	Time-out Sequence on Power-up	
Figure 11-12:	SPI Mode Timing (Slave Mode With		(MCLR not Tied to VDD): Case 1	134
	CKE = 0) (PIC16C66/67)	Figure 13-12:	Time-out Sequence on Power-up	
Figure 11-13:	SPI Mode Timing (Slave Mode With		(MCLR Not Tied To VDD): Case 2	134
	CKE = 1) (PIC16C66/67)	Figure 13-13:	Time-out Sequence on Power-up	
Figure 11-14:	Start and Stop Conditions95	•	(MCLR Tied to VDD)	134
	7-bit Address Format96	Figure 13-14:	External Power-on Reset Circuit	
	I ² C 10-bit Address Format96	J	(For Slow VDD Power-up)	135
	Slave-receiver Acknowledge96	Figure 13-15	External Brown-out	
	Data Transfer Wait State96	1.90.0 10 10.	Protection Circuit 1	135
•	Master-transmitter Sequence	Figure 13-16:	External Brown-out	100
	Master-receiver Sequence	rigule 15-10.	Protection Circuit 2	125
	Combined Format	Eiguro 12 17:		
			Interrupt Logic for PIC16C61	
rigure 11-22.	Multi-master Arbitration		Interrupt Logic for PIC16C6X	
F' 11 00	(Two Masters)98		INT Pin Interrupt Timing	
	Clock Synchronization		Watchdog Timer Block Diagram	140
	SSP Block Diagram (I ² C Mode)99	Figure 13-21:	Summary of Watchdog	
Figure 11-25:	I ² C Waveforms for Reception		Timer Registers	140
	(7-bit Address)101	Figure 13-22:	Wake-up from Sleep	
Figure 11-26:	I ² C Waveforms for Transmission		Through Interrupt	142
	(7-bit Address) 102	Figure 13-23:	Typical In-circuit Serial	
Figure 11-27:	Operation of the I ² C Module in		Programming Connection	142
	IDLE_MODE, RCV_MODE or	Figure 14-1:	General Format for Instructions	143
	XMIT_MODE104	Figure 16-1:	Load Conditions for Device Timing	
Figure 12-1:	TXSTA: Transmit Status and		Specifications	168
	Control Register (Address 98h) 105	Figure 16-2:	External Clock Timing	169
Figure 12-2:	RCSTA: Receive Status and	Figure 16-3:	CLKOUT and I/O Timing	170
•	Control Register (Address 18h) 106	Figure 16-4:	Reset, Watchdog Timer, Oscillator	
Figure 12-3:	RX Pin Sampling Scheme (BRGH = 0)	Ü	Start-up Timer and Power-up Timer	
Ü	PIC16C63/R63/65/65A/R65)110		Timing	171
Figure 12-4:	RX Pin Sampling Scheme (BRGH = 1)	Figure 16-5:	Timer0 External Clock Timings	
9	(PIC16C63/R63/65/65A/R65)110	Figure 17-1:	Typical RC Oscillator	
Figure 12-5:	RX Pin Sampling Scheme (BRGH = 1)	rigulo 17 1.	Frequency vs. Temperature	173
riguic 12 3.	(PIC16C63/R63/65/65A/R65)110	Figure 17-2:	Typical RC Oscillator	170
Ciaura 10 C	,	Figure 17-2.	Frequency vs. VDD	17/
Figure 12-6:	RX Pin Sampling Scheme (BRGH = 0 or = 1)	F: 17 0.		1/4
Ciaura 10 7	(PIC16C66/67)	Figure 17-3:	Typical RC Oscillator Frequency vs. VDD	17/
Figure 12-7:	USART Transmit Block Diagram	E'	True and DO Occillation	1/4
Figure 12-8:	Asynchronous Master Transmission113	Figure 17-4:	Typical RC Oscillator	474
Figure 12-9:	Asynchronous Master Transmission		Frequency vs. VDD	1/4
	(Back to Back)	Figure 17-5:	Typical IPD vs. VDD Watchdog Timer	
•	USART Receive Block Diagram 114		Disabled 25°C	174
	Asynchronous Reception114	Figure 17-6:	Typical IPD vs. VDD Watchdog Timer	
	Synchronous Transmission117		Enabled 25°C	175
Figure 12-13:	Synchronous Transmission	Figure 17-7:	Maximum IPD vs. VDD Watchdog	
	through TXEN117		Disabled	175
Figure 12-14:	Synchronous Reception	Figure 17-8:	Maximum IPD vs. VDD Watchdog	
	(Master Mode, SREN)119		Enabled*	176
Figure 13-1:	Configuration Word for PIC16C61123	Figure 17-9:	VTH (Input Threshold Voltage) of	
-		-	I/O Pins vs. VDD	176

Figure 17-10:	VIH, VIL of MCLR, TOCKI and OSC1		Figure 20-7:	Parallel Slave Port Timing	
	(in RC Mode) vs. VDD	177	Figure 20-8:	SPI Mode Timing	227
Figure 17-11:	VTH (Input Threshold Voltage) of		Figure 20-9:	I ² C Bus Start/Stop Bits Timing	228
	OSC1 Input (in XT, HS,		Figure 20-10:	I ² C Bus Data Timing	229
	and LP Modes) vs. VDD	177	Figure 20-11:	USART Synchronous Transmission	
Figure 17-12:	Typical IDD vs. Frequency			(Master/Slave) Timing	230
•	(External Clock, 25°C)	178	Figure 20-12:	USART Synchronous Receive	
Figure 17-13:	Maximum IDD vs. Frequency		3	(Master/Slave) Timing	230
ga	(External Clock, -40° to +85°C)	178	Figure 21-1:	Load Conditions for Device Timing	00
Eiguro 17 14:	Maximum IDD vs. Frequency	170	riguic 21 1.	Specifications	226
rigule 17-14.		170	Fig 01 0.	•	
	(External Clock, -55° to +125°C)		Figure 21-2:	External Clock Timing	
	WDT Timer Time-out Period vs. VDD	179	Figure 21-3:	CLKOUT and I/O Timing	238
Figure 17-16:	Transconductance (gm) of HS		Figure 21-4:	Reset, Watchdog Timer, Oscillator	
	Oscillator vs. VDD	179		Start-up Timer and Power-up Timer	
Figure 17-17:	Transconductance (gm) of LP			Timing	239
-	Oscillator vs. VDD	180	Figure 21-5:	Brown-out Reset Timing	239
Figure 17-18:	Transconductance (gm) of XT		Figure 21-6:	Timer0 and Timer1 External Clock	
ga	Oscillator vs. VDD	180	94.0 2 . 0.	Timings	240
Figure 17 10.			Figure 01 7	•	240
	IOH vs. VOH, VDD = 3V		Figure 21-7:	Capture/Compare/PWM Timings	044
	IOH vs. VOH, VDD = 5V		E: 010	(CCP1 and CCP2)	241
	IOL vs. VOL, VDD = 3V		Figure 21-8:	Parallel Slave Port Timing	
	IOL vs. VOL, VDD = 5V	181		(PIC16C65A)	
Figure 18-1:	Load Conditions for Device		Figure 21-9:	SPI Mode Timing	243
	Timing Specifications	188	Figure 21-10:	I ² C Bus Start/Stop Bits Timing	244
Figure 18-2:	External Clock Timing	189	Figure 21-11:	I ² C Bus Data Timing	245
Figure 18-3:	CLKOUT and I/O Timing			USART Synchronous Transmission	
Figure 18-4:	Reset, Watchdog Timer,			(Master/Slave) Timing	246
riguio 10 1.	Oscillator Start-up Timer and		Eiguro 21 12:	USART Synchronous Receive	0
	•	101	rigule 21-15.		040
F: 40 F	Power-up Timer Timing	191	F' 00.4	(Master/Slave) Timing	246
Figure 18-5:	Timer0 and Timer1 External		Figure 22-1:	Load Conditions for Device Timing	
	Clock Timings	192		Specifications	252
Figure 18-6:	Capture/Compare/PWM Timings		Figure 22-2:	External Clock Timing	253
	(CCP1)	193	Figure 22-3:	CLKOUT and I/O Timing	254
Figure 18-7:	Parallel Slave Port Timing		Figure 22-4:	Reset, Watchdog Timer, Oscillator	
	(PIC16C64)	194		Start-up Timer and Power-up Timer	
Figure 18-8:	SPI Mode Timing			Timing	255
Figure 18-9:	I ² C Bus Start/Stop Bits Timing		Figure 22-5:	Brown-out Reset Timing	
Figure 18-10:	I ² C Bus Data Timing		Figure 22-6:	Timer0 and Timer1 External Clock	200
•		107	riguic ZZ 0.		OFC
Figure 19-1:	Load Conditions for Device	004	F: 00 7	Timings	250
	Timing Specifications		Figure 22-7:	Capture/Compare/PWM Timings	
Figure 19-2:	External Clock Timing			(CCP1 and CCP2)	257
Figure 19-3:	CLKOUT and I/O Timing	206	Figure 22-8:	Parallel Slave Port Timing	
Figure 19-4:	Reset, Watchdog Timer,			(PIC16CR65)	258
	Oscillator Start-up Timer and		Figure 22-9:	SPI Mode Timing	259
	Power-up Timer Timing	207	Figure 22-10:	I ² C Bus Start/Stop Bits Timing	260
Figure 19-5:	Brown-out Reset Timing	207	Figure 22-11:	I ² C Bus Data Timing	261
Figure 19-6:	Timer0 and Timer1 External			USART Synchronous Transmission	
9	Clock Timings	208	9	(Master/Slave) Timing	262
Figure 19-7:	Capture/Compare/PWM Timings	200	Eiguro 22 12:	USART Synchronous Receive	202
rigule 13-7.		000	1 igule 22-15.		000
E: 40.0	(CCP1)	209	E: 00.4	(Master/Slave) Timing	202
Figure 19-8:	Parallel Slave Port Timing		Figure 23-1:	Load Conditions for Device Timing	
	(PIC16C64A/R64)			Specifications	
Figure 19-9:	SPI Mode Timing	211	Figure 23-2:	External Clock Timing	269
Figure 19-10:	I ² C Bus Start/Stop Bits Timing	212	Figure 23-3:	CLKOUT and I/O Timing	270
Figure 19-11:	I ² C Bus Data Timing	213	Figure 23-4:	Reset, Watchdog Timer, Oscillator	
Figure 20-1:	Load Conditions for Device Timing		•	Start-up Timer and Power-up Timer	
3	Specifications	220		Timing	271
Figure 20-2:	External Clock Timing		Figure 23-5:	Brown-out Reset Timing	
Figure 20-3:				Timer0 and Timer1 External Clock	/
•	CLKOUT and I/O Timing	८८८	Figure 23-6:		070
Figure 20-4:	Reset, Watchdog Timer, Oscillator		F: 22 =	Timings	2/2
	Start-up Timer and Power-up Timer		Figure 23-7:	Capture/Compare/PWM Timings	_
	Timing	223		(CCP1 and CCP2)	
Figure 20-5:	Timer0 and Timer1 External Clock		Figure 23-8:	Parallel Slave Port Timing (PIC16C67)	274
	Timings	224	Figure 23-9:	SPI Master Mode Timing (CKE = 0)	275
Figure 20-6:	Capture/Compare/PWM Timings		Figure 23-10:	SPI Master Mode Timing (CKE = 1)	
-	(CCP1 and CCP2)	225	•	SPI Slave Mode Timing (CKE = 0)	
	,			J (/ ········	-

Figure 23-12:	SPI Slave Mode Timing (CKE = 1) 276
Figure 23-13:	I ² C Bus Start/Stop Bits Timing278
Figure 23-14:	I ² C Bus Data Timing279
Figure 23-15:	USART Synchronous Transmission
-	(Master/Slave) Timing280
Figure 23-16:	USART Synchronous Receive
•	(Master/Slave) Timing280
Figure 24-1:	Typical IPD vs. VDD
•	(WDT Disabled, RC Mode)281
Figure 24-2:	Maximum IPD vs. VDD
Ü	(WDT Disabled, RC Mode)281
Figure 24-3:	Typical IPD vs. VDD @ 25°C
9	(WDT Enabled, RC Mode)282
Figure 24-4:	Maximum IPD vs. VDD
Ü	(WDT Enabled, RC Mode)282
Figure 24-5:	Typical RC Oscillator
3	Frequency vs. VDD282
Figure 24-6:	Typical RC Oscillator
	Frequency vs. VDD282
Figure 24-7:	Typical RC Oscillator
rigaro 2 1 7.	Frequency vs. VDD282
Figure 24-8:	Typical IPD vs. VDD Brown-out
rigaro E ro.	Detect Enabled (RC Mode)283
Figure 24-9:	Maximum IPD vs. VDD Brown-out
rigure 24-3.	Detect Enabled
	(85°C to -40°C, RC Mode)283
Figure 24-10:	Typical IPD vs. Timer1 Enabled
Figure 24-10.	(32 kHz, RC0/RC1 = 33 pF/33 pF,
Eiguro 24 11:	RC Mode)
Figure 24-11:	
	(32 kHz, RC0/RC1 = 33 pF/33 pF,
Fi 04.40	85°C to -40°C, RC Mode)
Figure 24-12:	Typical IDD vs. Frequency
E: 04.40	(RC Mode @ 22 pF, 25°C)284
Figure 24-13:	Maximum IDD vs. Frequency
E' 04.44	(RC Mode @ 22 pF, -40°C to 85°C)284
Figure 24-14:	Typical IDD vs. Frequency
Fig 04 45.	(RC Mode @ 100 pF, 25°C)
Figure 24-15:	Maximum IDD vs. Frequency
Fi 04.40	(RC Mode @ 100 pF, -40°C to 85°C) 285
Figure 24-16:	Typical IDD vs. Frequency
E: 04.4=	(RC Mode @ 300 pF, 25°C)286
Figure 24-17:	Maximum IDD vs. Frequency
E: 04.40	(RC Mode @ 300 pF, -40°C to 85°C) 286
Figure 24-18:	Typical IDD vs. Capacitance @ 500 kHz
	(RC Mode)287
Figure 24-19:	Transconductance(gm) of HS
	Oscillator vs. VDD287
Figure 24-20:	Transconductance(gm) of LP
	Oscillator vs. VDD287
Figure 24-21:	Transconductance(gm) of XT
	Oscillator vs. VDD287
Figure 24-22:	Typical XTAL Startup Time vs. VDD
	(LP Mode, 25°C)288
Figure 24-23:	Typical XTAL Startup Time vs. VDD
	(HS Mode, 25°C)288
Figure 24-24:	Typical XTAL Startup Time vs. VDD
	(XT Mode, 25°C)288
Figure 24-25:	Typical Idd vs. Frequency
	(LP Mode, 25°C)289
Figure 24-26:	Maximum IDD vs. Frequency
	(LP Mode, 85°C to -40°C)289
Figure 24-27:	Typical IDD vs. Frequency
	(XT Mode, 25°C)289
Figure 24-28:	Maximum IDD vs. Frequency
	(XT Mode, -40°C to 85°C)289

Figure 24-29:	Typical IDD vs. Frequency
	(HS Mode, 25°C)
Figure 24-30:	Maximum IDD vs. Frequency
	(HS Mode, -40°C to 85°C)

LIST OF	TABLES	Table 12-2	2: Registers Associated with Baud Rate Generator107
Table 1 1	DIC16C6V Family of Davison	Table 12-3	
Table 1-1:	PIC16C6X Family of Devices		•
Table 3-1:	PIC16C61 Pinout Description	. Table 12-4	(BRGH = 0)108
Table 3-2:	PIC16C62/62A/R62/63/R63/66	Table 12-	
T-bl- 0 0.	Pinout Description	Table 12-	(BRGH = 1)109
Table 3-3:	PIC16C64/64A/R64/65/65A/R65/67	Table 12-6	· ·
Table 4.4.	Pinout Description	1 able 12-0	Asynchronous Transmission 113
Table 4-1:	Special Function Registers for the	Toble 10	•
T 4.0	PIC16C61	Table 12-	
Table 4-2:	Special Function Registers for the	T-bl- 10 (Asynchronous Reception
	PIC16C62/62A/R6224	Table 12-8	•
Table 4-3:	Special Function Registers for the	T-bl- 10 /	Synchronous Master Transmission 117
	PIC16C63/R63	Table 12-9	•
Table 4-4:	Special Function Registers for the	T-bl- 10	Synchronous Master Reception
	PIC16C64/64A/R64	Table 12-	
Table 4-5:	Special Function Registers for the	Table 10	Synchronous Slave Transmission 121
T	PIC16C65/65A/R6530	Table 12-	
Table 4-6:	Special Function Registers for the	T-bl- 10	Synchronous Slave Reception
	PIC16C66/67		
Table 5-1:	PORTA Functions	Table 13-2	
Table 5-2:	Registers/Bits Associated with		PIC16C62/62A/R62/63/R63/
T = 0	PORTA		64/64A/R64/65/65A/R65/66/67
Table 5-3:	PORTB Functions	Table 13-	
Table 5-4:	Summary of Registers Associated with	Table 10	Oscillator for PIC16C61
	PORTB		- · · · · · · · · · · · · · · · · · · ·
Table 5-5:	PORTC Functions for PIC16C62/6455	i	Oscillator for PIC16C62/62A/R62/63/R63/
Table 5-6:	PORTC Functions for	T-1-1- 40 I	64/64A/R64/65/65A/R65/66/67
	PIC16C62A/R62/64A/R64	Table 13-	,
Table 5-7:	PORTC Functions for	T-1-1-40	PIC16C61/62/64/65130
	PIC16C63/R63/65/65A/R65/66/6756	Table 13-6	•
Table 5-8:	Summary of Registers Associated with		PIC16C62A/R62/63/R63/
	PORTC		64A/R64/65A/R65/66/67
Table 5-9:	PORTD Functions57	Table 13-	
Table 5-10:	Summary of Registers Associated with	T. I.I. 40 4	PIC16C61
	PORTD57		,
Table 5-11:	PORTE Functions59		PIC16C62/64/65
Table 5-12:	Summary of Registers Associated with	Table 13-9	•
	PORTE59)	PIC16C62A/R62/63/R63/
Table 5-13:	Registers Associated with	T. I.I. 40	64A/R64/65A/R65/66/67
	Parallel Slave Port		•
Table 7-1:	Registers Associated with Timer069		Registers on PIC16C61/62/64/65131
Table 8-1:	Capacitor Selection for the	Table 13-	•
	Timer1 Oscillator73	}	Registers on
Table 8-2:	Registers Associated with		PIC16C62A/R62/63/R63/
	Timer1 as a Timer/Counter74		64A/R64/65A/R65/66/67
Table 9-1:	Registers Associated with	Table 13-	
	Timer2 as a Timer/Counter76		all Registers
Table 10-1:	CCP Mode - Timer Resource77		•
Table 10-2:	Interaction of Two CCP Modules77		
Table 10-3:	Example PWM Frequencies	Table 15-	·
	and Resolutions at 20 MHz81	Table 16-	
Table 10-4:	Registers Associated with Timer1,		Specs for Oscillator Configurations
	Capture and Compare81		and Frequencies of Operation
Table 10-5:	Registers Associated with PWM	T 11 10	(Commercial Devices)
	and Timer282	Table 16-2	<u> </u>
Table 11-1:	Registers Associated with SPI		Requirements
	Operation88	Table 16-	ě .
Table 11-2:	Registers Associated with SPI		Requirements
	Operation (PIC16C66/67)		, ,
Table 11-3:	I ² C Bus Terminology95	i	Oscillator Start-up Timer and
Table 11-4:	Data Transfer Received Byte		Power-up Timer Requirements
	Actions100		•
Table 11-5:	Registers Associated with I ² C	Table 17-	
	Operation		2: Input Capacitance*181
Table 12-1:	Baud Bate Formula 107	•	

Table 18-1:	Cross Reference of Device Specs	Table 20-12:	USART Synchronous Receive	
	for Oscillator Configurations and		Requirements	230
	Frequencies of Operation	Table 21-1:	Cross Reference of Device	
	(Commercial Devices)183		Specs for Oscillator Configurations	
Table 18-2:	External Clock Timing		and Frequencies of Operation	
	Requirements189		(Commercial Devices)	231
Table 18-3:	CLKOUT and I/O Timing	Table 21-2:	External Clock Timing	
	Requirements190		Requirements	237
Table 18-4:	Reset, Watchdog Timer,	Table 21-3:	CLKOUT and I/O Timing	
	Oscillator Start-up Timer and	. 45.5 2.1 5.	Requirements	238
	Power-up Timer Requirements191	Table 21-4:	Reset, Watchdog Timer, Oscillator	200
Table 18-5:	Timer0 and Timer1 External	Table ET 1.	Start-up Timer, Power-up Timer, and	
Table 10 5.	Clock Requirements		Brown-out Reset Requirements	230
Table 18-6:	Capture/Compare/PWM	Table 21-5:	Timer0 and Timer1 External	200
Table 10-0.	Requirements (CCP1)	Table 21-5.	Clock Requirements	240
Table 18-7:	Parallel Slave Port Requirements (PIC16C64)	Table 21-6:	Capture/Compare/PWM	240
Table 10-7.	194	Table 21-0.		041
T-bl- 10 0.		T-bl- 01 7	Requirements (CCP1 and CCP2)	241
Table 18-8:	SPI Mode Requirements	Table 21-7:	Parallel Slave Port Requirements	040
Table 18-9:	I ² C Bus Start/Stop Bits	T-1-1- 04 0	(PIC16C65A)	
T-1-1- 40 40	Requirements	Table 21-8:	SPI Mode Requirements	243
Table 18-10:	I ² C Bus Data Requirements	Table 21-9:	I ² C Bus Start/Stop Bits	044
Table 19-1:	Cross Reference of Device Specs	T 11 04 40	Requirements	
	for Oscillator Configurations and	Table 21-10:	I ² C Bus Data Requirements	245
	Frequencies of Operation	Table 21-11:	USART Synchronous	
	(Commercial Devices)199		Transmission Requirements	246
Table 19-2:	External Clock Timing	Table 21-12:	USART Synchronous Receive	
	Requirements205		Requirements	246
Table 19-3:	CLKOUT and I/O Timing	Table 22-1:	Cross Reference of Device Specs	
	Requirements206		for Oscillator Configurations and	
Table 19-4:	Reset, Watchdog Timer,		Frequencies of Operation	
	Oscillator Start-up Timer,		(Commercial Devices)	247
	Power-up Timer, and Brown-out	Table 22-2:	External Clock Timing	
	Reset Requirements207		Requirements	253
Table 19-5:	Timer0 and Timer1 External	Table 22-3:	CLKOUT and I/O Timing	
	Clock Requirements208		Requirements	254
Table 19-6:	Capture/Compare/PWM	Table 22-4:	Reset, Watchdog Timer,	
	Requirements (CCP1)209		Oscillator Start-up Timer,	
Table 19-7:	Parallel Slave Port Requirements		Power-up Timer, and Brown-out	
	(PIC16C64A/R64)210		Reset Requirements	255
Table 19-8:	SPI Mode Requirements211	Table 22-5:	Timer0 and Timer1 External	
Table 19-9:	I ² C Bus Start/Stop Bits		Clock Requirements	256
	Requirements212	Table 22-6:	Capture/Compare/PWM	
Table 19-10:	I ² C Bus Data Requirements		Requirements (CCP1 and CCP2)	257
Table 20-1:	Cross Reference of Device Specs	Table 22-7:	Parallel Slave Port Requirements	
	for Oscillator Configurations and		(PIC16CR65)	258
	Frequencies of Operation	Table 22-8:	SPI Mode Requirements	
	(Commercial Devices)215	Table 22-9:	I ² C Bus Start/Stop Bits	
Table 20-2:	External Clock Timing		Requirements	260
. 00.0 20 2.	Requirements	Table 22-10:	I ² C Bus Data Requirements	
Table 20-3:	CLKOUT and I/O Timing	Table 22-11:	USART Synchronous Transmission	201
Table 20 0.	Requirements222	Table ZZ 11.	Requirements	262
Table 20-4:	Reset, Watchdog Timer,	Table 22-12:	USART Synchronous Receive	202
Table 20-4.		1 abie 22-12.	Requirements	262
	Oscillator Start-up Timer and Power-up Timer Requirements	Table 23-1:	Cross Reference of Device Specs	202
Table 20-5:	Timer0 and Timer1 External	Table 25-1.	for Oscillator Configurations and	
Table 20-5.			Frequencies of Operation	
T-bl- 00 C	Clock Requirements			000
Table 20-6:	Capture/Compare/PWM	T-bl- 00 0.	(Commercial Devices)	203
T-1-1- 00 7	Requirements (CCP1 and CCP2)225	Table 23-2:	External Clock Timing	000
Table 20-7:	Parallel Slave Port Requirements226	T-11 00 5	Requirements	269
Table 20-8:	SPI Mode Requirements	Table 23-3:	CLKOUT and I/O Timing	6=-
Table 20-9:	I ² C Bus Start/Stop Bits	- /	Requirements	270
	Requirements	Table 23-4:	Reset, Watchdog Timer,	
Table 20-10:	i ² C Bus Data Requirements229		Oscillator Start-up Timer,	
Table 20-11:	USART Synchronous Transmission		Power-up Timer, and Brown-out	
	Requirements230		Reset Requirements	271

Table 23-5:	Timer0 and Timer1 External	
	Clock Requirements	272
Table 23-6:	Capture/Compare/PWM	
	Requirements (CCP1 and CCP2)	273
Table 23-7:	Parallel Slave Port Requirements (PIC16 274	6C67)
Table 23-8:	SPI Mode Requirements	277
Table 23-9:	I ² C Bus Start/Stop Bits	
	Requirements	278
Table 23-10:	I ² C Bus Data Requirements	279
Table 23-11:	USART Synchronous Transmission	
	Requirements	280
Table 23-12:	USART Synchronous Receive	
	Requirements	280
Table 24-1:	RC Oscillator Frequencies	287
Table 24-2:	Capacitor Selection for Crystal	
	Oscillators	288
Table E-1:	Pin Compatible Devices	315

ON-LINE SUPPORT

Microchip provides two methods of on-line support. These are the Microchip BBS and the Microchip World Wide Web (WWW) site.

Use Microchip's Bulletin Board Service (BBS) to get current information and help about Microchip products. Microchip provides the BBS communication channel for you to use in extending your technical staff with microcontroller and memory experts.

To provide you with the most responsive service possible, the Microchip systems team monitors the BBS, posts the latest component data and software tool updates, provides technical help and embedded systems insights, and discusses how Microchip products provide project solutions.

The web site, like the BBS, is used by Microchip as a means to make files and information easily available to customers. To view the site, the user must have access to the Internet and a web browser, such as Netscape or Microsoft Explorer. Files are also available for FTP download from our FTP site.

Connecting to the Microchip Internet Web Site

The Microchip web site is available by using your favorite Internet browser to attach to:

www.microchip.com

The file transfer site is available by using an FTP service to connect to:

ftp://ftp.futureone.com/pub/microchip

The web site and file transfer site provide a variety of services. Users may download files for the latest Development Tools, Data Sheets, Application Notes, User's Guides, Articles and Sample Programs. A variety of Microchip specific business information is also available, including listings of Microchip sales offices, distributors and factory representatives. Other data available for consideration is:

- · Latest Microchip Press Releases
- Technical Support Section with Frequently Asked Questions
- · Design Tips
- Device Errata
- Job Postings
- · Microchip Consultant Program Member Listing
- Links to other useful web sites related to Microchip Products

Connecting to the Microchip BBS

Connect worldwide to the Microchip BBS using either the Internet or the CompuServe® communications network.

Internet:

You can telnet or ftp to the Microchip BBS at the address: mchipbbs.microchip.com

CompuServe Communications Network:

When using the BBS via the Compuserve Network, in most cases, a local call is your only expense. The Microchip BBS connection does not use CompuServe membership services, therefore you do not need CompuServe membership to join Microchip's BBS. There is no charge for connecting to the Microchip BBS.

The procedure to connect will vary slightly from country to country. Please check with your local CompuServe agent for details if you have a problem. CompuServe service allow multiple users various baud rates depending on the local point of access.

The following connect procedure applies in most locations.

- Set your modem to 8-bit, No parity, and One stop (8N1). This is not the normal CompuServe setting which is 7F1
- 2. Dial your local CompuServe access number.
- Depress the **<Enter>** key and a garbage string will appear because CompuServe is expecting a 7E1 setting.
- 4. Type +, depress the <Enter> key and "Host Name:" will appear.
- 5. Type MCHIPBBS, depress the **<Enter>** key and you will be connected to the Microchip BBS.

In the United States, to find the CompuServe phone number closest to you, set your modem to 7E1 and dial (800) 848-4480 for 300-2400 baud or (800) 331-7166 for 9600-14400 baud connection. After the system responds with "Host Name:", type NETWORK, depress the < Inter> key and follow CompuServe's directions.

For voice information (or calling from overseas), you may call (614) 723-1550 for your local CompuServe number.

Microchip regularly uses the Microchip BBS to distribute technical information, application notes, source code, errata sheets, bug reports, and interim patches for Microchip systems software products. For each SIG, a moderator monitors, scans, and approves or disapproves files submitted to the SIG. No executable files are accepted from the user community in general to limit the spread of computer viruses.

Systems Information and Upgrade Hot Line

The Systems Information and Upgrade Line provides system users a listing of the latest versions of all of Microchip's development systems software products. Plus, this line provides information on how customers can receive any currently available upgrade kits. The Hot Line Numbers are:

- 1-800-755-2345 for U.S. and most of Canada, and
- 1-602-786-7302 for the rest of the world.

970301

Trademarks: The Microchip name, logo, PIC, PICSTART, PICMASTER and PRO MATE are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries. FlexROM, MPLAB and fuzzyLAB, are trademarks and SQTP is a service mark of Microchip in the U.S.A.

fuzzyTECH is a registered trademark of Inform Software Corporation. IBM, IBM PC-AT are registered trademarks of International Business Machines Corp. Pentium is a trademark of Intel Corporation. Windows is a trademark and MS-DOS, Microsoft Windows are registered trademarks of Microsoft Corporation. CompuServe is a registered trademark of CompuServe Incorporated.

All other trademarks mentioned herein are the property of their respective companies.

READER RESPONSE

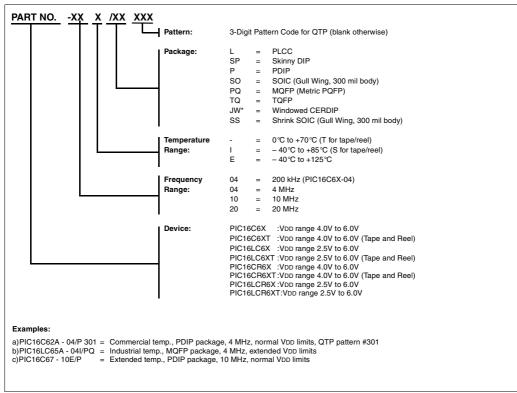
It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (602) 786-7578.

Please list the following information, and use this outline to provide us with your comments about this Data Sheet.

Io: RE:	Technical Publications Manager : Reader Response	Total Pages Sent			
Fror	m: Name Company Address City / State / ZIP / Country				
Ann	Telephone: ()	FAX: ()			
•	uld you like a reply?YN				
Dev	vice: PIC16C6X Literature N	Number: DS30234E			
Que	estions:				
1.	What are the best features of this document?	?			
2.	. How does this document meet your hardware and software development needs?				
3.	B. Do you find the organization of this data sheet easy to follow? If not, why?				
4.	What additions to the data sheet do you think would enhance the structure and subject?				
5.	What deletions from the data sheet could be	made without affecting the overall usefulness?			
			_		
6.	Is there any incorrect or misleading informati	on (what and where)?			
7.	How would you improve this document?				
8.	How would you improve our software, system	ns, and silicon products?			

PIC16C6X Product Identification System

To order or to obtain information, e.g., on pricing or delivery, please use the listed part numbers, and refer to the factory or the listed sales offices.



^{*} JW Devices are UV erasable and can be programmed to any device configuration. JW Devices meet the electrical requirement of each oscillator type (including LC devices).

Sales and Support

Products supported by a preliminary Data Sheet may possibly have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

- 1. The Microchip Website at www.microchip.com
- 2. Your local Microchip sales office (see following page)

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
 knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
 Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not
 mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Tradomarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rfPIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MTP, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

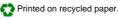
Analog-for-the-Digital Age, Application Maestro, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICWorks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, SQI, Serial Quad I/O, Total Endurance, TSHARC, UniWinDriver, WiperLock, ZENA and Z-Scale are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

GestIC and ULPP are registered trademarks of Microchip Technology Germany II GmbH & Co. & KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 1997-2013, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.



ISBN: 9781620769652

QUALITY MANAGEMENT SYSTEM

CERTIFIED BY DNV

= ISO/TS 16949=

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELO® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd.

Chandler, AZ 85224-6199 Tel: 480-792-7200

Fax: 480-792-7277 Technical Support:

http://www.microchip.com/

support Web Address:

www.microchip.com
Atlanta

Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Cleveland

Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Indianapolis

Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario, Canada Tel: 905-673-0699 Fax: 905-673-6509 ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway

Harbour City, Kowloon Hong Kong Tel: 852-2401-1200

Fax: 852-2401-3431
Australia - Svdnev

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Hangzhou Tel: 86-571-2819-3187 Fax: 86-571-2819-3189

China - Hong Kong SAR Tel: 852-2943-5100

Fax: 852-2401-3431 China - Nanjing

Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao

Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan

Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252

Fax: 86-29-8833-7256 China - Xiamen

Tel: 86-592-2388138 Fax: 86-592-2388130 China - Zhuhai

Tel: 86-756-3210040 Fax: 86-756-3210049 ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Osaka

Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo

Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857

Fax: 60-3-6201-9859 **Malaysia - Penang** Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366

Fax: 886-3-5770-955 **Taiwan - Kaohsiung**Tel: 886-7-213-7828

Fax: 886-7-330-9305
Taiwan - Taipei

Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350 **EUROPE**

Austria - Wels

Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4450-2828

Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

UK - Wokingham Tel: 44-118-921-5869 Fax: 44-118-921-5820

11/29/12



Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию.

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России, а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научноисследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,

Промышленная ул, дом № 19, литера Н,

помещение 100-Н Офис 331